## 16-bit MCU with 256 Kbyte Flash memory and 16 Kbyte RAM

## Features

- 16-bit CPU with DSP functions
- 50.0 ns instruction cycle time at 40 MHz (maximum) CPU clock
- Multiply/accumulate unit (MAC) $16 \times 16$-bit multiplication, 40-bit accumulator, repeat unit
- Enhanced boolean bit manipulations
- Additional instructions to support HLL and operating systems
- Single-cycle context switching support

■ Memory organization

- 256 Kbyte on-chip IFlash memory (single voltage with program/erase controller, full performance, 32-bit fetch)
- 100K erasing/programming cycles
- Up to 16 Mbytes linear address space for code and data (5 Mbyte with CAN)
- 2 Kbyte on-chip internal RAM (IRAM)
- 14 Kbyte extension RAM (XRAM).

Fast and flexible bus

- Programmable external bus characteristics for different address ranges (when 6 ADC added channels are not selected)
- 5 programmable chip-select signals
- Hold-acknowledge bus arbitration support.
- Interrupt
- 8-channel peripheral event controller for single cycle, interrupt driven data transfer
- 16-priority-level interrupt system with 56 sources, sample-rate down to 25.0 ns .
■ Two multi-functional general purpose timer units with 5 timers.
■ Two 16-channel capture/compare units(18 used).
■ 16-channel A/D converter
- 10-channel 10-bit (accuracy $\pm 2$ LSB)
- 6-channel (lower accuracy)

- $4.85 \mu \mathrm{~s}$ minimum conversion time.

■ 4-channel PWM unit and 4-Channel XPWM.
■ X-peripherals clock gating feature.

- Serial channels
- Two synch./asynch. serial channels
- Two high-speed synchronous channels
- One $\mathrm{I}^{2} \mathrm{C}$ standard interface.
- Fail-safe protection
- Programmable watchdog timer
- Oscillator watchdog.

■ Two CAN 2.0B interfaces operating on 1 or 2 CAN buses (64 or $2 \times 32$ message, C-CAN version)

- On-chip bootstrap loader.
- Clock generation
- On-chip PLL with 4 to 8 MHz oscillator
- Direct or pre-scaled clock input.

■ Real time clock.
■ Up to 76 general purpose I/O lines individually programmable as input, output or special function.

■ Idle, power down and stand-by modes.
■ Voltage supply for $5 \mathrm{~V} \pm 10 \%$ (embedded regulator for 1.8 V core supply).
■ Temperature range: -40 to $+125^{\circ} \mathrm{C}$.

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## 1 Introduction

### 1.1 Description

The ST10F252M is a new derivative of the STMicroelectronics ST10 family of 16-bit singlechip CMOS microcontrollers.

The ST10F252M combines high CPU performance (up to 24 million instructions per second) with high peripheral functionality and enhanced I/O capabilities. It also provides on-chip high-speed single voltage Flash memory, on-chip high-speed RAM, and clock generation via PLL.

The ST10F252M is processed in $0.18 \mu \mathrm{~m}$ CMOSM8 technology. The MCU core and the logic is supplied with a 5 V to 1.8 V on-chip voltage regulator. The part is supplied with a single 5 V supply and I/Os work at 5 V .
The ST10F252M is an optimized version of ST10F252E device, upward compatible with the following set of differences.

- The AC and DC parameters are modified due to a difference in the maximum CPU frequency. Refer to Section 27.5 and Section 27.8 for detailed description.
- XASC, XSSC, XPWM and I ${ }^{2} \mathrm{C}$ have been changed. Refer to Chapter 13.
- No external bus is available when all 16 ADC channels are selected.
- Pin T3EUD is added for encoder interface as alternate function of P1H.0.
- A/D Converter has 16 channels, 10 are on standard Port5, 6 channels on Port0.
- XPERCON register bit mapping modified according to new peripherals implementation.
- External bus NO ARBITRATION and READY, hold and ready pins not available
- On-chip low power oscillator, 32 KHz , is no longer available.

Figure 1. Logic symbol


## 2 Pin data

Figure 2. Pin configuration (top view)


## Table 1. Pin description

| Symbol | Pin | Type | Function |
| :---: | :---: | :---: | :---: |
| $\overline{\text { RSTIN }}$ | 1 | 1 | Reset Input with Schmitt-trigger characteristics. A low level at this pin for a specified duration while the oscillator is running resets the ST10F252M. An internal pull-up resistor permits power-on reset using only a capacitor connected to $\mathrm{V}_{\mathrm{SS}}$. In bidirectional reset mode (enabled by setting bit BDRSTEN in SYSCON register), the $\overline{\text { RSTIN }}$ line is pulled low for the duration of the internal reset sequence. |
| RSTOUT | 2 | 0 | Internal reset indication output. This pin is set to a low level when the device is executing either a hardware, a software or a watchdog timer reset. RSTOUT remains low until the EINIT (end of initialization) instruction is executed. |
| $\overline{\mathrm{NMI}}$ | 3 | 1 | Non-maskable interrupt input. A high to low transition at this pin causes the CPU to vector to the NMI trap routine. If bit PWDCFG = '0' in SYSCON register, when the PWRDN (power-down) instruction is executed, the $\overline{\text { NMI }}$ pin must be low in order to force the ST10F252M to go into power-down mode. If $\overline{\text { NMI }}$ is high and PWDCFG ='0', when PWRDN is executed, the part will continue to run in normal mode. If not used, pin $\overline{\mathrm{NMI}}$ should be pulled high externally. |

Table 1. Pin description (continued)

| Symbol | Pin | Type | Function |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| P2.2-P2.15 | $\begin{gathered} 4-11 \\ 15-20 \end{gathered}$ | I/O | PORT2 is a 14-bit bidirectional I/O port. It is bitwise programmable for input or output via direction bit. Programming an I/O pin as input forces the corresponding output driver to high impedance state. PORT2 outputs can be configured as push/pull or open drain drivers. The input threshold of PORT2 is selectable (TTL or CMOS). <br> The following PORT2 pins have alternate functions: |  |  |
|  | 4 | I/O | P2.2 | CC2IO | CAPCOM1: CC2 capture input / compare output |
|  | ... | ... | ... | ... | ... |
|  | 9 | I/O | P2.7 | CC7IO | CAPCOM1: CC7 capture input / compare output |
|  | 10 | I/O | P2.8 | CC8IO | CAPCOM1: CC8 capture input / compare output |
|  |  | 1 |  | EXOIN | Fast external interrupt 0 input |
|  | 11 | 1/O | P2.9 | CC9IO | CAPCOM1: CC9 capture-in/compare-out |
|  |  | 1 |  | EX1IN | Fast external interrupt 1input |
|  | 15 | 1/O | P2.10 | CC10IO | CAPCOM1: CC10 capture-in/compare-out |
|  |  | 1 |  | EX2IN | Fast external interrupt 2 input |
|  | ... | $\ldots$ | ... | ... | $\ldots$ |
|  | 20 | I/O | P2.15 | CC15IO | CAPCOM1: CC15 capture-in/compare-out |
|  |  | 1 |  | EX7IN | Fast external interrupt 7 input |
|  |  | 1 |  | T7IN | CAPCOM2 timer T7 count input |
| P5.0-P5.9 | 21-25 | I | PORT5 is a 10-bit input-only port with Schmitt-trigger characteristics. The pins of PORT5 can be the analog input channels (up to 10) for the A/D converter where P5.x equivals ANx (analog input channel $x$ ). |  |  |
|  | 28-32 | 1 |  |  |  |
| $\begin{gathered} \text { P3.0-P3.2, } \\ \text { P3.6 } \\ \text { P3.7-P3.13 } \\ \text { P3.15 } \end{gathered}$ | $\begin{gathered} 33-35 \\ 36, \\ 39-45 \\ 46 \end{gathered}$ | $\begin{aligned} & \text { I/O } \\ & \text { I/O } \\ & \text { I/O } \end{aligned}$ | PORT3 is a 12-bit (P3.3:5, P3.14 are missing) bidirectional I/O port, bitwise programmable for input or output via direction bit. Programming an I/O pin as input forces the corresponding output driver to high impedance state. PORT3 outputs can be configured as push/pull or open drain drivers. The input threshold of PORT3 is selectable (TTL or CMOS). <br> The following PORT3 pins have alternate functions: |  |  |
|  | 33 | I | P3.0 | TOIN | CAPCOM:1 timer T0 count input |
|  | 34 | 0 | P3.1 | T6OUT | GPT2: timer T6 toggle latch output |
|  | 35 | 1 | P3.2 | CAPIN | GPT2: register CAPREL capture input |
|  | 36 | 1 | P3.6 | T3IN | GPT1: timer T3 count / gate input |
|  | 39 | 1 | P3.7 | T2IN | GPT1: timer T2 input for count / gate / reload / capture |
|  | 40 | 1/O | P3.8 | MRST0 | SSC0 master-receiver / slave-transmitter I/O |
|  | 41 | I/O | P3.9 | MTSR0 | SSC0 master-transmitter / slave-receiver O/I |
|  | 42 | 0 | P3.10 | TxD0 | ASC0: clock / data output (asynchronous / synchronous) |
|  | 43 | I/O | P3.11 | RxD0 | ASCO: data input (asynchronous) or I/O (synchronous) |
|  | 44 | 0 | P3.12 | BHE | External memory high byte enable signal |
|  |  | 0 |  | $\overline{\text { WRH }}$ | External memory high byte write strobe |

Table 1. Pin description (continued)

| Symbol | Pin | Type | Function |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} \text { P3.0-P3.2, } \\ \text { P3.6 } \\ \text { P3.7-P3.13 } \\ \text { P3.15 } \end{gathered}$ | 45 | I/O | P3.13 | SCLK0 | SSC0: master clock output / slave clock input |
|  | 46 | 0 | P3.15 | CLKOUT | System clock output (programmable divider on CPU clock) |
| P7.0-P7.3 | 47-50 | I/O | PORT7 is a 4-bit bidirectional I/O port, bitwise programmable for input or output via direction bit (this port is connected to pins 47-50 only if bit P7EN of XMISC register is set.). Programming an I/O pin as input forces the corresponding output driver to high impedance state. PORT7 outputs can be configured as push/pull or open drain drivers. The input threshold of PORT7 is selectable (TTL or CMOS). The following PORT7 pins have alternate functions: (only if bit P7EN of XMISC register is set) |  |  |
|  | 47 | 0 | P7.0 | POUT0 | PWMO: channel 0 output |
|  | ... | $\ldots$ | ... | ... | PWMO: channel 1 output |
|  | 50 | 0 | P7.3 | POUT3 | PWMO: channel 3 output |
| P4.0-P4.7 | 47-54 | I/O | PORT4 is an 8-bit bidirectional I/O port. P4.0-P4.3 are connected to pins 47-50 only if P7EN of XMISC is not set (default after reset). <br> It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. In case of an external bus configuration, PORT4 can be used to output the segment address lines (A16...A19 output only if bit P7EN of XMISC register is not set): |  |  |
|  | 47 | 0 | P4.0 | A16 | Segment address line |
|  | 48 | 0 | P4.1 | A17 | Segment address line |
|  | 49 | 0 | P4.2 | A18 | Segment address line |
|  | 50 | 0 | P4.3 | A19 | Segment address line |
|  | 51 | 0 | P4.4 | A20 | Segment address line |
|  |  | I |  | CAN2_RxD | CAN2: receive data input |
|  | 52 | 0 | P4.5 | A21 | Segment address line |
|  |  | 1 |  | CAN1_RxD | CAN1: receive data input |
|  |  | 1 |  | CAN2_RxD | CAN2: receive data input |
|  | 53 | 0 | P4.6 | A22 | Segment address line |
|  |  | 0 |  | CAN1_TxD | CAN1 transmit data output |
|  |  | 0 |  | CAN2_TxD | CAN2 transmit data output |
|  | 54 | 0 | P4.7 | A23 | Segment address line |
|  |  | 0 |  | CAN2_TxD | CAN2 transmit data output |
| RPD | 55 | - | Timing pin for the return from interruptible power-down and synchronous / asynchronous reset selection. |  |  |
| $\overline{\mathrm{RD}}$ | 56 | 0 | External memory read strobe. $\overline{\mathrm{RD}}$ is activated for every external instruction or data read access. |  |  |

Table 1. Pin description (continued)

| Symbol | Pin | Type | Function |
| :---: | :---: | :---: | :---: |
| $\overline{W R} / \overline{W R L}$ | 57 | 0 | External memory write strobe. In $\overline{W R}$-mode this pin is activated for every external data write access. In WRL-mode this pin is activated for low byte data write accesses on a 16-bit bus, and for every data write access on an 8-bit bus. See WRCFG in SYSCON register for mode selection. |
| ALE | 58 | 0 | Address latch enable output. In case of use of external addressing or of multiplexed mode, this signal is the latch command pf the address lines. |
| $\overline{\mathrm{EA}} / \mathrm{V}_{\text {STBY }}$ | 59 | 1 | External access enable pin. <br> A low level applied to this pin during and after Reset forces the ST10F252M to start the program from the external memory space. A high level forces ST10F252M to start in the internal memory space. This pin is also used (when Stand-by mode is entered, that is ST10F252M under reset and main VDD turned off) to provide a reference voltage for the low-power embedded voltage regulator which generates the internal 1.8 V supply for the RTC module (when not disabled) and to retain data inside the Stand-by portion of the XRAM (16 Kbyte). <br> It can range from 4.5 to 5.5 V . In running mode, this pin can be tied low during reset RTC and XRAM activities, since the presence of a stable VDD guarantees the proper biasing of all those modules. |
| $\begin{aligned} & \text { POL.0-POL.7, } \\ & \text { POH.0-POH. } \end{aligned}$ | $\begin{aligned} & 63-70 \\ & 71-78 \end{aligned}$ | I/O | PORT0 is a two 8-bit bidirectional I/O ports POL and POH, bitwise programmable for input or output via direction bit. Programming an I/O pin as input forces the corresponding output driver to high impedance state. The input threshold of PORT0 is selectable (TTL or CMOS). <br> In case of an external bus configuration, PORT0 serves as the address ( A ) and as the address / data (AD) bus in multiplexed bus modes and as the data (D) bus in demultiplexed bus modes. <br> Demultiplexed bus modes <br> The pins of POL / POH also serve as the additional (up to six) analog input channels for the A/D converter, where POL. 7 equals to AN10 and POH.x equals ANy (Analog input channel $y$, where $y=x+11$ ). This additional function has a higher priority on demultiplexed bus function. |
| $\begin{aligned} & \text { P1L.0-P1L.7, } \\ & \text { P1H.0-P1H. } \end{aligned}$ | $\begin{aligned} & 79-86 \\ & 89-96 \end{aligned}$ | I/O | PORT1 is a two 8-bit bidirectional I/O ports P1L and P1H, bitwise programmable for input or output via direction bit. Programming an I/O pin as input forces the corresponding output driver to high impedance state. PORT1 is used as the 16-bit address bus ( A ) in demultiplexed bus modes: If at least BUSCONx is configured such that the demultiplexed mode is selected, the pins of PORT1 are not available for general purpose I/O function. The input threshold of PORT1 is selectable (TTL or CMOS). <br> The following PORT1 pins have alternate functions: |
|  | 79 | 0 | P1L. 0 XPOUT XPWM: channel 0 output |

Table 1. Pin description (continued)

| Symbol | Pin | Type | Function |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| P1L.0-P1L.7, P1H.0-P1H. 7 | 80 | 0 | P1L. 1 | XPOUT | XPWM: channel 1 output |
|  | 81 | 0 | P1L. 2 | XPOUT | XPWM: channel 2 output |
|  | 82 | 0 | P1L. 3 | XPOUT | XPWM: channel 3 output |
|  | 83 | 0 | P1L. 4 | TxD1 | ASC1: data input (asynchronous / synchronous) |
|  | 84 | I/O | P1L. 5 | RxD1 | ASC1: data input (asynchronous) or I/O (synchronous) |
|  | 85 | I/O | P1L. 6 | SCL | $1^{2} \mathrm{C}$ interface serial clock |
|  | 86 | I/O | P1L. 7 | SDA | $\mathrm{I}^{2} \mathrm{C}$ interface serial data |
|  | 89 | 1/0 | P1H. 0 | General purpose input |  |
|  |  | 1 | P3.4 | T3EUD | GPT3: external up / down |
|  | 90 | I/O | P1H. 1 | MRST1 | SSC1: master-receiver / slave-transmitter I/O |
|  | 91 | I/O | P1H. 2 | MTSR1 | SSC1: master-transmitter / slave-receiver O/I |
|  | 92 | I/O | P1H. 3 | SCLK1 | SSC1: master clock output / slave clock input |
|  | 93 | 1 | P1H. 4 | CC24I | CAPCOM2: CC24 capture input |
|  | 94 | 1 | P1H. 5 | CC25I | CAPCOM2: CC25 capture input |
|  | 95 | I | P1H. 6 | CC26I | CAPCOM2: CC26 capture input |
|  | 96 | 1 | P1H. 7 | CC27I | CAPCOM2: CC27 capture input |
| XTAL2 | 98 | 0 | XTAL2 | Output of the oscillator amplifier circuit. |  |
|  |  |  | To clock the device from an external source, drive XTAL1, while leaving XTAL2 unconnected. Minimum and maximum high/low and rise/fall times specified in the AC characteristics must be observed. |  |  |
| XTAL1 | 99 | 1 | XTAL1 | Main osc | amplifier circuit and/or external clock input. |
| $V_{\text {AREF }}$ | 26 | - | A/D converter reference voltage and analog supply. |  |  |
| $\mathrm{V}_{\text {AGND }}$ | 27 | - | A/D converter reference and analog ground. |  |  |
| $\mathrm{V}_{18}$ | 14, 62 | 0 | 1.8 V decoupling pin. <br> A decoupling capacitor (typical value of 10 nF , max. 100 nF ) must be connected between this pin and nearest $\mathrm{V}_{\mathrm{SS}}$ pin. |  |  |
| $V_{\text {DD }}$ | $\begin{gathered} 12,38, \\ 60,87, \\ 97 \end{gathered}$ | - | Digital supply voltage $=+5 \mathrm{~V}$ during normal operation, idle mode and power-down modes. <br> It can be turned off when Stand-by RAM mode is selected. |  |  |
| $\mathrm{V}_{S S}$ | $\begin{gathered} 13,37, \\ 61,88, \\ 100 \end{gathered}$ | - | Digital ground. |  |  |

## 3 Functional description

The architecture of the ST10F252M combines advantages of both RISC and CISC processors and an advanced peripheral subsystem. The block diagram gives an overview of the different on-chip components and the high bandwidth internal bus structure of the ST10F252M.

Figure 3. Block diagram


## 4 Memory organization

The memory space of the ST10F252M is configured in a unified memory architecture. Code memory, data memory, registers and I/O ports are organized within the same linear address space of 16 Mbytes. The entire memory space can be accessed bytewise or wordwise. Particular portions of the on-chip memory have additionally been made directly bit addressable.

IFlash: 256 Kbytes of on-chip Flash memory. It is divided in eight blocks (B0F0...B0F7) that constitute the Bank 0. When bootstrap mode is selected, the Test-Flash Block B0TF (4 Kbytes) appears at address 00'0000h: refer to Chapter 8: Internal Flash memory for more details on memory mapping in boot mode. The summary of address range for IFlash is the following Table 2:
Table 2. IFlash addresses

| Blocks | User Mode | Size |
| :---: | :---: | :---: |
| B0TF | Not visible | 4 K |
| B0F0 | $00^{\prime} 0000 \mathrm{~h}-00^{\prime} 1 \mathrm{FFFh}$ | 8 K |
| B0F1 | $00^{\prime} 2000 \mathrm{~h}-00^{\prime} 3 F F F h$ | 8 K |
| B0F2 | $00^{\prime} 4000 \mathrm{~h}-00^{\prime} 5 F F F h$ | 8 K |
| B0F3 | $00^{\prime} 6000 \mathrm{~h}-00^{\prime} 7 F F F h$ | 8 K |
| B0F4 | $01^{\prime} 8000 \mathrm{~h}-01^{\prime} \mathrm{FFFFh}$ | 32 K |
| B0F5 | $02^{\prime} 0000 \mathrm{~h}-0 \mathbf{\prime}^{\prime} \mathrm{FFFFh}$ | 64 K |
| B0F6 | $03^{\prime} 0000 \mathrm{~h}-03^{\prime}$ FFFFh | 64 K |
| B0F7 | $04^{\prime} 0000 \mathrm{~h}-04^{\prime} F F F F h$ | 64 K |
| Reserved area | $05^{\prime} 0000 \mathrm{~h}-07^{\prime} F F F F h$ | 192 K |
| Flash Regs | $08^{\prime} 0000 \mathrm{~h}-08^{\prime} F F F F h$ | 64 K |

Note: $\quad$ When bit ROMEN in SYSCON register is set, the address 05'0000h-07'FFFFh is considered as reserved (no external memory access is enabled). Trying to read in this address area outputs dummy data (software trap 009Bh).

IRAM: 2 Kbytes of on-chip internal RAM (dual-port) is provided as a storage for data, system stack, general purpose register banks and code. A register bank is 16 Wordwide (R0 to R15) and/or Bytewide (RL0, RH0, ... RL7, RH7) general purpose registers group. Base address is $00{ }^{\prime} F 600 \mathrm{~h}$, upper address is 00'FDFFh.
XRAM: 14Kbytes of on-chip extension RAM (single port XRAM) is provided as a storage for data, user stack and code.
The XRAM is divided into two areas, the first 2 Kbytes named XRAM1 and the second 12 Kbyte named XRAM2, connected to the internal XBUS and are accessed like an external memory in 16-bit demultiplexed bus-mode without wait state or read/write delay ( 50 ns access at 40 MHz CPU clock). Byte and Word accesses are possible.
The XRAM1 address range is 00'E000h - 00'E7FFh if XPEN (bit 2 of SYSCON register), and XRAM1EN (bit 2 of XPERCON register) are set. If bit XRAM1EN or XPEN is cleared, then any access in the address range 00'E000h - 00'E7FFh will be directed to external
memory interface, using the BUSCONx register corresponding to address matching ADDRSELx register.

The XRAM2 address range is the one selected programming XADDR3 register, if XPEN (bit 2 in SYSCON register), and XRAM2EN (bit 3 of XPERCON register) are set. If bit XPEN is cleared, then any access in the address range programmed for XRAM2 will be directed to external memory interface, using the BUSCONx register corresponding to address matching ADDRSELx register.
After reset, the XRAM2 address range is 09'0000h-09'3FFFh and is mirrored every 16 Kbyte boundary until 0F'FFFFh.

XRAM2 also represents the Stand-by RAM, which can be maintained biased through $\overline{\mathrm{EA}} / \mathrm{V}_{\mathrm{STBY}}$ pin when the main supply $\mathrm{V}_{\mathrm{DD}}$ is turned off.
As the XRAM appears like external memory, it cannot be used as system stack or as register banks. The XRAM is not provided for single bit storage and therefore is not bit addressable.

SFR/ESFR: 1024 bytes ( $2 \times 512$ bytes) of address space is reserved for the special function register areas. SFRs are Wordwide registers which are used to control and to monitor the function of the different on-chip units.

CAN1: Address range 00'EF00h - 00'EFFFh is reserved for the CAN1 module access. The CAN1 is enabled by setting XPEN bit 2 of the SYSCON register and by setting CAN1EN bit 0 of the XPERCON register. Accesses to the CAN1 module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two wait states give an access time of 100 ns at 40 MHz CPU clock. No tristate waitstate is used.

CAN2: Address range 00'EE00h - 00'EEFFh is reserved for the CAN2 module access. The CAN2 is enabled by setting XPEN bit 2 of the SYSCON register and by setting CAN2EN bit 1 of the XPERCON register. Accesses to the CAN2 module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two wait states give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used.

Note: $\quad$ If one or the two CAN modules are used, Port 4 cannot be programmed to output all eight segment address lines. Thus, only four segment address lines can be used, reducing the external memory space to 5 Mbytes (1 Mbyte per CS line).

XRTC: Address range 00'ED00h - 00'EDFFh is reserved for the XRTC module access. The XRTC is enabled by setting XPEN bit 2 of the SYSCON register and bit 4 of the XPERCON register. Accesses to the XRTC module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two wait states give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used.

XPWM: Address range 00'ECOOh - 00'ECFFh is reserved for the XPWM module access. The XPWM is enabled by setting XPEN bit 2 of the SYSCON register and bit 6 of the XPERCON register. Accesses to the XPWM module use demultiplexed addresses and a 16bit data bus (only word accesses are possible). Two waitstates give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used. Only word access is allowed.

XASC: Address range 00'E900h - 00'E9FFh is reserved for the XASC module access. The XASC is enabled by setting XPEN bit 2 of the SYSCON register and bit 7 of the XPERCON register. Accesses to the XASC module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two waitstates give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used.

XSSC: Address range 00'E800h - 00'E8FFh is reserved for the XSSC module access. The XSSC is enabled by setting XPEN bit 2 of the SYSCON register and bit 8 of the XPERCON register. Accesses to the XSSC module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two waitstates give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used.
$\mathrm{XI}^{2} \mathrm{C}$ : Address range $00^{\prime} \mathrm{EA} 00 \mathrm{~h}-00^{\prime} \mathrm{EAFFh}$ is reserved for the $\mathrm{XI}^{2} \mathrm{C}$ module access. The $\mathrm{XI}^{2} \mathrm{C}$ is enabled by setting XPEN bit 2 of the SYSCON register and bit 9 of the XPERCON register. Accesses to the $\mathrm{XI}^{2} \mathrm{C}$ module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two waitstates give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used.

X-Miscellaneous: Address range 00'EB00h - 00'EBFFh is reserved for the access to a set of XBUS additional features. They are enabled by setting XPEN bit 2 of the SYSCON register and bit10 of the XPERCON register. Accesses to these additional features use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two waitstates give an access time of 100.0 ns at 40 MHz CPU clock. No tristate waitstate is used. The following set of features are provided:

- CLKOUT programmable divider
- XBUS interrupt management registers
- CAN2 multiplexing on P4.5/P4.6
- CAN1-2 main clock prescaler
- main voltage regulator disable for power-down mode
- TTL / CMOS threshold selection for Port0, Port1, and Port5
- Flash temporary unprotection
- Port4/Port7 selection for pins 47-50

In order to keep the needs of designs where more memory is required than is provided on the chip, up to 16 Mbytes of external memory can be connected to the microcontroller.
Note: $\quad$ When P7EN bit is set in XMISC register, the Port7 low nibble is available on the pins 47 to 50 and Port4 low is not available. Therefore the relative address lines are not available and the external memory space is reduced to 64 Kbytes."

## Visibility of XBUS peripherals

In order to keep the ST10F252M compatible with ST10F168 / ST10F269, the XBUS peripherals can be selected to be visible on the external address / data bus. Different bits for X-peripheral enabling in XPERCON register must be set. If these bits are cleared before the global enabling with XPEN bit in SYSCON register, the corresponding address space, port pins and interrupts are not occupied by the peripherals, thus the peripheral is not visible and not available. Refer to Chapter 26: Register set on page 254

## XPERCON and XPEREMU clock gating

As already mentioned, the XPERCON register has to be programmed to enable the single X-BUS modules separately. The XPERCON is a read/write ESFR register.
The new feature of clock gating has been implemented by mean of this register. Once the EINIT instruction has been executed, all the peripherals (except RAMs and XMISC), not enabled in the XPERCON register are not be clocked. The clock gating can reduce power consumption and improve EMI when the user doesn't use all the X-Peripherals

## Note: $\quad$ When the clock has been gated in the disabled Peripherals, no Reset will be raised once the

 EINIT instruction has been executed.
### 4.1 XPERCON and XPEREMU registers

Once the XPEN bit of the SYSCON register is set and at least one of the X-peripherals (except memories) is activated, the register XPEREMU must be written with the same content of XPERCON: this is mandatory to allow correct emulation of the features on the X-BUS for the new ST10 generation.
XPEREMU must be programmed after XPERCON and after SYSCON so that the final configuration for X-peripherals is stored in XPEREMU and used for the emulation hardware setup.

## XPERCON



Table 3. XPERCON register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 11$ | Reserved |  |
| 10 | XMISCEN | XBUS additional features enable bit <br> '0': Access to the additional miscellaneous features is disabled. The <br> address range 00'EB00h-00'EBFFh is directed to external memory <br> only if CAN1EN, CAN2EN, XRTCEN, XASCEN, XSSCEN, XPWMEN <br> and XI2CEN are '0' also. <br> '1': The Additional Features are enabled and can be accessed. |
| 9 | XI2CEN | XI²C enable bit <br> '0': Accesses to the on-chip XI²C are disabled, external access is <br> performed. The address range 00'EA00h-00'EAFFh is directed to <br> external memory only if CAN1EN, CAN2EN, XRTCEN, XASCEN, <br> XSSCEN, XPWMEN and XMISCEN are '0' also. <br> '1': The on-chip XI²C is enabled and can be accessed. |
| 8 | XSSCEN | XSSC enable bit <br> '0': Accesses to the on-chip XSSC are disabled, external access is <br> performed. The address range 00'E800h-00'E8FFh is directed to <br> external memory only if CAN1EN, CAN2EN, XRTCEN, XASCEN, <br> XI2CEN, XPWMEN and XMISCEN are '0' also. <br> '1': The on-chip XSSC is enabled and can be accessed. |
| 7 | XASC enable bit <br> '0': Accesses to the on-chip XASC are disabled, external access is <br> performed. The address range O0'E900h-00'E9FFh is directed to <br> external memory only if CAN1EN, CAN2EN, XRTCEN, XASCEN, <br> XI2CEN, XPWMEN and XMISCEN are '0' also. |  |
| '1': The on-chip XASC is enabled and can be accessed. |  |  |

Table 3. XPERCON register functions (continued)

| Bit | Name | Function |
| :---: | :---: | :---: |
| 6 | XPWMEN | XPWM enable <br> '0': Accesses to the on-chip XPWM module are disabled, external access is performed. The address range $00^{\prime} E C 00 h-00^{\prime} E C F F$ is directed to external memory only if CAN1EN, CAN2EN, XASCEN, XSSCEN, XI2CEN, XRTCEN and XMISCEN are ' 0 ' also. <br> ' 1 ': The on-chip XPWM module is enabled and can be accessed. |
| 5 | Reserved |  |
| 4 | XRTCEN | XRTC enable <br> ' 0 ': Accesses to the on-chip XRTC module are disabled, external access is performed. The address range $00^{\prime} E D 00 h-00^{\prime} E D F F$ is directed to external memory only if CAN1EN, CAN2EN, XASCEN, XSSCEN, XI2CEN, XPWMEN and XMISCEN are ' 0 ' also. <br> ' 1 ': The on-chip XRTC module is enabled and can be accessed. |
| 3 | XRAM2EN | XRAM2 enable bit <br> ' 0 ': Accesses to the on-chip 16 Kbyte XRAM are disabled, external access is performed. <br> '1': The on-chip 16 Kbyte XRAM is enabled and can be accessed. |
| 2 | XRAM1EN | XRAM1 enable bit <br> ' 0 ': Accesses to the on-chip 2 Kbyte XRAM are disabled. The address range $00^{\prime} E 000 \mathrm{~h}-00^{\prime} E 7 F F h$ is directed to external memory. <br> ' 1 ': The on-chip 2 Kbyte XRAM is enabled and can be accessed. |
| 1 | CAN2EN | CAN2 enable bit <br> ' 0 ': Accesses to the on-chip CAN2 X=peripheral and its functions are disabled (P4.4 and P4.7 pins can be used as general purpose I/Os, but the address range $00^{\prime} E C 00 h-00^{\prime} E F F F h$ is directed to external memory only if CAN1EN, XRTCEN, XASCEN, XSSCEN, XI2CEN, XPWMEN and XMISCEN are '0' also). <br> '1': The on-chip CAN2 X-peripheral is enabled and can be accessed. |
| 0 | CAN1EN | CAN1 enable bit <br> '0': Accesses to the on-chip CAN1 X-peripheral and its functions are disabled (P4.5 and P4.6 pins can be used as general purpose I/Os, but the address range 00'ECOOh-00'EFFFh is directed to external memory only if CAN2EN, XRTCEN, XASCEN, XSSCEN, XI2CEN, XPWMEN an XMISCEN are ' 0 ' also). <br> ' 1 ': The on-chip CAN1 X-peripheral is enabled and can be accessed. |

Note: $\quad$ When CAN1, CAN2, XRTC, XASC, XSSC, $X I^{2} C, X P W M$ and the XBUS additional features are all disabled via XPERCON setting, any access in the address range 00'E800h OO'EFFFh is directed to external memory interface, using the BUSCONx register corresponding to address matching ADDRSELx register. All pins involved with

X-peripherals, can be used as general purpose I/O whenever the related module is not enabled.

When one or more of the peripherals $X A S C, X I^{2} C, X S S C$, and $X P W M$ are enabled, port P1 cannot be used for external memory addressing, that is, the external bus controller in demultiplexed mode is not available.

The default XPER selection after reset is identical to XBUS configuration of ST10F168/ST10F269: CAN1 is enabled, CAN2 is disabled, XRAM1 (2 Kbyte XRAM) is enabled, XRAM2 (16 Kbyte XRAM) is disabled; all the other X-peripherals are disabled after reset.
The register XPERCON cannot be changed after the global enabling of X-peripherals, that is, after setting of bit XPEN in SYSCON register.
In Emulation mode, all the $X$-peripherals are enabled (XPERCON bits are all set). It is up to the bondout chip (ST10R201) whether of not to redirect an access to external memory or to XBUS.
Reserved bits of XPERCON register are always written to ' 0 '.

## XPEREMU



The bit meaning is exactly the same as XPERCON.

### 4.2 Emulation dedicated registers

A set of four additional registers are for emulation purpose only. Similarly to XPEREMU, they are write only registers.

## Emulation register 1



## Emulation register 2

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |

## Emulation register 3



## Emulation register 4

RegTitle


### 4.3 XRAM2 memory range

XRAM2 memory range is addressed by an internal XBUS chip select. This internal chip select is enabled when XPEN bit of the SYSCON register is set and XRAM2EN bit of the XPERCOM register is set. Although this address range is accessed as external memory, it does not occupy the BUSCONx or ADDRSELx registers but is selected via additional dedicated XBCON/XADRS registers. The XADRS reset value is mask-programmed but the XADRS3 register used for flash control registers and XRAM2 memory range can be accessed and modified.

## XRAM2 memory range

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RGSAD |  |  |  |  |  |  |  |  |  |  |  | RGSZ |  |  |  |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 4. XRAM2 memory range functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 4$ | RGSAD | Range Start Address <br> Defines the upper bits (A8...A19) of the start address of the respective <br> address area. Bits A23...A20 of the resulting address are set to 0. See <br> Table 5. |
| $3: 0$ | RGSZ | Range Size Selection <br> Defines the size of the address area controlled by XBCON3 and <br> XADRS3 register pair. See Table 5. |

The register functionality is the same as the one of ADDRSELx registers use for external address range selection. However, the XADRS3 register is protected and it can only be written before the EINIT instruction execution. The range start address can be only on boundaries specified by the selected range size. Table 5 gives a definition of Range Size Selection and Range Start Address.

Upon Reset, the XADRS3 register is programmed so that address range 08'0000hOF'FFFFh is accessed with the internal XBUS chip select. The range 08'0000h-08'FFFFh is
overlapped by IFlash memory space (flash control register), which has higher priority on XBUS space.

The address range defined by XADRS3 can be reduced by reprogramming it before EINIT execution; the area which is no longer inside the new address range becomes external memory space (apart from range 08'0000h-08'FFFFh, which is dedicated to IFlash as long as ROMEN bit in SYSCON register is set).
The address range defined by XADRS3 has priority over any external address range defined through ADDRSELx ( $x=1 . . .4$ ) registers.
Table 5. Definition of address areas

| Bit-field RGSZ | Resulting Window Size | Relevant bit (R) of Start Address (A19...A8) |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | A19 |  |  |  |  |  |  |  |  |  |  | A8 |
| 0000 | 256 bytes | R | R | R | R | R | R | R | R | R | R | R | R |
| 0001 | 512 bytes | R | R | R | R | R | R | R | R | R | R | R | x |
| 0010 | 1 Kbyte | R | R | R | R | R | R | R | R | R | R | x | x |
| 0011 | 2 Kbytes | R | R | R | R | R | R | R | R | R | x | x | X |
| 0100 | 4 Kbytes | R | R | R | R | R | R | R | R | $x$ | x | x | x |
| 0101 | 8 Kbytes | R | R | R | R | R | R | R | x | x | X | x | x |
| 0110 | 16 Kbytes | R | R | R | R | R | R | $x$ | x | x | X | x | x |
| 0111 | 32 Kbytes | R | R | R | R | R | $x$ | x | X | x | X | x | X |
| 1000 | 64 Kbytes | R | R | R | R | x | $x$ | x | X | x | X | x | x |
| 1001 | 128 Kbytes | R | R | R | x | x | X | X | X | X | X | X | x |
| 1010 | 256 Kbytes | R | R | x | x | x | x | x | X | x | X | x | x |
| 1011 | 512 Kbytes | R | x | x | x | x | x | X | X | X | X | X | X |
| 11 xx | Reserved |  |  |  |  |  |  |  |  |  |  |  |  |

XRAM2 can be remapped on any 16 Kbyte Boundary within 00'8000h-00'BFFF address area and within 09'0000h-0F'FFFFF address area.

For example, to map the 16Kbyte XRAM2 in page 60 (starting address 0F'0000h, compatible with ST10F276), XADRS3 must be initialized with the value $\mathrm{F} 006_{\mathrm{H}}$. To map the 16Kbyte XRAM2 in page 2 (starting address 00'8000h, compatible with ST10F280), XADRS3 must be initialized with the value $0806_{\mathrm{H}}$.

Note: If XADRS3 is not reprogrammed after reset, the XRAM2 address window overlaps the one dedicated to IFlash. So Segment 8 address range mapping depends on bits ROMEN and XPEN of SYSCON register, and XRAM2EN of XPERCON register programming as summarized in Table 6.

Table 6. XRAM2EN of XPERCON register programming

| ROMEN | XPEN | XRAM2EN | Segment 8 |
| :---: | :---: | :---: | :---: |
| 0 | 0 | x | External memory |
| 0 | 1 | 0 | External memory |
| 0 | 1 | 1 | Reserved |
| 1 | x | x | IFlash registers |

Figure 4. ST10F252M memory mapping (user mode: flash read operations or XADRS = F006h)


Figure 5. ST10F252M memory mapping (user mode: flash write operations or ROMS1=1)


## 5 Central processing unit

The central processing unit (CPU) includes a four-stage instruction pipeline, a 16-bit arithmetic and logic unit (ALU) and dedicated SFRs. Additional hardware provides for a separate multiply and divide unit, a bit-mask generator and a barrel shifter.

Most of the ST10F252M's instructions can be executed in one instruction cycle which requires 50 ns at 40 MHz CPU clock. For example, shift and rotate instructions are processed in one instruction cycle independent of the number of bits to be shifted. Multiplecycle instructions have been optimized; branches are carried out in two cycles, $16 \times 16$ bit multiplication in five cycles and a 32/16 bit division in ten cycles. The jump cache reduces the execution time of repeatedly performed jumps in a loop, from two cycles to one cycle.

Figure 6. CPU block diagram (MAC unit not included)


The CPU uses an actual register context consisting of up to 16 wordwide GPRs physically allocated within the on-chip RAM area. A context pointer (CP) register determines the base address of the active register bank to be accessed by the CPU. The number of register banks is only restricted by the available internal RAM space. For easy parameter passing, a register bank may overlap others.
A system stack of up to 1024 bytes is provided as a storage for temporary data. The system stack is allocated in the on-chip RAM area, and it is accessed by the CPU via the stack pointer (SP) register. Two separate SFRs, STKOV and STKUN, are implicitly compared against the stack pointer value upon each stack access for the detection of a stack overflow or underflow.

### 5.1 The system configuration register SYSCON

This bit-addressable register provides general system configuration and control functions. The RESET value for register SYSCON depends on the state of the Port 0 pins during RESET.

## System configuration register SYSCON

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{aligned} & N \\ & N \\ & N \\ & N \end{aligned}$ | $\sum_{\substack{\infty}}^{\sum_{\widetilde{\prime}}}$ | $\begin{aligned} & \frac{\infty}{\bar{O}} \\ & \stackrel{O}{O} \end{aligned}$ | $\sum_{\substack{\text { Zu}}}^{\substack{\text { n}}}$ | $\frac{\infty}{\vdots}$ | $\begin{aligned} & \underset{\sim}{\underset{U}{u}} \end{aligned}$ | $\begin{aligned} & \text { U } \\ & \text { U } \\ & \text { M } \\ & 3 \end{aligned}$ | $\begin{aligned} & \text { O} \\ & 0 山 \\ & 0 \\ & 0 \\ & 0.0 \end{aligned}$ | $\begin{aligned} & \hline 0 \\ & \text { OU } \\ & \text { 2 } \\ & \text { an } \end{aligned}$ | $\begin{aligned} & \text { 毋 } \\ & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & \underset{\sim}{\underset{\sim}{\sim}} \\ & \underset{\sim}{\sim} \\ & \underset{\sim}{0} \end{aligned}$ | $\begin{aligned} & \underset{\underset{\sim}{u}}{\substack{x}} \end{aligned}$ | $\begin{aligned} & \underset{\sim}{w} \\ & \frac{\underline{\omega}}{\boldsymbol{\omega}} \end{aligned}$ | $\begin{aligned} & \text { O} \\ & 0 \\ & 0 \\ & 0 \\ & 0.0 \end{aligned}$ |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 7. System configuration register SYSCON functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15:14 | Reserved |  |
| 13 | STKSZ | System stack size <br> Selects the size of the system stack (in the internal I-RAM) from 32 to 1024 words. |
| 12 | ROMS1 | Internal memory mapping <br> ' 0 ': Internal memory area mapped to segment 0 (00'0000h...00'7FFFh). <br> ' 1 ': Internal memory area mapped to segment 1 (01'0000h...01'7FFFh). |
| 11 | SGTDIS | Segmentation disable/enable control '0': Segmentation enabled (CSP is saved/restored during interrupt entry/exit). <br> '1': Segmentation disabled (only IP is saved/restored). |
| 10 | ROMEN | Internal memory enable (set according to pin EA during reset) ' 0 ': Internal memory disabled: accesses to the I-Flash memory area use the external bus. <br> '1': Internal memory enabled. |
| 9 | BYTDIS | Disable/enable control for pin $\overline{\mathrm{BHE}}$ (set according to data bus width) <br> ' 0 ': Pin $\overline{B H E}$ enabled. <br> '1': Pin $\overline{B H E}$ disabled, pin P3. 12 may be used for general purpose I/O. |
| 8 | CLKEN | System clock output enable (CLKOUT) <br> ' 0 ': CLKOUT disabled, pin P3. 15 may be used for general purpose I/O. <br> '1': CLKOUT enabled, pin P3. 15 outputs the system clock or a prescaled value of system clock according to XCLKOUTDIV register setting (see Section 15). |
| 7 | WRCFG | Write configuration control (inverted copy of WRC bit of RPOH) <br> ' 0 ': Pins $\overline{W R}$ and $\overline{B H E}$ retain their normal function. <br> ' 1 ': Pin $\overline{W R}$ act as $\overline{W R L}$, pin $\overline{B H E}$ acts as $\overline{W R H .}$ |
| 6 | Reserved |  |

Table 7. System configuration register SYSCON functions (continued)

| Bit | Name | Function |
| :---: | :---: | :---: |
| 5 | PWDCFG | Power down mode configuration control <br> ' 0 ': Power down mode can only be entered during PWRDN instruction execution if NMI pin is low, otherwise the instruction has no effect. To exit power down mode, an external reset must occurs by asserting the RSTIN pin. <br> ' 1 ': Power down mode can only be entered during PWRDN instruction execution if all enabled fast external interrupt EXxIN pins are in their inactive level. Exiting this mode can be done by asserting one enabled EXxIN pin or with external reset. |
| 4 | OWDDIS | Oscillator watchdog disable control <br> ' 0 ': Oscillator watchdog (OWD) is enabled. If PLL is bypassed, the OWD monitors XTAL1 activity. If there is no activity on XTAL1 for at least $1 \mu \mathrm{~s}$, the CPU clock is switched automatically to PLL's base frequency (around $750 \mathrm{kHz}-3 \mathrm{MHz}$ ). <br> ' 1 ': OWD is disabled. If the PLL is bypassed, the CPU clock is always driven by XTAL1 signal. The PLL is turned off to reduce power supply current. |
| 3 | XPEN | XBUS peripheral enable bit <br> ' 0 ': Accesses to the on-chip X-peripherals and their functions are disabled. <br> ' 1 ': The on-chip X-peripherals are enabled and can be accessed. |
| 3 | BDRSTEN | Bidirectional reset enable <br> ' 0 ': $\overline{\text { RSTIN }}$ pin is an input pin only. SW Reset or WDT Reset have no effect on this pin. <br> ' 1 ': $\overline{\text { RSTIN }}$ pin is a bidirectional pin. This pin is pulled low during 1024 TCL during reset sequence. |
| 1 | VISIBLE | Visible mode control <br> ' 0 ': Accesses to XBUS peripherals are internal. <br> ' 1 ': XBUS peripherals accesses are visible externally on the external pins. |

## 6 Multiplier-accumulator unit

The multiplier-accumulator (MAC) unit is a specialized co-processor that improves the performance of signal processing algorithms. It includes:

- a multiply-accumulate unit.
- an address generation unit, able to feed the MAC unit with two operands per cycle.
- a repeat unit, to execute a series of multiply-accumulate instructions.

The CPU can supply the MAC with up to two operands per instruction cycle. The MAC instructions multiply, multiply-accumulate, 32-bit signed arithmetic operations and the CoMOV transfer instruction are part of the standard instruction set. Full details are provided in the 'ST10 Family Programming Manual'.

### 6.1 MAC features

### 6.1.1 Enhanced addressing capabilities

The MAC has the following enhanced addressing capabilities:

- double indirect addressing mode with pointer post-modification
- parallel data move allows one operand move during multiply-accumulate instructions without penalty
- coSTORE instruction (for fast access to the MAC SFRs) and CoMOV (for fast memory to memory table transfer).


### 6.1.2 General

The MAC also has the following features:

- two-cycle execution for all MAC operations
- $16 \times 16$ signed/unsigned parallel multiplier
- 40-bit signed arithmetic unit with automatic saturation mode
- 40-bit accumulator
- 8-bit left/right shifter
- scaler (one-bit left shifter)
- data limiter
- full instruction set with multiply and multiply-accumulate, 32-bit signed arithmetic and compare instructions
- three 16-bit status and control registers: MSW (MAC status word), MCW (MAC control word), and MRW (MAC repeat word).

The working register of the MAC unit is a dedicated 40-bit wide accumulator register. A set of consistent flags is automatically updated in the MSW register (see Section 6.3.2) after each MAC operation. These flags allow branching on specific conditions. Unlike the PSW flags, these flags are not preserved automatically by the CPU upon entry into an interrupt or trap routine. All dedicated MAC registers must be saved on the stack if the MAC unit is shared between different tasks and interrupts.

### 6.1.3 Program control

MAC program control features include:

- a repeat unit that allows some MAC co-processor instructions to be repeated up to 8192 times - repeated instructions may be interrupted
- MAC interrupt (class B trap) on MAC condition flags.


### 6.2 MAC operation

Figure 7. MAC unit architecture


1. Shared with standard ALU.

### 6.2.1 Instruction pipelining

All MAC instructions use the four-stage pipeline. During each stage the following tasks are performed.

1. FETCH: All new instructions are double-word instructions.
2. DECODE: If required, operand addresses are calculated and the resulting operands are fetched. IDX and GPR pointers are post-modified if necessary.
3. EXECUTE: Performs the MAC operation. At the end of the cycle, the accumulator and the MAC condition flags are updated if required. Modified GPR pointers are writtenback during this stage, if required.
4. WRITEBACK: Operand write-back in the case of parallel data move.

### 6.2.2 Particular pipeline effects with the MAC unit

Because the registers used by the MAC are shared with the standard ALU and because of the MAC instructions pipelining, some care must be taken when switching from the "standard instruction set" to the "MAC instruction set".

## Initialization of the pointers and offset registers

The MAC instructions which use IDXi pointer are mostly not capable of using a IDXi register value, which is updated by an immediately preceding instruction. Thus, to make sure that the IDXi register value is used, at least one instruction must be inserted between a IDXichanging instruction and one MAC instruction which explicitly uses IDXi in its addressing mode as shown in the following example,
$I_{n}$ : MOV IDXO, \#OF200h
$I_{n+1}: \ldots$
$I_{n+2}: C o X X X ~[I D X 0+Q X 1],[R 2]$
update IDX0 register
must not be an CoXXX $[I D X 0 \otimes],\left[R w_{m} \otimes\right]$ instruction
first operand read at (IDXO) address to provide the MAC function
parallel data move to (((IDX0))-((QX1))) address (if CoXXX is CoMACM)
move (R2) content to (IDX0) address (if CoXXX is CoMOV)
(IDX0) <-- (IDX0) + (QX1) post modification of the pointer The requirements between the update of one of the offset registers, QXi and QRi, and their next use are the same.

## Read access to MAC registers (CoReg)

At least one instruction which does not use the MAC must be inserted between two instructions that read from a MAC register. This is because the accumulator and the status of the MAC are modified during the execute stage.
Table 8. Example of MAC register read access

| Code | MSW (before) | MSW (after) | Comment |
| :--- | :---: | :---: | :--- |
| MOV MSW, \#0 | - | 0000 h |  |
| MOV R0, \#0 | - | - |  |
| CoADD R0, R0 | 0000 h | 0200 h | MSW.Z set at execute |
| BFLDL MSW, \#FFh, \#FFh | 0200 h | $00 F F h$ | Error! |

In this example, the BFLDL instruction performs a read access to the MSW during the decode stage while the MSW.Z flag is only set at the end of the execute stage of the CoADD.

### 6.2.3 Address generation

MAC instructions can use some standard ST10 addressing modes such as GPR direct or \#data4 for immediate shift value.

Addressing modes have been added to supply the MAC with two new operands per instruction cycle. These allow indirect addressing with address pointer post-modification.

Double indirect addressing requires two pointers. Any GPR can be used for one pointer, the other pointer is provided by one of two specific SFRs IDX0 and IDX1. Two pairs of offset registers QR0/QR1 and QX0/QX1 are associated with each pointer (GPR or IDX ${ }_{i}$ ). The GPR pointer allows access to the entire memory space, but IDX ${ }_{i}$ are limited to the internal dualport RAM, except for the CoMOV instruction.
Table 9 shows the various combinations of pointer post-modification for each of these 2 new addressing modes. In this document, the symbols " $\left[R w_{n} \otimes\right]$ " and " $\left[I D X_{i} \otimes\right]$ " refer to these addressing modes.
Table 9. Pointer post-modification combinations for IDXi and Rwn

| Symbol | Mnemonic | Address pointer operation |
| :---: | :---: | :---: |
| "[IDX ${ }_{i} \otimes$ ]" stands for | [IDX ${ }_{\text {] }}$ ] | $\left(\mathrm{IDX}_{\mathrm{i}}\right) \leftarrow\left(\mathrm{IDX}_{\mathrm{i}}\right)(\mathrm{no-op})$ |
|  |  | $\left(I D X_{i}\right) \leftarrow\left(I D X_{i}\right)+2(\mathrm{i}=0,1)$ |
|  | [IDX ${ }_{\text {i }}$-] | $\left(I D X_{i}\right) \leftarrow\left(I D X_{i}\right)-2(\mathrm{i}=0,1)$ |
|  | $\left[I D X_{i}+Q X_{j}\right]$ | $\left(I D X_{i}\right) \leftarrow\left(I D X_{i}\right)+\left(Q X_{j}\right)(\mathrm{i}, \mathrm{j}=0,1)$ |
|  | $\left[I D X ~_{i}-\mathrm{QX}_{\mathrm{j}}\right]$ | $\left(I D X_{i}\right) \leftarrow\left(I D X_{i}\right)-\left(Q X_{j}\right)(\mathrm{i}, \mathrm{j}=0,1)$ |
| " $\left[R w_{n} \otimes\right]^{\prime}$ stands for | [Rwn] | $(R w n) \leftarrow(R w n)$ (no-op) |
|  | [Rwn\# | $($ Rwn $) \leftarrow($ Rwn $)+2(n=0-15)$ |
|  | [Rwn-] | (Rwn) $\leftarrow(\mathrm{Rwn})-2(\mathrm{k}=0-15)$ |
|  | [Rwn-QR ${ }_{\text {] }}$ ] | $($ Rwn $) \leftarrow($ Rwn $)+\left(\mathrm{QR}_{\mathrm{j}}\right)(\mathrm{n}=0-15 ; \mathrm{j}=0,1)$ |
|  | [Rwn - QR ${ }_{\text {j }}$ ] | $(R w n) \leftarrow(R w n)-\left(Q_{j}\right)(\mathrm{n}=0-15 ; \mathrm{j}=0,1)$ |

For the CoMACM class of instruction, a parallel data move mechanism is implemented. This class of instruction is only available with double indirect addressing mode. Parallel data move allows the operand, pointed to by IDX ${ }_{i}$, to be moved to a new location in parallel with the MAC operation. The write-back address of parallel data move is calculated depending on the post-modification of IDX ${ }_{i}$. It is obtained by the reverse operation than the one used to calculate the new value of IDX ${ }_{i}$. Table 10 shows these rules.
Table 10. Parallel data move addressing

| Instruction | Writeback address |
| :---: | :---: |
| CoMACM [IDX $\left.{ }_{\text {i }}+\right], \ldots$ | <IDX ${ }_{\text {i }}$-2> |
| CoMACM [IDX ${ }_{\text {i }}$ ],... | <IDX ${ }_{\text {i }}+2>$ |
| CoMACM [IDX ${ }_{\text {i }}+\mathrm{QX}_{\mathrm{j}}$ ],.. | $<I D X_{i}-\mathrm{QX}_{\mathrm{j}}>$ |
| CoMACM [IDX ${ }_{i}$-QX ${ }_{\text {j }}$ ],.. | <IDX ${ }_{i}+\mathrm{QX}_{j}>$ |

The parallel data move shifts a table of operands in parallel with a computation on those operands. Its specific use is for signal processing algorithms like filter computation. Figure 8 gives an example of parallel data move with CoMACM instruction.

Figure 8. Example of parallel data move


### 6.2.4 $16 \times 16$ signed / unsigned parallel multiplier

The multiplier executes $16 \times 16$-bit parallel signed/unsigned fractional and integer multiplies. The multiplier has two 16-bit input ports, and a 32-bit product output port. The input ports can accept data from the MA-bus and from the MB-bus. The output is sign-extended and feeds a scaler that shifts the multiplier output according to the shift mode bit MP specified in the co-processor control word (MCW). The product can be shifted one bit left to compensate for the extra sign bit gained in multiplying two 16-bit signed (2's complement) fractional numbers if bit MP is set.

### 6.2.5 40-bit signed arithmetic unit

The arithmetic unit is over 32 bits wide to allow intermediate overflow in a series of multiply/accumulate operations. The extension flag E, contained in the most significant byte of MSW, is set when the accumulator has overflowed beyond the 32-bit boundary, that is, when there are significant (non-sign) bits in the top eight (signed arithmetic) bits of the accumulator.

The 40-bit arithmetic unit has two 40-bit input ports A and B. The A-input port accepts data from four possible sources: 00,0000,0000h, 00,0000,8000h (round), the sign-extended product, or the sign-extended data conveyed by the 32-bit bus resulting from the concatenation of MA- and MB-buses. Product and concatenation can be shifted left by one according to MP for the multiplier or to the instruction for the concatenation. The B-input port is fed either by the 40-bit shifted/not shifted and inverted/not inverted accumulator or by 00,0000,0000h. A-input and B-input ports can receive 00,0000,0000h to allow direct transfers from the B-source and A-source, respectively, to the accumulator (in the case of multiplication or shift). The output of the arithmetic unit goes to the accumulator.

It is also possible to saturate the accumulator on a 32-bit value, automatically after every accumulation. Automatic saturation is enabled by setting the saturation bit MS in the MCW register. When the accumulator is in the saturation mode and an 32-bit overflow occurs, the accumulator is loaded with either the most positive or the most negative value representable in a 32-bit value, depending on the direction of the overflow. The value of the accumulator upon saturation is $00,7 \mathrm{fff}$,ffffh (positive) or $\mathrm{ff}, 8000,0000 \mathrm{~h}$ (negative) in signed arithmetic. Automatic saturation sets the SL flag MSW. This flag is a sticky flag which means it stays set until it is explicitly reset.

40-bit overflow of the accumulator sets the SV flag in MSW. This flag is also a sticky flag.

### 6.2.6 40-bit adder/subtracter

The 40-bit adder/subtracter allows intermediate overflows in a series of multiply/accumulate operations. The adder/subtracter has two input ports. One input is the feedback of the 40-bit signed accumulator output through the ACCU-shifter. The second input is the 32-bit operand coming from the one-bit scaler. The 32-bit operands are sign-extended to 40-bit before the addition/subtraction is performed.

The output of the adder/subtracter goes to the 40-bit signed accumulator. It is also possible to round and to saturate the result to 32-bit automatically after every accumulation before to be loaded into the accumulator. The round operation is performed by adding 00'00008000h to the result. Automatic saturation is enabled by setting the MCW.MS saturation bit.

When the 40-bit signed accumulator is in the overflow saturation mode and an overflow occurs, the accumulator is loaded with either the most positive or the most negative possible 32 -bit value, depending on the direction of the overflow as well as the arithmetic used. The value of the accumulator upon saturation is 00'7FFF FFFFh (positive) or FF'8000'0000h (negative).

### 6.2.7 Data limiter

Saturation arithmetic is also provided to selectively limit overflow, when reading the accumulator by means of a CoSTORE <destination> MAS instruction. Limiting is performed on the MAC accumulator. If the contents of the accumulator can be represented in the destination operand size without overflow, the data limiter is disabled and the operand is not modified. If the contents of the accumulator cannot be represented without overflow in the destination operand size, the limiter substitutes a 'limited' data as explained in Table 11'

## Table 11. Limiter output using CoSTORE instruction

| ME-flag | MN-flag | MAS value (saturated MAH value) ${ }^{(1)}$ |
| :---: | :---: | :--- |
| 0 | $x$ | Unchanged $^{(2)}$ |
| 1 | 0 | $7 \mathrm{FFFh}^{(3)}$ |
| 1 | 1 | $8000 h^{(4)}$ |

1. If the data limiter is activated, a read with "CoSTORE <destination>, <MAH> instruction" or "CoSTORE <destination>, <MAS> instruction" gives different results.
2. When the data limiter is disabled, a reading with "CoSTORE <destination>, <MAH> instruction" or "CoSTORE <destination>, <MAS> instruction" gives the same result.
3. If the data limiter is activated, a read with "CoSTORE <destination>, <MAH> instruction" or "CoSTORE <destination>, <MAS> instruction" gives different results.
4. If the data limiter is activated, a read with "CoSTORE <destination>, <MAH> instruction" or "CoSTORE <destination>, <MAS> instruction" gives different results.

### 6.2.8 The accumulator shifter

The accumulator shifter is a parallel shifter with a 40-bit input and a 40-bit output. The source accumulator shifting operation are:

- no shift (unmodified)
- up to 8-bit arithmetic left shift
- up to 8-bit arithmetic right shift

MSW.ME, MSW.MSV and MSW.MSL bits (see the MSW register description) are affected by left shifts. Therefore, if the saturation detection is enabled (MCW.MS bit is set), the behavior is similar to the one of the adder/subtracter.

Some precautions are required for left shift with enabled saturation. If the MSW.MAE bit-field (the most significant byte of the 40-bit signed accumulator) contains significant bits, the 32-bit value in the accumulator is generally saturated. However, it is possible that a left shift may move some significant bits out of the accumulator. The 40-bit result will be misinterpreted and will be either not be saturated or saturated incorrectly. There is a chance that the result of a left shift may produce a result which can saturate an original positive number to the minimum negative value, or vice versa.

### 6.2.9 Repeat unit

The MAC includes a repeat unit that allows the repetition of some co-processor instructions up to $2^{13}$ (8192) times. The repeat count may be specified either by an immediate value (up to 31 times) or by the content of the repeat count (bits 12 to 0 ) in the MAC repeat word (MRW). If the repeat count is " $N$ " the instruction is executed " $N+1$ " times. At each iteration of a cumulative instruction, the repeat count is tested for zero. If it is zero the instruction is terminated, otherwise the repeat count is decremented and the instruction is repeated. During such a repeat sequence, the repeat flag in MRW is set until the last execution of the repeated instruction.
The syntax of repeated instructions is shown in the following examples:.
1 Repeat \#24 times
CoMAC[IDX0+],[R0+] ; repeated 24 times
In this example, the instruction is repeated according to a 5 -bit immediate value. The repeat count in MRW is automatically loaded with this value minus one (MRW=23).
1

```
MOV MRW, #OOFFh ; load MRW
NOP ; instruction latency
Repeat MRW times
CoMACM [IDX1-],[R2+] ; repeated 256 times
```

In this example, the instruction is repeated according to the repeat count in MRW. Due to the pipeline processing at least one instruction should be inserted between the write of MRW and the next repeated instruction.

Repeat sequences may be interrupted. When an interrupt occurs during a repeat sequence, the sequence is stopped and the interrupt routine is executed. The repeat sequence resumes at the end of the interrupt routine. During the interrupt, MR remains set, indicating that a repeated instruction has been interrupted and the repeat count holds the number (minus 1) of repetition that remains to complete the sequence. If the repeat unit is used in the interrupt routine, MRW must be saved and restored before the end of the interrupt routine.

Note: $\quad$ The repeat count should be used with caution. In this case, MR should be written as 0 . In general, MR should not be set otherwise correct instruction processing can not be guaranteed.

### 6.2.10 MAC interrupt

The MAC can generate an interrupt according to the value of the status flags C (carry), SV (overflow), E (extension) or SL (limit) of the MSW. The MAC interrupt is globally enabled when the MIE flag in MCW is set. When it is enabled the flags C, SV, E or SL can trigger a MAC interrupt when they are set provided that the corresponding mask flag, CM, VM, EM or LM in MCW, is also set. A MAC interrupt request sets the MIR flag in MSW; this flag must be
reset during the interrupt routine otherwise the interrupt processing restarts when returning from the interrupt routine.

The MAC interrupt is implemented as a class B hardware trap (trap number Ah - trap priority I). The associated trap flag in the TFR register is MACTRP, bit \#6 of the TFR (this flag must also be reset in a MAC interrupt request).

As the MAC status flags are updated (or eventually written by software) during the execute stage of the pipeline, the response time of a MAC interrupt request is three instruction cycles (see Figure 9). It is the number of instruction cycles required between the time the request is sent and the time the first instruction located at the interrupt vector location enters the pipeline. The IP value stacked after a MAC interrupt does not point to the instruction that triggers the interrupt.
Figure 9. Pipeline diagram for MAC interrupt response time

| FETCH | Response Time |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | N | N+1 | N+2 | N+3 | N+4 | 11 | 12 |
| DECODE | N-1 | N | $\mathrm{N}+1$ | N+2 | TRAP (1) | TRAP (2) | 11 |
| EXECUTE | N-2 | $\mathrm{N}-1$ | N | $\mathrm{N}+1$ | N+2 | TRAP (1) | TRAP (2) |
| WRITEBACK | N-3 | N-2 | $\mathrm{N}-1$ | N | N+1 | N+2 | TRAP (1) |
|  |  |  |  | C Int | Request |  |  |

### 6.2.11 Number representation and rounding

The MAC supports the two's-complement representation of binary numbers. In this format, the sign bit is the MSB of the binary word. This is set to zero for positive numbers and set to one for negative numbers. Unsigned numbers are supported only by multiply/multiplyaccumulate instructions which specifies whether each operand is signed or unsigned.
In two's complement fractional format, the N -bit operand is represented using the 1.[ $\mathrm{N}-1$ ] format ( 1 signed bit, $\mathrm{N}-1$ fractional bits). Such a format can represent numbers between -1 and $+1-2^{[\mathrm{N}-1]}$. This format is supported when MP of MCW is set.

The MAC implements 'two's complement rounding'. With this rounding type, one is added to the bit to the right of the rounding point (bit 15 of MAL), before truncation (MAL is cleared).

### 6.3 MAC register set

### 6.3.1 Address registers

The addressing modes require (E)SFRs: two address pointers IDX0 / IDX1 and four offset registers QX0 / QX1 and QR0 / QR1.

## Address pointer

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |  | ID Xy |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 12. Address pointer functions

| Bit | Name |  | Function |
| :---: | :--- | :--- | :--- |
| 15.0 | IDXy | 16-bit IDXy address |  |

## Offset register



Table 13. Offset register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.0 | QRz/QXz | 16-bit address offset for IDXy pointers (QXz) or GPR pointers (QRz). <br> As MAC instructions handle word operands, bit 0 of these offset <br> registers is hard-wired to '0'. |

### 6.3.2 Accumulator and control registers

The MAC unit SFRs include the 40-bit accumulator (MAL, MAH and the low byte of MSW) and three control registers: the status word MSW, the control word MCW and the repeat word MRW.

MAH and MAL are located in the non bit-addressable SFR space.

## MAH register



Table 14. MAH register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.0 | MAH | MAC unit accumulator high (bits [31..16]) |

## MAL register



Table 15. MAL register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.0 | MAL | MAC unit accumulator low (bits [15..0]) |

## Status word register



Table 16. Status word register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15 | MIR | MAC interrupt request <br> Set when the MAC unit generates an interrupt request. |
| 14 | Reserved |  |
| 13 | SL | Sticky limit flag <br> Set when the result of a MAC operation is automatically saturated. Also <br> used for CoMIN, CoMAX instructions to indicate that the accumulator <br> has changed. It remains set until it is explicitly reset by software. |
| 12 | SV | Extension flag <br> Set when MAE contains significant bits at the end of a MAC operation |
| 11 | C | Sticky overflow flag <br> Set when a MAC operation produces a 40-bit arithmetic overflow. It <br> remains set until it is explicitly reset by software. |
| 19 | Z | Carry flag <br> Set when a MAC operation produces a carry or a borrow bit. |
| 9 | N | Zero flag <br> Set when the accumulator is zero at the end of a MAC operation. |
| 8 | Negative flag <br> Set when the accumulator is negative at the end of a MAC operation. |  |
| $7: 0$ | MAE | Accumulator extension (bits [39:32]) |

Note: $\quad$ The MAC condition flags are evaluated (if required) by the instruction being executed. In particular, they are not affected by any instruction of the regular instruction set. In consequence, their values may not be consistent with the accumulator content. For example, loading the accumulator with MOV instructions will not modify the condition flags

## Control register



Table 17. Control register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15 | MIE | MAC Interrupt Enable <br> '0': MAC interrupt globally disabled, <br> '1': MAC interrupt globally enabled. |
| 14 | LM | SL Mask <br> When set, the SL Flag can generate a MAC interrupt request. |
| 13 | EM | E Mask <br> When set, the E Flag can generate a MAC interrupt request. |
| 12 | CM | SV Mask <br> When set, the SV Flag can generate a MAC interrupt request. |
| 11 | C Mask <br> When set, the C Flag can generate a MAC interrupt request. |  |
| 10 | MP | Product Shift Mode <br> When set, enables the one-bit left shift of the multiplier output in case <br> of a signed-signed multiplication |
| 9 | MS | Saturation Mode <br> When set, enables automatic 32-bit saturation of the result of a MAC <br> operation |
| $8: 0$ | Reserved |  |

## Repeat register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Table 18. Repeat register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15 | MR | Repeat Flag <br> Set when a repeated instruction is executed |
| 12.0 | Repeat Count | 13-bit unsigned integer value <br> Indicates the number of time minus one a repeated instruction must be <br> executed |

Note: $\quad$ As for the CPU Core SFRs, any write operation with the regular instruction set to a single byte of a MAC SFR clears the non-addressed complementary byte within the specified SFR. Non-implemented SFR bits cannot be modified and will always supply a read value of'0'.

These registers are mapped in the SFR space and can addressed by the regular instruction set like any SFR. They can also be addressed by the new instruction CoSTORE. This instruction allows the user to access the MAC registers without any pipeline side effect. CoSTORE uses a specific 5 -bit addressing mode called CoReg. The following table gives the address of the MAC registers in this CoReg addressing mode.
Table 19. Register address in CoReg addressing mode

| Registers | Description | Address |
| :---: | :--- | :--- |
| MSW | MAC unit status word | 00000 b |
| MAH | MAC unit accumulator high | 00001 b |
| MAS | llimited" MAH /signed | 00010 b |
| MAL | MAC unit accumulator low | 00100 b |
| MCW | MAC unit control word | 00101 b |
| MRW | MAC unit repeat word | 00110 b |

## 7 External bus controller

All of the external memory accesses are performed by the on-chip external bus controller (EBC), when no additional (6) ADC channels are selected. The EBC can be programmed to single chip mode when no external memory is required, or to one of four different external memory access modes:

- 16- / 18- / 20- / 24-bit addresses and 16-bit data, demultiplexed
- 16- / 18- / 20- / 24-bit addresses and 16-bit data, multiplexed
- 16- / 18- / 20- / 24-bit addresses and 8-bit data, multiplexed
- 16- / 18- / 20- / 24-bit addresses and 8-bit data, demultiplexed

In demultiplexed bus modes, addresses are output on PORT1 and data is input and output on PORT0 or P0L, respectively. In the multiplexed bus modes, both addresses and data use PORT0 for input and output.
Timing characteristics of the external bus interface (memory cycle time, memory tri-state time, length of ALE and read write delay) are programmable giving the choice of a wide range of memories and external peripherals.

Up to four independent address windows may be defined (using register pairs ADDRSELx / BUSCONx) to access different resources and bus characteristics. These address windows are arranged hierarchically where BUSCON4 overrides BUSCON3 and BUSCON2 overrides BUSCON1. All accesses to locations not covered by these four address windows are controlled by BUSCONO. No chip select signals are provided, if needed they must be generated through external glue logic.

Bus arbitration, to share external resources with other bus masters, is not supported. Connection of the slave controller to more than one master controller needs the addition of glue logic. For bus arbitration policy, the ST10F276 user manual, where the EBC automatically handle bus arbitration through dedicated pins, can be used as a reference.

For applications which require less external memory space, the address space can be restricted to 1 Mbyte, 256 Kbyte or to 64 Kbyte. Port 4 outputs all eight address lines if an address space of 16 Mbytes is used, otherwise four, two or no address lines.

### 7.1 Controlling the external bus controller

A set of registers controls the function of EBC. General features like the use of pins (WR, BHE), segmentation and internal memory mapping are controlled by the SYSCON register. The properties of a bus cycle like length of ALE, external bus mode, read/write delay and waitstates are controlled by BUSCON4...BUSCON0. This allows the use of memory components or peripherals with different interfaces within the same system, while optimizing access to each of them.

### 7.1.1 External bus controller registers

| BUSCONO (FFOCh/86h) |  |  |  | SFR |  |  |  |  |  |  |  |  | Reset value: 0xx0 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| - | - | - | - | - | BUS ACT4 | $\begin{aligned} & \text { ALE } \\ & \text { CTL4 } \end{aligned}$ |  |  |  | $\begin{gathered} \text { MTT } \\ \text { C4 } \end{gathered}$ | $\begin{gathered} \text { RWD } \\ \mathrm{C} 4 \end{gathered}$ |  |  |  |  |
| RW | RW | RW | RW | - | RW | RW | - | RW | RW | RW | RW | RW | RW | RW | RW |



Table 20. External bus controller functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 10 | BUSACTx | ' 0 ': Bus not active <br> '1': Bus active |
| 9 | ALECTLx | ALE lengthening control <br> '0': Normal ALE signal <br> '1': Lengthened ALE signal |
| 6.7 | BTYP | External bus configuration <br> 0 0: 8-bit demultiplexed <br> 0 1: 8-bit multiplexed <br> 10: 16-bit Demultiplexed <br> 11: 16-bit multiplexed <br> For BUSCONO BTYP is defined via PORTO during reset, |
| 5 | MTTCx | Memory Tristate Time Control ' 0 ': 1 waitstates <br> '1': No waitstates |
| 4 | RWDCX | Read/write delay control for BUSCONx <br> ' 0 ': With read/write delay: activate command 1 TCL after falling edge of ALE <br> '1': No read/write delay: activate command with falling edge of ALE |
| 0.3 | MCTC | Memory cycle time control (number of memory cycle time wait states) 0000 : 15 waitstates (number = $15-<$ MCTC $>$ ) <br> 1111 : no waitstates |

### 7.2 EA functionality

In ST10F252M, the $\overline{E A}$ pin is shared with $V_{\text {STBY }}$ supply pin. When main $V_{D D}$ is on and stable, $\mathrm{V}_{\text {STBY }}$ can be temporary grounded: in stand-by mode, the logic that is powered by $\mathrm{V}_{\text {STBY }}$ (that is 12Kbyte portion of XRAM and stand-by voltage regulator), is powered by the main $V_{D D}$. This means that the $\overline{E A}$ pin can be driven low during reset, if requested, to configure the system to start from the external memory.

An appropriate external circuit must be provided to manage dynamically both the functionalities associated with the pin: during reset and with stable $\mathrm{V}_{\mathrm{DD}}$, the pin can be tied low, while after reset (or anyway before turning off the main $\mathrm{V}_{\mathrm{DD}}$ to enter stand-by mode) the $\mathrm{V}_{\text {STBY }}$ supply is applied. Refer to Section 21.3 for more details.

Figure 10. $\overline{E A} / V_{\text {STBY }}$ external circuit


In Figure 10, a possible external circuit is represented. When selecting the resistance for current limitation, ensure that the resistance does not disturb the stand-by mode when some current (in the order of hundreds of $\mu \mathrm{A}$ ) is provided to the device by $\mathrm{V}_{\text {STBY; }}$; the voltage at the pin of ST10F252M cannot become lower than 4.5 V .

To reduce the effect of the current consumption transients on $\mathrm{V}_{\text {STBY }}$ pin (refer to $\mathrm{I}_{\text {SB3 }}$ in the Electrical Characteristics section), add an external capacitance which can filter any current peaks, which could create potential problems of voltage drops if a very low power external voltage regulator is used. The external hardware must limit current peaks due to the presence of the capacitance (when $\overline{E A}$ is used and the external bipolar is turned on, see Figure 10).

## 8 Internal Flash memory

### 8.1 Overview

The on-chip Flash has one matrix module 256 Kbyte wide. This Flash is accessed from the ST10 internal bus, hence it is also known as IFlash.

Figure 11. Flash modules structure


The programming operations of the Flash are managed by an embedded Flash program/erase controller (FPEC). The high voltages needed for program/erase operations are internally generated.
The data bus is 32 -bits wide for fetch accesses to IFlash, whereas it is 16 -bits wide for read accesses to the IFlash control registers. Write accesses are possible only in the IFlash control registers area.

### 8.2 Functional description

### 8.2.1 Structure

Table 21 below shows the address space reserved to the IFlash module (that is, ROMEN set to 1 in the SYSCON register).
Table 21. Address space reserved for the Flash module

| Description | Addresses | Size |
| :--- | :---: | :---: |
| IFlash sectors | $0 \times 000000$ to $0 \times 04$ FFFF | 256 Kbyte |
| Reserved area | $0 \times 050000$ to $0 \times 07$ FFFF | Reserved |
| Registers and Flash internal reserved area | $0 \times 080000$ to $0 \times 08$ FFFF | 64 Kbyte |

### 8.2.2 Modules structure

The IFlash module is composed of a bank (Bank0) of 256 Kbyte of program memory divided into eight sectors (B0F0...B0F7). Bank0 contains a reserved sector named Test-Flash used in bootstrap mode.
Addresses from 0x08 0000h to $0 \times 08$ FFFFh are reserved for the control register interface and other internal service memory space used by the Flash program/erase controller.

The following tables shows the memory mapping of the Flash when it is accessed in read mode (Table 22: Flash modules sectorization (read operations)), and when accessed in write or erase mode (Table 23: Flash modules sectorization (write operations or with ROMS1='1'or Bootstrap mode)).

With this second mapping, the first four banks are remapped into code segment 1 (same as obtained by setting bit ROMS1 in SYSCON register).

Table 22. Flash modules sectorization (read operations)

| Bank | Description | Addresses | $\begin{aligned} & \text { Size } \\ & \text { (bytes) } \end{aligned}$ |
| :---: | :---: | :---: | :---: |
| B0 | Bank 0 Flash 0 (B0FO) | 0x0000 0000-0x0000 1FFF | 8 K |
|  | Bank 0 Flash 1 (B0F1) | 0x0000 2000-0x0000 3FFF | 8 K |
|  | Bank 0 Flash 2 (B0F2) | 0x0000 4000-0x0000 5FFF | 8 K |
|  | Bank 0 Flash 3 (B0F3) | 0x0000 6000-0x0000 7FFF | 8 K |
|  | Bank 0 Flash 4 (B0F4) | 0x0001 8000-0x0001 FFFF | 32 K |
|  | Bank 0 Flash 5 (B0F5) | 0x0002 0000-0x0002 FFFF | 64 K |
|  | Bank 0 Flash 6 (B0F6) | 0x0003 0000-0x0003 FFFF | 64 K |
|  | Bank 0 Flash 7 (B0F7) | 0x0004 0000-0x0004 FFFF | 64 K |

Table 23. Flash modules sectorization (write operations or with ROMS1='1'or Bootstrap mode)

| Bank | Description | Addresses | $\begin{gathered} \text { Size } \\ \text { (bytes) } \end{gathered}$ |
| :---: | :---: | :---: | :---: |
| B0 | Bank 0 Test-Flash (BOTF) | 0x0000 0000-0x0000 1FFF | 8 K |
|  | Bank 0 Flash 0 (B0FO) | 0x0001 0000-0x0001 1FFF | 8 K |
|  | Bank 0 Flash 1 (B0F1) | 0x0001 2000-0x0001 3FFF | 8 K |
|  | Bank 0 Flash 2 (B0F2) | 0x0001 4000-0x0001 5FFF | 8 K |
|  | Bank 0 Flash 3 (B0F3) | 0x0001 6000-0x0001 7FFF | 8 K |
|  | Bank 0 Flash 4 (B0F4) | 0x0001 8000-0x0001 FFFF | 32 K |
|  | Bank 0 Flash 5 (B0F5) | 0x0002 0000-0x0002 FFFF | 64 K |
|  | Bank 0 Flash 6 (B0F6) | 0x0003 0000-0x0003 FFFF | 64 K |
|  | Bank 0 Flash 7 (B0F7) | 0x0004 0000-0x0004 FFFF | 64 K |

Table 23 above refers to the configuration when bit ROMS1 of SYSCON register is set. Refer to Chapter 24 for more details on bootstrap mode memory mapping during Bootstrap mode. In particular, when Bootstrap mode is entered:

- Test-Flash is seen and available for code fetches (address 000000 h ).
- user I-Flash is available for read and write accesses.
- write accesses must be made with addresses starting in segment 1 from 010000 h , whatever ROMS1 bit in SYSCON value.
- read accesses are made in segment 0 or in segment 1 depending on ROMS1 value. In bootstrap mode, ROMS1 = 0 by default, so the first 32 Kbytes of IFlash are mapped in segment 0.


## Example:

In default configuration, to program address 0 , the user must put the value 010000 h in the FARL and FARH registers but to verify the content of the address 0 , a read to 000000 h must be performed.

The next Table 24 shows the control register interface composition: this set of registers can be addressed by the CPU.
Table 24. Control register interface

| Name | Description | Addresses | $\begin{array}{\|c} \text { Size } \\ \text { (bytes) } \end{array}$ | $\begin{aligned} & \text { Bus } \\ & \text { size } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: |
| FCR1-0 | Flash control registers 1-0 | 0x0008 0000-0x0008 0007 | 8 | 16-bit |
| FAR | Flash address registers | 0x0008 0010-0x0008 0013 | 4 |  |
| FER | Flash error register | 0x0008 0014-0x0008 0015 | 2 |  |
| FNVWPIR | Flash non-volatile protection I register | 0x0008 DFB0-0x0008 DFB1 | 2 |  |
| FNVWPIRMirror | Flash non-volatile protection I register | 0x0008 DFB4-0x0008 DFB5 | 2 |  |
| FNVAPR0 | Flash non-volatile access protection register 0 | 0x0008 DFB8-0x0008 DFB9 | 2 |  |
| FNVAPR1 | Flash non-volatile access protection register 1 | 0x0008 DFBC - 0x0008 DFBF | 4 |  |
| FVTAU0 | Flash volatile temporary access unprotection register 0 | 0x0000 EB50-0x0000 EB51 | 2 |  |

### 8.2.3 Low power mode

The Flash module is automatically switched off when executing a PWRDN instruction. The consumption is drastically reduced, but exiting this state can require a long time ( $\mathrm{t}_{\mathrm{PD}}$ ).

Recovery time from power-down mode for the Flash modules is anyway shorter than the main oscillator start-up time. To avoid any problems in restarting to fetch code from the Flash, it is important to size properly the external circuit on RPD pin.
Note: $\quad$ PWRDN instruction must not be executed while a Flash program/erase operation is in progress.

### 8.3 Write operation

The Flash module has one single register interface mapped in the memory space of the IBus (08'0000h-08'0015h). All the operations are enabled through four 16-bit control registers: Flash Control Register 1-0 High/Low (FCR1H/L-FCR0H/L). Eight other 16-bit registers are used to store Flash address and data for program operations (FARH/L and FDR1H/L-FDR0H/L) and Write Operation Error flags (FERH/L). All registers are accessible with 8 - and 16 -bit instructions (since the IBUS operates in 16-bit mode for read/write accesses to data).

Note: $\quad$ The register that controls the Temporary Unprotection of the Flash is located on the XBus at address 00 EB50h in the XMiscellaneous Register area.
Before accessing the IFlash module (and consequently the Flash register to be used for program/erasing operations), the ROMEN bit in SYSCON register must be set.

Caution: During a Flash write operation any attempt to read the Flash itself, that is under modification, will output invalid data (software trap 009Bh). This means that the Flash is not fetchable when a programming operation is active. The write operation commands must be executed from another memory (internal RAM or external memory), as in ST10F269 device. In fact, due to IBus characteristics, it is not possible to perform a write operation on IFlash, when fetching code from IFlash.
Direct addressing is not allowed for write accesses to IFlash Control Registers.

Warning: During a Write operation, when bit LOCK of FCR0 is set, it is forbidden to write into the Flash Control Registers.

## Power supply drop

If during a write operation the internal low voltage supply drops below a certain internal voltage threshold, any write operation running is suddenly interrupted and the module is reset to Read mode. At following Power-on, the interrupted Flash write operation must be repeated.

### 8.4 Registers description

### 8.4.1 Flash control register 0 low (FCROL)

The Flash Control Register 0 Low (FCROL) together with the Flash Control Register 0 High (FCROH) are used to enable and to monitor all the write operations on the IFlash. The user has no access in write mode to the Test-Flash (BOTF). Moreover, the Test-Flash block is seen by the user in Bootstrap mode only.


Table 25. Flash control register 0 low

| Bit | Name | Function |
| :---: | :--- | :--- |
| $15: 5$ | Reserved | These bits are left at their reset value (0). <br> 4LOCKFlash Registers Access Locked <br> When this bit is set, it means that the access to the Flash Control <br> Registers FCROH/-FCR1H/L, FDROH/L-FDR1H/L, FARH/L and FER is <br> locked by the FPEC: any read access to the registers will output invalid <br> data (software trap 009Bh) and any write access will be ineffective. <br> LOCK bit is automatically set when the Flash bit WMS is set. <br> This is the only bit the user can always access to detect the status of <br> the Flash: once it is found low, the rest of FCROL and all the other <br> Flash registers are accessible by the user as well. <br> Note that FER content can be read when LOCK is low, but its content is <br> updated only when the BSY0 bit is reset. |
| 3.2 | Reserved | These bits are left at their reset value (0). |
| 1 | BSY | Bank 0 Busy (IFlash) <br> This bit indicates that a write operation is running on Bank 0 (IFlash). It <br> is automatically set when bit WMS is set. Setting Protection operation <br> sets bit BSY0 (since protection registers are in this Block). When this <br> bit is set, every read access to Bank 0 will output invalid data (software <br> trap 009Bh), while every write access to the Bank will be ignored. At <br> the end of the write operation or during a Program or Erase Suspend <br> this bit is automatically reset and the Bank returns to read mode. After <br> a Program or Erase Resume this bit is automatically set again. |
| 0 | Reserved | This bit is left at its reset value (0). |

### 8.4.2 Flash control register 0 high (FCROH)

The Flash Control Register 0 High (FCROH) together with the Flash Control Register 0 Low (FCROL) is used to enable and to monitor all the write operations on the IFlash. The user has no access in write mode to the Test-Flash (BOTF). Moreover, the Test-Flash block is seen by the user in Bootstrap mode only.

| FCROH (0x08 0002) |  |  |  |  |  | FCR |  |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 109 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| wms | SUSP | WPG | DWPG | SER | Reserved | SPR | Reserved |  |  |  |  |  |  |  |
| RW | RW | RW | RW | RW | - | RW |  |  |  |  |  |  |  |  |

Table 26. Flash control register 0 high

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15 | WMS | Write Mode Start <br> This bit must be set to start every write operation in the Flash module. At the end of the write operation or during a Suspend, this bit is automatically reset. To resume a suspended operation, this bit must be set again. It is forbidden to set this bit if bit ERR of FER is high (the operation is not accepted). It is also forbidden to start a new write (program or erase) operation (by setting WMS high) when bit SUSP of FCRO is high. Resetting this bit by software has no effect. |
| 14 | SUSP | Suspend <br> This bit must be set to suspend the current Program (Word or Double Word) or Sector Erase operation in order to read data in one of the Sectors of the Bank under modification or to program data in another Bank. The Suspend operation resets the Flash Bank to normal read mode (automatically resetting bit BSYO). When in Program Suspend, the Flash module accepts only the following operations: Read and Program Resume. When in Erase Suspend the module accepts only the following operations: Read, Erase Resume and Program (Word or Double Word; Program operations cannot be suspended during Erase Suspend). To resume a suspended operation, the WMS bit must be set again, together with the selection bit corresponding to the operation to resume (WPG, DWPG, SER). <br> Note: It is forbidden to start a new Write operation with bit SUSP already set. |
| 13 | WPG | Word Program <br> This bit must be set to select the Word (32 bits) Program operation in the Flash module. The Word Program operation can be used to program 0s in place of 1s. The Flash Address to be programmed must be written in the FARH/L registers, while the Flash Data to be programmed must be written in the FDROH/L registers before starting the execution by setting bit WMS. WPG bit is automatically reset at the end of the Word Program operation. |
| 12 | DWPG | Double Word Program <br> This bit must be set to select the Double Word ( 64 bits) Program operation in the Flash module. The Double Word Program operation can be used to program Os in place of 1s. The Flash Address in which to program (aligned with even words) must be written in the FARH/L registers, while the two Flash Data words to be programmed must be written in the FDROH/L registers (even word) and FDR1H/L registers (odd word) before starting the execution by setting bit WMS. DWPG bit is automatically reset at the end of the Double Word Program operation. |
| 11 | SER | Sector Erase <br> This bit must be set to select the Sector Erase operation in the Flash modules. The Sector Erase operation can be used to erase all the Flash locations to value $0 x F F$. From 1 to all the sectors of the same Bank (excluded Test-Flash for Bank BO) can be selected to be erased through bits BxFy of FCR1H/L registers before starting the execution by setting bit WMS. It is not necessary to preprogram the sectors to $0 \times 00$, because this is done automatically. SER bit is automatically reset at the end of the Sector Erase operation. |
| 10:9 | Reserved | These bits are left at their reset value (0). |

Table 26. Flash control register 0 high (continued)

| Bit | Name | Function |
| :---: | :---: | :--- |
| 8 | SPR | Set protection. <br> This bit is set to select the set protection operation. The set protection operation <br> programs Os in place of 1s in the Flash non volatile protection registers. The <br> Flash address in which to program is written in the FARH/L registers, while the <br> Flash data to be programmed is written in the FDROH/L before starting the <br> execution by setting bit WMS. A sequence error is flagged by bit SEQER of FER <br> if the address written in FARH/L is not in the range 0x08DFB0-0x08DFBF. This <br> bit is automatically reset at the end of the set protection operation. |
| $7: 0$ | Reserved | These bits are left at their reset value (0). |

### 8.4.3 Flash control register 1 low (FCR1L)

The Flash Control Register 1 Low (FCR1L), together with Flash Control Register 1 High (FCR1H), is used to select the Sectors to Erase, or during any write operation to monitor the status of each Sector and Bank.

| FCR | x0 | 00 |  |  |  |  | CR |  |  |  |  |  | Reset | value: | 0000h |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Reserved |  |  |  |  |  |  |  | B0F7 | B0F6 | B0F5 | B0F4 | B0F3 | B0F2 | B0F1 | B0FO |
|  |  |  |  |  |  |  |  | RS | RS | RS | RS | RS | RS | RS | RS |

Table 27. Flash control register 1 low

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:8 | Reserved | These bits are left at their reset value (0). |
| 7:0 | B0F[7:0] | Bank 0 IFlash Sectors 7-0 Status <br> These bits must be set during a Sector Erase operation to select the sectors to <br> erase in Bank 0. Moreover, during any erase operation, these bits are <br> automatically set and give the status of the eight sectors of Bank 0 (B0F7-B0F0). <br> The meaning of B0Fy bit for Sector y of Bank 0 is given in Table 29. These bits <br> are automatically reset at the end of a write operation if no errors are detected. |

### 8.4.4 Flash control register 1 high (FCR1H)

The Flash Control Register 1 High (FCR1H), together with Flash Control Register 1 Low (FCR1L), is used to select the Sectors to Erase, or during any write operation to monitor the status of each Sector and Bank.


Table 28. Flash control register 1 high

| Bit | Name | Function |
| :---: | :---: | :--- |
| $7: 0$ | Reserved | These bits are left at their reset value (0). |
| 8 | BOS | Bank 0 Status (IFlash) <br> During any erase operation, this bit is automatically modified and gives the status <br> of the Bank 0. The meaning of B0S bit is given in Table 29. This bit is <br> automatically reset at the end of an erase operation if no errors are detected. |
| $15: 9$ | Reserved | These bits are left at their reset value (0). |

During any erase operation, this bit is automatically set and gives the status of the Bank 0.
The meaning of BOFy bit for Sector y of Bank 0 is given by the next Table 4 Banks (BxS) and Sectors (BxFy) Status bits meaning. These bits are automatically reset at the end of an erase operation if no errors are detected.

Table 29. Banks (BxS) and sectors (BxFy) status bits meaning

| ERR | SUSP | BOS = 1 meaning | BOFy =1 meaning |
| :---: | :---: | :--- | :--- |
| 1 | - | Erase Error in Bank0 | Erase Error in Sector y of Bank0 |
| 0 | 1 | Erase Suspended in Bank0 | Erase Suspended in Sector y of Bank0 |
| 0 | 0 | Don't care | Don't care |

### 8.4.5 Flash data register 0 low (FDROL)

During program operations, the Flash Address Registers (FARH/L) are used to store the Flash address in which to program and the Flash Data Registers (FDR1H/L-FDR0H/L) are used to store the Flash data to program.


Table 30. Flash data register 0 low

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | DIN[15:0] | Data Input 15:0 <br> These bits must be written with the Data to program the Flash with the following <br> operations: Word Program (32-bit), Double Word Program (64-bit) and Set <br> Protection. |

### 8.4.6 Flash data register 0 high (FDROH)



Table 31. Flash data register 0 high

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | DIN[31:16] | Data Input 31:16 <br> These bits must be written with the Data to program the Flash with the following <br> operations: Word Program (32-bit), Double Word Program (64-bit) and Set <br> Protection. |

### 8.4.7 Flash data register 1 low (FDR1L)



Table 32. Flash data register 1 low

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | DIN[15:0] | Data Input 15:0 <br> These bits must be written with the Data to program the Flash with the following <br> operations: Word Program (32-bit), Double Word Program (64-bit) and Set <br> Protection. |

### 8.4.8 Flash data register 1 high (FDR1H)



Table 33. Flash data register 1 high

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | DIN[31:16] | Data Input 31:16 <br> These bits must be written with the Data to program the Flash with the following <br> operations: Word Program (32-bit), Double Word Program (64-bit) and Set <br> Protection. |

### 8.4.9 Flash address register low (FARL)



Table 34. Flash address register low

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:2 | ADD[15:2] | Address 15:2 <br> These bits must be written with the Address of the Flash location to program in the <br> following operations: Word Program (32-bit) and Double Word Program (64-bit). In <br> Double Word Program bit ADD2 must be written to ' 0 '. |
| 1:0 | Reserved | These bits are left at their reset value (0). |

### 8.4.10 Flash address register high (FARH)



Table 35. Flash address register high

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 5$ | Reserved | These bits are left at their reset value (0). |
| $4: 0$ | ADD[20:16] | Address $20: 16$ <br> These bits must be written with the Address of the Flash location to program in <br> the following operations: Word Program and Double Word Program. |

### 8.4.11 Flash error register (FER)

The Flash Error register, as well as all the other Flash registers, can be read only once the LOCK bit of register FCROL is low. Nevertheless, the FER content is updated after completion of the Flash operation, that is, when BSYO is reset. Therefore, the FER content can only be read once the LOCK and BSYO bits are cleared.


Table 36. Flash error register

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15:9 | Reserved | These bits are left at their reset value (0). |
| 8 | WPF | Write Protection Flag <br> This bit is automatically set when trying to program or erase in a sector write protected. In case of multiple Sector Erase, the not protected sectors are erased, while the protected sectors are not erased and bit WPF is set. This bit has to be software reset. |
| 7 | RESER | Resume Error <br> This bit is automatically set when a suspended Program or Erase operation is not resumed correctly due to a protocol error. In this case the suspended operation is aborted. This bit has to be software reset. |
| 6 | SEQER | Sequence Error <br> This bit is automatically set when the control registers (FCR1H/L-FCR0H/L, FARH/L, FDR1H/L-FDROH/L) are not correctly filled to execute a valid Write Operation. In this case no Write Operation is executed. This bit has to be software reset. |
| 5:4 | Reserved | These bits are left at their reset value (0). |
| 3 | 10ER | 1 over 0 Error <br> This bit is automatically set when trying to program at 1 bits previously set at 0 (this does not happen when programming the Protection bits). This error is not due to a failure of the Flash cell, but only flags that the desired data has not been written. This bit has to be software reset. |
| 2 | PGER | Program Error <br> This bit is automatically set when a Program error occurs during a Flash write operation. This error is due to a real failure of a Flash cell, that can no more be programmed. The word where this error occurred must be discarded. This bit has to be software reset. |
| 1 | ERER | Erase Error <br> This bit is automatically set when an Erase error occurs during a Flash write operation. This error is due to a real failure of a Flash cell, that can no more be erased. This kind of error is fatal and the sector where it occurred must be discarded. This bit has to be software reset. |
| 0 | ERR | Write Error <br> This bit is automatically set when an error occurs during a Flash write operation or when a bad write operation setup is done. Once the error has been discovered and understood, ERR bit must be software reset. |

### 8.5 Protection strategy

The protection bits are stored in Non-Volatile Flash cells inside IFlash module, that are read once at reset and stored in four Volatile registers. Before they are read from the NonVolatile cells, all the available protections are forced active during reset.
The protections can be programmed using the Set Protection operation (see Flash Control Registers paragraph), that can be executed from all the internal or external memories except from the Flash itself.

Two kind of protections are available: write protections to avoid unwanted writings and access protections to avoid piracy. In next paragraphs all different level of protections are shown, and architecture limitations are highlighted as well.

### 8.5.1 Protection registers

The four Non-Volatile Protection Registers are one time programmable for the user.
One register (FNVWPIR) is used to store the Write Protection fuses respectively for each sector IFlash module. The other three registers (FNVAPR0 and FNVAPR1L/H) are used to store the Access Protection fuses.

### 8.5.2 Flash non-volatile write protection I register (FNVWPIR)

| FNVWPIR (0x08 DFB0) |  |  |  | NVR |  |  |  |  |  | Reset value: FFFFh |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Reserved |  |  |  |  |  |  |  | WOP7 W0P6 |  | WOP5 | WOP4 | WOP3 | WOP2 | WOP1 | WOPO |
|  |  |  |  |  |  |  |  | RW | RW | RW | RW | RW | RW | RW | RW |

Table 37. Flash non-volatile write protection I register

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 8$ | Reserved | These bits are left at their reset value (F). |
| 7:0 | W0P[7:0] | Write Protection Bank 0 / Sectors 7-0 (IFlash) <br> These bits, if programmed at 0, disable any write access to the sectors of Bank 0 <br> (IFlash) |

### 8.5.3 Flash non-volatile access protection register 0 (FNVAPR0)



Table 38. Flash non-volatile access protection register 0

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 2$ | Reserved |  |
| 1 | DBGP | Debug Protection <br> This bit, if erased at 1, can be used to by-pass all the protections using the Debug <br> features through the Test Interface. If programmed at 0, on the contrary, all the <br> debug features, the Test Interface and all the Flash Test modes are disabled. Even <br> STMicroelectronics will not be able to access the device to run any eventual failure <br> analysis. |
| 0 | ACCP | Access Protection <br> This bit, if programmed at 0, disables any access (read/write) to data mapped <br> inside IFlash Module address space, unless the current instruction is fetched from <br> IFlash. |

### 8.5.4 Flash non-volatile access protection register 1 low (FNVAPR1L)



Table 39. Flash non-volatile access protection register 1 low

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | PDS[15:0] | Protections Disable 15-0 <br> If bit PDSx is programmed at 0 and bit PENx is erased at 1, the action of bit ACCP <br> is disabled. Bit PDSO can be programmed at 0 only if both bits DBGP and ACCP <br> have already been programmed at 0. Bit PDSx can be programmed at 0 only if bit <br> PENx-1 has already been programmed at 0. |

### 8.5.5 Flash non-volatile access protection register 1 high (FNVAPR1H)

| FNVAPR1H (0x08 DFBE) NVR |  |  |  |  |  |  |  |  |  |  |  | Delivery value: FFFFh |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PEN15 | PEN14 | PEN13 | PEN12P | PEN11 | PEN10 | PEN9 | PEN8 | PEN7 | PEN6 | PEN5 | PEN4 | PEN3 | PEN2 | PEN1 | PENO |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 40. Flash non-volatile access protection register 1 high

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15:0 | PEN[15:0] | Protections Enable 15-0 <br> If bit PEN $x$ is programmed at 0 and bit PDS $x+1$ is erased at 1, the action of bit <br> ACCP is enabled again. Bit PEN $x$ can be programmed at 0 only if bit PDSx has <br> already been programmed at 0. |

### 8.5.6 XBus Flash volatile temporary access unprotection register (XFVTAURO)



Table 41. XBus Flash volatile temporary access unprotection register

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 1$ | Reserved | These bits are left at their reset value (0). |
| 0 | TAUB | Temporary Access Unprotection bit <br> If this bit is set to 1, the Access Protection is temporary disabled. <br> The fact that this bit can be written only while executing from IFlash guarantees <br> that only a code executed in IFlash can unprotect the IFlash when it is Access <br> Protected. |

### 8.5.7 Access protection

The IFlash module has one level of access protection (access to data both in Reading and Writing).

When bit ACCP of FNVAPR0 is programmed at 0 and bit TAUB in XFVTAUR0 is set at 0 , the IFlash module becomes access protected (data in the IFlash module can be read only if the current execution is from the IFlash module itself).

Trying to read into the access protected Flash from internal RAM or external memories will output a dummy data (software trap 009Bh).
When the Flash module is protected in access, data access through PEC transfers is also forbidden. To read/write data through PEC in a protected Bank, first it is necessary to temporarily unprotect the Flash module.

To enable Access Protection, the following sequence of operations is recommended:

- execution from external memory or internal Rams
- program TAUB bit at 1 in XFVTAUR0 register
- program ACCP bit in FNVAPR0 to 0 using Set Protection operation
- program TAUB bit at 0 in XFVTAURO register
- Access Protection is active when both ACCP bit and TAUB bit are set to 0 .

Protection can be permanently disabled by programming bit PDS0 of FNVAPR1H, in order to analyze rejects. Protection can be permanently enabled again by programming bit PEN0 of FNVAPR1L. The action to disable and enable again Access Protections in a permanent way can be executed a maximum of 16 times. To execute the above described operations, the Flash has to be temporarily unprotected (see Section 8.5.9: Temporary unprotection).

Trying to write into the access protected Flash from internal RAM or external memories will be unsuccessful. Trying to read into the access protected Flash from internal RAM or external memories will output dummy data (software trap 0x009Bh).
When the Flash module is protected in access, data access through PEC of a peripheral is also forbidden. To read/write data in PEC mode from/to a protected Bank, it is necessary to first temporarily unprotect the Flash module.

The following table summarizes all possible Access Protection levels: In particular, it shows what is possible and not possible to do when fetching from a memory (see fetch location column) supposing all possible access protections are enabled.

Table 42. Summary of access protection level

| Fetch location | Read XRAM or <br> External <br> Rump to IFlash <br> Memory / <br> Jump to XRAM <br> or External <br> Memory | Read Flash <br> Registers | Write Flash <br> Registers |  |
| :--- | :---: | :---: | :---: | :---: |
| Fetching from IFlash | Yes / Yes | Yes / Yes | Yes | No |
| Fetching from IRAM | No / Yes | No / Yes | Yes / No | No |
| Fetching from XRAM | No / Yes | No / Yes | Yes / No | No |
| Fetching from external <br> memory | No / Yes | No /Yes | Yes / No | No |

When the Access Protection is enabled, Flash registers can not be written, so no program/erase operation can be run on IFlash. To enable the access to registers again, the Temporary Access Unprotection procedure has to be followed (see Section 8.5.9).

### 8.5.8 Write protection

The Flash modules have one level of Write Protections: each Sector of each Bank of each Flash Module can be Software Write Protected by programming at 0 the related bit WOPx in FNVWPIRL register.

### 8.5.9 Temporary unprotection

Bits WOPx of FNVWPIRL can be temporarily unprotected by executing the Set Protection operation and by writing 1 into these bits.

To restore the write protection bits it is necessary to reset the microcontroller or to execute a Set Protection operation and write 0 into the desired bits.
In reality, when a temporary write unprotection operation is executed, the corresponding volatile register is written to 1 , while the non-volatile registers bits previously written to 0 (for a protection set operation), will continue to maintain the 0 . For this reason, the User software must be in charge to track the current write protection status (for instance using a specific RAM area), it is not possible to deduce it by reading the non-volatile register content (a temporary unprotection cannot be detected).
To temporarily unprotect the Flash when the Access Protection is active, it is necessary to set to ' 1 ' the bit TAUB in XFVTAUR0. This bit can be set to ' 1 ' only while executing from Flash: In this way only an instruction executed from Flash can unprotect the Flash itself.
To restore the Access Protection, it is necessary to reset the microcontroller or to write at 0 the bit TAUB in XFVTAURO.

### 8.6 Write operation examples

The following examples represent each kind of Flash write operation.
Note: $\quad$ The write operation commands must be executed from another memory (internal RAM or external memory), as in ST10F269 device. In fact, due to I-bus characteristics, it is not possible to perform write operation in IFlash while fetching code from IFlash.
Direct addressing is not allowed for write accesses to IFlash control registers. This means that both address and data for a writing operation must be loaded in one ST10 GPR register (R0...R15).
A write operation on the I-bus is 16 bits wide.
Example: indirect addressing mode:

```
MOV R RWm, #ADDRESS; /*Load Add in R RWm*/
MOV R RWn, #DATA; /*Load Data in R RWn*/
MOV [ }\mp@subsup{R}{Wm}{}],\mp@subsup{R}{Wn}{}; /*Indirect addressing*/
```

Word program example: 32-bit word program of data 0xAAAAAAAA at address 0x015554.

```
FCROH |= 0x2000; /*Set WPG in FCROH* /
FARL = 0x5554; /*Load Add in FARL*/
```

| FARH | $=0 \times 0001 ;$ | /*Load Add in FARH*/ |
| :--- | :--- | :--- |
| FDROL | 0xAAAA; | /*Load Data in FDROL*/ |
| FDROH | 0xAAAA; | /*Load Data in FDROH*/ |
| FCROH | $=0 x 8000 ;$ | /*Operation start*/ |

Double word program example: double word program (64-bit) of data 0x55AA55AA at address $0 \times 015558$ and data 0xAA55AA55 at address 0x01555C.

| FCROH | \| $=0 \times 1000$; | /*Set DWPG*/ |
| :---: | :---: | :---: |
| FARL | $=0 \times 5558$; | /*Load Add in FARL*/ |
| FARH | $=0 \times 0001$; | /*Load Add in FARH*/ |
| FDR0L | $=0 \times 55 A A$; | /*Load Data in FDROL*/ |
| FDROH | $=0 \times 55 A A$; | /*Load Data in FDROH*/ |
| FDR1L | $=0 \times 1.555$; | /*Load Data in FDR1L*/ |
| FDR1H | $=0 \times A A 55$; | /*Load Data in FDR1H*/ |
| FCROH | \| $=0 \times 8000$; | /*Operation start*/ |

Note: $\quad$ A double word program is always performed on the double word aligned on a even word bit ADD2 of FARL is ignored.

Sector erase example: sector erase of sectors B0F1 and B0F0 of Bank0 in IFlash module.

| FCR0H \|= 0x0800; | /*Set SER in FCR0H*/ |
| :--- | :--- |
| FCR1H \|= 0x0003; | /*Set B0F1, B0F0*/ |
| FCR0H \|= 0x8000; | /*Operation start*/ |

Suspend and resume example: word program, double word program, and sector erase operations can be suspended in the following way.
FCROH |= 0x4000;
/*Set SUSP in FCROH*/
The operation can be resumed in the following way.

| FCROH $\&=0 \times B F F F ;$ | $/ * R$ st SUSP in FCROH*/ |
| :--- | :--- |
| FCROH $\mid=0 \times 8000 ;$ | /*Operation resume*/ |

Note: $\quad$ The original set up of select operation bits in FCROH/L must be restored before the operation resume, otherwise the operation is aborted and bit RESER of FER is set.

Erase suspend, program and resume examples: a sector erase operation can be suspended to program (word or double word) another sector.

Sector erase of sector B0F1 of Bank0 in IFlash module.

| FCR0H $\mid=0 \times 0800 ;$ | /*Set SER in FCROH*/ |
| :--- | :--- |
| FCR1H $\mid=0 \times 0002 ;$ | $/ *$ Set B3F1*/ |
| FCR0H $\mid=0 x 8000 ;$ | /*Operation start*/ |

Sector erase suspend.

| FCROH \|= 0x4000; | /*Set SUSP in FCROH*/ |
| :--- | :--- |
| do | /*Loop to Wait WMS=0*/ |
| \{tmp = FCR0H; | /*Read FCROH*/ |
| \} while (tmp \& 0x8000); |  |

Example: word program of data 0x5555AAAA at address $0 \times 015554$ in IFlash module.

| FCROH | \|= 0x2000; | /*Set WPG in FCROH*/ |
| :---: | :---: | :---: |
| FARL | $=0 \times 5554$; | /*Load Add in FARL*/ |
| FARH | $=0 \times 000 \mathrm{C}$; | /*Load Add in FARH*/ |
| FDR0L | $=0 \times A A A A$; | /*Load Data in FDR0L*/ |
| FDROH | = 0x5555; | /*Load Data in FDROH*/ |
| FCROH | \|= 0x8000; | /*Operation start*/ |

Once the program operation is finished, the erase operation can be resumed in the following way.

| FCROH $\&=0 \times B F F F ;$ | /*Rst SUSP in FCROH*/ |
| :--- | :--- |
| FCROH $\mid=0 \times 8000 ;$ | /*Operation resume*/ |

Note: During the program operation in erase suspend, bits SER and SUSP remain high. A word or double word program during erase suspend cannot be suspended.

Set protection example 1: enable write protection of sectors B0F3...B0F0 of Bank 0 in IFlash module.

| FCROH | $1=0 \times 0100$; | /*Set SPR in FCROH*/ |
| :---: | :---: | :---: |
| FARL | $=0 \mathrm{xDFB4}$; | /*Load Add of register FNVWPIRL in FARL*/ |
| FARH | $=0 \times 0008$; | /*Load Add of register FNVWPIRL in FARH*/ |
| FDROL | $=0 \mathrm{XFFFO} 0$; | /*Load Data in FDROL*/ |
| FCROH | $1=0 \times 8000$; | /*Operation start*/ |

Set protection example 2: enable access and debug protection.

| FVTUR | $=0 \times 0001$; | /*Set TAUB in FVTAUR0*/ |
| :---: | :---: | :---: |
| FCROH | \| $=0 \times 0100$; | /*Set SPR in FCROH*/ |
| FARL | $=0 \mathrm{xDFB8}$; | /*Load Add of register FNVAPRO in FARL*/ |
| FARH | $=0 \times 0008$; | /*Load Add of register FNVAPRO in FARH*/ |
| FDROL | $=0 \times F F F C$; | /*Load Data in FDROL*/ |
| FCROH | \| $=0 \times 8000$; | /*Operation start*/ |
| FVTUR | $=0 \times 0000$; | /*Set TAUB in FVTAUR0*/ |

Set protection example 3: permanently disable access and debug protection.

| FVTUR | $=0 \times 0001$; | /*Set TAUB in FVTAUR0*/ |
| :---: | :---: | :---: |
| FCROH | \| $=0 \times 0100$; | /*Set SPR in FCROH*/ |
| FARL | $=0 \times D F B C$; | /*Load Add of register FNVAPR1L in FARL*/ |
| FARH | $=0 \times 000 \mathrm{E}$; | /*Load Add of register FNVAPR1L in FARH*/ |
| FDR0L | $=0 \times F F F E$; | /*Load Data in FDROL for clearing PDSO*/ |
| FCROH | $1=0 \times 8000$; | /*Operation start*/ |

Set protection example 4: permanently re-enable access and debug protection, after having disabled them.

```
FVTUR = 0x0001; /*Set TAUB in FVTAUR0*/
FCR0H |= 0x0100; /*Set SPR in FCR0H*/
```

| FARL $=0 \times D F B C ;$ | /*Load Add register FNVAPR1H in FARL*/ |
| :--- | :--- | :--- |
| FARH $=0 \times 0008 ;$ | /*Load Add register FNVAPR1H in FARH*/ |
| FDR0H $=0 \times F F F E ;$ | /*Load Data in FDR0H for clearing PEN0*/ |
| FCR0H $\mid=0 \times 8000 ;$ | /*Operation start*/ |
| FVTUR $=0 \times 0000 ;$ | /*Set TAUB in FVTAUR0*/ |

Note: $\quad$ Disable and re-enable of access and debug protection in a permanently (as shown by examples 3 and 4) can be done for a maximum of 16 times.

### 8.7 Write operation summary

In general, each write operation is started through a sequence of three steps:

1. The first instruction is used to select the desired operation by setting its corresponding selection bit in the Flash Control Register 0.
2. The second step is the definition of the Address and Data for programming or the Sectors or Banks to erase.
3. The last instruction is used to start the write operation, by setting the start bit WMS in the FCRO.

Once selected, but not yet started, one operation can be canceled by resetting the operation selection bit.

Available Flash Module Write Operations are summarized in the following Table 43.
Table 43. Flash write operations

| Operation | Select bit | Address and data | Start bit |
| :--- | :---: | :---: | :---: |
| Word program (32-bit) | WPG | FARL/FARH <br> FDROL/FDROH | WMS |
| Double word program (64-bit) | DWPG | FARL/FARH <br> FDROL/FDROH <br> FDR1L/FDR1H | WMS |
| Sector erase | SER | FCR1L/FCR1H | WMS |
| Set protection | SPR | FDROL/FDROH | WMS |
| Program/erase suspend | SUSP | None | None |

Figure 12 shows the complete flow needed for a Write operation.
Figure 12. Write operation control flow


## $9 \quad$ Interrupt system

The interrupt response time for internal program execution is from 125 ns to 300 ns at 40 MHz CPU frequency.

The ST10F252M architecture supports several mechanisms for fast and flexible response to service requests that can be generated from various sources internal or external to the microcontroller. Any of these interrupt requests can be serviced by the interrupt controller or by the peripheral event controller (PEC).

In contrast to a standard interrupt service where the current program execution is suspended and a branch to the interrupt vector table is performed, just one cycle is 'stolen' from the current CPU activity to perform a PEC service. A PEC service implies a single byte or word data transfer between any two memory locations with an additional increment of either the PEC source or the destination pointer. An individual PEC transfer counter is implicitly decremented for each PEC service except when performing in the continuous transfer mode. When this counter reaches zero, a standard interrupt is performed to the corresponding source related vector location. PEC services are very well suited, for example, for supporting the transmission or reception of blocks of data. The ST10F252M has eight PEC channels each of which offers such fast interrupt-driven data transfer capabilities.

There is a separate control register, which contains an interrupt request flag, an interrupt enable flag and an interrupt priority bit-field for each of the possible interrupt sources. Via its related register, each source can be programmed to one of sixteen interrupt priority levels. Once having been accepted by the CPU, an interrupt service can only be interrupted by a higher prioritized service request. For the standard interrupt processing, each of the possible interrupt sources has a dedicated vector location.
Software interrupts are supported by means of the 'TRAP' instruction in combination with an individual trap (interrupt) number.

### 9.1 Fast external interrupt

Fast external interrupt inputs are provided to service external interrupts with high precision requirements. These fast interrupt inputs feature programmable edge detection (rising edge, falling edge or both edges).

### 9.1.1 External interrupt source selection register (EXISEL)

Fast external interrupts may also have interrupt sources selected from other peripherals; for example the CANx controller receive signal (CANx_RxD) can be used to interrupt the system. The same is valid for $I^{2} \mathrm{C}$ interface serial clock line (SCL), and for real time clock. This function is controlled using the external interrupt source selection register (EXISEL), and allows to wake-up the system from interruptible power down having to reset the device.

## External interrupt source selection register

| External interrupt source selection register (F1DA ED) |  |  | EXISEL |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1514 | $13 \quad 12$ | 1110 | 98 | $7 \quad 6$ | $5 \quad 4$ | 32 | 10 | 0 |
| EXI7SS | EXI6SS | EXI5SS | EXI4SS | EXI3SS | EXI2SS | EXI1SS | EXIOSS |  |
| RW | RW | RW | RW | RW | RW | RW | RW |  |

Table 44. External interrupt source selection register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | EXIxSS(7:0) | External interrupt $x$ source selection ( $x=7 \ldots 0$ ) <br> '00': Input from associated port 2 pin. <br> '01': Input from "alternate source". <br> '10': Input from port 2 pin ORed with "alternate source". <br> '11': Input from port 2 pin ANDed with "alternate source" |

Table 45. EXIxSS interrupts

| EXIxSS | Port 2 pin | Alternate Source |  |
| :---: | :--- | :--- | :--- |
| 0 | P2.8 | CAN1_RxD | P4.5 |
| 1 | P2.9 | CAN2_RxD | P4.4 |
| 2 | P2.10 | RTC_secIT | Internal MUX |
| 3 | P2.11 | RTC_alarmIT | Internal MUX |
| 4 | P2.12 | SCL | P1.6 |
| $5 \ldots 7$ | P2.13...15 | Not used (zero) | - |

CAN and $\mathrm{I}^{2} \mathrm{C}$ interrupt need some considerations, the following are general rules.

- When a module is not enabled, even though the interrupt source is enabled (see for example EXIxSS='01'), an event on the pin does not generate any request to the CPU.
- CAN parallel mode is enabled only when both CAN modules are enabled (on the contrary it has no effect).

EXxIN inputs are normally sampled interrupt inputs. However, the power down mode circuitry uses them as level-sensitive inputs. An EXxIN ( $x=7 \ldots 0$ ) interrupt enable bit (bit CCxIE in the respective CCxIC register) needs not to be set to bring the device out of power down mode.

If the Interrupt was enabled (bit CCxIE='1' in the respective CCxIC register) before entering power down mode, the device executes the interrupt service routine, and then resumes execution after the PWRDN instruction. If the interrupt was disabled, the device executes the instruction following PWRDN instruction, and the interrupt request flag (bit CCxIR in the respective CCxIC register) remains set until it is cleared by software.

In Table 46, all the possible pin configurations are summarized for CAN parallel mode. In the table, the bit of XPERCON register are shown (used to enable/disable each module) and the bit CANPAR of XMISC register used to enable/disable the CAN parallel mode. The table
shows when the wake-up interrupt can be generated by the two modules (providing that the EXISEL register is properly set).
Table 46. CAN parallel mode pin configurations

| CANPAR | CAN2EN | CAN1EN | Interrupt P4.5 | Interrupt P4.4 |
| :---: | :---: | :---: | :---: | :---: |
| x | 0 | 0 | No | No |
| x | 0 | 1 | Yes (CAN1) | No |
| x | 1 | 0 | No | Yes (CAN2) |
| 0 | 1 | 1 | Yes (CAN1) | Yes (CAN2) |
| 1 | 1 | 1 | Yes (CAN1/2) | No |

Note: $\quad$ For CAN1 (and CAN2 when parallel mode is set) the related interrupt control register is CC8IC; for CAN2 the register is CC9IC, for I2C is CC12IC

### 9.1.2 External interrupt control register (EXICON)

The Power Down mode can be entered if enabled Fast External Interrupt pins (EXxIN pins, Alternate Functions of Port 2 pins, with $x=7 \ldots 0$ ) are in their inactive level. This inactive level is configured with the EXIxES bit field in the EXICON register.

## External interrupt control register



Table 47. External interrupt control register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | EXIxES(7:0) | External Interrupt x Edge Selection Field ( $x=7 \ldots 0$ ) <br> ' 00 ': Fast external interrupts disabled: standard mode. The EXxIN pin is not taken into account for entering/exiting power down mode. <br> '01': Interrupt on positive edge (rising). Enter power down mode if EXiN = ' 0 ', exit if EXxIN = ' 1 ' (referred as 'high' active level) ' 10 ': Interrupt on negative edge (falling). Enter power down mode if EXiN = ' 1 ', exit if EXxIN = ' 0 ' (referred as 'low' active level) <br> '11': Interrupt on any edge (rising or falling). Always enter power down mode, exit if EXxIN level changes. |

While for CAN and $I^{2} \mathrm{C}$ the EXICON programming depends on the customer application (even though inactive state of both CAN and $\mathrm{I}^{2} \mathrm{C}$ protocols is the high level, so a new activity on the bus can be detected by a falling edge observed at the related pins), for RTC the internal hardware circuitry is such that the interrupts are generated on the positive edge, so the EXICON register must be programmed accordingly.
Note: $\quad$ The $I^{2} C$ interface implements a input analog filter to avoid spurious spikes are assumed as valid bus transitions. For this reason, a pulse on SCL line is long enough to be recognized as valid pulse: this is in the range of 500 ns (minimum). All pulses shorter than 50 ns are
certainly filtered: a pulse longer than 50 ns but shorter than 500 ns could either trigger or not trigger the exit from power down mode.

### 9.2 X-Peripheral interrupt

The limited number of X-Bus interrupt lines of the present ST10 architecture, imposes some constraints on the implementation of the new functionality. In particular, the additional XPeripherals SSC1, ASC1, $I^{2} \mathrm{C}, \mathrm{PWM} 1$ and RTC need some resources to implement interrupt and PEC transfer capabilities. For this reason, a multiplexed structure for the interrupt management is proposed. In the next Figure 13, the principle is explained through a simple diagram, which shows the basic structure replicated for each of the four X -interrupt available vectors (XPOINT, XP1INT, XP2INT and XP3INT).
It is based on a set of 16 -bit registers XIRxSEL ( $x=0,1,2,3$ ), divided in two portions each:

- Byte High
- Byte Low
XIRxSEL[15:8] Interrupt Enable bits

When different sources submit an interrupt request, the enable bits (Byte High of XIRxSEL register) define a mask which controls which sources will be associated with the unique available vector. If more than one source is enabled to issue the request, the service routine will have to take care to identify the real event to be serviced. This can easily be done by checking the flag bits (Byte Low of XIRxSEL register). Note that the flag bits can also provide information about events which are not currently serviced by the interrupt controller (since they are masked through the enable bits), allowing an effective software management even if the related interrupt request cannot be served: A periodic polling of the flag bits may be implemented inside the user application.

Figure 13. X-interrupt basic structure


Table 48 summarizes the mapping of the different interrupt sources, which share the four X-interrupt vectors.

Since the XIRxSEL registers are not bit addressable, another pair of registers (a pair for each XIRxSEL) is provided to allow setting and clearing the bits of XIRxSEL without risking overwriting requests arriving after reading the register and before writing it. These registers are described in this section as well.

Table 48. X-Interrupt detailed mapping

| Interrupt | XPOINT | XP1INT | XP2INT | XP3INT |
| :---: | :---: | :---: | :---: | :---: |
| CAN1 Interrupt | X |  |  | X |
| CAN2 Interrupt |  | x |  | X |
| $I^{2} \mathrm{C}$ Receive | X | X | X |  |
| $I^{2} \mathrm{C}$ Transmit | X | X | X |  |
| $\mathrm{I}^{2} \mathrm{C}$ Error |  |  |  | X |
| SSC1 Receive | X | X | X |  |
| SSC1 Transmit | X | X | X |  |
| SSC1 Error |  |  |  | x |
| ASC1 Receive | X | X | X |  |
| ASC1 Transmit | X | X | X |  |
| ASC1 Transmit Buffer | X | X | X |  |
| ASC1 Error |  |  |  | X |
| PLL Unlock / OWD |  |  |  | X |
| PWM1 Channel 3... 0 |  |  | X | X |

### 9.3 Interrupt sources

Table 49 shows all of the possible ST10F252M interrupt sources and the corresponding hardware-related interrupt flags, vectors, vector locations and trap (interrupt) numbers:

Table 49. Interrupt sources

| Source of Interrupt or <br> PEC Service Request | Request <br> Flag | Enable <br> Flag | Interrupt <br> Vector | Vector <br> Location | Trap <br> Number |
| :--- | :---: | :---: | :---: | :---: | :---: |
| CAPCOM Register 0 | CC0IR | CC0IE | CCOINT | $000^{\prime 0040 \mathrm{~h}}$ | 10 h |
| CAPCOM Register 1 | CC1IR | CC1IE | CC1INT | $00^{\prime} 0044 \mathrm{~h}$ | 11 h |
| CAPCOM Register 2 | CC2IR | CC2IE | CC2INT | $00^{\prime} 0048 \mathrm{~h}$ | 12 h |
| CAPCOM Register 3 | CC3IR | CC3IE | CC3INT | $000^{\prime} 004 \mathrm{Ch}$ | 13 h |
| CAPCOM Register 4 | CC4IR | CC4IE | CC4INT | $00^{\prime} 0050 \mathrm{~h}$ | 14 h |
| CAPCOM Register 5 | CC5IR | CC5IE | CC5INT | $000^{\prime 0054 h}$ | 15 h |
| CAPCOM Register 6 | CC6IR | CC6IE | CC6INT | $00^{\prime} 0058 \mathrm{~h}$ | 16 h |
| CAPCOM Register 7 | CC7IR | CC7IE | CC7INT | $000^{\prime 005 C h ~}$ | 17 h |
| CAPCOM Register 8 | CC8IR | CC8IE | CC8INT | $00^{\prime} 0060 \mathrm{~h}$ | 18 h |
| CAPCOM Register 9 | CC9IR | CC9IE | CC9INT | $00^{\prime} 0064 \mathrm{~h}$ | 19 h |

Table 49. Interrupt sources (continued)

| Source of Interrupt or PEC Service Request | Request Flag | Enable Flag | Interrupt Vector | Vector Location | Trap Number |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CAPCOM Register 10 | CC10IR | CC10IE | CC10INT | 00'0068h | 1 Ah |
| CAPCOM Register 11 | CC11IR | CC11IE | CC11INT | 00'006Ch | 1Bh |
| CAPCOM Register 12 | CC12IR | CC12IE | CC12INT | 00'0070h | 1Ch |
| CAPCOM Register 13 | CC13IR | CC13IE | CC13INT | 00'0074h | 1Dh |
| CAPCOM Register 14 | CC14IR | CC14IE | CC14INT | 00'0078h | 1Eh |
| CAPCOM Register 15 | CC15IR | CC15IE | CC15INT | 00'007Ch | 1Fh |
| CAPCOM Register 16 | CC16IR | CC16IE | CC16INT | 00'00C0h | 30h |
| CAPCOM Register 17 | CC17IR | CC17IE | CC17INT | 00'00C4h | 31h |
| CAPCOM Register 18 | CC18IR | CC18IE | CC18INT | 00'00C8h | 32h |
| CAPCOM Register 19 | CC19IR | CC19IE | CC19INT | 00'00CCh | 33h |
| CAPCOM Register 20 | CC20IR | CC20IE | CC20INT | 00'00D0h | 34h |
| CAPCOM Register 21 | CC21IR | CC21IE | CC21INT | 00'00D4h | 35h |
| CAPCOM Register 22 | CC22IR | CC22IE | CC22INT | 00'00D8h | 36h |
| CAPCOM Register 23 | CC23IR | CC23IE | CC23INT | 00'00DCh | 37h |
| CAPCOM Register 24 | CC24IR | CC24IE | CC24INT | 00'00EOh | 38h |
| CAPCOM Register 25 | CC25IR | CC25IE | CC25INT | 00'00E4h | 39h |
| CAPCOM Register 26 | CC26IR | CC26IE | CC26INT | 00'00E8h | 3Ah |
| CAPCOM Register 27 | CC27IR | CC27IE | CC27INT | 00'00ECh | 3Bh |
| CAPCOM Register 28 | CC28IR | CC28IE | CC28INT | 00'00EOh | 3Ch |
| CAPCOM Register 29 | CC29IR | CC29IE | CC29INT | 00'0110h | 44h |
| CAPCOM Register 30 | CC30IR | CC30IE | CC30INT | 00'0114h | 45h |
| CAPCOM Register 31 | CC311R | CC31IE | CC31INT | 00'0118h | 46h |
| CAPCOM Timer 0 | TOIR | TOIE | TOINT | 00'0080h | 20h |
| CAPCOM Timer 1 | T1IR | T1IE | T1INT | 00'0084h | 21h |
| CAPCOM Timer 7 | T7IR | T7IE | T7INT | 00'00F4h | 3Dh |
| CAPCOM Timer 8 | T8IR | T8IE | T8INT | 00'00F8h | 3Eh |
| GPT1 Timer 2 | T21R | T2IE | T2INT | 00'0088h | 22h |
| GPT1 Timer 3 | T3IR | T3IE | T3INT | 00'008Ch | 23h |
| GPT1 Timer 4 | T4IR | T4IE | T4INT | 00'0090h | 24h |
| GPT2 Timer 5 | T5IR | T5IE | T5INT | 00'0094h | 25h |
| GPT2 Timer 6 | T6IR | T6IE | T6INT | 00'0098h | 26h |
| GPT2 CAPREL Register | CRIR | CRIE | CRINT | 00'009Ch | 27h |
| A/D Conversion Complete | ADCIR | ADCIE | ADCINT | 00'00A0h | 28h |
| A/D Overrun Error | ADEIR | ADEIE | ADEINT | 00'00A4h | 29h |

Table 49. Interrupt sources (continued)

| Source of Interrupt or PEC Service Request | Request Flag | Enable Flag | Interrupt Vector | Vector <br> Location | Trap Number |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ASCO Transmit | SOTIR | SOTIE | SOTINT | 00'00A8h | 2Ah |
| ASC0 Transmit Buffer | SOTBIR | SOTBIE | SOTBINT | 00'011Ch | 47h |
| ASCO Receive | SORIR | SORIE | SORINT | 00'00ACh | 2Bh |
| ASC0 Error | SOEIR | SOEIE | SOEINT | 00'00B0h | 2Ch |
| SSC Transmit | SCTIR | SCTIE | SCTINT | 00'00B4h | 2Dh |
| SSC Receive | SCRIR | SCRIE | SCRINT | 00'00B8h | 2Eh |
| SSC Error | SCEIR | SCEIE | SCEINT | 00'00BCh | 2Fh |
| PWM Channel 0... 3 | PWMIR | PWMIE | PWMINT | 00'00FCh | 3Fh |
| See Section 9.2 | XPOIR | XPOIE | XPOINT | 00'0100h | 40h |
|  | XP1IR | XP1IE | XP1INT | 00'0104h | 41h |
|  | XP2IR | XP2IE | XP2INT | 00'0108h | 42h |
|  | XP3IR | XP3IE | XP3INT | 00'010Ch | 43h |

Hardware traps are exceptions or error conditions that arise during run-time. They cause an immediate non-maskable system reaction similar to a standard interrupt service (branching to a dedicated vector table location).
The occurrence of a hardware trap is additionally signified by an individual bit in the trap flag register (TFR). Except when another higher prioritized trap service is in progress, a hardware trap will interrupt any actual program execution. In turn, hardware trap services can normally not be interrupted by standard or PEC interrupts.

### 9.4 Exception and traps list

Table 50 shows all of the possible exceptions or error conditions that can arise during runtime.

Table 50. Trap priorities

| Exception condition | Trap <br> flag | Trap <br> vector | Vector <br> location | Trap <br> number | Trap <br> priority${ }^{(\mathbf{1})}$ |
| :--- | :---: | :---: | :---: | :---: | :---: |$|$

Table 50. Trap priorities (continued)

| Exception condition | Trap flag | Trap vector | Vector location | Trap number | Trap priority ${ }^{(1)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Class B Hardware Traps: |  |  |  |  |  |
| Undefined Opcode | UNDOPC | BTRAP | 00'0028h | OAh | 1 |
| MAC Interruption | MACTRP | BTRAP | 00'0028h | OAh | I |
| Protected Instruction Fault | PRTFLT | BTRAP | 00'0028h | OAh | I |
| Illegal word Operand Access | ILLOPA | BTRAP | 00'0028h | OAh | I |
| Illegal Instruction Access | ILLINA | BTRAP | 00'0028h | OAh | I |
| Illegal External Bus Access | ILLBUS | BTRAP | 00'0028h | OAh | I |
| Reserved |  |  | [002Ch-003Ch] | [0Bh - OFh] |  |
| Software Traps TRAP Instruction |  |  | $\begin{gathered} \text { Any } \\ \text { 0000h - 01FCh } \\ \text { in steps of 4h } \end{gathered}$ | $\begin{gathered} \text { Any } \\ {[00 \mathrm{~h}-7 \mathrm{Fh}]} \end{gathered}$ | $\begin{aligned} & \text { Current } \\ & \text { CPU } \\ & \text { Priority } \end{aligned}$ |

1.     - All the class B traps have the same trap number (and vector) and the same lower priority compared to the class A traps and to the resets.

- Each class A trap has a dedicated trap number (and vector). They are prioritized in the second priority level.
- The resets have the highest priority level and the same trap number.
- The PSW.ILVL CPU priority is forced to the highest level (15) when these exceptions are serviced.


## 10 Capture compare (CAPCOM) units

The ST10F252M has two 16 channel CAPCOM units. They support generation and control of timing sequences on up to 32 channels with a maximum resolution of 200 ns at 40 MHz CPU clock.

The CAPCOM units are typically used to handle high speed I/O tasks such as pulse and waveform generation, pulse width modulation (PMW), digital to analog (D/A) conversion, software timing, or time recording relative to external events.

These two CAPCOM units are identical to the ones of the ST10F269 and ST10F27x, but, due to 100-pins limitation in the ST10F252, the I/O capability is limited to 18 channels.
For CAPCOM1, 14 input-capture/output-compare channels with 4 only input-capture channel for CAPCOM2.

The number of timer input lines has not changed, the TOIN input line is available for CAPCOM1, T7IN input line timer for CAPCOM2.

All capture/compare registers and timers register are available, but some of them are not connected to external pins

Figure 14. SFR and port pins associated with CAPCOM units


## 11 General purpose timer unit

The general purpose timer (GPT) unit is a flexible multifunctional timer/counter structure which is used for time related tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation, or pulse multiplication. The GPT unit contains five 16-bit timers organized into two separate modules GPT1 and GPT2. Each timer in each module may operate independently in several different modes, or may be concatenated with another timer of the same module.

### 11.1 GPT1

Each of the three timers T2, T3, T4 of the GPT1 module can be configured individually for one of four basic modes of operation:

1. timer
2. gated timer
3. counter mode
4. incremental interface mode.

Although due to pins limitation in ST10F252 not all modes are available for each timer.
In timer mode, the input clock for a timer is derived from the CPU clock, divided by a programmable prescaler, Each of the three timers T2, T3, T4 of the GPT1 module can be configured in this mode.

In counter mode, the timer is clocked by reference to external events. Pulse width or duty cycle measurement is supported in gated timer mode where the operation of a timer is controlled by the 'gate' level on an external input pin. For these purposes, timers have one associated port pin (TxIN) which serves as gate or clock input. Only T2 and T3 have such an input pin associated in ST10F252, so gated timer and counter mode are not available for timer T4.

The count direction (up/down) for each timer is programmable only by software.
Functionality that dynamically changes direction by an external signal on a port pin is not available on ST10F252. For the same reason, incremental interface mode is not available for all the GPT1 timers (T2, T3, T4).

Timer T3 has output toggle latches (TxOTL) which changes state on each timer overflow/underflow. The state of this latch may be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to their basic operating modes, timers T2 and T4 may be configured as reload or capture registers for timer T3. When used as capture or reload registers, timers T2 and T4 are stopped. The contents of timer T3 is captured into T2 or T4 in response to a signal at their associated input pins (TxIN). Timer T3 is reloaded with the contents of T2 or T4 triggered either by an external signal or by a selectable state transition of its toggle latch T3OTL. When both T2 and T4 are configured to alternately reload T3 on opposite state transitions of T3OTL with the low and high times of a PWM signal, this signal can be constantly generated without software intervention.

Figure 15. SFRs and port pins associated with timer block GPT1

## Ports \& Direction Control Alternate Functions Data Registers

```
Control Registers
```



$$
\begin{array}{ll}
\text { ODP3 } & \text { Port3 Open Drain Control Register } \\
\text { DP3 } & \text { Port3 Direction Control Register } \\
\text { P3 } & \text { Port3 Data Register } \\
\text { T2CON } & \text { GPT1 Timer } 2 \text { Control Register } \\
\text { T3CON } & \text { GPT1 Timer 3 Control Register } \\
\text { T4CON } & \text { GPT1 Timer } 4 \text { Control Register }
\end{array}
$$

1514131211109876543210


Interrupt Control
1514131211109876543210


Y: Bit is linked to a function

- Bit has no function or is not implemented

E: Register is in ESFR internal memory space

T2 GPT1 Timer 2 Register
T3 GPT1 Timer 3 Register
T4 GPT1 Timer 4 Register
T2IC GPT1 Timer 2 Interrupt Control Register
T3IC GPT1 Timer 3 Interrupt Control Register T4IC GPT1 Timer 4 Interrupt Control Register

### 11.2 GPT2

The GPT2 module provides precise event control and time measurement. It includes two timers (T5, T6) and a capture/reload register (CAPREL). Both timers can be clocked with an input clock which is derived from the CPU clock via a programmable prescaler. The count direction (up/down) for each timer is programmable by software. Concatenation of the timers is supported via the output toggle latch (T6OTL) of timer T6 which changes its state on each timer overflow/underflow.

The state of this latch may be used to clock timer T5, or it may be output on a port pin (T6OUT). The overflow/underflow of timer T6 can additionally be used to clock the CAPCOM timers T0 or T1, and to cause a reload from the CAPREL register. The CAPREL register may capture the contents of timer T5 based on an external signal transition on the corresponding port pin (CAPIN), and timer T5 may optionally be cleared after the capture procedure. This allows absolute time differences to be measured or pulse multiplication to be performed without software overhead.

The capture trigger (timer T5 to CAPREL) may also be generated upon transitions of GPT1 timer T3's inputs T3IN and/or T3EUD.
Note: In ST10F252, port pins to clock timers T5 and T6 with external signals and pins to control counter direction are not available.

Figure 16. SFRs and port pins associated with timer block GPT2


## 12 PWM modules

Two pulse width modulation modules are available on ST10F252M: standard PWM0 and XBUS PWM1. They can generate up to four PWM output signals each, using edge-aligned or center-aligned PWM. In addition, the PWM modules can generate PWM burst signals and single shot outputs. Table 51 shows the PWM frequencies for different resolutions. The level of the output signals is selectable and the PWM modules can generate interrupt requests.

Figure 17. Block diagram of PWM module


Table 51. PWM unit frequencies and resolutions at 40 MHz CPU clock

| Mode 0 | Resolution | 8-bit | 10-bit | 12-bit | 14-bit | 16-bit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CPU Clock/1 | 25 ns | 156.25 kHz | 39.1 kHz | 9.77 kHz | 2.44 Hz | 610 Hz |
| CPU <br> Clock/64 | $1.6 \mu \mathrm{~s}$ | 2.44 kHz | 610 Hz | 152.6 Hz | 38.15 Hz | 9.54 Hz |
| Mode 1 | Resolution | $\mathbf{8 - b i t}$ | $\mathbf{1 0 - b i t}$ | $\mathbf{1 2 - b i t}$ | $\mathbf{1 4 - b i t}$ | $\mathbf{1 6 - b i t}$ |
| CPU Clock/1 | 25 ns | 78.12 kHz | 19.53 kHz | 4.88 kHz | 1.22 kHz | 305.2 Hz |
| CPU <br> Clock/64 | $1.6 \mu \mathrm{~s}$ | 1.22 kHz | 305.17 Hz | 76.29 Hz | 19.07 Hz | 4.77 Hz |

## 13 Parallel ports

### 13.1 Introduction

To accept or generate single external control signals or parallel data, the ST10F252 provides up to 76 parallel I/O lines, organized into one 14-bit I/O port (Port 2), five 8-bit I/O ports (PORT0 comprising P0H and P0L, PORT1 comprising P1H and P1L, and Port 4), one 12-bit I/O port (Port 3) and one 10-bit input port (Port 5).

These port lines may be used for general purpose input and output, controlled via software, or may be used implicitly by ST10F252's integrated peripherals or the external bus controller.

All port lines are bit addressable and all input/output lines are individually (bit-wise) programmable as inputs or outputs via direction registers (except for Port 5). The I/O ports are true bidirectional ports, which are switched to high impedance state when configured as inputs. The output drivers of three I/O ports $(2,3,4)$ can be configured (pin by pin) for push/pull operation or open-drain operation via control registers.

The logic level of a pin is clocked into the input latch once per state time, regardless whether the port is configured for input or output.

A write operation to a port pin configured as an input causes the value to be written into the port output latch, while a read operation returns the latched state of the pin itself. A read-modify-write operation reads the value of the pin, modifies it, and writes it back to the output latch.

Writing to a pin configured as an output (DPx.y='1') causes the output latch and the pin to have the written value, since the output buffer is enabled. Reading this pin returns the value of the output latch. A read-modify-write operation reads the value of the output latch, modifies it, and writes it back to the output latch, thus also modifying the level at the pin.

Note: $\quad$ A set of registers, mapped on XBUS, is implemented on ST10F252 to manage the data, direction and open-drain mode for those pins where the XPWM, XASC and XSSC are mapped. The standard port register bits for these pins are working when the X-peripherals are not enabled (see XPERCON register); however, when the X-Peripherals are enabled, the new registers take the control of the pins and the content if the standard registers is ignored.

Figure 18．SFRs，XBUS registers and pins associated with the parallel ports



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### 13.2 I/O's special features

### 13.2.1 Open drain mode

Some of the I/O ports of ST10F252M support the open drain capability. This programmable feature may be used with an external pull-up resistor, in order to provide an AND wired logical function.

When open-drain mode is selected, the voltage on the pin must not exceed the $\mathrm{V}_{\text {DD }}$ value to avoid injecting current through the diode, inherent in disabled upper transistor (turned off, but still physically connected to the pin). This is taken into account especially during poweron and power-off sequences (see stand-by mode entering procedure).

This feature is implemented for ports P2, P3, P4 (see Section 13.5, Section 13.6 and Section 13.7 respectively) and is controlled through the respective Open Drain Control Registers ODPx, for port P1 it's implemented only when XSSC, XASC or XPWM are enabled. Open Drain Control Registers allow the individual bit-wise selection of the open drain mode for each port line. If the respective control bit ODPx.y is ' 0 ' (default after reset), the output driver is in the push/pull mode. If ODPx.y is ' 1 ', the open drain configuration is selected. Note that all ODPx registers are located in the ESFR space.

Note: $\quad$ When XPWM, XASC and XSSC are used (enabled through XPERCON) the open-drain mode of the related pins is controlled by a set of new registers (XPWMPORT, XS1PORT, XSSCPORT).

When XI2C is enabled (through XPERCON), the related pins of Port1 are automatically set to open-drain mode.

Figure 19. Output drivers in push/pull mode and in open drain mode


### 13.2.2 Input threshold control

The standard inputs of the ST10F252M determine the status of input signals according to TTL levels. In order to accept and recognize noisy signals, CMOS input thresholds can be selected instead of the standard TTL thresholds for all the pins. These CMOS thresholds are defined above the TTL thresholds and feature a higher hysteresis to prevent the inputs from toggling while the respective input signal level is near the thresholds.
Two port input control registers (PICON and XPICON) are used to select these thresholds for each byte of the indicated ports: the 8-bit ports P4 is controlled by one bit while ports P0, P1, P2, P3 and P5 are controlled by two bits each.

| PICON (F1C4 / E2) |  |  |  | ESFR |  |  |  |  |  |  |  |  | Reset value: --00h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Reserved |  |  |  |  |  |  |  |  |  |  | P4LIN | P3HIN | P3LIN | P2HIN | P2LIN |
| - | - | - | - | - | - | - | - | - | - | - | RW | RW | RW | RW | RW |

Table 52. Port input control register (PICON)


Table 53. Additional port input control register (XPICON)

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 6$ | Reserved |  |
| $5: 0$ | PxHIN | Port $x$ high byte input level selection <br> '0': Pins Px.15...Px.8 switch on standard TTL input levels. <br> '1': Pins Px.15...Px.8 switch on standard CMOS input levels. |

Note: $\quad$ PICON is an ESFR register, while XPICON is an XBUS register. XPICON is accessible only after bit XMISCEN of XPERCON register and bit XPEN of SYSCON register have been set.

All options for individual direction and output mode control are available for each pin, independent of the selected input threshold. The input hysteresis (variable, according to TTL or CMOS selection) provides stable inputs from noisy or slowly changing external signals.
Figure 20. Hysteresis concept


### 13.2.3 Alternate port functions

Each port line has one (or more) associated programmable alternate input or output functions. If an alternate output function of a pin is to be used, the direction of this pin must be programmed for output (DPx.y=‘1'), except for some signals that are used directly after reset and are configured automatically. Otherwise the pin remains in the high-impedance
state and is not affected by the alternate output function. The respective port latch should hold a '1', because its output is ANDed with the alternate output data (except for PWM output signals).

If an alternate input function of a pin is used, the direction of the pin must be programmed for input (DPx.y='0') if an external device is driving the pin. The input direction is the default after reset. If no external device is connected to the pin, however, the direction for this pin can also be set to output. In this case, the pin reflects the state of the port output latch. Thus, the alternate input function reads the value stored in the port output latch. This can be used for testing purposes to allow a software trigger of an alternate input function by writing to the port output latch.

On most of the port lines, user software is responsible for setting the proper direction when using an alternate input or output function of a pin. This is done by setting or clearing the direction control bit DPx.y of the pin before enabling the alternate function. There are port lines, however, where the direction of the port line is switched automatically. For instance, in the multiplexed external bus modes of PORT0, the direction must be switched several times for an instruction fetch to output the addresses and to input the data. Obviously, this cannot be done through instructions. In these cases, the direction of the port line is switched automatically by hardware if the alternate function of such a pin is enabled. To determine the appropriate level of the port output latches check how the alternate data output is combined with the respective port latch output.

There is one basic structure for all port lines with only an alternate input function. Port lines with only an alternate output function, however, have different structures due to the way the direction of the pin is switched and depending on whether the pin is accessible by the user software or not in the alternate function mode.

All port lines that are not used for these Alternate Functions may be used as general purpose I/O lines. When using port pins for general purpose output, the initial output value should be written to the port latch prior to enabling the output drivers, to avoid undesired transitions on the output pins. This applies to single pins as well as to pin groups (see examples below).

| SINGLE_BIT: | BSET | P4.7 | initial output level is "high" |
| :--- | :--- | :--- | :--- |
|  | BSET | DP4.7 | ; Switch on the output driver |
| BIT_GROUP: | BFLDH | P4, \#24H, \#24H | ; Initial output level is "high" |
|  | BFLDH | DP4, \#24H, \#24H | $;$ Switch on the output drivers |

Note: $\quad$ When using several BSET pairs to control more pins of one port, these pairs must be separated by instructions, which do not reference the respective port.

### 13.3 PORTO

The two 8-bit ports POH and POL represent the higher and lower part of PORT0, respectively. Both halves of PORT0 can be written (for example, via a PEC transfer) without affecting the other half.

## POL register

| POL register (FF00/80) |  |  | SFR |  |  |  |  |  |  |  |  |  | Reset value: --00h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| reserved |  |  |  |  |  |  |  | POL. 7 | POL. 6 | POL. 5 | POL. 4 | POL. 3 | POL. 2 | POL. 1 | POL. 0 |
| - |  |  |  |  |  |  |  | RW | RW | RW | RW | RW | RW | RW | RW |

## POH register



Table 54. POL and POH registers functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| POL 7.0 | POX.y | Port data register POH or POL bit y |
| POH 7.0 |  |  |

If this port is used for general purpose I/O, the direction of each line can be configured via the corresponding direction registers DPOH and DPOL.

## DPOL register



## DPOH register



Table 55. DPOL and DPOH registers functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| DPOL 7.0 | DP0X.y | Port direction register DPOH or DPOL bit y <br> DPOH 7.0 |
|  | '0': Port line P0X.y is an input (high-impedance) |  |

### 13.3.1 Alternate functions of PORTO

When an external bus is enabled, PORT0 is used as a data bus or an address and data bus, when no additional ADC Channels (6) are selected.

An external 8-bit de-multiplexed bus only uses POL, while POH is free for I/O (provided that no other bus mode is enabled).

PORT0 is also used to select the system start-up configuration. During reset, PORT0 is configured to input and each line is held high through an internal pull-up device. Each line can now be individually pulled to a low level (see the DC-level specifications in the appropriate data sheets) through an external pull-down device. A default configuration is selected when the respective PORTO lines are at a high level. Through pulling individual lines to a low level, this default can be changed according to the needs of the application. The internal pull-up devices are designed such that an external pull-down resistors (see Data Sheet specification) can be used to apply a correct low level. These external pull-down resistors can remain connected to the PORTO pins also during normal operation, however, take care that they do not disturb the normal function of PORT0 (this may be the case, for example, if the external resistor is too strong).

At the end of reset, the selected bus configuration is written to the BUSCONO register. The configuration of the high byte of PORT0, is copied into the special register RPOH. This readonly register holds the selection for the number of chip selects and segment addresses. Software can read this register to react to the selected configuration, if required. When the reset is terminated, the internal pull-up devices are switched off, and PORT0 is switched to the appropriate operating mode.

During external accesses in multiplexed bus modes, PORT0 first outputs the 16-bit intrasegment address as an alternate output function. PORT0 is then switched to highimpedance input mode to read the incoming instruction or data. In 8-bit data bus mode, two memory cycles are required for word accesses, the first for the low byte and the second for the high byte of the word. During write cycles PORTO outputs the data byte or word after outputting the address. During external accesses in de-multiplexed bus modes, PORT0 reads the incoming instruction or data word or outputs the data byte or word.

Figure 21. PORTO I/O and alternate functions


When an external bus mode is enabled, the direction of the port pin and the loading of data into the port output latch are controlled by the bus controller hardware. The input of the port output latch is disconnected from the internal bus and is switched to the line labeled "Alternate Data Output" via a multiplexer. The alternate data can be the 16-bit intra-segment address or the 8/16-bit data information. The incoming data on PORTO is read on the line "Alternate Data Input". While an external bus mode is enabled, the user software should not
write to the port output latch, otherwise unpredictable results may occur. When the external bus modes are disabled, the contents of the direction register last written becomes active.
Figure 22 shows the structure of a PORT0 pin.
Figure 22. Block diagram of a PORT0


### 13.3.2 Disturb protection on analog inputs

A register is provided for additional disturb protection support on analog inputs for PORT0. In particular, the register can disable both the digital input and output sections of the I/O structure. To access this register the bit XMISCEN of register XPERCON and bit XPEN of register SYSCON must be set.

Disturb protection register


Table 56. Disturb protection register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 5.0 | XPODIDIS.y | Port 1 Digital Disable register bit y <br> '0': Port line P0.y digital input and output are not disabled: the port pin <br> is defined through the corresponding bits of the standard registers <br> POL/DPOL. General Purpose Input/Output functionality is available, as <br> well as the external memory interface functionality. <br> '1': Port line P0.y digital input and output are disabled (necessary for <br> input leakage current reduction and to avoid undesired conflict <br> between output driver configuration and analog input signal). Once this <br> bit is set, POL/DPOL corresponding bits are no longer effective and the <br> external memory interface functionality is masked on the single bit. |

Figure 23. Block diagram of input section of PORTOL pin


Figure 24. Block diagram of a PORTO pin


### 13.4 PORT1

The two 8-bit ports P 1 H and P1L represent the higher and lower part of PORT1, respectively. Either half of PORT1 can be written (for example, by a PEC transfer) without effecting the other half.

## P1L register

| P1L register (FF04/82) |  |  |  | SFR |  |  |  |  |  |  |  |  | Reset value: --00h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|  |  |  | - |  |  |  |  | P1L7 | P1L6 | P1L5 | P1L4 | P1L3 | P1L2 | P1L1 | P1L0 |
|  |  |  | - |  |  |  |  | RW | RW | RW | RW | RW | RW | RW | RW |

## P1H register



Table 57. P 1 L and P 1 H registers functions

| Pin | Name | Function |
| :---: | :---: | :---: |
| P1L 7.0 | P1X.y | Port data register P1H or P1L bit y |
| P1R 7.0 |  |  |

If PORT1 is used for general purpose I/O, the direction of each line can be configured via the corresponding direction registers DP1H and DP1L.

## DP1L register



## DP1H register



Table 58. DP1L and DP1H registers functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| DP1L 7.0 | DP1X.y | Port direction register DP1H or DP1L bit y <br> '0': Port line P1X.y is an input (high-impedance) <br> DP1H 7.0 |
|  |  | '1: Port line P1X.y is an output |

If PORT1 pins are used as alternate function for input/output of XPWM, XASC or XSSC peripherals, the direction of each pins is configured by dedicated registers mapped in the X peripheral memory area, an open drain setting is also available for used port P1 pins. Registers that are used for different alternate function are described in the following.

## XSSCPORT

This register is enabled and visible only when bit XPEN of SYSCON is set, and bit XSSCEN in XPERCON is also set. If not enabled, the standard $\mathrm{P} 1 \mathrm{H}, \mathrm{DP} 1 \mathrm{H}$ registers are used to configure pins P1H.1, P1H. 2 and P1H.3; the open drain setting is not available.

## XSSCPORT register



Table 59. XSSCPORT register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| $8,5,2$ | XODP1H.y | Port open drain control register bit $\mathrm{y}(\mathrm{y}=1,2,3$ only) <br> ' $':$ Port line P1H.y output driver in push/pull mode <br> '1': Port line P1H.y output driver in open drain mode |
| $7,4,1$ | XP1H.y | Port data register bit y ( $\mathrm{y}=1,2,3$ only) |
| 6.3 .0 | XDP1H.y | Port direction register bit y ( $\mathrm{y}=1,2,3$ only) <br> '0': Port line P1H.y is an input (high-impedance) <br> '1': Port line P1H.y is an output |

## XS1PORT

This register is enabled and visible only when bit XPEN of SYSCON is set, and bit XASCEN in XPERCON is also set. If not enabled, the standard P1L, DP1L registers are used to configure pins P1L. 4 and P1L.5; the open drain setting is not available.

## XS1PORT register

| XS1PORT register (E980) |  |  |  |  |  |  |  |  |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Reserved |  |  |  |  |  |  |  |  |  | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } 4 \end{aligned}$ | $\begin{gathered} \hline \text { XP1 } \\ \text { L. } 4 \end{gathered}$ | XDP1 | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } 5 \end{aligned}$ | $\begin{gathered} \mathrm{XP} 1 \\ \mathrm{~L} .5 \end{gathered}$ | $\begin{gathered} \text { XDP1 } \\ \text { L. } 5 \end{gathered}$ |

Table 60. XS1PORT register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 5,2 | XODP1L.y | Port open drain control register bit $y$ ( $y=4,5$ only $)$ <br> '0': Port line P1L.y output driver in push/pull mode <br> '1': Port line P1L.y output driver in open drain mode |
| 4,1 | XP1L.y | Port data register bit y (y $=4,5$ only) |
| 3,0 | XDP1L.y | Port direction register bit $y$ ( $\mathrm{y}=4,5$ only) <br> '0': Port line P1L.y is an input (high-impedance) <br> '1': Port line P1L.y is an output |

## XPWMPORT

This register is enabled and visible only when bit XPEN of SYSCON is set, and bit XPWMEN in XPERCON is also set. If not enabled, the standard P1L, DP1L registers are used to configure pins P1L.0, P1L.1, P1L. 2 and P1L.3; the open drain setting is not available.

## XPWPORT register

| XPWNPORT register (EC80) |  |  |  |  |  |  |  |  |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|  | - |  |  | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } 3 \end{aligned}$ | $\begin{gathered} \text { XP1 } \\ \text { L. } 3 \end{gathered}$ | $\begin{gathered} \text { XDP1 } \\ \text { L. } 3 \end{gathered}$ | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } \end{aligned}$ | $\begin{gathered} \text { XP1 } \\ \text { L. } 2 \end{gathered}$ | $\begin{gathered} \text { XDP1 } \\ \text { L.2.2 } \end{gathered}$ | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } 1 \end{aligned}$ | $\begin{gathered} \text { XP1 } \\ \text { L. } 1 \end{gathered}$ | $\begin{array}{\|c} \text { XDP1 } \\ \text { L. } 1 \end{array}$ | $\begin{aligned} & \text { XOD } \\ & \text { P1L. } 0 \end{aligned}$ | $\begin{gathered} \text { XP1 } \\ \text { L. } 0 \end{gathered}$ | $\begin{gathered} \text { XDP1 } \\ \text { L. } 0 \end{gathered}$ |
| - |  |  |  | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 61. XPWPORT register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 11,8, <br> 5,2 | XODP1L.y | Port open drain control register bit $y(y=0,1,2,3$ only $)$ <br> '0': Port line P1L.y output driver in push/pull mode <br> '1': Port line P1L.y output driver in open drain mode |
| 10,7, <br> 4,1 | XP1L.y | Port data register bit $y$ ( $y=0,1,2,3$ only $)$ |
| 9,6, <br> 3,0 | XDP1L.y | Port direction register bit $y$ ( $y=0,1,2,3$ only) <br> '0': Port line P1L.y is an input (high-impedance) <br> '1': Port line P1L.y is an output |

### 13.4.1 Alternate functions of PORT1

When a de-multiplexed external bus is enabled, PORT1 is used as address bus. Demultiplexed bus modes use PORT1 as a 16-bit port. Otherwise all 16 port lines can be used for general purpose I/O.

Pins P1H.3...P1H. 1 of PORT1 are also used for receive/transmit and clock lines of SSC1.
Pins P1L. 7 and P1L. 6 of PORT1 are also used for input/output lines of I2C.
Pins P1L. 5 and P1L. 4 of PORT1 are also used for receive, transmit lines of ASC1.
Pins P1L.3...P1L. 0 of PORT1 are also used for output lines of PWM1.
The upper four pins of PORT1 (P1H.7...P1H.4) also serve as capture input lines for the CAPCOM2 unit (CC27I...CC24I). As all other capture inputs, the capture input function of pins P1H.7...P1H. 4 can also be used as external interrupt inputs ( 83.34 ns sample rate at 48 MHz CPU clock).

During external accesses in de-multiplexed bus modes, PORT1 outputs the 16-bit intra-segment address as an alternate output function.

During external accesses in multiplexed bus modes, when no BUSCON register selects a de-multiplexed bus mode, PORT1 is not used and is available for general purpose I/O and other alternate functions.

Figure 25. PORT1 I/O and alternate functions


When demultiplexed external bus mode is enabled, the direction of the port pin and the loading of data into the port output latch are controlled by the bus controller hardware. The input of the port output latch is disconnected from the internal bus and is switched to the line labeled "Demux Bus" via a multiplexer. The alternate data is the 16 -bit intra-segment address. While an external bus mode is enabled, the software does not write to the port output latch, otherwise unpredictable results may occur. When external bus modes are disabled, the contents of the direction register last written becomes active.
If one or more peripherals from XASC, I2C, XSSC, XPWM (bit XPEN of SYSCON is set, and associated bit to peripheral in XPERCON is set) are enabled, alternate functions for demultiplexed bus cannot be used.

Figure 26. Block diagram of a PORT1 pin P1H.7...P1H. 4


Figure 27. Block diagram of pins P1H. 3 ...P1H. 1


Figure 28. Block diagram of pin P1L.6, P1.7


Figure 29. Block diagram of pins P1L. 5


Figure 30. Block diagram of pins P1L. 4


Figure 31. Block diagram of pins P1L.3...P1L. 0


### 13.5 PORT2

If this 14-bit port is used for general purpose I/O, the direction of each line is configured by the corresponding direction register DP2. Each port line can be switched into push/pull or open drain mode by the open drain control register ODP2.

## PORT2 register

| PORT2 register (FFCO/E0) |  |  |  | SFR |  |  |  |  |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| P2.15 | P2.14 | P2.13 | P2.12 | P2.11 | P2.10 | P2.9 | P2.8 | P2.7 | P2.6 | P2.5 | P2.4 | P2.3 | P2.2 | - | - |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | - | - |

Table 62. PORT2 register functions

| Bit | Name | Function |  |
| :---: | :---: | :--- | :--- |
| 15.2 | P2.y | Port data register P2 bit y |  |

## PORT2 direction register



Table 63. PORT2 direction register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.2 | DP2.y | Port direction register DP2 bit y <br> '0': Port line P2.y is an input (high-impedance) <br> '1': Port line P2.y is an output |

## PORT2 open drain control register

| PORT2 open drain control register (F1C2/E1) |  |  |  |  |  | ESFR |  |  |  | 5 | 4 | 3 | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 |  |  |  | 2 | 1 | 0 |
| $\begin{gathered} \text { ODP2 } \\ .15 \end{gathered}$ | $\begin{gathered} \text { ODP2 } \\ .14 \end{gathered}$ | $\begin{gathered} \text { ODP2 } \\ .13 \end{gathered}$ | $\begin{gathered} \text { ODP2 } \\ .12 \end{gathered}$ | $\begin{gathered} \text { ODP2 } \\ .11 \end{gathered}$ | $\begin{gathered} \text { ODP2 } \\ .10 \end{gathered}$ | ODP2. $9$ | ODP2. $8$ | $\begin{gathered} \text { ODP2 } \\ .7 \end{gathered}$ | $\begin{array}{\|c} \text { ODP2 } \\ .6 \end{array}$ | $\begin{gathered} \text { ODP2 } \\ .5 \end{gathered}$ | $\begin{array}{\|c} \text { ODP2 } \\ .4 \end{array}$ | $\begin{gathered} \text { ODP2 } \\ .3 \end{gathered}$ | ODP2 $.$ | - | - |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | - | - |

Table 64. PORT2 open drain control register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.2 | ODP2.y | Port 2 open drain control register bit y <br> '0': Port line P2.y output driver in push/pull mode <br> '1': Port line P2.y output driver in open drain mode |

### 13.5.1 Alternate functions of PORT2

All PORT2 lines (P2.15 to P2.2) serve as capture inputs or compare outputs (CC15IO to CC2IO) for the CAPCOM1 unit.

When a PORT2 line is used as a capture input, the state of the input latch, which represents the state of the port pin, is directed to the CAPCOM unit via the line "Alternate Pin Data Input". If an external capture trigger signal is used, the direction of the respective pin is set to input. If the direction is set to output, the state of the port output latch is read since the pin represents the state of the output latch. This can be used to trigger a capture event through software by setting or clearing the port latch. In the output configuration, no external device may drive the pin, otherwise conflicts would occur.
When a PORT2 line is used as a compare output (compare modes 1 and 3), the compare event (or the timer overflow in compare mode 3) directly effects the port output latch. In compare mode 1, when a valid compare match occurs, the state of the port output latch is read by the CAPCOM control hardware via the line "Alternate Latch Data Input", inverted, and written back to the latch via the line "Alternate Data Output". The port output latch is clocked by the signal "Compare Trigger" which is generated by the CAPCOM unit. In compare mode 3, when a match occurs, the value ' 1 ' is written to the port output latch via the line "Alternate Data Output". When an overflow of the corresponding timer occurs, a '0' is written to the port output latch. In both cases, the output latch is clocked by the signal "Compare Trigger". The direction of the pin is set to output by the user, otherwise the pin will be in the high-impedance state and will not reflect the state of the output latch.
As can be seen from the port structure (Figure 33), the user software always has free access to the port pin even when it is used as a compare output. This is useful for setting up the initial level of the pin when using compare mode 1 or the double-register mode. In these modes, unlike in compare mode 3, the pin is not set to a specific value when a compare match occurs but is toggled instead.
When the user software wants to write to the port pin at the same time a compare trigger tries to clock the output latch, the write operation of the user software has priority. Each time a CPU write access to the port output latch occurs, the input multiplexer of the port output latch is switched to the line connected to the internal bus. The port output latch receives the value from the internal bus and the hardware-triggered change is lost.

As all other capture inputs, the capture input function of pins P2.15...P2.0 can also be used as external interrupt inputs ( 83.34 ns sample rate at $48 \mathrm{MHz} \mathrm{CPU} \mathrm{clock)}$.

The upper eight PORT2 lines (P2.15 to P2.8) also can serve as fast external Interrupt inputs (EX7IN to EXOIN).

P2.15 also serves as the input for CAPCOM2 timer T7 (T7IN).
Table 65 summarizes the alternate functions of PORT2.
Table 65. PORT2 alternate functions

| Pin | Alternate function a) | Alternate function b) | Alternate function c) |
| :---: | :---: | :--- | :--- |
| P2.2 | CC2IO |  | - |
| P2.3 | CC3IO | - | - |
| P2.4 | CC4IO | - | - |
| P2.5 | CC5IO | - | - |
| P2.6 | CC6IO | - | - |
| P2.7 | CC7IO | - | - |
| P2.8 | CC8IO | EX0IN Fast Ext. Interrupt 0 Input | - |
| P2.9 | CC9IO | EX1IN Fast Ext. Interrupt 1 Input | - |

Table 65. PORT2 alternate functions (continued)

| Pin | Alternate function a) | Alternate function b) | Alternate function c) |
| :---: | :---: | :---: | :--- |
| P2.10 | CC10IO | EX2IN Fast Ext. Interrupt 0 Input | - |
| P2.11 | CC11IO | EX3IN Fast Ext. Interrupt 1 Input | - |
| P2.12 | CC12IO | EX4IN Fast Ext. Interrupt 0 Input | - |
| P2.13 | CC13IO | EX5IN Fast Ext. Interrupt 1 Input | - |
| P2.14 | CC14IO | EX6IN Fast Ext. Interrupt 0 Input | - |
| P2.15 | CC15IO | EX7IN Fast Ext. Interrupt 1 Input | T7IN timer external count input |

Figure 32. PORT2 I/O and alternate functions


The pins of PORT2 combine internal bus data with alternate data output before the port latch input.

Figure 33. Block diagram of a PORT2 pin


### 13.6 PORT3

If this 12-bit port is used for general purpose I/O, the direction of each line can be configured by the corresponding direction register DP3. Most port lines can be switched into push/pull or open drain mode by the open drain control register ODP3 (pins P3.15 and P3.12 do not support open drain mode). P3.4 function can be used if P34EN, bit 5 of XMISC register, is set to 1, see Section 18.3.

## PORT3 register



Table 66. PORT3 register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | P3.y | Port data register P3 bit y |

## PORT3 direction register



Table 67. PORT3 direction register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.0 | DP3.y | Port direction register DP3 bit y <br> '0': Port line P3.y is an input (high-impedance) <br> '1': Port line P3.y is an output |

## PORT3 open drain control register

| PORT3 open drain control register (F1C5/E3) |  |  |  |  |  | ESFR |  |  |  | 5 | 4 | 3 | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 |  |  |  | 2 | 1 | 0 |
| - | - | $\begin{gathered} \text { ODP3. } \\ 13 \end{gathered}$ | - | ODP3. 11 | ODP3. <br> 10 | ODP3. $9$ | ODP3. $8$ | ODP3. $7$ | ODP3. $6$ | - | ODP3. $4$ | - | ODP3. $2$ | ODP3. 1 | ODP3. $0$ |
| - | - | RW | - | RW | RW | RW | RW | RW | RW | - | - | - | RW | RW | RW |

Table 68. PORT3 open drain control register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 13.0 | ODP3.y | Port 3 open drain control register bit y <br> '0': Port line P3.y output driver in push/pull mode <br> '1': Port line P3.y output driver in open drain mode |

### 13.6.1 Alternate functions of PORT3

The pins of PORT3 serve for various functions which include external timer control lines, two serial interfaces ASCO and SSCO, the control lines $\overline{\mathrm{BHE}} / \overline{\mathrm{WRH}}$ and CLKOUT.

Table 69. PORT3 alternative functions

| PORT3 <br> Pin | Name |  |
| :---: | :---: | :--- |
| P3.0 | TOIN | CAPCOM1 Timer 0 Count Input |
| P3.1 | T6OUT | Timer 6 Toggle Output |
| P3.2 | CAPIN | GPT2 Capture Input |
| P3.3 | --- | No pin assigned! |
| P3.4 | T3EUD | Timer 3 External Up/Down Input |
| P3.5 | --- | No pin assigned! |
| P3.6 | T3IN | Timer 3 Count Input |
| P3.7 | T2IN | Timer 2 Count Input |
| P3.8 | MRST0 | SSC0 Master Receive / Slave Transmit |
| P3.9 | MTSR0 | SSC0 Master Transmit / Slave Receive |
| P3.10 | TxD0 | ASC0 Transmit Data Output |
| P3.11 | RxD0 | ASC0 Receive Data Input |
| P3.12 | $\overline{\text { BHE/WRH }}$ | Byte High Enable / Write High Output |
| P3.13 | SCLK0 | SSC0 Shift Clock Input/Output |
| P3.14 | --- | No pin assigned! |
| P3.15 | CLKOUT | System Clock Output (either prescaled or not through register CLKDIV) |

Figure 34. PORT3 I/O and alternate functions


The port structure of the PORT3 pins depends on their alternate function (see Figure 35).
When the on-chip peripheral associated with a PORT3 pin is configured to use the alternate input function, it reads the input latch, which represents the state of the pin, via the line labeled "Alternate Data Input". PORT3 pins with alternate input functions are TOIN, T2IN, T3IN_, T3EUD and CAPIN.
When the on-chip peripheral associated with a PORT3 pin is configured to use the alternate output function, its "Alternate Data Output" line is ANDed with the port output latch line.
When using these alternate functions, the user software must set the direction of the port line to output (DP3.y=1) and set the port output latch (P3.y=1). Otherwise, the pin is in its high-impedance state (when configured as input) or the pin is held at ' 0 ' (when the port
output latch is cleared). When the alternate output functions are not used, the "Alternate Data Output" line is in its inactive state, which is a high level ('1'). PORT3 pins with alternate output functions are: T6OUT, TxD0 and CLKOUT.

When the on-chip peripheral associated with a PORT3 pin is configured to use both the alternate input and output function, the descriptions above apply to the respective current operating mode. The direction must be set accordingly. PORT3 pins with alternate input and output functions are: MTSR0, MRST0, RxD0, TxD0 and SCLK0.
Note: Enabling the CLKOUT function automatically enables the P3.15 output driver. Setting bit DP3. $15=$ ' 1 ' is not required.

Figure 35. Block diagram of PORT3 pin with alternate input or alternate output function


Pin P3.12 ( $\overline{\mathrm{BHE}} / \overline{\mathrm{WRH}})$ is another pin with an alternate output function, however, its structure is slightly different (see Figure 36). After reset, the $\overline{\mathrm{BHE}}$ or $\overline{\mathrm{WRH}}$ function must be used
depending on the system start-up configuration. In either of these cases, it is not possible to program port latches. Thus, the appropriate alternate function is selected automatically. If $\overline{\mathrm{BHE}} / \overline{\mathrm{WRH}}$ is not used in the system, this pin can be used for general purpose I/O by disabling the alternate function (BYTDIS = ' 1 ' / WRCFG='0').

Figure 36. Block diagram of pins P3.15 (CLKOUT) and P3.12 (BHE/WRH)


Note: $\quad$ Enabling the $\overline{B H E}$ or $\overline{W R H}$ function automatically enables the P3.12 output driver. Setting bit DP3. 12 = ' 1 ' is not required.

### 13.7 PORT4

Port 4 is 8 -bit port, it can be used for general purpose $/ / \mathrm{O}$, the direction of each line can be configured via the corresponding direction register DP4.

PORT4 register


Table 70. PORT4 register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7.0 | P4.y | Port data register P4 bit y |

PORT4 direction register


Table 71. PORT4 direction register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7.0 | DP4.y | Port direction register DP4 bit y <br> '0': Port line P4.y is an input (high-impedance) <br>  |
|  | '1': Port line P4.y is an output |  |

For CAN configuration support (see Section 18), PORT4 has an open drain function, controlled with the ODP4 register.

## PORT4 open drain control register



Table 72. PORT4 open drain control register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7.4 | ODP4.y | Port 4 open drain control register bit y <br> '0': Port line P4.y output driver in push/pull mode <br> '1': Port line P4.y output driver in open drain mode if P4.y is not a <br> segment address line output |

Only bits 4, 5, 6 and 7 are implemented, all other bits are read as " 0 ".
Port 4 pins $0,1,2$, and 3 are connected to external pins 47-50 only if bit P7EN of XMISC register is zero, that is its default value (see Section 18.3 for XMISC description).

### 13.7.1 Alternate functions of PORT4

During external bus cycles that use segmentation (that is, an address space above 64 Kbyte), a number of PORT4 pins may output the segment address lines. The number of pins that is used for segment address output determines the external address space which is directly accessible. The other pins of PORT4 may be used for general purpose I/O. If segment address lines are selected, the alternate function of PORT4 may be necessary to access, for example, external memory directly after reset. For this reason, PORT4 is switched to this alternate function automatically.

The number of segment address lines is selected via PORT0 during reset. The selected value can be read from bitfield SALSEL in register RPOH (read only) to, for example, check the configuration during run time.

Devices with CAN interfaces use two pins of PORT4 to interface each CAN Module to an external CAN transceiver. In this case, the number of possible segment address lines is reduced.

Table 73 summarizes the alternate functions of PORT4 depending on the number of selected segment address lines (coded via bitfield SALSEL).
Table 73. PORT4 alternate functions

| Pin | Standard function <br> SALSEL=01 64 Kb | Alternate function <br> SALSEL=11 256 Kb | Alternate function <br> SALSEL=00 1 Mb | Alternate function <br> SALSEL=10 $\mathbf{6} \mathbf{~ M b}$ |
| :--- | :--- | :--- | :--- | :--- |
| P4.0 | GPIO | Seg. Address A16 | Seg. Address A16 | Seg. Address A16 |
| P4.1 | GPIO | Seg. Address A17 | Seg. Address A17 | Seg. Address A17 |
| P4.2 | GPIO | GPIO | Seg. Address A18 | Seg. Address A18 |
| P4.3 | GPIO | GPIO | Seg. Address A19 | Seg. Address A19 |
| P4.4 | GPIO/CAN2_RxD | GPIO/CAN2_RxD | GPIO/CAN2_RxD | Seg. Address A20 |
| P4.5 | GPIO/CAN1-2_RxD | GPIO/CAN1-2_RxD | GPIO/CAN1-2_RxD | Seg. Address A21 |
| P4.6 | GPIO/CAN1-2_TxD | GPIO/CAN1-2_TxD | GPIO/CAN1-2_TxD | Seg.Address A22 |
| P4.7 | GPIO/CAN2_TxD | GPIO/CAN2_TxD | GPIO/CAN2_TxD | Seg. Address A23 |

Note: $\quad$ When SALSEL='10', CAN1 and CAN2 cannot be used: it means that external memory has higher priority on CAN alternate function. PORT4 I/O and alternate functions

Figure 37. PORT4 I/O and alternate functions


Figure 38. Block diagram of pins P4.0 ... P4.3


Figure 39. Block diagram of pin P4.4


1. When SALSEL='10', that is 8 -bit segment address lines are selected, P4.4 is dedicated to output the address; any attempt to use CAN2 on P4.4 is masked
When CAN parallel mode is selected, CAN2_RxD is remapped on P4.5; this occurs only if CAN1 is also enabled. If CAN1 is disabled, no remapping occurs.

Figure 40. Block diagram of pin P4.5


1. When SALSEL='10', that is 8 -bit segment address lines are selected, P4.5 is dedicated to output the address; any attempt to use the CAN1 on P4.5 is masked.
When CAN parallel mode is selected, CAN2_RxD is remapped on P4.5; this occurs only if CAN1 is also enabled. If CAN1 is disabled, no remapping occurs.

Figure 41. Block diagram of pin P4.6


1. When SALSEL='10', that is 8 -bit segment address lines are selected, P4.6 is dedicated to output the address; any attempt to use the CAN1 on P4.6 is masked.
When CAN parallel mode is selected, CAN2_TxD is remapped on P4.6: this occurs only if CAN1 is also enabled. If CAN1 is disabled, no remapping occurs.

Figure 42. Block diagram of pin P4.7


1. When SALSEL='10', that is 8 -bit segment address lines are selected, P 4.7 is dedicated to output the address; any attempt to use the CAN2 on P4.7 is masked.
When CAN parallel mode is selected, CAN2_TxD is remapped on P4.6: this occurs only if CAN1 is also enabled. If CAN1 is disabled, no remapping occurs.

### 13.8 PORT7

PORT7 is a 4-bit bidirectional I/O port. This port is connected to pins 47-50 only if bit P7EN of the XMISC register is set (see Section 18.3 for XMISC description). If it is used for general purpose I/O, the direction of each line can be configured using the corresponding direction register DP7. Each port line can be switched into push/pull or open drain mode by the open drain control register ODP7.

## PORT7 register



Table 74. PORT7 register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 3.0 | P7.y | Port data register P7 bit y |

## PORT7 direction register



Table 75. PORT7 direction register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 3.0 | DP7.y | Port direction register DP7 bit y <br> '0': Port line P7.y is an input (high-impedance) <br> '1': Port line P7.y is an output |

## PORT7 open drain control register

| PORT7 open drain control register (F1D2/E9) |  |  |  |  |  | ESFR |  |  |  | 5 | 4 | 3 | Reset value: --00h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 |  |  |  | 2 | 1 | 0 |
| Reserved |  |  |  |  |  |  |  | - | - | - | - | $\begin{gathered} \text { ODP7 } \\ .3 \end{gathered}$ | $\begin{gathered} \text { ODP7 } \\ .2 \end{gathered}$ | ODP7. <br> 1 | $\begin{gathered} \text { ODP7. } \\ 0 \end{gathered}$ |
|  |  |  |  |  |  |  |  | RW RW |  | RW | RW | RW | RW | RW | RW |

Table 76. PORT7 open drain control register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 3.0 | ODP7.y | Port 7 open drain control register bit y <br> '0': Port line P7.y output driver in push/pull mode <br> '1': Port line P7.y output driver in open drain mode |

### 13.8.1 Alternate functions of PORT7

The four lines of PORT7 (P7.3...P7.0) serve as outputs from the PWM module (POUT3...POUTO). At these pins, the value of the respective port output latch is XORed with the value of the PWM output rather than ANDed, as the other pins do. This permits the use of the alternate output value either as it is (port latch holds a ' 0 ') or invert its level at the pin
(port latch holds a ' 1 '). The PWM outputs must be enabled via the respective PENx bits in PWMCON1.

Table 77 summarizes the alternate functions of PORT7.

## Table 77. PORT7 alternate functions

| Pin | Name |  | Alternate function |
| :---: | :---: | :--- | :--- |
| P7.0 | POUT0 | PWM0 channel 0 output |  |
| P7.1 | POUT1 | PWM0 channel 1 output |  |
| P7.2 | POUT2 | PWM0 channel 2 output |  |
| P7.3 | POUT3 | PWM0 channel 3 output |  |

Figure 43. PORT7 I/O and alternate functions


The port structures of PORT7 differ in the way the output latches are connected to the internal bus and to the pin driver (see Figure 44 and Figure 45).

Pins P7.3...P7.0 (POUT3...POUT0) XOR the alternate data output with the port latch output, which permits the use of the alternate data directly or inverted at the pin driver.

Figure 44. Block diagram of PORT7 pins P7.3...P7.0


### 13.9 PORT5

This 10-bit input port can only read data. There is no output latch and no direction register. Data written to P5 is lost.

## PORT5 register



Table 78. PORT5 register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 9.0 | P5.y | Port data register P5 bit y (Read only) |

### 13.9.1 Alternate functions of PORT5

Each line of PORT5 is also connected to one of the multiplexers of the analog to digital converter (ADC). All port lines (P5.9...P5.0) can accept analog signals (AN9...AN0) that can be converted by the ADC. No special programming is required for pins that shall be used as analog inputs.

Table 79 summarizes the alternate functions of PORT5.
Table 79. PORT5 alternate functions

| Port 5 Pin | Alternate function |
| :---: | :--- |
| P5.0 | Analog Input AN0 |
| P5.1 | Analog Input AN1 |
| P5.2 | Analog Input AN2 |
| P5.3 | Analog Input AN3 |
| P5.4 | Analog Input AN4 |
| P5.5 | Analog Input AN5 |
| P5.6 | Analog Input AN6 |
| P5.7 | Analog Input AN7 |
| P5.8 | Analog Input AN8 |
| P5.9 | Analog Input AN9 |

Figure 45. PORT5 I/O and alternate functions


PORT5 pins have a special port structure (see Figure 46), first because it is an input only port, and second because the analog input channels are directly connected to the pins rather than to the input latches.

### 13.9.2 Disturb protection on analog inputs

A register is provided for additional disturb protection support on analog inputs for PORT5.

## PORT5 digital disable register

| PORT5 disturb protection register (FFA4/D2) |  |  |  |  |  |  |  |  |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|  | $\begin{aligned} & \dot{J} \\ & \dot{\omega} \\ & \vdots \\ & \bar{O} \\ & 0 \end{aligned}$ |  |  |  |  | $\begin{aligned} & \text { O} \\ & \text { ஸ } \\ & \bar{\partial} \\ & \text { に } \end{aligned}$ | $\begin{aligned} & \infty \\ & \stackrel{\perp}{\mathrm{D}} \\ & \overline{0} \\ & \stackrel{n}{\mathrm{O}} \end{aligned}$ |  | $\begin{aligned} & \circ \\ & \stackrel{\dot{1}}{\mathrm{O}} \\ & \overline{0} \\ & \stackrel{\circ}{\mathrm{O}} \end{aligned}$ | $\begin{aligned} & \stackrel{\circ}{\dot{C}} \\ & \stackrel{1}{O} \\ & \overline{0} \end{aligned}$ |  |  | $\begin{aligned} & \text { N } \\ & \text { N } \\ & \bar{O} \\ & \text { O} \end{aligned}$ | $\stackrel{\Gamma}{0}$ <br> 0 <br> 0 <br> 0 <br> 0 |  |
| RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

Table 80. PORT5 digital disable register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15-0 | P5DIDIS.y | PORT5 digital disable register bit y <br> '0': Port line P5.y digital input is enabled (Schmitt trigger enabled) <br> '1': Port line P5.y digital input is disabled (Schmitt trigger disabled, <br> necessary for input leakage current reduction) |

Note: $\quad$ This feature is currently not supported by the emulator.
Figure 46. Block diagram of a PORT5 pin


## 14 Analog / digital converter

The ST10F252M provides an analog to digital converter (ADC) with 10-bit resolution and a sample and hold circuit on-chip. A multiplexer selects between up to 10+6 analog input channels (alternate functions of PORT5 and PORT0) either via software (fixed channel modes) or automatically (auto scan modes works automatically among the 10 channels on PORT5, or among the 8 channels on PORT0). An automatic self-calibration adjusts the ADC module to process parameter variations at each reset event.

The accuracy is guaranteed with a total unadjusted error of $\pm 2$ LSB on PORT5 and $\pm 5$ LSB on PORT0 ( $\pm 7$ LSB when overload condition is applied). Refer to Section 27.7 for detailed characteristics. The sample time (for loading the capacitors) and the conversion time is programmable and can be adjusted by external circuitry.

To fulfill most requirements of embedded control applications, the ADC supports the following conversion modes:

- fixed channel single conversion
produces just one result from the selected channel
- fixed channel continuous conversion
repeatedly converts the selected channel
- auto scan single conversion
produces one result from each of a selected group of channels
- auto scan continuous conversion
repeatedly converts the selected group of channels
- wait for ADDAT read mode
start a conversion automatically when the previous result is read
- channel injection mode
insert the conversion of a specific channel into a group conversion (auto scan).
A set of SFRs and port pins provide access to control functions and results of the ADC.

Figure 47. SFRs, XBUS registers and port pins associated with the A/D converter

| Ports \& Direction Control Alternate Functions |  |  | Data Registers |
| :---: | :---: | :---: | :---: |
|  | 1514131211109876543210 |  | 1514131211109876543210 |
| P5 | . . . . $Y_{Y Y Y Y Y Y Y Y Y Y ~}^{\text {Y }}$ | ADDAT | Y Y Y Y - Y Y Y Y Y Y Y Y Y Y |
| P5DIDIS | . . . . Y Y Y Y Y Y Y Y Y Y | ADDAT2 E | Y Y Y Y - Y Y Y Y Y Y Y Y |
|  | ANO/P5.0... AN9/P5.9 |  | Interrupt Control |
|  | 1514131211109876543210 |  | 1514131211109876543210 |
| DPOL | - - - . - Y - . . - | ADCIC | - . . . . . Y Y Y Y Y Y Y Y |
| POL | - - - - - Y - - - | ADEIC | . . . . . y y y y y y y |
| DPOH | - . . . . . - y y y y |  |  |
| POH | - . . . . . . - y y y y y |  |  |
|  | AN10/POL.7... AN15/POH. 4 | P5 | Port5 Data Register |
|  |  | P5DIDIS | Port5 Analog Inputs Disturb Protection Register |
|  | Control Registers | DPOL | PortOL Direction Register |
|  |  | POL | Portol Data Register |
|  | 1514131211109876543210 | DPOH | PortOH Direction Register |
|  |  | POH | Port0H Data Register |
| ADCON | Y Y Y Y Y Y Y Y - Y Y Y Y Y | ADDAT | A/D Converter Result Register |
|  |  | ADCON | A/D Converter Control Register |
| Xmisc | $\cdots y^{\prime} \ldots Y^{\prime}$ | XMISC | Miscellaneous Register (XBUS) |
|  |  | ADCIC | A/D Converter Interrupt Control Register |
| Y : Bit is linked to a function |  |  | (End of Conversion) |
| - : Bit has no function or is not implemented <br> E : Register is in ESFR internal memory space |  | ADEIC | A/D Converter Interrupt Control Register (Overrun Error / Channel Injection) |

The external analog reference voltages $\mathrm{V}_{\text {AREF }}$ and $\mathrm{V}_{\mathrm{AGND}}$ are fixed.
The sample time as well as the conversion time, is programmable, so that the ADC can be adjusted to the internal resistances of the analog sources and/or the analog reference voltage supply.

Figure 48. Analog to digital converter block diagram


### 14.1 Mode selection and operation

The analog input channels AN0 to AN9 are alternate functions of PORT5 which is a 10-bit input-only port. The PORT5 lines may either be used as analog or digital inputs. No special action is required to configure the PORT5 lines as analog inputs. The additional register P5DIDIS can be used to further protect the ADC input analog section by disabling the digital input section. Refer to Section 13.9.2 for details on register P5DIDIS.

The functions of the A/D converter are controlled by the bit-addressable A/D Converter Control Register ADCON.

Its bit fields specify the analog channel to be acted upon, the conversion mode, and also reflect the status of the converter.

| ADCON (FFAOh / DOh) |  |  |  |  | SFR |  |  | Reset Value: 0000h |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $15 \quad 14$ | 1312 | 11 | 10 | 9 | 8 | 7 | 6 | 54 | 3 | 2 | 1 | 0 |
| ADCTC | ADSTC | $\begin{gathered} \text { AD } \\ \text { CRQ } \end{gathered}$ | $\begin{aligned} & \text { AD } \\ & \text { CIN } \end{aligned}$ | $\begin{aligned} & \text { AD } \\ & \text { WR } \end{aligned}$ | $\begin{gathered} \text { AD } \\ \text { BSY } \end{gathered}$ | ADST | $\begin{aligned} & \text { AD } \\ & \text { OFF } \end{aligned}$ | ADM |  |  |  |  |
| RW | RW | RW | RW | RW | R | RW | RW | RW |  |  |  |  |

Table 81. ADCON functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| $15: 14$ | ADCTC | ADC Conversion Time Control (1) |
| $13: 12$ | ADSTC | ADC Sample Time Control (1) |
| 11 | ADCRQ | ADC Channel Injection Request Flag |
| 10 | ADCIN | ADC Channel Injection Enable |
| 9 | ADWR | ADC Wait for Read Control |
| 8 | ADBSY | ADC Busy Flag <br> '1': a conversion or calibration is active |
| 7 | ADST | ADC Start bit |
| 6 | ADC Disable <br> '0': Analog circuitry of A/D converter is on: it can be used properly <br> '1': Analog circuitry of A/D converter is turned off (no consumption): non <br> Conversion possible |  |
| 5 | ADM | ADC Mode Selection <br> '0 0': Fixed Channel Single Conversion <br> '0 1': Fixed Channel Continuous Conversion <br> '1 0': Auto Scan Single Conversion <br> '1 1': Auto Scan Continuous Conversion |
| $4: 0$ | ADCH | ADC Analog Channel Input Selection |

1. ADSTC and ADCTC control the conversion timing. Refer to Section 14.2 on page 134.

Bit field ADCH specifies the analog input channel which is to be converted (first channel of a conversion sequence in auto scan modes). Bit field ADM selects the operating mode of the ADC. A conversion (or a sequence) is started by setting bit ADST. Clearing ADST stops the ADC after a specified operation which depends on the selected operating mode.
The busy flag (read-only) ADBSY is set, as long as a conversion is in progress. After reset, this bit is set because the self-calibration is ongoing (duration of self-calibration depends on

CPU clock: it takes up to $40.629 \pm 1$ clock pulses). The user software can poll this bit to determine when the first conversion can be launched.

The result of a conversion is stored in the result register ADDAT, or in ADDAT2 for an injected conversion.

Note: $\quad$ Bit field CHNR of register ADDAT is loaded by the ADC to indicate, which channel the result refers to. Bit field CHNR of register ADDAT2 is loaded by the CPU to select the analog channel, which is to be injected.

## ADDAT register



## ADDAT2 register

| ADDAT2 register (F9A0/50) |  |  |  |  |  | SFR |  |  |  | Reset value: 0000h |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CHNR |  |  |  | - | - | ADRES |  |  |  |  |  |  |  |  |  |
| RW |  |  |  | - | - | RW |  |  |  |  |  |  |  |  |  |

Table 82. ADDAT and ADDAT2 registers functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.12 | CHNR | Channel number (4-bit, identifies the converted analog channel) |
| 9.0 | ADRES | Analog to digital conversion result (10-bit) |

A conversion is started by setting bit ADST to ' 1 '. The busy flag ADBSY is set and the converter selects and samples the input channel, which is specified by the channel selection field ADCH in register ADCON. The sampled level is held internally during the conversion. When the conversion of this channel is complete, the 10-bit result together with the number of the converted channel is transferred into the result register ADDAT and the interrupt request flag ADCIR is set. Field ADCH represents the channel of PORT5 (0h = channel 0, $1 \mathrm{~h}=$ channel $1, \ldots, 9 \mathrm{~h}=$ channel 9 ).

If bit ADST is reset via software while a conversion is in progress, the ADC stops after the current conversion (fixed channel modes) or after the current conversion sequence (auto scan modes).

Setting bit ADST, while a conversion is running, aborts this conversion and starts a new conversion with the parameters specified in ADCON.

Note: Abortion and restart (see above) are triggered by bit ADST changing from ' 0 ' to ' 1 ', that is, ADST must be ' 0 ' before being set.

While a conversion is in progress, the mode selection field ADM and the channel selection field ADCH may be changed. ADM is evaluated after the current conversion. ADCH is evaluated after the current conversion (fixed channel modes) or after the current conversion sequence (auto scan modes).

### 14.1.1 Fixed channel conversion modes

These modes are selected by programming the mode selection field ADM in register ADCON to '00' (single conversion) or to '01' (continuous conversion). After starting the converter through bit ADST, the busy flag ADBSY is set and the channel specified in bit field ADCH is converted. After the conversion is complete, the interrupt request flag ADCIR (bit 7 of ADCIC register; Section 14.3) is set.

- In single conversion mode, the converter automatically stops and resets bits ADBSY and ADST.
- In continuous conversion mode, the converter automatically starts a new conversion of the channel specified in ADCH. ADCIR is set after each completed conversion.

When bit ADST is reset by software while a conversion is in progress, the converter completes the current conversion and then stops and resets bit ADBSY.

### 14.1.2 Auto scan conversion modes

These modes are selected by programming the mode selection field ADM in register ADCON to '10' (single conversion) or to '11' (continuous conversion). Auto scan modes automatically convert a sequence of analog channels, beginning with the channel specified in bit field ADCH and ending with channel 0 , without requiring software to change the channel number. If the ADCH value is greater than 9 h , the sequence starts converting the nonexistent channel; this corresponds to an unpredictable result, since the input of ADC is left floating.

After starting the converter through bit ADST, the busy flag ADBSY is set and the channel specified in bit field ADCH is converted. After the conversion is complete, the interrupt request flag ADCIR is set and the converter automatically starts a new conversion of the next lower channel. ADCIR set after each completed conversion. After conversion of channel 0 the current sequence is complete.

- In single conversion mode the converter automatically stops and resets bits ADBSY and ADST.
- In continuous conversion mode the converter automatically starts a new sequence beginning with the conversion of the channel specified in ADCH.

When bit ADST is reset by software while a conversion is in progress, the converter completes the current sequence (including conversion of channel 0 ) and then stops and resets bit ADBSY.

Figure 49. Auto scan conversion mode example


### 14.1.3 Wait for ADDAT read mode

If, in the default mode of the ADC, a previous conversion result has not been read out of register ADDAT by the time a new conversion is complete, the previous result in register ADDAT is lost because it is overwritten by the new value and the analog to digital overrun error interrupt request flag ADEIR (bit 7 of ADEIC register; see Section 14.3) is set.

To avoid error interrupts and the loss of conversion results, especially when using continuous conversion modes, the ADC can be switched to "Wait for ADDAT read mode" by setting bit ADWR in register ADCON.

If the value in ADDAT has not been read by the time the current conversion is complete, the new result is stored in a temporary buffer and the next conversion is suspended (ADST and ADBSY remain set in the meantime but no end-of-conversion interrupt is generated). After reading the previous value from ADDAT, the temporary buffer is copied into ADDAT (generating an ADCIR interrupt) and the suspended conversion is started. This mechanism applies to both single and continuous conversion modes.

Note: $\quad$ While in standard mode, continuous conversions are executed at a fixed rate (determined by the conversion time), in "Wait for ADDAT read mode" there may be delays due to suspended conversions. However, this only affects the conversions, if the CPU (or PEC) cannot keep track with the conversion rate.

Figure 50. Wait for read mode example


### 14.1.4 Channel injection mode

Channel injection mode allows the conversion of a specific analog channel (also while the ADC is running in a continuous or auto scan mode) without changing the current operating mode. After the conversion of this specific channel, the ADC continues with the original operating mode.

Channel injection mode is enabled by setting bit ADCIN in register ADCON and requires the Wait for ADDAT read mode (ADWR=' 1 '). The channel to be converted in this mode is specified in bit field CHNR of register ADDAT2.
Note: $\quad$ These four bits in ADDAT2 are not modified by the ADC, but only the ADRES bit field. Since the channel number for an injected conversion is not buffered, bitfield CHNR of ADDAT2 is never modified during the sample phase of an injected conversion, otherwise the input multiplexer switches to the new channel. It is recommended to only change the channel number with no injected conversion running.

Figure 51. Channel injection example


A channel injection can be triggered by set the channel injection request bit ADCRQ via software.

Note: $\quad$ While an injected conversion is in progress, no further channel injection request can be triggered. The channel injection request flag ADCRQ remains set until the result of the injected conversion is written to the ADDAT2 register.
If the converter was idle before the channel injection, and during the injected conversion the converter is started by software for normal conversions, the channel injection is aborted, and the converter starts in the selected mode (as described above). This can be avoided by checking the busy bit ADBSY before starting a new operation.
After completing the current conversion (if any is in progress), the converter starts (injects) the conversion of the specified channel. When the conversion of this channel is complete, the result is placed into the alternate result register ADDAT2, and a channel injection complete interrupt request is generated, which uses the interrupt request flag ADEIR (for this reason the Wait for ADDAT read mode is required).
Note: If the temporary data register used in Wait for ADDAT read mode is full, the respective next conversion (standard or injected) is suspended. The temporary register can hold data for ADDAT (from a standard conversion) or for ADDAT2 (from an injected conversion).

Figure 52. Channel injection example with wait for read


### 14.1.5 ADC power down (ADOFF)

Setting bit ADOFF in ADCON register, turns off the ADC and zeroes the static power consumption related with ADC analog circuitry. If this bit is set during a conversion, the command is ignored (even though the ADOFF bit is immediately set); only at the end of the conversion (or sequence of conversions if SCAN mode was selected), is the ADC switched off (as soon as the ADBSY bit is cleared).

When ADC is off (ADOFF bit set), setting bit ADST automatically wakes up the ADC and a conversion starts; the accuracy is unfortunately not yet granted, since the analog circuitry
needs at least $50 \mu \mathrm{~s}$ to complete the power-up transient phase. Clear the ADOFF bit first, and start the first conversion only after $50 \mu \mathrm{~s}$.

Note: If bit ADOFF is set and when ADST is also set, at the end of the conversion (or cycle of conversions if SCAN mode is selected), the ADC is switched off (as soon as ADBSY is cleared).

Turning off ADC consumption (setting bit ADOFF) should be done once the calibration is completed (starts after every reset occurrence); if not, the calibration is stopped by setting bit ADOFF and not restarted/completed when bit ADOFF is cleared again.

### 14.2 Conversion timing control

When a conversion is started, first the capacitances of the converter are loaded via the respective analog input pin to the current analog input voltage. The time to load the capacitances is referred to as sample time. Next the sampled voltage is converted to a digital value in several successive steps, which correspond to the 10-bit resolution of the ADC. During these steps the internal capacitances are repeatedly charged and discharged via the $\mathrm{V}_{\text {AREF }}$ pin.

The current that has to be drawn from the sources for sampling and changing charges depends on the time that each respective step takes, because the capacitors must reach their final voltage level within the given time, at least with a certain approximation. The maximum current, however, that a source can deliver, depends on its internal resistance.
The time that the two different actions during conversion take (sampling, and converting) can be programmed within a certain range in the ST10F252M with respect to the CPU clock. The absolute time that is consumed by the different conversion steps is independent of the general speed of the controller. This allows the ADC of the ST10F252M to be adjusted to the properties of the system.

- Fast conversion can be achieved by programming the respective times to their absolute possible minimum. This is preferable for scanning high frequency signals. However, the internal resistance of analog source and analog supply must be sufficiently low.
- High internal resistance can be achieved by programming the respective times to a higher value, or the possible maximum. This is preferable when using analog sources and supply with a high internal resistance to keep the current as low as possible. The conversion rate in this case may be considerably lower.

The ADC input bandwidth is limited by the achievable accuracy. For example, supposing a maximum error of $0.5 \mathrm{LSB}(2 \mathrm{mV})$ impacting the global TUE (TUE also depends on other causes), in the worst case of temperature and process, the maximum frequency for a sine wave analog signal is around 7.5 kHz . To reduce the effect of the input signal variation on the accuracy down to 0.05 LSB , the maximum input frequency of the sine wave is reduced to 800 Hz .

If a static signal is applied during the sampling phase, the series resistance is not greater than $20 \mathrm{k} \Omega$ (this takes into account any possible input leakage). Do not connect any capacitance on analog input pins to reduce the effect of charge partitioning (and consequent voltage drop error) between the external and the internal capacitance. If an RC filter is necessary, the external capacitance must be greater than 10 nF to minimize the accuracy impact.

The conversion times are programmed via the upper four bits of register ADCON. Bit fields ADCTC and ADSTC are used to define the basic conversion time and, in particular, the partition between sample phase and comparison phases. The table below lists the possible combinations. The timings refer to the unit TCL, where $f_{C P U}=1 / 2 T C L$.
Table 83. ADC programming

| ADCTC | ADSTC | Sample | Comparison | Extra | Total conversion |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 00 | 00 | TCL * 120 | TCL * 240 | TCL * 28 | TCL * 388 |
| 00 | 01 | TCL * 140 | TCL * 280 | TCL * 16 | TCL * 436 |
| 00 | 10 | TCL * 200 | TCL * 280 | TCL * 52 | TCL * 532 |
| 00 | 11 | TCL * 400 | TCL * 280 | TCL * 44 | TCL * 724 |
| 11 | 00 | TCL * 240 | TCL * 480 | TCL * 52 | TCL * 772 |
| 11 | 01 | TCL * 280 | TCL * 560 | TCL * 28 | TCL * 868 |
| 11 | 10 | TCL * 400 | TCL * 560 | TCL * 100 | TCL * 1060 |
| 11 | 11 | TCL * 800 | TCL * 560 | TCL * 52 | TCL * 1444 |
| 10 | 00 | TCL * 480 | TCL * 960 | TCL * 100 | TCL * 1540 |
| 10 | 01 | TCL * 560 | TCL * 1120 | TCL * 52 | TCL * 1732 |
| 10 | 10 | TCL * 800 | TCL * 1120 | TCL * 196 | TCL * 2116 |
| 10 | 11 | TCL * 1600 | TCL * 1120 | TCL * 164 | TCL * 2884 |

The complete conversion time includes the conversion itself, the sample time and the time required to transfer the digital value to the result register.

Note: $\quad$ The total conversion time is compatible with the formula valid for ST10F269, while the meaning of the bit fields ADCTC and ADSTC is no longer compatible: the minimum conversion time is 388 TCL, which at 40 MHz CPU frequency corresponds to $4.85 \mu$ s (see ST10F269).

### 14.3 ADC interrupt control

At the end of each conversion, the interrupt request flag ADCIR in the interrupt control register ADCIC is set. This end-of-conversion interrupt request may cause an interrupt to vector ADCINT or it may trigger a PEC data transfer which reads the conversion result from register ADDAT, for example, to store it in a table in the internal RAM for later evaluation.

The interrupt request flag ADEIR in the register ADEIC is set if either a conversion result overwrites a previous value in register ADDAT (error interrupt in standard mode) or if the result of an injected conversion has been stored in ADDAT2 (end-of-injected-conversion interrupt). This interrupt request may be used to cause an interrupt to vector ADEINT or it may trigger a PEC data transfer.

## ADC interrupt control



Note: $\quad$ Refer to the general interrupt control register description (Section 9.1.2) for an explanation of the control fields.

### 14.4 Calibration

A full calibration sequence is performed after a reset. This full calibration lasts $40.629 \pm 1$ CPU clock cycles. During this time, the busy flag ADBSY is set to indicate the operation. It compensates for any capacitance mismatch, so the calibration procedure does not need any update during normal operation.

No conversion can be performed during this time. The bit ADBSY can be polled to verify when the calibration is over, and the module is able to start a conversion.
Since the calibration process writes repeatedly spurious conversion results to the ADDAT register, at the end of the calibration, both ADCIR and ADEIR flags are set. For this reason, before starting a conversion, the ADC initialization routine performs a dummy read of ADDAT register and clears the two flags.
Note: If ADDAT is not read before starting the first conversion and, for example, "wait for read mode" is entered (ADWR bit set), the ADC is stack waiting for the ADDAT read, since the result of the current conversion cannot be immediately written to ADDAT, which contains the results of the calibration (meaningless data).

## 15 Programmable output clock divider

### 15.1 Functionality

A specific register mapped on the XBUS allows to choose the division factor on the CLKOUT signal (P3.15). This register is mapped on X-Miscellaneous memory address range.

| XCLKOUTDIV (EB02h) |  |  |  |  |  |  | XBUS |  |  |  | Reset Value: --00h |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| - | - | - | - | - | - | - | - |  |  |  |  |  |  |  |  |

Table 84. CLKOUTDIV functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 7:0 | DIV | $\begin{aligned} & \text { Clock Divider setting } \\ & \text { ‘00h': } \mathrm{f}_{\mathrm{CLKOUT}}=\mathrm{f}_{\mathrm{CPU}} \\ & \text { ‘01h': } \mathrm{f}_{\mathrm{CLKOUT}}=\mathrm{f}_{\mathrm{CPU}} / 2 \\ & \text { ‘02h': } \mathrm{f}_{\mathrm{CLKOUT}}=\mathrm{f}_{\mathrm{CPU}} / 3 \\ & \text { ‘03h': } \mathrm{f}_{\mathrm{CLKOUT}}=\mathrm{f}_{\mathrm{CPU}} / 4 \\ & : \\ & \text { 'FFh': } \mathrm{f}_{\mathrm{CLKOUT}}=\mathrm{f}_{\mathrm{CPU}} / 256 \end{aligned}$ |

When the CLKOUT function is enabled by setting bit CLKEN of register SYSCON, by default the CPU clock is output on P3.15. Setting bit XMISCEN of register XPERCON and bit XPEN of register SYSCON programs the clock prescaling factor. In this way, a prescaled value of the CPU clock is output on P3.15.

When the CLKOUT function is not enabled (bit CLKEN of register SYSCON cleared), P3.15 does not output any clock signal, even though the XCLKOUTDIV register is programmed.

## 16 Serial channels

Serial communication with other microcontrollers, microprocessors, terminals or external peripheral components is provided by up to four serial interfaces: two asynchronous / synchronous serial channels (ASC0 and ASC1) and two high-speed synchronous serial channel (SSC0 and SSC1). Dedicated baudrate generators set up all standard baudrates without the requirement of oscillator tuning. For transmission, reception and erroneous reception, separate interrupt vectors are provided for ASC0 and SSC0 serial channel. A more complex mechanism of interrupt sources multiplexing is implemented for ASC1 and SSC1 (XBUS mapped).

### 16.1 Asynchronous / synchronous serial interfaces

The asynchronous / synchronous serial interfaces (ASC0 and ASC1) provides serial communication between the ST10F252M and other microcontrollers, microprocessors or external peripherals.

### 16.2 ASCx in asynchronous mode

In asynchronous mode, 8- or 9-bit data transfer, parity generation and the number of stop bits can be selected. Parity framing and overrun error detection is provided to increase the reliability of data transfers. Transmission and reception of data is double-buffered. Fullduplex communication up to 1.25 Mbaud (at 40 MHz of $\mathrm{f}_{\mathrm{CPU}}$ ) is supported in this mode.

Table 85. ASC asynchronous baudrates by reload value and deviation errors ( $\mathrm{f}_{\mathrm{CPU}}=\mathbf{4 0} \mathbf{M H z}$ )

| SOBRS $=$ ' 0 ', $\mathrm{f}_{\text {CPU }}=40 \mathrm{MHz}$ |  |  | SOBRS $=$ ' 1 ', $\mathrm{f}_{\mathrm{CPU}}=40 \mathrm{MHz}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Baudrate (baud) | Deviation error | Reload value (hex) | Baudrate (baud) | Deviation error | Reload value (hex) |
| 1250000 | 0.0\% / 0.0\% | 0000 / 0000 | 833333 | 0.0\% / 0.0\% | 0000 / 0000 |
| 112000 | +1.5\% / -7.0\% | 000A / 000B | 112000 | +6.3\% / -7.0\% | 0006 / 0007 |
| 56000 | +1.5\% / -3.0\% | 0015 / 0016 | 56000 | +6.3\% / -0.8\% | 000D / 000E |
| 38400 | +1.7\% / -1.4\% | 001F / 0020 | 38400 | +3.3\% / -1.4\% | 0014 / 0015 |
| 19200 | +0.2\% / -1.4\% | 0040 / 0041 | 19200 | +0.9\% / -1.4\% | 002A / 002B |
| 9600 | +0.2\% / -0.6\% | 0081/0082 | 9600 | +0.9\% / -0.2\% | 0055 / 0056 |
| 4800 | +0.2\% / -0.2\% | 0103 / 0104 | 4800 | +0.4\% / -0.2\% | 00AC / 00AD |
| 2400 | +0.2\% / 0.0\% | 0207 / 0208 | 2400 | +0.1\% / -0.2\% | 015A / 015B |
| 1200 | 0.1\% / 0.0\% | 0410 / 0411 | 1200 | +0.1\% / -0.1\% | 02B5 / 02B6 |
| 600 | 0.0\% / 0.0\% | 0822 / 0823 | 600 | +0.1\% / 0.0\% | 056B / 056C |
| 300 | 0.0\% / 0.0\% | 1045 / 1046 | 300 | 0.0\% / 0.0\% | 0AD8 / 0AD9 |
| 153 | 0.0\% / 0.0\% | 1FE8 / 1FE9 | 102 | 0.0\% / 0.0\% | 1FE8 / 1FE9 |

Note: $\quad$ The deviation errors given in the Table 85 are rounded off. To avoid deviation errors use a baudrate crystal (providing a multiple of the ASCO sampling frequency).

### 16.3 ASCx in synchronous mode

In synchronous mode, data is transmitted or received synchronously to a shift clock which is generated by the ST10F252M. Half-duplex communication up to 5 Mbaud (at 40 MHz of $\left.\mathrm{f}_{\mathrm{CPU}}\right)$ is possible in this mode.

Table 86. ASC synchronous baudrates by reload value and deviation errors ( $f_{C P U}=\mathbf{4 0} \mathbf{M H z}$ )

| SOBRS $=$ ' 0 ', $\mathrm{f}_{\text {CPU }}=40 \mathrm{MHz}$ |  |  | SOBRS $=$ ' 1 ', $\mathrm{f}_{\text {CPU }}=40 \mathrm{MHz}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Baudrate (baud) | Deviation error | Reload value (hex) | Baudrate (baud) | Deviation error | Reload value (hex) |
| 5000000 | 0.0\% / 0.0\% | 0000 / 0000 | 3333333 | 0.0\% / 0.0\% | 0000 / 0000 |
| 112000 | +1.5\% / -0.8\% | 002B / 002C | 112000 | +2.6\% / -0.8\% | 001C / 001D |
| 56000 | +0.3\% / -0.8\% | 0058 / 0059 | 56000 | +0.9\% / -0.8\% | 003A / 003B |
| 38400 | +0.2\% / -0.6\% | 0081 / 0082 | 38400 | +0.9\% / -0.2\% | 0055 / 0056 |
| 19200 | +0.2\% / -0.2\% | 0103 / 0104 | 19200 | +0.4\% / -0.2\% | 00AC / 00AD |
| 9600 | +0.2\% / 0.0\% | 0207 / 0208 | 9600 | +0.1\% / -0.2\% | 015A / 015B |
| 4800 | +0.1\% / 0.0\% | 0410 / 0411 | 4800 | +0.1\% / -0.1\% | 02B5 / 02B6 |
| 2400 | 0.0\% / 0.0\% | 0822 / 0823 | 2400 | +0.1\% / 0.0\% | 056B / 056C |
| 1200 | 0.0\% / 0.0\% | 1045 / 1046 | 1200 | 0.0\% / 0.0\% | 0AD8 / 0AD9 |
| 900 | 0.0\% / 0.0\% | 15B2 / 15B3 | 600 | 0.0\% / 0.0\% | 15B2 / 15B3 |
| 612 | 0.0\% / 0.0\% | 1FE8 / 1FE9 | 407 | 0.0\% / 0.0\% | 1FFD / 1FFE |

Note: $\quad$ The deviation errors given in the Table 86 are rounded off. To avoid deviation errors use a baudrate crystal (providing a multiple of the ASCO sampling frequency).

### 16.4 High speed synchronous serial interfaces

The High-Speed Synchronous Serial Interfaces (SSC0 and SSC1) provides flexible highspeed serial communication between the ST10F252M and other microcontrollers, microprocessors or external peripherals.
The SSCx supports full-duplex and half-duplex synchronous communication. The serial clock signal can be generated by the SSCx itself (master mode) or be received from an external master (slave mode). Data width, shift direction, clock polarity and phase are programmable.

This allows communication with SPI-compatible devices. Transmission and reception of data is double-buffered. A 16-bit baudrate generator provides the SSCx with a separate serial clock signal. The serial channel SSCx has its own dedicated 16-bit baudrate generator with 16-bit reload capability, allowing baudrate generation independent from the timers.

Table 87 lists some possible baudrates against the required reload values and the resulting bit times for the 40 MHz CPU clock. The maximum is limited to 8 Mbaud.

Table 87. Synchronous baudrate and reload values ( $f_{C P U}=40 \mathrm{MHz}$ )

| Baudrate | Bit time | Reload value |
| :--- | :---: | :---: |
| Reserved | - | 0000 h |
| Can be used only with $\mathrm{f}_{\mathrm{CPU}}=32 \mathrm{MHz}$ (or lower) | - | 0001 h |
| 6.6 Mbaud | 150 ns | 0002 h |
| 5 Mbaud | 200 ns | 0003 h |
| 2.5 Mbaud | 400 ns | 0007 h |
| 1 Mbaud | $1 \mu \mathrm{~s}$ | 0013 h |
| 100 Kbaud | $10 \mu \mathrm{~s}$ | 00 C 7 h |
| 10 Kbaud | $100 \mu \mathrm{~s}$ | 07 CFh |
| 1 Kbaud | 1 ms | 4 E 1 Fh |
| 306 baud | 3.26 ms | FF4Eh |

## $17 \quad \mathrm{I}^{2} \mathrm{C}$ interface

The integrated $I^{2} \mathrm{C}$ Bus Module handles the transmission and reception of frames over the two-line SDA/SCL in accordance with the $I^{2} \mathrm{C}$ Bus specification. The $\mathrm{I}^{2} \mathrm{C}$ Module can operate in slave mode, in master mode or in multi-master mode. It can receive and transmit data using 7 -bit or 10-bit addressing. Data can be transferred at speeds up to $400 \mathrm{Kbit} / \mathrm{s}$ (both Standard and Fast $\mathrm{I}^{2} \mathrm{C}$ bus modes are supported).

The module can generate three different types of interrupt:

- requests related to bus events, such as start or stop events, or arbitration lost
- requests related to data transmission
- requests related to data reception

These requests are issued to the interrupt controller by three different lines, and identified as Error, Transmit, and Receive interrupt lines.
When the $\mathrm{I}^{2} \mathrm{C}$ module is enabled by setting bit XI2CEN in XPERCON register, pins P4.4 and P4.7 (where SCL and SDA are respectively mapped as alternate functions) are automatically configured as bidirectional open-drain: the value of the external pull-up resistor depends on the application. P4, DP4 and ODP4 cannot influence the pin configuration.
When the $\mathrm{I}^{2} \mathrm{C}$ cell is disabled (clearing bit XI2CEN), P 4.4 and P 4.7 pins are standard $\mathrm{I} / \mathrm{O}$ controlled by P4, DP4 and ODP4.
The speed of the $I^{2} C$ interface can be selected between Standard mode ( 0 to 100 kHz ) and Fast $I^{2} \mathrm{C}$ mode ( 100 to 400 kHz ).

## 18 CAN modules

The two integrated CAN modules (CAN1 and CAN2) are identical and handle the completely autonomous transmission and reception of CAN frames in accordance with the CAN specification V2.0 part A and B (active).

These two CAN modules are different with respect to the ones implemented on ST10F269. The new module is based on C-CAN module characteristics. The following system resources are used to interface the module with the ST10 core:

- Interrupt of CAN1 and CAN2 are connected to the XBUS interrupt lines: refer to Section 18.2 for details.
- Both CAN modules have to be selected, before the bit XPEN is set in SYSCON register, by setting the proper bit in XPERCON register.
- After reset, CAN1 is enabled by default (see the reset value of the XPERCON register). The CAN2 is not enabled.

This peripheral uses the new clock gating feature.
Note: $\quad$ When the clock is gated, no reset is raised once the EINIT instruction has been executed.

### 18.1 Memory and pin mapping

### 18.1.1 CAN1 mapping

Address range 00'EF00h - 00'EFFFh is reserved for the CAN1 module access. The CAN1 is enabled by setting bit XPEN of the SYSCON register and bit 0 of XPERCON register. Accesses to the CAN module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two wait states give an access time of 83.34 ns at 40 MHz CPU clock. No tristate wait state is used.

After reset, CAN1 is enabled by default (see the reset value of the XPERCON register). It is available on pins P4.5 and P4.6.

### 18.1.2 CAN2 mapping

Address range 00'EE00h - 00'EEFFh is reserved for the CAN2 module access. The CAN2 is enabled by setting bit XPEN of the SYSCON register and bit 1 of the XPERCON register. Accesses to the CAN module use demultiplexed addresses and a 16-bit data bus (only word accesses are possible). Two wait states give an access time of 83.34 ns at 40 MHz CPU clock. No tristate wait state is used.

After reset, CAN2 is disabled by default (see the reset value of the XPERCON register). Once enabled, it is available on pins P4.4 and P4.7.
Note: $\quad$ If one or both CAN modules are used, PORT4 cannot be programmed to output all 8 segment address lines. Thus, only 4 segment address lines can be used, reducing the external memory space to 1 Mbyte.

### 18.1.3 Register summary

Table 88 and Table 89 summarize the CAN modules register mapping
Table 88. CAN1 register mapping

| Address | Description | Reset |
| :---: | :---: | :---: |
| 00 EF00 | CAN1: CAN Control Register | 0001 |
| 00 EF02 | CAN1: Status Register | 0000 |
| 00 EF04 | CAN1: Error Counter | 0000 |
| 00 EF06 | CAN1: Bit Timing Register | 2301 |
| 00 EF08 | CAN1: Interrupt Register | 0000 |
| 00 EFOA | CAN1: Test Register | 00x0 |
| 00 EFOC | CAN1: BRP Extension Register | 0000 |
| 00 EF10 | CAN1: IF1 Command Request | 0001 |
| 00 EF12 | CAN1: IF1 Command Mask | 0000 |
| 00 EF14 | CAN1: IF1 Mask 1 | FFFF |
| 00 EF16 | CAN1: IF1 Mask 2 | FFFF |
| 00 EF18 | CAN1: IF1 Arbitration 1 | 0000 |
| 00 EF 1 A | CAN1: IF1 Arbitration 2 | 0000 |
| 00 EF1C | CAN1: IF1 Message Control | 0000 |
| 00 EF1E | CAN1: IF1 Data A 1 | 0000 |
| 00 EF20 | CAN1: IF1 Data A 2 | 0000 |
| 00 EF22 | CAN1: IF1 Data B 1 | 0000 |
| 00 EF24 | CAN1: IF1 Data B 2 | 0000 |
| 00 EF40 | CAN1: IF2 Command Request | 0001 |
| 00 EF42 | CAN1: IF2 Command Mask | 0000 |
| 00 EF44 | CAN1: IF2 Mask 1 | FFFF |
| 00 EF46 | CAN1: IF2 Mask 2 | FFFF |
| 00 EF48 | CAN1: IF2 Arbitration 1 | 0000 |
| 00 EF4A | CAN1: IF2 Arbitration 2 | 0000 |
| 00 EF 4 C | CAN1: IF2 Message Control | 0000 |
| 00 EF4E | CAN1: IF2 Data A 1 | 0000 |
| 00 EF50 | CAN1: IF2 Data A 2 | 0000 |
| 00 EF52 | CAN1: IF2 Data B 1 | 0000 |
| 00 EF54 | CAN1: IF2 Data B 2 | 0000 |
| 00 EF80 | CAN1: Transmission Request 1 | 0000 |
| 00 EF82 | CAN1: Transmission Request 2 | 0000 |
| 00 EF90 | CAN1: New Data 1 | 0000 |

Table 88. CAN1 register mapping (continued)

| Address | Description | Reset |
| :---: | :--- | :---: |
| 00 EF92 | CAN1: New Data 2 | 0000 |
| 00 EFA0 | CAN1: Interrupt Pending 1 | 0000 |
| 00 EFA2 | CAN1: Interrupt Pending 2 | 0000 |
| 00 EFB0 | CAN1: Message Valid 1 | 0000 |
| 00 EFB2 | CAN1: Message Valid 2 | 0000 |

Table 89. CAN2 register mapping

| Address | Description | Reset |
| :---: | :---: | :---: |
| 00 EE00 | CAN2: CAN Control Register | 0001 |
| 00 EE02 | CAN2: Status Register | 0000 |
| 00 EE04 | CAN2: Error Counter | 0000 |
| 00 EE06 | CAN2: Bit Timing Register | 2301 |
| 00 EE08 | CAN2: Interrupt Register | 0000 |
| 00 EEOA | CAN2: Test Register | 00x0 |
| 00 EEOC | CAN2: BRP Extension Register | 0000 |
| 00 EE10 | CAN2: IF1 Command Request | 0001 |
| 00 EE12 | CAN2: IF1 Command Mask | 0000 |
| 00 EE14 | CAN2: IF1 Mask 1 | FFFF |
| 00 EE16 | CAN2: IF1 Mask 2 | FFFF |
| 00 EE18 | CAN2: IF1 Arbitration 1 | 0000 |
| 00 EE1A | CAN2: IF1 Arbitration 2 | 0000 |
| 00 EE 1 C | CAN2: IF1 Message Control | 0000 |
| 00 EE 1 E | CAN2: IF1 Data A 1 | 0000 |
| 00 EE20 | CAN2: IF1 Data A 2 | 0000 |
| 00 EE22 | CAN2: IF1 Data B 1 | 0000 |
| 00 EE24 | CAN2: IF1 Data B 2 | 0000 |
| 00 EE40 | CAN2: IF2 Command Request | 0001 |
| 00 EE42 | CAN2: IF2 Command Mask | 0000 |
| 00 EE44 | CAN2: IF2 Mask 1 | FFFF |
| 00 EE46 | CAN2: IF2 Mask 2 | FFFF |
| 00 EE48 | CAN2: IF2 Arbitration 1 | 0000 |
| 00 EE4A | CAN2: IF2 Arbitration 2 | 0000 |
| 00 EE4C | CAN2: IF2 Message Control | 0000 |
| 00 EE4E | CAN2: IF2 Data A 1 | 0000 |
| 00 EE50 | CAN2: IF2 Data A 2 | 0000 |

Table 89. CAN2 register mapping (continued)

| Address | Description | Reset |
| :--- | :--- | :---: |
| 00 EE52 | CAN2: IF2 Data B 1 | 0000 |
| 00 EE54 | CAN2: IF2 Data B 2 | 0000 |
| 00 EE80 | CAN2: Transmission Request 1 | 0000 |
| 00 EE82 | CAN2: Transmission Request 2 | 0000 |
| 00 EE90 | CAN2: New Data 1 | 0000 |
| 00 EE92 | CAN2: New Data 2 | 0000 |
| 00 EEA0 | CAN2: Interrupt Pending 1 | 0000 |
| 00 EEA2 | CAN2: Interrupt Pending 2 | 0000 |
| 00 EEB0 | CAN2: Message Valid 1 | 0000 |
| 00 EEB2 | CAN2: Message Valid 2 | 0000 |

### 18.2 Interrupt

Up to four interrupt control registers (XIRxSEL, $x=0,1,2,3$ ) are provided to select the source of the XBUS interrupt. One line for each module is provided and linked differently to one of the XPxIC registers ( $x=0,1,2,3$ ). In particular, two interrupt lines are available on the following interrupt vectors:

- CAN1
XPOINT
XP3INT
- CAN2
XP1INT
XP3INT

Refer to Section 9.2 for details.
When interruptible power down mode is entered, both CAN1 and CAN2 lines can be used to wake-up the device from low power mode without resetting it, restarting the application from where it was stopped before the execution of PWRDN instruction.

Refer to Section 9.1.

### 18.3 Configuration support

It is possible that both CAN controllers are working on the same CAN bus, together supporting up to 64 message objects. In this configuration, both receive signals and both transmit signals are linked together when using the same CAN transceiver. This configuration is supported by providing open drain outputs for the CAN1_TxD and CAN2_TxD signals. The open drain function is controlled with the ODP4 register for PORT4. In this way it is possible to connect together P4.4 with P4.5 (receive lines) and P4.6 with P4.7 (transmit lines configured to be configured as open-drain).

The user software can also internally map both CAN modules on the same pins P4.5 and P4.6. In this way, P4.4 and P4.7 may be used as general purpose input and output lines. This is possible by setting bit CANPAR of XMISC register. To access this register, set bit XMISCEN of XPERCON register and bit XPEN of SYSCON register.

Note: $\quad$ CAN parallel mode is possible only if both CAN1 and CAN2 are enabled through the setting of bits CAN1EN and CAN2EN in XPERCON register. If CAN1 is disabled, CAN2 remains on P4.4/P4.7 even if bit CANPAR is set.

## XMISC register



Table 90. XMISC register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 5 | P34EN | Port pin P3.4 enable on Port pin P1H.0 <br> '0' pins 0 of Port1(P1H.0) is connected to external pin 89 <br> '1' pins 4 of Port3 (P3.4) is connected to external pin 89 |
| 4 | P7EN | Port 7[3:0] enable on Port4[3:0] <br> '0' pins 3:0 of Port4 are connected to external pins 47-50 <br> '1' pins 3:0 of Port7 are connected to external pins 47-50 |
| 3 | VREGOFF | Main Voltage Regulator disable in Power-Down mode <br> '0': On-chip Main Regulator is held active when Power-Down mode is <br> entered <br> '1': On-chip Main Regulator is turned off when Power-Down mode is <br> entered |
| 2 | CANCK2 | CAN Clock divider by 2 disable <br> '0': Clock provided to CAN modules is CPU clock divided by 2 <br> (mandatory when fcPu is higher than 40MHz) <br> '1': Clock provided to CAN modules is directly CPU clock |
| 1 | CANPAR | CAN parallel mode selection <br> '0': CAN2 is mapped on P4.4/P4.7, while CAN1 is mapped on <br> P4.5/P4.6 <br> '1': CAN1 and CAN2 are mapped in parallel on P4.5/P4.6. This is <br> effective only if both CAN1 and CAN2 are enabled through setting of <br> bits CAN1EN and CAN2EN in XPERCON register. If CAN1 is disabled, <br> CAN2 remains on P4.4/P4.7 even if bit CANPAR is set. |

### 18.3.1 Configuration examples

Figure 53, Figure 54, Figure 55 and Figure 56 show different configuration examples, where the two CAN controllers of the ST10F252M are working on the same CAN bus or on different CAN busses.

Wired-OR connections to a CAN bus use open drain outputs as described above. A wired-OR structure can be used for on-board data exchange between two or more controller devices via one signal line. As no CAN transceiver is used in this case, the maximum wire length is very limited ( $\ll 1 \mathrm{~m}$ ) and noise conditions must be considered.

Finally, when only one bus is interfaced, the parallel mode for the two on-chip CAN modules allows a doubling of the buffer capability and the saving two pins for other functionalities. The receive lines are internally tied together, while the transmit lines from the two modules are logically ANDed on the single pin. This assigns the active value to the pin as driven by one of the two (for CAN protocol logic level ' 1 ' is the inactive state, so the non-transmitting CAN module, allows the other to drive the pin).

Figure 53. Connection to single CAN bus via separate CAN transceivers


Figure 54. Connection to single CAN bus via one common transceiver


Figure 55. Connection to two different CAN buses (for example, for gateway application)


Figure 56. Connection to one CAN bus with internal parallel mode enabled


### 18.4 Clock prescaling

In the register XMISC, there is also a bit (CANCK2) to modify the clock frequency driving both the CAN modules. For architectural limitations of the CAN module, when the CPU frequency is higher than 40 MHz , it is recommended to divide the CPU clock by two to each CAN module. 20 MHz is sufficient for CAN module to produce the maximum baud rate defined by the protocol standard. If, on the other hand, the CPU frequency can be reduced to 8 MHz , thus providing the CAN module directly with the CPU clock and disabling the prescaler factor, it is still possible to obtain the maximum CAN speed (1 Mbaud).

After reset, the prescaler is enabled so the CPU clock is divided by two and provided to the CAN modules. According to the system clock frequency, the application can disable the prescaler to obtain the required baud rate.

Refer to Section 18.3.1 for the description of the register XMISC.

### 18.5 CAN module: functional overview

The C-CAN consists of the components (see Figure 57):

- CAN core
- message RAM
- message handler
- control registers
- module interface.

The CAN core performs communication according to the CAN protocol version 2.0 parts A and $B$. The bit rate can be programmed to values up to $1 \mathrm{MBit} / \mathrm{s}$ depending on the technology used. For the connection to the physical layer, additional transceiver hardware is required.
For communication on a CAN network, individual message objects are configured. The message objects and identifier masks for acceptance filtering of received messages are stored in the message RAM.

All functions concerning the handling of messages are implemented in the message handler. Those functions are the acceptance filtering, the transfer of messages between the CAN core and the message RAM, and the handling of transmission requests as well as the generation of the module interrupt.
The register set of the C-CAN can be accessed directly by an external CPU via the module interface. These registers are used to control/configure the CAN core and the message handler and to access the message RAM.
The module interfaces delivered with the C-CAN module can easily be replaced by a customized module interface adapted to user requirements.

C-CAN implements the following features:

- CAN protocol version 2.0 parts $A$ and $B$
- bit rates up to $1 \mathrm{MBit} / \mathrm{s}$
- 32 message objects
- each message object has its own identifier mask
- programmable FIFO mode (concatenation of message objects)
- maskable interrupt
- disabled automatic retransmission mode for time triggered CAN applications
- programmable loop-back mode for self-test operation.


### 18.6 Block diagram

The design consists of the following functional blocks (see Figure 57):

- CAN core

CAN protocol controller and $\mathrm{Rx} / T x$ shift register for serial/parallel conversion of messages.

- Message RAM

Stores message objects and identifier masks.

- Registers

All registers used to control and to configure the C-CAN module.

- Message handler

State machine that controls the data transfer between the Rx/Tx shift register of the CAN core and the message RAM as well as the generation of interrupts as programmed in the control and configuration registers.

Figure 57. Block diagram of the C-CAN


### 18.7 Operating modes

### 18.7.1 Software initialisation

Software initialization is started by setting the Init bit in the CAN control register, either by software or by a hardware reset, or by going Bus_Off.
While Init is set, all message transfer from and to the CAN bus is stopped, the status of the CAN bus output CAN_TX is recessive (HIGH). The counters of the EML are unchanged.
Setting Init does not change any configuration register.

To initialize the CAN controller, the CPU has to set up the bit timing register and each message object. If a message object is not needed, it is sufficient to set it's MsgVal bit to not valid. Otherwise, the whole message object has to be initialized.

Access to the bit timing register and to the BRP extension register for the configuration of the bit timing is enabled when both bits Init and CCE in the CAN control register are set.

Resetting Init (by CPU only) finishes the software initialisation. Afterwards the bit stream processor (BSP see Section 18.9.10) synchronizes itself to the data transfer on the CAN bus by waiting for the occurrence of a sequence of 11 consecutive recessive bits ( $\equiv$ Bus Idle) before it can take part in bus activities and starts the message transfer.

The initialization of the message objects is independent of Init and can be done on the fly, but the message objects should all be configured to particular identifiers or set to not valid before the BSP starts the message transfer.

To change the configuration of a message object during normal operation, the CPU starts by setting MsgVal to not valid. When the configuration is completed, MsgVal is set to valid again.

### 18.7.2 CAN message transfer

Once the C-CAN is initialized and Init is reset to zero, the C-CAN's CAN core synchronizes itself to the CAN bus and starts the message transfer.

Received messages are stored into their appropriate message objects if they pass the message handler's acceptance filtering. The whole message including all arbitration bits, DLC and eight data bytes is stored into the message object. If the identifier mask is used, the arbitration bits which are masked to "don't care" may be overwritten in the message object.

The CPU may read or write each message any time via the interface registers, the message handler guarantees data consistency in case of concurrent accesses.

Messages to be transmitted are updated by the CPU. If a permanent message object (arbitration and control bits set up during configuration) exists for the message, only the data bytes are updated and then TxRqst bit with NewDat bit are set to start the transmission. If several transmit messages are assigned to the same message object (when the number of message objects is not sufficient), the whole message object has to be configured before the transmission of this message is requested.

The transmission of any number of message objects may be requested at the same time, they are transmitted subsequently according to their internal priority. Messages may be updated or set to not valid at any time, even when their requested transmission is still pending. The old data is discarded when a message is updated before its pending transmission has started.

Depending on the configuration of the message object, the transmission of a message may be requested autonomously by the reception of a remote frame with a matching identifier.

### 18.7.3 Disabled automatic retransmission

According to the CAN specification (see ISO11898, 6.3.3 Recovery Management), the CCAN provides means for automatic retransmission of frames that have lost arbitration or that have been disturbed by errors during transmission. The frame transmission service is confirmed to the user before the transmission is successfully completed. By default, this
means that automatic retransmission is enabled. It can be disabled to enable the C-CAN to work within a time triggered CAN (TTCAN, see ISO11898-1) environment.

The disabled automatic retransmission mode is enabled by programming bit DAR in the CAN Control Register to one. In this operation mode, a programmer must consider the different behavior of bits TxRqst and NewDat in the control registers of the message buffers:

- when a transmission starts bit TxRqst of the respective message buffer is reset, while bit NewDat remains set
- when the transmission completed successfully bit NewDat is reset.

When a transmission fails (lost arbitration or error) bit NewDat remains set. To restart the transmission the CPU has to set TxRqst back to one.

### 18.7.4 Test mode

The test mode is entered by setting bit Test in the CAN control register to one. In test mode the bits Tx1, Tx0, LBack, Silent and Basic in the test register are writable. Bit Rx monitors the state of pin CAN_RX and, therefore, is only readable. All test register functions are disabled when bit test is reset to zero.

### 18.7.5 Silent mode

The CAN core can be set in silent mode by programming the test register bit Silent to one.
In Silent mode, the C-CAN is able to receive valid data frames and valid remote frames, but it sends only recessive bits on the CAN bus and it cannot start a transmission. If the CAN core is required to send a dominant bit (ACK bit, overload flag, active error flag), the bit is rerouted internally so that the CAN core monitors this dominant bit, although the CAN bus may remain in recessive state. The silent mode can be used to analyze the traffic on a CAN bus without affecting it by the transmission of dominant bits (acknowledge bits, error frames). Figure 58 shows the connection of signals CAN_TX and CAN_RX to the CAN Core in Silent Mode.

Figure 58. CAN core in silent mode


In ISO 11898-1, the silent mode is called the bus monitoring mode.

### 18.7.6 Loop back mode

The CAN core can be set in loop back mode by programming the test register bit LBack to one. In loop back mode, the CAN core treats its own transmitted messages as received messages and stores them (if they pass acceptance filtering) into a receive buffer. Figure 59 shows the connection of signals CAN_TX and CAN_RX to the CAN core in loop back mode.

Figure 59. CAN core in loop back mode


This mode is provided for self-test functions. To be independent from external stimulation, the CAN core ignores acknowledge errors (recessive bit sampled in the acknowledge slot of a data/remote frame) in loop back mode. In this mode the CAN core performs an internal feedback from its Tx output to its Rx input. The actual value of the CAN_RX input pin is disregarded by the CAN core. The transmitted messages can be monitored at the CAN_TX pin.

### 18.7.7 Loop back combined with silent mode

It is also possible to combine loop back mode and silent mode by programming bits LBack and Silent to one at the same time. This mode can be used for a "hot self test", meaning the C-CAN can be tested without affecting a running CAN system connected to the pins CAN_TX and CAN_RX. In this mode, the CAN_RX pin is disconnected from the CAN core and the CAN_TX pin is held recessive. Figure 60 shows the connection of signals CAN_TX and CAN_RX to the CAN core in case of the combination of loop back mode with silent mode.

Figure 60. CAN core in loop back combined with silent mode


### 18.7.8 Basic mode

The CAN core can be set in basic mode by programming the test register bit Basic to one. In this mode the C-CAN module runs without the message RAM.
The IF1 registers are used as transmit buffer. The transmission of the contents of the IF1 registers is requested by writing the Busy bit of the IF1 command request register to ' 1 '. The IF1 registers are locked while the Busy bit is set. The Busy bit indicates that the transmission is pending.

As soon the CAN bus is idle, the IF1 registers are loaded into the shift register of the CAN core and the transmission is started. When the transmission has completed, the Busy bit is reset and the locked IF1 registers are released.

A pending transmission can be aborted at any time by resetting the Busy bit in the IF1 command request register while the IF1 registers are locked. If the CPU has reset the Busy bit, a possible retransmission in case of lost arbitration or in case of an error is disabled.

The IF2 registers are used as the receive buffer. After the reception of a message the contents of the shift register is stored into the IF2 registers, without any acceptance filtering.

Additionally, the actual contents of the shift register can be monitored during the message transfer. Each time a read message object is initiated by writing the Busy bit of the IF2 command request register to '1', the contents of the shift register are stored into the IF2 registers.

In basic mode the evaluation of all message object related control and status bits and of the control bits of the IFx command mask registers is turned off. The message number of the command request registers is not evaluated. The NewDat and MsgLst bits of the IF2 message control register retain their function, DLC3-0 shows the received DLC, the other control bits are read as ' 0 '.

In basic mode the ready output CAN_WAIT_B is disabled (always ' 1 ').

### 18.7.9 Software control of pin CAN_TX

Four output functions are available for the CAN transmit pin CAN_TX. Additionally to its default function - the serial data output, it can drive the CAN sample point signal to monitor CAN_Core's bit timing and it can drive constant dominant or recessive values. The last two functions, combined with the readable CAN receive pin CAN_RX, can be used to check the CAN bus physical layer.
The output mode of pin CAN_TX is selected by programming the Test Register bits Tx1 and Tx0 as described in Section 18.8.2.

The three test functions for pin CAN_TX interfere with all CAN protocol functions. CAN_TX must be left in its default function when CAN message transfer or any of the test modes loop back mode, silent mode, or basic mode are selected.

### 18.8 Programmer's model

The C-CAN module allocates an address space of 256 bytes. The registers are organized as 16-bit registers, with the high byte at the odd address and the low byte at the even address.

The two sets of interface registers (IF1 and IF2) control the CPU access to the message RAM. They buffer the data to be transferred to and from the RAM, avoiding conflicts between CPU accesses and message reception/transmission.

Table 91. C-CAN register summary

| Address | Name | Reset Value | Note |
| :--- | :--- | :--- | :--- |
| CAN Base $+0 \times 00$ | CAN Control Register | $0 \times 0001$ |  |
| CAN Base $+0 \times 02$ | Status Register | $0 \times 0000$ |  |
| CAN Base $+0 \times 04$ | Error Counter | $0 \times 0000$ | read only |

Table 91. C-CAN register summary (continued)

| Address | Name | Reset Value | Note |
| :---: | :---: | :---: | :---: |
| CAN Base + 0x06 | Bit Timing Register | 0x2301 | write enabled by CCE |
| CAN Base + 0x08 | Interrupt Register | 0x0000 | read only |
| CAN Base + 0x0A | Test Register | 0x00 \& Obr0000000 ${ }^{(1)}$ | write enabled by Test |
| CAN Base + 0x0C | BRP Extension Register | 0x0000 | write enabled by CCE |
| CAN Base + 0x0E | - reserved | - ${ }^{(2)}$ |  |
| CAN Base $+0 \times 10$ | IF1 Command Request | 0x0001 |  |
| CAN Base + 0x12 | IF1 Command Mask | 0x0000 |  |
| CAN Base + 0x14 | IF1 Mask 1 | 0xFFFF |  |
| CAN Base + 0x16 | IF1 Mask 2 | 0xFFFF |  |
| CAN Base + 0x18 | IF1 Arbitration 1 | 0x0000 |  |
| CAN Base + 0x1A | IF1 Arbitration 2 | 0x0000 |  |
| CAN Base + 0x1C | IF1 Message Control | 0x0000 |  |
| CAN Base $+0 \times 1 \mathrm{E}$ | IF1 Data A 1 | 0x0000 |  |
| CAN Base + 0x20 | IF1 Data A 2 | 0x0000 |  |
| CAN Base + 0x22 | IF1 Data B 1 | 0x0000 |  |
| CAN Base + 0x24 | IF1 Data B 2 | 0x0000 |  |
| CAN Base + 0x28-0x3E | - reserved | - ${ }^{(2)}$ |  |
| CAN Base + 0x40-0x54 | IF2 registers | see note ${ }^{(3)}$ | same as IF1 registers |
| CAN Base $+0 \times 56-0 \times 7 E$ | - reserved | - ${ }^{(2)}$ |  |
| CAN Base + 0x80 | Transmission Request 1 | 0x0000 | read only |
| CAN Base + 0x82 | Transmission Request 2 | 0x0000 | read only |
| CAN Base + 0x84-0x8E | - reserved | - ${ }^{(2)}$ |  |
| CAN Base + 0x90 | New Data 1 | 0x0000 | read only |
| CAN Base + 0x92 | New Data 2 | 0x0000 | read only |
| CAN Base + 0x94-0x9E | - reserved | - ${ }^{(2)}$ |  |
| CAN Base + 0xA0 | Interrupt Pending 1 | 0x0000 | read only |
| CAN Base + 0xA2 | Interrupt Pending 2 | 0x0000 | read only |
| CAN Base + 0xA4-0xAE | - reserved | - ${ }^{(2)}$ |  |
| CAN Base + 0xB0 | Message Valid 1 | 0x0000 | read only |
| CAN Base + 0xB2 | Message Valid 2 | 0x0000 | read only |
| CAN Base + 0xB4-0xBE | - reserved | - ${ }^{(2)}$ |  |

1. $r$ signifies the actual value of the CAN_RX pin.
2. Reserved bits are read as ' 0 ' except for IFx mask 2 register where they are read as ' 1 '
3. The two sets of message interface registers - IF1 and IF2 - have identical functions.

### 18.8.1 Hardware reset description

After hardware reset, the busoff state is reset and the output CAN_TX is set to recessive (HIGH). The value 0x0001 (Init = ' 1 ') in the CAN control register enables the software initialisation. The C-CAN does not influence the CAN bus until the CPU resets Init to ' 0 '.

The data stored in the message RAM is not affected by a hardware reset. After power-on, the contents of the message RAM are undefined.

### 18.8.2 CAN protocol related registers

These registers are related to the CAN protocol controller in the CAN core. They control the operating modes and the configuration of the CAN bit timing and provide status information.

## CAN control register (addresses $0 \times 01$ and $0 \times 00$ )



Table 92. CAN control register (addresses 0x01 and 0x00) functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7 | Test | Test mode enable <br> '1' Test mode <br> '0' Normal operation. |
| 6 | CCE | Configuration change enable <br> '1' The CPU has write access to the bit timing register (while Init=1) <br> '0' The CPU has no write access to the bit timing register. |
| 5 | DAR | Disable automatic retransmission <br> '1' Automatic retransmission disabled |
| 3 | EIE | '0' Automatic retransmission of disturbed messages enabled. |
| 2 | SIE | '1' Enabled - A change in the bits BOff or EWarn in the register <br> generates an interrupt <br> '0' Disabled - no error status interrupt is generated. |
|  | Status change interrupt enable <br> '1' Enabled - an interrupt is generated when a message transfer is <br> successfully completed or a CAN bus error is detected <br> '0' Disabled - no status change interrupt is generated. |  |

Table 92. CAN control register (addresses 0x01 and 0x00) functions (continued)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 1 | IE | Module interrupt enable <br> '1' Enabled - interrupts set IRQ_B to LOW. IRQ_B remains LOW until <br> all pending interrupts are processed. <br> '0' Disabled - module interrupt IRQ_B is always HIGH. |
| 0 | INIT | Initialization <br> '1' Initialization is started. <br> '0' Normal operation. |

Note: $\quad$ The busoff recovery sequence (see CAN Specification Rev. 2.0) cannot be shortened by setting or resetting Init. If the device goes busoff, it sets Init of its own accord, stopping all bus activities. Once Init has been cleared by the CPU, the device waits for 129 occurrences of Bus Idle (129 * 11 consecutive recessive bits) before resuming normal operations. At the end of the busoff recovery sequence, the error management counters are reset.

During the waiting time after the resetting of Init, each time a sequence of 11 recessive bits has been monitored, a Bit0Error code is written to the status register, enabling the CPU to readily check up whether the CAN bus is stuck at dominant or continuously disturbed and to monitor the proceeding of the busoff recovery sequence.

Status register (addresses 0x03 and 0x02)


Table 93. Status register (addresses $0 \times 03$ and $0 \times 02$ ) functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7 | BOff | Busoff status <br> '1' The CAN module is in busoff state <br> '0' The CAN module is not busoff. |
| 6 | EWarn | Warning status <br> '1' At least one of the error counters in the EML has reached the error <br> warning limit of 96 <br> '0' Both error counters are below the error warning limit of 96. |
| 5 | EPass | Error passive <br> '1' The CAN core is in the error passive state as defined in the CAN <br> specification <br> '0' The CAN core is error active. |

Table 93. Status register (addresses $0 \times 03$ and $0 \times 02$ ) functions (continued)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 4 | RxOk | $\begin{array}{l}\text { Received a message successfully } \\ \text { '1' Since this bit was last reset (to zero) by the CPU, a message has } \\ \text { been successfully received (independently of the result of acceptance } \\ \text { filtering) } \\ \text { '0' Since this bit was last reset by the CPU, no message has been } \\ \text { successfully received. This bit is never reset by the CAN core. }\end{array}$ |
| 3 | TxOk | $\begin{array}{l}\text { Transmitted a message successfully } \\ \text { '1' Since this bit was last reset by the CPU, a message has been } \\ \text { successfully (error free and acknowledged by at least one other node) } \\ \text { transmitted. } \\ \text { '0' Since this bit was reset by the CPU, no message has been } \\ \text { successfully transmitted. This bit is never reset by the CAN core. }\end{array}$ |
| 2.0 LEC | $\begin{array}{l}\text { Last error code (type of the last error to occur on the CAN bus) } \\ \text { '000' No error }\end{array}$ |  |
| '001' Stuff error: more than five equal bits in a sequence have occurred |  |  |
| in a part of a received message where this is not allowed |  |  |
| '010' Form error: a fixed format part of a received frame has the wrong |  |  |
| format |  |  |
| '011' AckError: the message this CAN core transmitted was not |  |  |
| acknowledged by another node |  |  |$\}$| '100' Bit1Error: during the transmission of a message (with the |
| :--- |
| exception of the arbitration field), the device wanted to send a |
| recessive level (bit of logical value '1'), but the monitored bus value was |
| dominant |
| '101' Bit0Error: during the transmission of a message (or acknowledge |
| bit, or active error flag, or overload flag), the device wanted to send a |
| dominant level (data or identifier bit logical value '0'), but the monitored |
| Bus value was recessive. During busoff recovery this status is set each |
| time a sequence of 11 recessive bits has been monitored. This enables |
| the CPU to monitor the proceeding of the busoff recovery sequence |
| (indicating the bus is not stuck at dominant or continuously disturbed) |
| '110' CRCError: the CRC check sum was incorrect in the message |
| received, the CRC received for an incoming message does not match |
| with the calculated CRC for the received data |
| '111' unused: when the LEC shows the value '111', no CAN bus event |
| is detected since the CPU wrote this value to the LEC. |$|$

The LEC field holds a code which indicates the type of the last error to occur on the CAN bus. This field will be cleared to ' 0 ' when a message has been transferred (reception or transmission) without error. The unused code '111' may be written by the CPU to check for updates.

## Status interrupts

A status interrupt is generated by bits BOff and EWarn (error Interrupt) or by RxOk, TxOk, and LEC (status change interrupt) assuming that the corresponding enable bits in the CAN control register are set. A change of bit EPass or a write to RxOk, TxOk, or LEC never generates a status interrupt.

Reading the status register clears the status interrupt value (8000h) in the interrupt register, if it is pending.

## Error counter (addresses 0x05 and 0x04)



Table 94. Error counter (addresses 0x05 and 0x04) functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15 | RP | Receive error passive <br> '1' The receive error counter has reached the error passive level as <br> defined in the CAN specification. <br> '0' The receive error counter is below the error passive level. |
| 14.8 | REC6-0 | Receive error counter <br> Actual state of the receive error counter. Values between 0 and 127. |
| 7.0 | TEC7-0 | Transmit error counter <br> Actual state of the transmit error counter. Values between 0 and 255. |

## Bit timing register (addresses 0x07 and 0x06)



Table 95. Bit timing register (addresses $0 \times 07$ and $0 \times 06$ ) functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 14.12 | TSeg2 | Time segment after the sample point <br> Valid values for TSeg2 are [0 to 7]. The actual interpretation by the <br> hardware of this value is such that one more than the value <br> programmed here is used. |
| 11.8 | TSeg1 | Time segment before the sample point <br> Valid values for TSeg1 are [1 to15]. The actual interpretation by the <br> hardware of this value is such that one more than the value <br> programmed here is used. |

Table 95. Bit timing register (addresses $0 \times 07$ and $0 \times 06$ ) functions (continued)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7.6 | SJW | (Re)synchronisation jump width <br> Valid programmed values are [0 to 3]. The actual interpretation by the <br> hardware of this value is such that one more than the value <br> programmed here is used. |
| 5.0 | BRP | Baud rate prescaler <br> The value by which the oscillator frequency is divided for generating <br> the bit time quantum. The bit time is built up from a multiple of this <br> quantum. Valid values for the baud rate prescaler are [0 to 63]. The <br> actual interpretation by the hardware of this value is such that one <br> more than the value programmed here is used. |

Note: $\quad$ With a CAN module clock of 8 MHz , the reset value of $0 \times 2301$ configures the C-CAN for a bit rate of $500 \mathrm{kBit} / \mathrm{s}$. The registers are only writable if bits CCE and Init in the CAN control register are set.

Test register (addresses 0x0B and 0x0A)


Table 96. Test register (addresses $0 \times 0 B$ and $0 \times 0 A$ ) functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7 | $R x$ | Monitors the actual value of the CAN_RX Pin <br> '1' The CAN bus is recessive (CAN_RX = '1') <br> '0' The CAN bus is dominant (CAN_RX = '0'). |
| 6.5 | Tx1 and Tx0 | Control of CAN_TX pin <br> '00' Reset value, CAN_TX is controlled by the CAN core <br> '01' Sample point can be monitored at CAN_TX pin <br> '10' CAN_TX pin drives a dominant ('0') value <br> '11' CAN_TX pin drives a recessive ('1') value. |
| 4 | LBack | Loop back mode <br> '1' Loop back mode is enabled <br> '0' Loop back mode is disabled. |
| 3 | Silent | Silent mode <br> '1' The module is in silent mode <br> '0' Normal operation. |
| 2 | Basic | Basic mode <br> '1' F1 registers used as Tx buffer, IF2 registers used as Rx buffer <br> '0' Basic mode disabled. |

Write access to the test register is enabled by setting bit Test in the CAN control register.
The different test functions may be combined, but Tx1-0 $=$ " 00 " disturbs message transfer.

BRP extension register (addresses 0x0D and 0x0C)


Table 97. BRP extension register (addresses 0x0D and 0x0C) functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 3.0 | BRPE | Baud rate prescaler extension <br> the baud rate prescaler can be extended to values up to 1023. The <br> actual interpretation by the hardware is that one more than the value <br> programmed by BRPE (MSBs) and BRP (LSBs) is used. |

### 18.8.3 Message interface register sets

There are two sets of interface registers which are used to control the CPU access to the message RAM. The interface registers avoid conflicts between CPU access to the message RAM and CAN message reception and transmission by buffering the data to be transferred. A complete message object or parts of the message object may be transferred between the message RAM and the IFx message buffer registers in one single transfer.
The function of the two interface register sets is identical (except for test mode Basic). They can be used the way that one set of registers is used for data transfer to the message RAM while the other set of registers is used for the data transfer from the message RAM, allowing both processes to be interrupted by each other. Table 98 gives an overview of the two interface register sets.
Each set of interface registers consists of message buffer registers controlled by their own command registers. The command mask register specifies the direction of the data transfer and which parts of a message object are transferred. The command request register is used to select a message object in the message RAM as target or source for the transfer and to start the action specified in the command mask register.

Table 98. IF1 and IF2 message interface register sets

| Address | IF1 Register Set | Address | IF2 Register Set |
| :--- | :--- | :--- | :--- |
| CAN Base $+0 \times 10$ | IF1 Command Request | CAN Base $+0 \times 40$ | IF2 Command Request |
| CAN Base $+0 \times 12$ | IF1 Command Mask | CAN Base $+0 \times 42$ | IF2 Command Mask |
| CAN Base $+0 \times 14$ | IF1 Mask 1 | CAN Base $+0 \times 44$ | IF2 Mask 1 |
| CAN Base $+0 \times 16$ | IF1 Mask 2 | CAN Base $+0 \times 46$ | IF2 Mask 2 |
| CAN Base $+0 \times 18$ | IF1 Arbitration 1 | CAN Base $+0 \times 48$ | IF2 Arbitration 1 |
| CAN Base $+0 \times 1$ A | IF1 Arbitration 2 | CAN Base $+0 \times 4 A$ | IF2 Arbitration 2 |
| CAN Base $+0 \times 1$ C | IF1 Message Control | CAN Base $+0 \times 4 C$ | IF2 Message Control |
| CAN Base $+0 \times 1$ E | IF1 Data A 1 | CAN Base $+0 \times 4 E$ | IF2 Data A 1 |
| CAN Base $+0 \times 20$ | IF1 Data A 2 | CAN Base $+0 \times 50$ | IF2 Data A 2 |

Table 98. IF1 and IF2 message interface register sets (continued)

| Address | IF1 Register Set | Address | IF2 Register Set |
| :---: | :--- | :---: | :---: |
| CAN Base + 0x22 | IF1 Data B 1 | CAN Base + 0x52 | IF2 Data B 1 |
| CAN Base + 0x24 | IF1 Data B 2 | CAN Base + 0x54 | IF2 Data B 2 |

A message transfer is started as soon as the CPU has written the message number to the command request register. With this write operation the Busy bit is automatically set to ' 1 '. After a wait time of 3 to 6 CAN clock periods, the transfer between the interface register and the message RAM is completed and the Busy bit is set back to zero.

## IFx command request registers



Table 99. IFx command request registers functions

| Bit | Name | Function |
| :--- | :--- | :--- |
| 15 | Busy | Busy flag <br> '1' Set when writing to the IFx command request register <br> '0' Read/write action has finished. |
| 5.0 | Message Number | Message number <br> '0x01-0x20' <br> Valid message number, the message object in the message RAM is <br> selected for data transfer <br> '0x00' <br> Not a valid message number, interpreted as 0x20 <br> '0x21-0x3F' <br> Not a valid message number, interpreted as 0x01-0x1F. |

Note: $\quad$ When a message number that is not valid is written into the command request register, the message number is transformed into a valid value and that message object is transferred.

The control bits of the IFx command mask register specify the transfer direction and select which of the IFx message buffer registers are source or target of the data transfer.

## IFx command mask registers



IF2 Command Mask Register (addresses 0x43
\& $0 \times 42$ )


Table 100. IFx command mask registers functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 7 | WR/RD | Write/Read <br> '1' Write: transfer data from the selected message buffer registers to <br> the message object addressed by the command request register <br> '0' Read: transfer data from the message object addressed by the <br> command request register into the selected message buffer registers. |

The other bits of IFx command mask register have different functions depending on the transfer direction.
Table 101. IFx command mask registers functions (direction - write)

| Bit | Name | $\quad$ Function |
| :---: | :--- | :--- |
| 6 | Mask | Access mask bits <br> '1' Transfer identifier mask + MDir + MXtd to message object <br> '0' Mask bits unchanged. |
| 5 | Arb | Access arbitration bits <br> '1' Transfer identifier + Dir + Xtd + MsgVal to message object <br> '0' Arbitration bits unchanged. |
| 4 | Control | Access control bits <br> '1' Transfer control bits to message object <br> '0' Control bits unchanged. |
| 3 | CIrIntPnd | Clear interrupt pending bit <br> When writing to a message object, this bit is ignored. |
| 2 | TxRqst/NewDat | Access transmission request bit <br> '1' Set TxRqst bit <br> '0' TxRqst bit unchanged <br> If a transmission is requested by programming bit TxRqst/NewDat in <br> the IFx command mask register, bit TxRqst in the IFx message control <br> register is ignored. |

Table 101. IFx command mask registers functions (direction - write) (continued)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 1 | Data A | Access data bytes 0-3 <br> '1' Transfer data bytes 0-3 to message object <br> '0' Data bytes 0-3 unchanged. |
| 0 | Data B | Access data bytes 4-7 <br> '1' Transfer data bytes 4-7 to message object <br> '0' Data bytes 4-7 unchanged. |

Table 102. IFx command mask registers functions (direction - read)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 6 | Mask | Access mask bits <br> '1' Transfer identifier mask + MDir + MXtd to IFx message buffer <br> register <br> '0' Mask bits unchanged. |
| 5 | Arb | Access arbitration bits <br> '1' Transfer identifier + Dir + Xtd + MsgVal to IFx message buffer <br> register <br> '0' Arbitration bits unchanged. |
| 4 | Control | Access control bits <br> '1' Transfer control bits to IFx message buffer register |
| 3 | CIrIntPnd 0 '0' Control bits unchanged. |  |

### 18.8.4 IFx message buffer registers

The bits of the message buffer registers mirror the message objects in the message RAM.

## IFx mask register



## IFx arbitration registers



| $\begin{aligned} & \text { IF2 Ark } \\ & \text { Ox4A) } \end{aligned}$ | ation | Regi |  |  |  |  |  |  |  |  |  |  |  | va | xxxxh |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| $\begin{gathered} \mathrm{MsgV} \\ \mathrm{al} \end{gathered}$ | Xtd | Dir |  |  |  |  |  |  | 28-1 |  |  |  |  |  |  |
| RW | RW | R | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW | RW |

## IFx message control registers



0x4D \& 0x4C)


IFx Data A and Data B Registers
The data bytes of CAN messages are stored in the IFx Message Buffer Registers in the order shown in Table 103.
Table 103. IFx Data A and Data B registers

|  | $[15: 8]$ | [7:0] |
| :--- | :--- | :--- |
| IF1 Message Data A1 (addresses 0x1F \& 0x1E) | Data(1) | Data(0) |
| IF1 Message Data A2 (addresses 0x21 \& 0x20) | Data(3) | Data(2) |
| IF1 Message Data B1 (addresses 0x23 \& 0x22) | Data(5) | Data(4) |
| IF1 Message Data B2 (addresses 0x25 \& 0x24) | Data(7) | Data(6) |
| IF2 Message Data A1 (addresses 0x4F \& 0x4E) | Data(1) | Data(0) |
| IF2 Message Data A2 (addresses 0x51 \& 0x50) | Data(3) | Data(2) |
| IF2 Message Data B1 (addresses 0x53 \& 0x52) | Data(5) | Data(4) |
| IF2 Message Data B2 (addresses 0x55 \& 0x54) | Data(7) | Data(6) |

In a CAN data frame, $\operatorname{Data}(0)$ is the first, $\operatorname{Data}(7)$ is the last byte to be transmitted or received. In CAN's serial bit stream, the MSB of each byte is transmitted first.

## Message object in the message memory

There are 32 message objects in the message RAM. To avoid conflicts between CPU access to the message RAM and CAN message reception and transmission, the CPU cannot directly access the message objects, these accesses are handled via the IFx interface registers.

Figure 61 gives an overview of the two structures of a message object.
Figure 61. Structure of a message object in the message memory

| Message Object |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| UMask | Msk28-0 | MXtd | MDir | EoB | NewDat |  | MsgLst | RxIE | TxIE | IntPnd | RmtEn | TxRqst |
| MsgVal | ID28-0 | Xtd | Dir | DLC3-0 | Data 0 | Data 1 | Data 2 | Data 3 | Data 4 | Data 5 | Data 6 | Data 7 |

Table 104. Message object functions

| Bit | Name | Function |
| :---: | :---: | :---: |
|  | MsgVal | Message valid <br> ' 1 ' The message object is configured and should be considered by the message handler <br> ' 0 ' The message object is ignored by the message handler. <br> The CPU must reset the MsgVal bit of all unused message objects during the initialization before it resets bit Init in the CAN control register. This bit must also be reset before the identifier Id28-0, the control bits Xtd, Dir, or the Data Length Code DLC3-0 are modified, or if the message object is no longer required. |
|  | UMask | Use acceptance mask <br> ' 1 ' Use mask (Msk28-0, MXtd, and MDir) for acceptance filtering '0’ Mask ignored. <br> If the UMask bit is set to one, the message object's mask bits have to be programmed during initialization of the message object before MsgVal is set to one. |
|  | ID28-0 | Message identifier <br> ID28 - ID0 29-bit Identifier ("extended frame"). <br> ID28 - ID18 11-bit Identifier ("standard frame"). |
|  | Msk28-0 | Identifier mask <br> ' 1 ' The corresponding identifier bit is used for acceptance filtering ' 0 ' The corresponding bit in the identifier of the message object cannot inhibit the match in the acceptance filtering. |
|  | Xtd | Extended identifier <br> ' 1 ' The 29-bit ("extended") Identifier is used for this message object. ' 0 ' The 11-bit ("standard") Identifier is used for this message object. |
|  | MXtd | Mask extended identifier <br> ' 1 ' The extended identifier bit (IDE) is used for acceptance filtering '0' The extended identifier bit (IDE) has no effect on the acceptance filtering. <br> When 11-bit ("standard") identifiers are used for a message object, the identifiers of received data frames are written into bits ID28 to ID18. For acceptance filtering, only these bits together with mask bits Msk28 to Msk18 are considered. |

Table 104. Message object functions (continued)

| Bit | Name | $\quad$ Function |
| :--- | :--- | :--- |
| Dir | $\begin{array}{l}\text { Message direction } \\ \text { '1' Direction = transmit: On TxRqst, the respective message object is } \\ \text { transmitted as a data frame. On reception of a remote frame with } \\ \text { matching identifier, the TxRqst bit of this message object is set (if } \\ \text { RmtEn = one) }\end{array}$ |  |
| '0' Direction = receive: On TxRqst, a remote frame with the identifier of |  |  |
| this message object is transmitted. On reception of a data frame with |  |  |
| matching identifier, that message is stored in this message object. |  |  |$\}$

Table 104. Message object functions (continued)

| Bit | Name | Function |
| :---: | :---: | :---: |
|  | TxIE | Transmit interrupt enable ' 1 ' IntPnd is set after a successful transmission of a frame ' 0 ' IntPnd is left unchanged after the successful transmission of a frame. |
|  | IntPnd | Interrupt pending <br> ' 1 ' This message object is the source of an interrupt. The interrupt identifier in the interrupt register point to this message object if there is no other interrupt source with higher priority <br> ' 0 ' This message object is not the source of an interrupt. |
|  | RmtEn | Remote enable <br> ' 1 ' At the reception of a remote frame, TxRqst is set ' 0 ' At the reception of a remote frame, TxRqst is left unchanged. |
|  | TxRqst | Transmit request ' 1 ' The transmission of this message object is requested and is not yet done ' 0 ' This message object is not waiting for transmission. |
|  | DLC3-0 | Data length code <br> '0-8' Data frame has 0-8 data bytes. <br> '9-15' Data frame has 8 data bytes <br> The data length code of a message object is defined the same as in all the corresponding objects with the same identifier at other nodes. <br> When the message handler stores a data frame, it will write the DLC to the value given by the received message. <br> Data 0 1st data byte of a CAN data frame <br> Data 1 2nd data byte of a CAN data frame <br> Data 2 3rd data byte of a CAN data frame <br> Data 3 4th data byte of a CAN data frame <br> Data 4 5th data byte of a CAN data frame <br> Data 5 6th data byte of a CAN data frame <br> Data 6 7th data byte of a CAN data frame <br> Data 7 8th data byte of a CAN data frame <br> Byte Data 0 is the first data byte shifted into the shift register of the CAN core during a reception, byte Data 7 is the last. When the message handler stores a data frame, it writes all the eight data bytes into a message object. If the data length code is less than 8 , the remaining bytes of the message object are overwritten by non specified values. |

### 18.8.5 Message Handler Registers

All Message Handler registers are read-only. Their contents (TxRqst, NewDat, IntPnd, and MsgVal bits of each Message Object and the Interrupt Identifier) is status information provided by the Message Handler FSM.

## Interrupt register (addresses 0x09 and 0x08)

| Interrupt Register (addresses 0x09 \& 0x08) |  |  |  |  |  |  | SFR |  |  | 5 | 4 | 3 | Reset value: xxxxh |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 |  |  |  | 2 | 1 | 0 |
| Intld15-8 |  |  |  |  |  |  |  | Intld7-0 |  |  |  |  |  |  |  |

R
R

Table 105. Interrupt register (addresses $0 \times 09$ and $0 \times 08$ ) functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | Intld15-0 | Interrupt identifier (the number indicates the source of the interrupt) ' $0 \times 0000$ ’ No interrupt is pending <br> '0x0001-0x0020' Number of message object which caused the interrupt <br> '0x0021-0x7FFF' unused <br> '0x8000’ Status Interrupt <br> '0x8001-0xFFFF' unused. |

If several interrupts are pending, the CAN interrupt register points to the pending interrupt with the highest priority, disregarding their chronological order. An interrupt remains pending until the CPU has cleared it. If Intld is not $0 \times 0000$ and IE is set, the interrupt line to the CPU, IRQ_B, is active. The interrupt line remains active until Intld is back to value 0x0000 (the cause of the interrupt is reset) or until IE is reset.

The status interrupt has the highest priority. Among the message interrupts, the message object' s interrupt priority decreases with increasing message number.

A message interrupt is cleared by clearing the message object's IntPnd bit. The status interrupt is cleared by reading the status register.

### 18.8.6 Transmission request registers

| Transmission Request 1 Register (addresses $0 \times 81$ \& $0 \times 80$ ) |  |  |  |  |  | SFR |  |  |  | Reset value: xxxxh |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| TxRqst16-9 |  |  |  |  |  |  |  | TxRqst8-1 |  |  |  |  |  |  |  |
| R |  |  |  |  |  |  |  | R |  |  |  |  |  |  |  |
| Transmission Request 2 Register (addresses $0 \times 83$ \& $0 \times 82$ ) |  |  |  |  |  | SFR |  |  |  | Reset value: xxxxh |  |  |  |  |  |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| TxRqst32-25 |  |  |  |  |  |  |  | TxRqst24-17 |  |  |  |  |  |  |  |

Table 106. Transmission request register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15.0 | TxRqst32-1 | Transmission request bits (of all message objects) <br> '1' The transmission of this message object is requested and is not yet <br> done <br> '0' This message object is not waiting for transmission. |

These registers hold the TxRqst bits of the 32 message objects. By reading out the TxRqst bits, the CPU can check for which message object a transmission request is pending. The TxRqst bit of a specific message object can be set/reset by the CPU via the IFx message interface registers or by the message handler after reception of a remote frame or after a successful transmission.

### 18.8.7 New data registers



Table 107. New data register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15.0 | NewDat32-1 | New data bits (of all message objects) <br> '1' The message handler or the CPU has written new data into the data <br> portion of this message object <br> '0' No new data has been written into the data portion of this message <br> object by the message handler since last time this flag was cleared by <br> the CPU. |

These registers hold the NewDat bits of the 32 message objects. By reading out the NewDat bits, the CPU can check for which message object the data portion is updated. The NewDat bit of a specific message object can be set/reset by the CPU via the IFx message interface registers or by the message handler after reception of a data frame or after a successful transmission.

### 18.8.8 Interrupt pending registers



Table 108. Interrupt pending register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15.0 | IntPnd32-1 | Interrupt pending bits (of all message objects) <br> '1' This message object is the source of an interrupt <br> '0' This message object is not the source of an interrupt. |

These registers hold the IntPnd bits of the 32 message objects. By reading out the IntPnd bits, the CPU can check for which message object an interrupt is pending. The IntPnd bit of a specific message object can be set/reset by the CPU via the IFx message interface registers or by the message handler after reception or after a successful transmission of a frame. This will also affect the value of Intld in the interrupt register.

### 18.8.9 Message valid registers



Table 109. Message valid register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 15.0 | MsgVal32-1 | Message valid bits (of all message objects) <br> '1' This message object is configured and should be considered by the <br> message handler <br> '0' This message object is ignored by the message handler. |

These registers hold the MsgVal bits of the 32 message objects. By reading out the MsgVal bits, the CPU can check which message object is valid. The MsgVal bit of a specific message object can be set/reset by the CPU via the IFx message interface registers.

### 18.9 CAN application

### 18.9.1 Management of message objects

The configuration of the message objects in the message RAM are (with the exception of the bits MsgVal, NewDat, IntPnd, and TxRqst) not affected by resetting the chip. All the message objects are initialized by the CPU or they are not valid (MsgVal = ' 0 '); bit timing is configured before the CPU clears the Init bit in the CAN control register.
The configuration of a message object is done by programming mask, arbitration, control and data fields of one of the two interface register sets to the desired values. By writing to the corresponding IFx command request register, the IFx message buffer registers are loaded into the addressed message object in the message RAM.

When the Init bit in the CAN control register is cleared, the CAN protocol controller state machine of the CAN core and the message handler state machine control the C-CAN's internal data flow. Received messages that pass the acceptance filtering are stored into the message RAM, messages with pending transmission request are loaded into the CAN core's shift register and are transmitted via the CAN bus.

The CPU reads received messages and updates messages to be transmitted via the IFx interface registers. Depending on the configuration, the CPU is interrupted on certain CAN message and CAN error events.

### 18.9.2 Message handler state machine

The message handler controls the data transfer between the Rx/Tx shift register of the CAN core, the message RAM and the IFx registers.

The message handler FSM controls the following functions:

- data transfer from IFx registers to the message RAM
- data transfer from message RAM to the IFx registers
- data transfer from shift register to the message RAM
- data transfer from message RAM to shift register
- data transfer from shift register to the acceptance filtering unit
- scanning of message RAM for a matching message object
- handling of TxRqst flags.
- handling of interrupts.


## Data transfer from and to message RAM

When the CPU initiates a data transfer between the IFx registers and message RAM, the message handler sets the Busy bit in the respective command register to ' 1 '. After the transfer has completed, the Busy bit is set back to ' 0 ' (see Figure 62).

The respective command mask register specifies whether a complete message object or only parts of it are transferred. Due to the structure of the message RAM it is not possible to write single bits/bytes of one message object, it is always necessary to write a complete message object into the message RAM. Therefore, the data transfer from the IFx registers to the message RAM requires a read-modify-write cycle. First, those parts of the message object that are not to be changed are read from the Message RAM and, then, the complete contents of the message buffer registers are into the message object.

Figure 62. Data transfer between IFx registers and message RAM


After the partial write of a message object, the message buffer registers that are not selected in the command mask register are set to the actual contents of the selected message object.
After the partial read of a message object, the message buffer registers that are not selected in the command mask register are left unchanged.

## Transmission of messages

If the shift register of the CAN core cell is ready for loading and if there is no data transfer between the IFx registers and message RAM, the MsgVal bits in the message valid register TxRqst bits in the transmission request register are evaluated. The valid message object with the highest priority pending transmission request is loaded into the shift register by the message handler and the transmission is started. The message object's NewDat bit is reset.

After a successful transmission and if no new data was written to the message object (NewDat = ' 0 ') since the start of the transmission, the TxRqst bit is reset. If TxIE is set, IntPnd is set after a successful transmission. If the C-CAN has lost the arbitration or if an error occurred during the transmission, the message is retransmitted as soon as the CAN bus is free again. If, meanwhile, the transmission of a message with higher priority is requested, the messages are transmitted in the order of their priority.

## Acceptance filtering of received messages

When the arbitration and control field (Identifier + IDE + RTR + DLC) of an incoming message is completely shifted into the $\mathrm{Rx} / \mathrm{Tx}$ shift register of the CAN core, the message handler FSM starts the scanning of the message RAM for a matching valid message object.

To scan the message RAM for a matching message object, the acceptance filtering unit is loaded with the arbitration bits from the CAN core shift register. The arbitration and mask fields (including MsgVal, UMask, NewDat, and EoB) of message object 1 are loaded into the acceptance filtering unit and compared with the arbitration field from the shift register. This is repeated with each following message object until a matching message object is found or until the end of the message RAM is reached.
If a match occurs, the scanning is stopped and the message handler FSM proceeds depending on the type of frame (data frame or remote frame) received.

## Reception of data frame

The message handler FSM stores the message from the CAN core shift register into the respective message object in the message RAM. Not only the data bytes, but all arbitration bits and the data length code are stored into the corresponding message object. This is implemented to keep the data bytes connected with the identifier even if arbitration mask registers are used.

The NewDat bit is set to indicate that new data (not yet seen by the CPU) has been received. The CPU resets NewDat when it reads the message object. If, at the time of the reception, the NewDat bit was already set, MsgLst is set to indicate that the previous data (supposedly not seen by the CPU) is lost. If the RxIE bit is set, the IntPnd bit is set, causing the interrupt register to point to this message object.

The TxRqst bit of this message object is reset to prevent the transmission of a remote frame, while the requested data frame has just been received.

## Reception of remote frame

When a remote frame is received, three different configurations of the matching message object have to be considered:

1. $\quad$ Dir $=$ ' 1 ' (direction $=$ transmit), RmtEn $=$ ' 1 ', UMask $=$ ' 1 ' or ' 0 ' At the reception of a matching remote frame, the TxRqst bit of this message object is set. The rest of the message object remains unchanged.
2. $\operatorname{Dir}=$ ' 1 ' (direction = transmit), RmtEn = ' 0 ', UMask = '0' At the reception of a matching remote frame, the TxRqst bit of this message object remains unchanged; the remote frame is ignored.
3. $\operatorname{Dir}=$ ' 1 ' (direction = transmit), RmtEn = '0', UMask = '1'

At the reception of a matching remote frame, the TxRqst bit of this message object is reset. The arbitration and control field (Identifier + IDE + RTR + DLC) from the shift register is stored into the message object in the message RAM and the NewDat bit of this message object is set. The data field of the message object remains unchanged; the remote frame is treated similar to a received data frame.

## Receive/transmit priority

The receive/transmit priority for the message objects is attached to the message number. Message object 1 has the highest priority, while message object 32 has the lowest priority. If more than one transmission request is pending, they are serviced according to the priority of the corresponding message object.

### 18.9.3 Configuration of a transmit object

Figure 63 shows how a transmit object is initialized.
Figure 63. Initialisation of a transmit object

| MsgVal | Arb | Data | Mask | EoB | Dir | NewDat | MsgLst | RxIE | TxIE | IntPnd | RmtEn | TxRqst |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | appl. | appl. | appl. | 1 | 1 | 0 | 0 | 0 | appl. | 0 | appl. | 0 |

The arbitration registers (ID28-0 and Xtd bit) are given by the application. They define the identifier and type of the outgoing message. If an 11-bit identifier ("standard frame") is used, it is programmed to ID28-ID18, ID17 - ID0 can be disregarded.

If the TxIE bit is set, the IntPnd bit is be set after a successful transmission of the message object.
If the RmtEn bit is set, a matching received remote frame causes the TxRqst bit to be set; the remote frame is autonomously answered by a Data Frame.

The data registers (DLC3-0, Data0-7) are given by the application, TxRqst and RmtEn may not be set before the data is valid.

The mask registers (Msk28-0, UMask, MXtd, and MDir bits) may be used (UMask='1') to allow groups of remote frames with similar identifiers to set the TxRqst bit. For details see Section 18.9.2, handle with care; the Dir bit should not be masked.

### 18.9.4 Updating a transmit object

The CPU may update the data bytes of a transmit object any time via the IFx interface registers, neither MsgVal nor TxRqst need be reset before the update.

Even if only a part of the data bytes are to be updated, all four bytes of the corresponding IFx Data A Register or IFx Data B Register have to be valid before the content of that register is transferred to the message object. Either the CPU has to write all four bytes into
the IFx data register or the message object is transferred to the IFx data register before the CPU writes the new data bytes.

When only the (eight) data bytes are updated, first, $0 \times 0087$ is written to the command mask register and, then, the number of the message object is written to the command request register, concurrently updating the data bytes and setting TxRqst.

To prevent the reset of TxRqst at the end of a transmission that may already be in progress while the data is updated, NewDat is set together with TxRqst. For details see Section 18.9.2.

When NewDat is set together with TxRqst, NewDat is reset as soon as the new transmission has started.

### 18.9.5 Configuration of a receive object

Figure 64 shows how a receive object is initialized.
Figure 64. Initialization of a receive object

| MsgVal | Arb | Data | Mask | EoB | Dir | NewDat | MsgLst | RxIE | TxIE | IntPnd | RmtEn | TxRqst |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | appl. | appl. | appl. | 1 | 0 | 0 | 0 | appl. | 0 | 0 | 0 | 0 |

The arbitration registers (ID28-0 and Xtd bit) are given by the application. They define the identifier and type of accepted received messages. If an 11-bit Identifier ("standard frame") is used, it is programmed to ID28-ID18, ID17-ID0 can then be disregarded. When a data frame with an 11-bit Identifier is received, ID17 - ID0 is set to ' 0 '.
If the RxIE bit is set, the IntPnd bit is set when a received data frame is accepted and stored in the message object.

The data length code (DLC3-0) is given by the application. When the message handler stores a data frame in the message object, it stores the received data length code and eight data bytes. If the data length code is less than eight, the remaining bytes of the message object are overwritten by non specified values.

The mask registers (Msk28-0, UMask, MXtd, and MDir bits) may be used (UMask='1') to allow groups of data frames with similar identifiers to be accepted. For details see Section 18.9.2. The Dir bit should not be masked in typical applications.

### 18.9.6 Handling of received messages

The CPU may read a received message any time via the IFx interface registers, the data consistency is guaranteed by the message handler state machine.
Typically, the CPU first writes 0x007F to the command mask register and then writes the number of the message object to the command request register. This combination transfers the whole received message from the message RAM into the message buffer register. Additionally, the bits NewDat and IntPnd are cleared in the message RAM (not in the message buffer).
If the message object uses masks for acceptance filtering, the arbitration bits show which of the matching messages has been received.

The actual value of NewDat shows whether a new message has been received since last time this message object was read. The actual value of MsgLst shows whether more than
one message has been received since last time this message object was read. MsgLst is not automatically reset.
By a remote frame, the CPU may request another CAN node to provide new data for a receive object. Setting the TxRqst bit of a receive object causes the transmission of a remote frame with the receive object's identifier. This remote frame triggers the other CAN node to start the transmission of the matching data frame. If the matching data frame is received before the remote frame could be transmitted, the TxRqst bit is automatically reset.

### 18.9.7 Configuration of a FIFO buffer

With the exception of the EoB bit, the configuration of receive objects belonging to a FIFO buffer is the same as the configuration of a (single) receive object, see Section 18.9.5.

To concatenate two or more message objects into a FIFO buffer, the identifiers and masks (if used) of these message objects have to be programmed to matching values. Due to the implicit priority of the message objects, the message object with the lowest number will be the first message object of the FIFO buffer. The EoB bit of all message objects of a FIFO buffer except the last have to be programmed to zero. The EoB bits of the last message object of a FIFO buffer is set to one, configuring it as the end of the block.

### 18.9.8 Reception of messages with FIFO buffers

Received messages with identifiers matching to a FIFO buffer are stored into a message object of this FIFO buffer starting with the message object with the lowest message number.

When a message is stored into a message object of a FIFO buffer, the NewDat bit of this message object is set. By setting NewDat while EoB is zero, the message object is locked for further write accesses by the message handler until the CPU has written the NewDat bit back to zero.

Messages are stored into a FIFO buffer until the last message object of this FIFO buffer is reached. If none of the preceding message objects is released by writing NewDat to zero, all further messages for this FIFO buffer are written into the last message object of the FIFO buffer and, therefore, overwrite previous messages.

## Reading from a FIFO buffer

When the CPU transfers the contents of message object to the IFx message buffer registers by writing its number to the IFx command request register, the corresponding command mask register is programmed such that bits NewDat and IntPnd are reset to zero (TxRqst/NewDat = '1' and CIrIntPnd = '1'). The values of these bits in the message control register always reflect the status before resetting the bits.

To assure the correct function of a FIFO buffer, the CPU reads out the message objects starting at the FIFO Object with the lowest message number.

Figure 65 shows how a set of message objects which are concatenated to a FIFO buffer can be handled by the CPU.

Figure 65. CPU Handling of a FIFO Buffer


### 18.9.9 Handling of interrupts

If several interrupts are pending, the CAN interrupt register points to the pending interrupt with the highest priority, disregarding their chronological order. An interrupt remains pending until the CPU has cleared it.

The status interrupt has the highest priority. Among the message interrupts, the message object' s interrupt priority decreases with increasing message number.

A message interrupt is cleared by clearing the message object's IntPnd bit. The status interrupt is cleared by reading the status register.

The interrupt identifier Intld in the interrupt register indicates the cause of the interrupt. When no interrupt is pending, the register holds the value zero. If the value of the interrupt register is not zero, there is an interrupt pending and, if IE is set, the interrupt line to the CPU, IRQ_B, is active. The interrupt line remains active until the interrupt register is back to value zero (the cause of the interrupt is reset) or until IE is reset.

The value $0 x 8000$ indicates that an interrupt is pending because the CAN core has updated (not necessarily changed) the status register (error interrupt or status interrupt). This interrupt has the highest priority. The CPU can update (reset) the status bits RxOk, TxOk and LEC, but a write access of the CPU to the status register can never generate or reset an interrupt.

All other values indicate that the source of the interrupt is one of the message objects, Intld points to the pending message interrupt with the highest interrupt priority.
The CPU controls whether a change of the status register may cause an interrupt (bits EIE and SIE in the CAN control register) and whether the interrupt line becomes active when the interrupt register is not zero (bit IE in the CAN control register). The interrupt register is updated even when IE is reset.

The CPU has two possibilities to follow the source of a message interrupt. First it can follow the Intld in the interrupt register and second it can poll the interrupt pending register (see Section 18.8.5).

An interrupt service routine reading the message that is the source of the interrupt may read the message and reset the message object's IntPnd at the same time (bit CIrIntPnd in the command mask register). When IntPnd is cleared, the interrupt register points to the next message object with a pending interrupt.

### 18.9.10 Configuration of bit timing

Even if minor errors in the configuration of the CAN bit timing do not result in immediate failure, the performance of a CAN network can be reduced significantly.

In many cases, the CAN bit synchronization amends a faulty configuration of the CAN bit timing to such a degree that only an occasional error frame is generated. In the case of arbitration however, when two or more CAN nodes simultaneously try to transmit a frame, a misplaced sample point may cause one of the transmitters to become error passive.
The analysis of such sporadic errors requires a detailed knowledge of the CAN bit synchronization inside a CAN node and of the CAN nodes' interaction on the CAN bus.

## Bit time and bit rate

CAN supports bit rates in the range of lower than $1 \mathrm{kBit} / \mathrm{s}$ up to $1000 \mathrm{kBit} / \mathrm{s}$. Each member of the CAN network has its own clock generator, usually a quartz oscillator. The timing parameter of the bit time (that is, the reciprocal of the bit rate) can be configured individually for each CAN node, creating a common bit rate even though the CAN nodes' oscillator periods ( $\mathrm{f}_{\mathrm{osc}}$ ) may be different.

The frequencies of these oscillators are not absolutely stable, small variations are caused by changes in temperature or voltage and by deteriorating components. As long as the variations remain inside a specific oscillator tolerance range (df), the CAN nodes are able to compensate for the different bit rates by resynchronising to the bit stream.

According to the CAN specification, the bit time is divided into four segments (see
Figure 66):

1. the synchronization segment
2. the propagation time segment
3. the phase buffer segment 1
4. the phase buffer segment 2.

Each segment consists of a specific, programmable number of time quanta (see Table 110). The length of the time quantum $\left(\mathrm{t}_{\mathrm{q}}\right)$, which is the basic time unit of the bit time, is defined by the CAN controller's system clock $f_{\text {sys }}$ and the baud rate prescaler (BRP): $t_{q}=B R P / f_{\text {sys }}$. The C-CAN's system clock $\mathrm{f}_{\text {sys }}$ is the frequency of its CAN module clock input.
The synchronization segment, Sync_Seg, is that part of the bit time where edges of the CAN bus level are expected to occur; the distance between an edge that occurs outside of Sync_Seg and the Sync_Seg is called the phase error of that edge. The propagation time segment, Prop_Seg, is intended to compensate for the physical delay times within the CAN network. The phase buffer segments, Phase_Seg1 and Phase_Seg2, surround the sample point. the (re-)synchronisation jump width (SJW) defines how far a resynchronisation may move the sample point inside the limits defined by the phase buffer segments to compensate for edge phase errors.

Figure 66. Bit timing


Table 110. Parameters of the CAN bit time

| Parameter | Range | Remark |  |
| :--- | :---: | :--- | :---: |
| BRP | $[1 . .32]$ | defines the length of the time quantum $\mathrm{t}_{\mathrm{q}}$ |  |
| Sync_Seg | $1 \mathrm{t}_{\mathrm{q}}$ | fixed length, synchronisation of bus input to system clock |  |
| Prop_Seg | $[1 . .8] \mathrm{t}_{\mathrm{q}}$ | compensates for the physical delay times |  |
| Phase_Seg1 | $[1 . .8] \mathrm{t}_{\mathrm{q}}$ | may be lengthened temporarily by synchronisation |  |
| Phase_Seg2 | $[1 . .8] \mathrm{t}_{\mathrm{q}}$ | may be shortened temporarily by synchronisation |  |
| SJW | $[1 . .4] \mathrm{t}_{\mathrm{q}}$ | may not be longer than either Phase Buffer Segment |  |
| This table describes the minimum programmable ranges required by the CAN protocol |  |  |  |

A given bit rate may be met by different bit time configurations but, for the proper function of the CAN network, the physical delay times and the oscillator's tolerance range have to be considered.

## Propagation time segment

This part of the bit time is used to compensate physical delay times within the network. These delay times consist of the signal propagation time on the bus and the internal delay time of the CAN nodes.

Any CAN node synchronized to the bit stream on the CAN bus is out of phase with the transmitter of that bit stream, caused by the signal propagation time between the two nodes. The CAN protocol's non-destructive bitwise arbitration and the dominant acknowledge bit provided by receivers of CAN messages require that a CAN node transmitting a bit stream must also be able to receive dominant bits transmitted by other CAN nodes that are synchronized to that bit stream. The example in Figure 67 shows the phase shift and propagation times between two CAN nodes.

Figure 67. The propagation time segment


In this example, both nodes $A$ and $B$ are transmitters performing an arbitration for the CAN bus. The node $A$ has sent its start of frame bit less than one bit time earlier than node $B$, therefore, node $B$ has synchronized itself to the received edge from recessive to dominant. Since node B has received this edge delay(A_to_B) after it has been transmitted, B's bit timing segments are shifted with regard to $A$. Node B sends an identifier with higher priority and so it wins the arbitration at a specific identifier bit when it transmits a dominant bit while node $A$ transmits a recessive bit. The dominant bit transmitted by node $B$ arrives at node $A$ after the delay(B_to_A).

Due to oscillator tolerances, the actual position of node A's sample point can be anywhere inside the nominal range of node A's phase buffer segments, so the bit transmitted by node B must arrive at node A before the start of Phase_Seg1. This condition defines the length of Prop_Seg.

If the edge from recessive to dominant transmitted by node $B$ arrives at node $A$ after the start of Phase_Seg1, it could happen that node A samples a recessive bit instead of a dominant bit, resulting in a bit error and the destruction of the current frame by an error flag.

The error occurs only when two nodes arbitrate for the CAN bus that have oscillators of opposite ends of the tolerance range and that are separated by a long bus line; this is an example of a minor error in the bit timing configuration (Prop_Seg too short) that causes sporadic bus errors.

Some CAN implementations provide an optional three-sample mode The C-CAN does not. In this mode, the CAN bus input signal passes a digital low-pass filter, using three samples and a majority logic to determine the valid bit value. This results in an additional input delay of $1 t_{q}$, requiring a longer Prop_Seg.

## Phase buffer segments and synchronisation

The phase buffer segments (Phase_Seg1 and Phase_Seg2) and the synchronisation jump width (SJW) are used to compensate for the oscillator tolerance. The phase buffer segments may be lengthened or shortened by synchronisation.

Synchronizations occur on edges from recessive to dominant, their purpose is to control the distance between edges and sample points.

Edges are detected by sampling the actual bus level in each time quantum and comparing it with the bus level at the previous sample point. A synchronisation may be done only if a recessive bit was sampled at the previous sample point and if the actual time quantum's bus level is dominant.

An edge is synchronous if it occurs inside of Sync_Seg, otherwise the distance between edge and the end of Sync_Seg is the edge phase error, measured in time quanta. If the edge occurs before Sync_Seg, the phase error is negative, else it is positive.
Two types of synchronisation exist: hard synchronisation and resynchronisation. A hard synchronisation is done once at the start of a frame; inside a frame only resynchronisations occur.

## - Hard synchronisation

After a hard synchronisation, the bit time is restarted with the end of Sync_Seg, regardless of the edge phase error. Thus hard synchronisation forces the edge which has caused the hard synchronisation to lie within the synchronisation segment of the restarted bit time.

## - Bit resynchronisation

Resynchronisation leads to a shortening or lengthening of the bit time such that the position of the sample point is shifted with regard to the edge.
When the phase error of the edge which causes resynchronisation is positive, Phase_Seg1 is lengthened. If the magnitude of the phase error is less than SJW, Phase_Seg1 is lengthened by the magnitude of the phase error, else it is lengthened by SJW.
When the phase error of the edge which causes resynchronisation is negative, Phase_Seg2 is shortened. If the magnitude of the phase error is less than SJW, Phase_Seg2 is shortened by the magnitude of the phase error, else it is shortened by SJW.

When the magnitude of the phase error of the edge is less than or equal to the programmed value of SJW, the results of hard synchronisation and resynchronisation are the same. If the magnitude of the phase error is larger than SJW, the resynchronisation cannot compensate the phase error completely, an error of (phase error - SJW) remains.
Only one synchronisation may be done between two sample points. The synchronisations maintain a minimum distance between edges and sample points, giving the bus level time to stabilize and filtering out spikes that are shorter than (Prop_Seg + Phase_Seg1).
Apart from noise spikes, most synchronisations are caused by arbitration. All nodes synchronize "hard" on the edge transmitted by the "leading" transceiver that started transmitting first, but due to propagation delay times, they cannot become ideally synchronized. The "leading" transmitter does not necessarily win the arbitration, therefore the receivers have to synchronize themselves to different transmitters that subsequently "take the lead" and that are differently synchronized to the previously "leading" transmitter. The same happens at the acknowledge field, where the transmitter and some of the
receivers will have to synchronize to that receiver that "takes the lead" in the transmission of the dominant acknowledge bit.

Synchronisations after the end of the arbitration are caused by oscillator tolerance, when the differences in the oscillator's clock periods of transmitter and receivers sum up during the time between synchronisations (at most ten bits). These summarized differences may not be longer than the SJW, limiting the oscillator's tolerance range.
The examples in Figure 68 show how the phase buffer segments are used to compensate for phase errors. There are three drawings of each two consecutive bit timings. The upper drawing shows the synchronisation on a "late" edge, the lower drawing shows the synchronisation on an "early" edge, and the middle drawing is the reference without synchronisation.

Figure 68. Synchronisation on "late" and "early" edges


In the first example an edge from recessive to dominant occurs at the end of Prop_Seg. The edge is "late" since it occurs after the Sync_Seg. Reacting to the "late" edge, Phase_Seg1 is lengthened so that the distance from the edge to the sample point is the same as it would have been from the Sync_Seg to the sample point if no edge had occurred. The phase error of this "late" edge is less than SJW, so it is fully compensated and the edge from dominant to recessive at the end of the bit, which is one nominal bit time long, occurs in the Sync_Seg.
In the second example an edge from recessive to dominant occurs during Phase_Seg2. The edge is "early" since it occurs before a Sync_Seg. Reacting to the "early" edge, Phase_Seg2 is shortened and Sync_Seg is omitted, so that the distance from the edge to the sample point is the same as it would have been from an Sync_Seg to the sample point if no edge had occurred. As in the previous example, the magnitude of this "early" edge's phase error is less than SJW, so it is fully compensated.
The phase buffer segments are lengthened or shortened temporarily only; at the next bit time, the segments return to their nominal programmed values.

In these examples, the bit timing is seen from the point of view of the CAN implementation's state machine, where the bit time starts and ends at the sample points. The state machine
omits Sync_Seg when synchronizing on an "early" edge because it cannot subsequently redefine that time quantum of Phase_Seg2 where the edge occurs to be the Sync_Seg.
The examples in Figure 69 show how short dominant noise spikes are filtered by synchronisations. In both examples the spike starts at the end of Prop_Seg and has the length of (Prop_Seg + Phase_Seg1).

Figure 69. Filtering of short dominant spikes


In the first example, the synchronisation jump width is greater than or equal to the phase error of the spike's edge from recessive to dominant. Therefore, the sample point is shifted after the end of the spike; a recessive bus level is sampled.

In the second example, SJW is shorter than the phase error, so the sample point cannot be shifted far enough; the dominant spike is sampled as actual bus level.

## Oscillator tolerance range

The oscillator tolerance range was increased when the CAN protocol was developed from version 1.1 to version 1.2 (version 1.0 was never implemented in silicon). The option to synchronize on edges from dominant to recessive became obsolete, only edges from recessive to dominant are considered for synchronisation. The protocol update to version 2.0 ( $A$ and $B$ ) had no influence on the oscillator tolerance.

The tolerance range df for an oscillator's frequency $f_{\text {osc }}$ around the nominal frequency $f_{\text {nom }}$ with $(1-\mathrm{df}) \bullet \mathrm{f}_{\text {nom }} \mathrm{S}_{\mathrm{osc}} \leq(1+\mathrm{df}) \bullet \mathrm{f}_{\text {nom }}$ depends on the proportions of Phase_Seg1, Phase_Seg2, SJW, and the bit time. The maximum tolerance df is the defined by two conditions (both must be met):

$$
\begin{aligned}
& \text { I: } \quad \mathrm{df}=\frac{\text { min(Phase_Seg1, Phase_Seg2) }}{2 \cdot(13 \cdot \text { bit_time }- \text { Phase_Seg2) }} \\
& \text { II: } \quad \mathrm{df}=\frac{\text { SJW }}{20 \cdot \text { bit_time }}
\end{aligned}
$$

It has to be considered that SJW may not be larger than the smaller of the phase buffer segments and that the propagation time segment limits that part of the bit time that may be used for the phase buffer segments.

The combination Prop_Seg = 1 and Phase_Seg1 = Phase_Seg2 = SJW = 4 allows the largest possible oscillator tolerance of $1.58 \%$. This combination with a propagation time segment of only $10 \%$ of the bit time is not suitable for short bit times; it can be used for bit rates of up to $125 \mathrm{kBit} / \mathrm{s}$ (bit time $=8 \mu \mathrm{~s}$ ) with a bus length of 40 m .

## Configuration of the CAN protocol controller

In most CAN implementations and also in the C-CAN, the bit timing configuration is programmed in two register bytes. The sum of Prop_Seg and Phase_Seg1 (as TSEG1) is combined with Phase_Seg2 (as TSEG2) in one byte, SJW and BRP are combined in the other byte (see Figure 70).

In these bit timing registers, the four components TSEG1, TSEG2, SJW, and BRP have to be programmed to a numerical value that is one less than its functional value; so instead of values in the range of [1...n], values in the range of [0...n-1] are programmed. That way, e.g. SJW (functional range of [1...4]) is represented by only two bits.
Therefore the length of the bit time is (programmed values) [TSEG1 + TSEG2 + 3] $\mathrm{t}_{\mathrm{q}}$ or (functional values) [Sync_Seg + Prop_Seg + Phase_Seg1 + Phase_Seg2] $\mathrm{t}_{\mathrm{q}}$.

Figure 70. Structure of the CAN Core's CAN Protocol Controller


The data in the bit timing registers are the configuration input of the CAN protocol controller. The baud rate prescaler (configured by BRP) defines the length of the time quantum, the basic time unit of the bit time; the bit timing logic (configured by TSEG1, TSEG2, and SJW) defines the number of time quanta in the bit time.

The processing of the bit time, the calculation of the position of the sample point, and occasional synchronizations are controlled by the BTL state machine, which is evaluated once each time quantum. The rest of the CAN protocol controller, the bit stream processor (BSP) state machine is evaluated once each bit time, at the sample point.

The shift register serializes the messages to be sent and parallelize received messages. Its loading and shifting is controlled by the BSP.

The BSP translates messages into frames and vice versa. It generates and discards the enclosing fixed format bits, inserts and extracts stuff bits, calculates and checks the CRC code, performs the error management, and decides which type of synchronization is to be used. It is evaluated at the sample point and processes the sampled bus input bit. The time after the sample point that is needed to calculate the next bit to be sent (for example, data bit, CRC bit, stuff bit, error flag, or idle) is called the information processing time (IPT).
The IPT is application specific but may not be longer than $2 t_{q}$; the C-CAN's IPT is $0 t_{q}$. Its length is the lower limit of the programmed length of Phase_Seg2. For a synchronization, Phase_Seg2 may be shortened to a value less than IPT, which does not affect bus timing.

## Calculation of the bit timing parameters

Usually, the calculation of the bit timing configuration starts with a desired bit rate or bit time. The resulting bit time ( $1 /$ bit rate) must be an integer multiple of the system clock period.

The bit time may consist of 4 to 25 time quanta, the length of the time quantum $t_{q}$ is defined by the baud rate prescaler with $\mathrm{t}_{\mathrm{q}}=$ (Baud Rate Prescaler)/f $\mathrm{f}_{\text {sys }}$. Several combinations may lead to the desired bit time, allowing iterations of the following steps.

The first part of the bit time to be defined is the Prop_Seg. Its length depends on the delay times measured in the system. A maximum bus length as well as a maximum node delay has to be defined for expandible CAN bus systems. The resulting time for Prop_Seg is converted into time quanta (rounded up to the nearest integer multiple of $\mathrm{t}_{\mathrm{q}}$ ).
The Sync_Seg is $1 t_{q}$ long (fixed), leaving (bit time - Prop_Seg - 1 ) $\mathrm{t}_{\mathrm{q}}$ for the two phase buffer segments. If the number of remaining $t_{q}$ is even, the phase buffer segments have the same length, Phase_Seg2 = Phase_Seg1, else Phase_Seg2 = Phase_Seg1 +1 .

The minimum nominal length of Phase_Seg2 must be considered as well. Phase_Seg2 may not be shorter than the CAN controller's information processing time, which is, depending on the actual implementation, in the range of $[0 . .2] \mathrm{t}_{\mathrm{q}}$.
The length of the synchronization jump width is set to its maximum value, which is the minimum of four and Phase_Seg1.

The oscillator tolerance range necessary for the resulting configuration is calculated by the formulae given in Section 18.9.10

If more than one configuration is possible, that configuration allowing the highest oscillator tolerance range should be chosen.

CAN nodes with different system clocks require different configurations to come to the same bit rate. The calculation of the propagation time in the CAN network, based on the nodes with the longest delay times, is done once for the whole network.
The CAN system's oscillator tolerance range is limited by that node with the lowest tolerance range.
The calculation may show that bus length or bit rate have to be decreased or that the oscillator frequencies' stability has to be increased in order to find a protocol compliant configuration of the CAN bit timing.
The resulting configuration is written into the bit timing register:
(Phase_Seg2-1) and (Phase_Seg1 + Prop_Seg-1) and (SynchronisationJumpWidth - 1) and (Prescaler-1).

## Example for bit timing at high baud rate

In this example, the frequency of CAN module clock is $10 \mathrm{MHz}, \mathrm{BRP}$ is 0 , the bit rate is $1 \mathrm{MBit} / \mathrm{s}$.
$t_{q}$
delay of bus driver
delay of receiver circuit
delay of bus line (40m)
$t_{\text {Prop }}$
$t_{\text {SJW }}$
$\mathrm{t}_{\text {TSeg } 1} \quad 700 \mathrm{~ns}=\mathrm{t}_{\text {Prop }}+\mathrm{t}_{\text {SJW }}$
$\mathrm{t}_{\text {TSeg2 }} 200 \mathrm{~ns}=$ Information Processing Time $+1 \cdot \mathrm{t}_{\mathrm{q}}$
$t_{\text {Sync-Seg }}$
$100 \mathrm{~ns}=1 \times \mathrm{t}_{\mathrm{q}}$
bit time
100 ns $=\mathrm{t}_{\text {CAN_CLK }}$
50 ns
30 ns
220 ns
$600 \mathrm{~ns}=6 \times \mathrm{t}_{\mathrm{q}}$
$100 \mathrm{~ns}=1 \times \mathrm{t}_{\mathrm{q}}$
$1000 \mathrm{~ns}=\mathrm{t}_{\text {Sync-Seg }}+\mathrm{t}_{\mathrm{TSeg} 1}+\mathrm{t}_{\mathrm{TSeg} 2}$
tolerance for CAN clock $0.39 \%=\frac{\min (P B 1, P B 2)}{? \cdot(13 \cdot \text { bit_time }- \text { PB2 }}$

$$
=\frac{0.1 \mu \mathrm{~s}}{\underline{2} \cdot(13 \cdot 1 \mu \mathrm{~s}-0.2 \mu \mathrm{~s})}
$$

In this example, the concatenated bit time parameters are $(2-1)_{3} \&(7-1)_{4} \&(1-1)_{2} \&(1-1)_{6}$, the bit timing register is programmed to $=0 \times 1600$.

## Example for bit timing at low baud rate

In this example, the frequency of CAN module clock is $2 \mathrm{MHz}, \mathrm{BRP}$ is 1 , the bit rate is $100 \mathrm{KBit} / \mathrm{s}$.

| $\mathrm{t}_{\mathrm{q}}$ | 1 | $\mu \mathrm{s}$ | $=2 \times t_{\text {CAN_CLK }}$ |
| :---: | :---: | :---: | :---: |
| delay of bus driver | 200 | ns |  |
| delay of receiver circuit | 80 | ns |  |
| delay of bus line (40m) | 220 | ns |  |
| $t_{\text {Prop }}$ | 1 | $\mu \mathrm{s}$ | $=1 \times t_{\text {q }}$ |
| $t_{\text {SJW }}$ | 4 | $\mu \mathrm{s}$ | $=4 \times \mathrm{t}_{\mathrm{q}}$ |
| $t_{\text {TSeg1 }}$ | 5 | $\mu \mathrm{s}$ | $=t_{\text {Prop }}+t_{\text {SJW }}$ |
| $\mathrm{t}_{\text {TSeg2 }}$ | 4 | $\mu \mathrm{s}$ | $=$ Information Processing Time $+3 \cdot \mathrm{t}_{\mathrm{q}}$ |
| $t_{\text {Sync-Seg }}$ | 1 | $\mu \mathrm{s}$ | $=1 \times t_{\text {q }}$ |
| bit time | 10 | $\mu \mathrm{s}$ | $=t_{\text {Sync-Seg }}+t_{\text {TSeg } 1}+t_{\text {TSeg2 }}$ |
| tolerance for CAN clock | 1.58 | \% | $=\frac{\min (\mathrm{PB} 1, \mathrm{~PB} 2)}{2 \cdot(13 \cdot \text { bit_time }-\mathrm{PB} 2}$ |

In this example, the concatenated bit time parameters are $(4-1)_{3} \&(5-1)_{4} \&(4-1)_{2} \&(2-1)_{6}$, the bit timing register is programmed to $=0 \times 34 \mathrm{C} 1$.

## 19 Watchdog timer

The watchdog timer is a fail-safe mechanism which prevents the microcontroller from malfunctioning for long periods of time. The watchdog timer is always enabled after a reset of the chip (just after PORTO latching) and can only be disabled in the time interval until the EINIT (end of initialization) instruction has been executed. Therefore, the chip's start-up procedure is always monitored. The software is designed to service the watchdog timer before it overflows. If, due to hardware or software related failures, the software fails to do so, the watchdog timer overflows and generates an internal hardware reset. It pulls the RSTOUT pin low to allow external hardware components to be reset.

Each of the different reset sources is indicated in the WDTCON register. The indicated bits are cleared with the EINIT instruction. It is, thus, possible to identify the reset during the initialization phase. The mechanism only detects a failure on the internal 1.8 V , not on the external power supply ( $\mathrm{V}_{\mathrm{DD}}$ ).

## WDTCON register



Table 111. WDTCON register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 0 | WDTIN | Watchdog timer input frequency selection <br> '0': Input frequency is $\mathrm{f}_{\mathrm{CPU}} / 2$. <br> '1': Input frequency is $\mathrm{f}_{\mathrm{CPU}} / 128$. |
| 1 | WDTR ${ }^{(1)(3)}$ | Watchdog timer reset indication flag <br> Set by the watchdog timer on an overflow. Cleared by a hardware reset <br> or by the SRVWDT instruction. |
| 2 | SWR $^{(1)(3)}$ | Software reset indication flag <br> Set by the SRST execution. Cleared by the EINIT instruction. |
| 3 | SHWR $^{(1)(3)}$ | Short hardware reset indication flag <br> Set by the input $\overline{\text { RSTIN. Cleared by the EINIT instruction. }}$ |
| 4 | LHWR $^{(1)(3)}$ | Long hardware reset indication flag <br> Set by the input $\overline{\text { RSTIN. Cleared by the EINIT instruction. }}$ |
| 5 | PONR $^{(1)(2)(3)}$ | Power-on (asynchronous) reset indication flag <br> Set by the input $\overline{\text { RSTIN if a power-on condition has been detected. }}$ <br> Cleared by the EINIT instruction. |
| $15: 8$ | WDTREL $^{2}$ | Watchdog timer reload value (for the high byte) |

1. More than one reset indication flag may be set. After EINIT, all flags are cleared.
2. Power-on is detected when a ramp on internal 1.8 V (generated by the on-chip voltage regulator) is detected.
3. These bits cannot be directly modified by software.

Table 112. Reset flag settings

| Reset Source | PONR | LHWR | SHWR | SWR | WDTR |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Power On Reset | X | X | X | X |  |
| Power On after a partial supply failure | (see Note) | X | X | X |  |
| Long Hardware Reset |  | X | X | X |  |
| Short Hardware Reset |  |  | X | X |  |
| Software Reset |  |  |  | X |  |
| Watchdog Reset |  |  |  | X | X |

Note: $\quad$ PONR bit may not be set for short supply failure.
If a bi-directional reset is enabled and if the $\overline{R S T I N}$ pin is latched low after the end of the internal reset sequence, a short hardware reset, a software reset or a watchdog reset triggers a long hardware reset. Thus, reset indications flags are set to indicate a long hardware reset.

## 20 System reset

System reset initializes the device in a predefined state. There are many ways to activate a reset state. The system start-up configuration is different for each case as shown in Table 113. The reset history is flagged inside WDTCON register (see also Chapter 19 for additional details).

Table 113. Reset event definition

| Reset Source | Flag | RPD Status | Conditions |
| :---: | :---: | :---: | :---: |
| Power-on reset | PONR | Low | Power-on |
| Asynchronous hardware reset |  | Low | $t_{\text {RSTIN }}>{ }^{(1)}$ |
| Synchronous long hardware reset | LHWR | High | $\begin{aligned} & \text { t } \begin{array}{l} \text { tSTIN } \\ 500 \mathrm{~ns}) \end{array} \text { (1032 + 12) TCL }+\max (4 \mathrm{TCL}, \end{aligned}$ |
| Synchronous short hardware reset ${ }^{(2)}$ | SHWR | High | $\begin{aligned} & \mathrm{t}_{\mathrm{RSTIN}}>\max (4 \mathrm{TCL}, 500 \mathrm{~ns}) \\ & \mathrm{t}_{\mathrm{RSTIN}} \leq(1032+12) \mathrm{TCL}+\max (4 \mathrm{TCL}, \\ & 500 \mathrm{~ns}) \end{aligned}$ |
| Watchdog timer reset | WDTR | (3) | WDT overflow |
| Software reset | SWR | (3) | SRST instruction execution |

1. $\overline{\text { RSTIN }}$ pulse should be longer than 500 ns (Filter) and than settling time for configuration of PORTO.
2. See Section 20.1 for more details on minimum reset pulse duration.
3. The RPD status has no influence unless bidirectional reset is activated (bit BDRSTEN in SYSCON): RPD low inhibits the bidirectional reset on SW and WDT reset events, that is $\overline{\text { RSTIN }}$ is not activated (refer to Section 20.4, Section 20.5 and Section 20.6).

### 20.1 Input filter

On RSTIN input pin, there is an on-chip RC filter. This filter is sized to filter all the spikes shorter than 50 ns . A valid pulse must be longer than 500 ns before the ST10 recognizes a reset command. Between 50 ns and 500 ns a pulse can either be filtered or recognized as valid, depending on the operating conditions and process variations.

For this reason all minimum durations, mentioned in this chapter for the different kind of reset events, should be carefully evaluated taking into account of the above requirements.
In particular, for short hardware reset, where only 4 TCL is specified as minimum input reset pulse duration, the operating frequency is a key factor. For example:

- for a CPU clock of $40 \mathrm{MHz}, 4 \mathrm{TCL}$ is 50 ns , so it would be filtered; in this case the minimum becomes the one imposed by the filter (that is 500 ns )
- for a CPU clock of $4 \mathrm{MHz}, 4 \mathrm{TCL}$ is 500 ns ; in this case the minimum from the formula is coherent with the limit imposed by the filter.


### 20.2 Asynchronous reset

An asynchronous reset is triggered when $\overline{\text { RSTIN }}$ pin is pulled low while the RPD pin is low. The ST10F252M is immediately (after the input filter delay) forced in reset default state. It pulls low the RSTOUT pin, it cancels pending internal hold states if any, it aborts all internal/external bus cycles, it switches buses (data, address and control signals) and I/O pin drivers to high-impedance, it pulls high PORT0 pins.

Note: If an asynchronous reset occurs during a read or write phase in internal memories, the content of the memory itself could be corrupted. To avoid this, synchronous reset use is strongly recommended.

## Power-on reset

Asynchronous reset must be used during the power-on of the device. Depending on crystal or resonator frequency, the on-chip oscillator needs about 1 ms to 10 ms to stabilize (refer to Section 27.8.2), with an already stable $\mathrm{V}_{\mathrm{DD}}$. The logic of the ST10F252M does not need a stabilized clock signal to detect an asynchronous reset, so it is suitable for power-on conditions. To ensure a proper reset sequence, the $\overline{\text { RSTIN }}$ pin and the RPD pin must be held at low level until the device clock signal is stabilized and the system configuration value on PORT0 is settled.

At power-on it is important to consider some additional constraints introduced by the start-up phase of the different embedded modules.
In particular the on-chip voltage regulator needs at least 1 ms to stabilize the internal 1.8 V for the core logic - this time is computed from when the external reference ( $\mathrm{V}_{\mathrm{DD}}$ ) becomes stable (inside specification range, that is at least 4.5 V ). This is a constraint for the application hardware (external voltage regulator). The RSTIN pin assertion should be extended to guarantee the voltage regulator stabilization.
A second constraint is imposed by the embedded Flash. When booting from internal memory, starting from the release of $\overline{\text { RSTIN }}$, it needs a maximum of 1 ms for its initialization; before that, the internal reset (RST signal) is not released, so the CPU does not start code execution in internal memory.

Note: $\quad$ This is not true if external memory is used (pin $\overline{E A}$ held low during reset phase). In this case, once $\overline{R S T I N}$ pin is released, and after few CPU clock pulses (filter delay plus 3... 8 TCL), the internal reset signal RST is released, so the code execution can start immediately. Access to the data in internal Flash is forbidden before its initialization phase is completed; an attempted access during the start-up phase returns FFFFh (just at the beginning), while later 009Bh (an illegal opcode trap is generated).
At power-on, the $\overline{\text { RSTIN }}$ pin is tied low for a minimum time that includes also the start-up time of the main oscillator ( $\mathrm{t}_{\text {STUP }}=1 \mathrm{~ms}$ for resonator, 10 ms for crystal) and PLL synchronization time ( $\mathrm{t}_{\text {PSUP }}=200 \mu \mathrm{~s}$ ). This means that, if the internal Flash is used, the $\overline{\text { RSTIN }}$ pin could be released before the main oscillator and PLL are stable to recover some time in the start-up phase (Flash initialization only needs stable $\mathrm{V}_{18}$, but does not need stable system clock since an internal dedicated oscillator is used).

Warning: It is recommended to provide the external hardware with a current limitation circuitry. This is necessary to avoid permanent damage to the device during the power-on transient, when the capacitance on $\mathrm{V}_{18}$ pin is charged. For the on-chip voltage regulator functionality, 10 nF is sufficient. However, a maximum of 100 nF on the $\mathrm{V}_{18}$ pin should not generate problems of over-current (higher value is allowed if current is limited by the external hardware). External current limitation is also recommended to avoid risk of damage in the event of a temporary short between $\mathrm{V}_{18}$ and ground. The internal 1.8 V drivers are sized to drive currents of several tens of Amperes, so the current should be limited by the external hardware. The limit of current is imposed by power dissipation considerations (refer to Section 27.3 for details).

In the next Figure 71 and 72 Asynchronous Power-on timing diagrams are shown, respectively with boot from internal or external memory, highlighting the reset phase extension introduced by the embedded Flash module when selected.

Figure 71. Asynchronous power-on RESET ( $\overline{E A}=1$ )


Figure 72. Asynchronous power-on RESET ( $\overline{E A}=0$ )


1. 3 to 8 TCL depending on clock source selection.

## Hardware reset

The asynchronous reset must be used to recover from catastrophic situations of the application. It may be triggered by the hardware of the application. Internal hardware logic and application circuitry are described in Section 20.7 and Figure 84, Figure 85 and Figure 86. It occurs when RSTIN is low and RPD is detected (or becomes) low as well.

Figure 73. Asynchronous hardware RESET (EA=1)


1. Longer than Port0 settling time + PLL synchronization (if needed, that is $P 0(15: 13)$ changed) Longer than 500 ns to take into account of Input Filter on RSTIN pin

Figure 74. Asynchronous hardware RESET (EA=0)


1. Longer than Port0 settling time + PLL synchronization (if needed, that is $\mathrm{P} 0(15: 13)$ changed) Longer than 500ns to take into account of Input Filter on RSTIN pin
2. 3 to 8 TCL depending on clock source selection.

## Exit from asynchronous reset state

When the $\overline{\text { RSTIN }}$ pin is pulled high, the device restarts. As already mentioned, if internal Flash is used, the restarting occurs after the embedded Flash initialization routine is completed. The system configuration is latched from PORTO: ALE, $\overline{R D}$ and $\overline{W R} / \overline{W R L}$ pins are driven to their inactive level. The ST10F252M starts program execution from memory location 00'0000h in code segment 0 . This starting location will typically points to the general initialization routine. The timing of asynchronous hardware reset sequence are summarized in Figure 73 and Figure 74.

### 20.3 Synchronous reset (warm reset)

A synchronous reset is triggered when $\overline{\text { RSTIN }}$ pin is pulled low while RPD pin is at high level. In order to properly activate the internal reset logic of the device, the $\overline{\text { RSTIN }}$ pin must be held low, at least, during 4 TCL (two periods of CPU clock): refer also to Section 20.1 for details on minimum reset pulse duration. The I/O pins are set to high impedance and $\overline{\text { RSTOUT }}$ pin is driven low. After RSTIN level is detected, a short duration of a maximum of 12 TCL (six periods of CPU clock) elapses, during which pending internal hold states are
cancelled and the current internal access cycle if any is completed. The external bus cycle is aborted. The internal pull-down of RSTIN pin is activated if bit BDRSTEN of SYSCON register was previously set by software. This bit is always cleared on power-on or after a reset sequence.

## Short and long synchronous reset

Once the first maximum 16 TCL are elapsed (4+12 TCL), the internal reset sequence starts. It is 1024 TCL cycles long. At the end of the sequence and after another 8 TCL, the level of $\overline{\text { RSTIN }}$ is sampled (after the filter, see $\overline{\text { RSTF }}$ in the drawings). If it is already at high level, only a short reset is flagged (refer to Chapter 19 for details on reset flags); if it is recognized as still low, a long reset is flagged. The major difference between long and short reset is that during the long reset, $\mathrm{P} 0(15: 13)$ also becomes transparent, so it is possible to change the clock options.

WARNING:


#### Abstract

Warning: For a short pulse on $\overline{\text { RSTIN }}$ pin and when bidirectional reset is enabled, the RSTIN pin is held low by the internal circuitry. At the end of the 1024 TCL cycles, the RTSIN pin is released but, due to the presence of the input analog filter, the internal input reset signal ( $\overline{\text { RSTF }}$ in the drawings) is released later (from 50 to 500 ns ). This delay is in parallel with the additional 8 TCL, at the end of which the internal input reset line ( $\overline{\text { RSTF }}$ ) is sampled, to decide if the reset event is short or long. In particular:


The same behavior occurs also when unidirectional reset is selected and RSTIN pin is held low till the end of the internal sequence (exactly 1024 TCL + max 16 TCL) and released exactly at that time.

- if $8 \mathrm{TCL}>500 \mathrm{~ns}\left(\mathrm{~F}_{\mathrm{CPU}}<8 \mathrm{MHz}\right)$, the reset event is always recognized as Short
- if $8 \mathrm{TCL}<500 \mathrm{~ns}\left(\mathrm{~F}_{\mathrm{CPU}}>8 \mathrm{MHz}\right.$ ), the reset event could be recognized either as Short or Long, depending on the real filter delay (between 50 and 500 ns ) and the CPU frequency ( $\overline{R S T F}$ sampled high means Short reset, $\overline{\text { RSTF sampled low means Long }}$ reset). Note that in case a Long reset is recognized, once the 8 TCL are elapsed, the $\mathrm{P} 0(15: 13)$ pins becomes transparent, so the system clock can be re-configured. The port returns not transparent 3-4 TCL after the internal RSTF signal becomes high.

The same behavior just described, occurs also when unidirectional reset is selected and $\overline{\text { RSTIN }}$ pin is held low till the end of the internal sequence (exactly 1024TCL + max 16 TCL ) and released exactly at that time.

Note: $\quad$ When running with CPU frequency lower than 40 MHz , the minimum valid reset pulse to be recognized by the CPU (4 TCL) could be longer than the minimum analog filter delay (50ns); so it might happen that a short reset pulse is not filtered by the analog input filter, but on the other hand it is not long enough to trigger a CPU reset (shorter than 4 TCL): this would generate a Flash reset but not a system reset. In this condition, the Flash answers always with FFFFh, which leads to an illegal opcode and consequently a trap event is generated.

## Exit from synchronous reset state

The reset sequence is extended until RSTIN level becomes high. Moreover, it is internally prolonged by the Flash initialization when EA=1 (internal memory selected). Then, the code execution restarts. The system configuration is latched from PORTO, and ALE, $\overline{R D}$ and WR/WRL pins are driven to their inactive level. The ST10F252M starts program execution from memory location 00 '0000 h in code segment 0 . This starting location will typically points to the general initialization routine. Timing of synchronous reset sequence is summarized in Figure 75 and Figure 76 where a Short reset event is shown, with particular emphasis on the fact that it can degenerate into Long reset: the two figures show the behavior when booting from internal or external memory respectively. Figure 77 and 78 report the timing of a typical synchronous Long reset, again when booting from internal or external memory.

## Synchronous reset and RPD pin

Whenever the $\overline{\text { RSTIN }}$ pin is pulled low (by external hardware or as a consequence of a Bidirectional reset), the RPD internal weak pull-down is activated. The external capacitance (if any) on the RPD pin is slowly discharged through the internal weak pull-down. If the voltage level on the RPD pin reaches the input low threshold (approximately 2.5 V ), the reset event becomes immediately asynchronous. In case of hardware reset (short or long) the situation goes immediately to the one illustrated in Figure 73. There is no effect if RPD comes again above the input threshold: the asynchronous reset is completed coherently. To correctly complete a synchronous reset, the value of the capacitance should be big enough to maintain a sufficiently high voltage on the RPD pin for the duration of the internal reset sequence.
For a Software or Watchdog reset events, an active synchronous reset is completed regardless of the RPD status.
It is important to highlight that the signal that makes RPD status transparent under reset is the internal RSTF (after the noise filter).

Figure 75. Synchronous short / long hardware RESET (EA=1)


1. $\overline{\text { RSTIN }}$ assertion can be released there. Refer also to Section 21.1 for details on minimum pulse duration.
2. If during the reset condition ( $\overline{\mathrm{RSTIN}}$ low), RPD voltage drops below the threshold voltage (about 2.5 V for 5 V operation), the asynchronous reset is then immediately entered.
3. $\overline{\text { RSTIN }}$ pin is pulled low if bit BDRSTEN (bit 3 of SYSCON register) was previously set by software. Bit BDRSTEN is cleared after reset.
4. Minimum $\overline{\text { RSTIN }}$ low pulse duration shall also be longer than 500 ns to guarantee the pulse is not masked by the internal filter (refer to Section 21.1)

Figure 76. Synchronous short / long hardware RESET ( $\overline{\mathrm{EA}}=\mathbf{0}$ )


1. $\overline{\text { RSTIN }}$ assertion can be released there. Refer also to Section 21.1 for details on minimum pulse duration.
2. If during the reset condition ( $\overline{\mathrm{RSTIN}}$ low), RPD voltage drops below the threshold voltage (about 2.5 V for 5 V operation), the asynchronous reset is then immediately entered.
3. 3 to 8 TCL depending on clock source selection.
4. $\overline{R S T I N}$ pin is pulled low if bit BDRSTEN (bit 3 of SYSCON register) was previously set by software. Bit BDRSTEN is cleared after reset.
5. Minimum $\overline{\text { RSTIN }}$ low pulse duration shall also be longer than 500 ns to guarantee the pulse is not masked by the internal filter (refer to Section 21.1).

Figure 77. Synchronous long hardware RESET ( $\overline{\mathrm{EA}}=1$ )


1. If during the reset condition ( $\overline{\mathrm{RSTIN}}$ low), RPD voltage drops below the threshold voltage (about 2.5 V for 5 V operation), the asynchronous reset is then immediately entered. Even if RPD returns above the threshold, the reset is definitively taken as asynchronous.
2. Minimum $\overline{\text { RSTIN }}$ low pulse duration shall also be longer than 500 ns to guarantee the pulse is not masked by the internal filter (refer to Section 21.1).

Figure 78. Synchronous long hardware RESET ( $\overline{\mathrm{EA}}=0$ )


1. If during the reset condition ( $\overline{\mathrm{RSTIN}}$ low), RPD voltage drops below the threshold voltage (about 2.5 V for 5 V operation), the asynchronous reset is then immediately entered.
2. Minimum RSTIN low pulse duration shall also be longer than 500 ns to guarantee the pulse is not masked by the internal filter (refer to Section 21.1).
3. 3 to 8 TCL depending on clock source selection.

### 20.4 Software reset

A software reset sequence can be triggered at any time by the protected SRST (software reset) instruction. This instruction can be deliberately executed within a program, for example, to leave bootstrap loader mode, or on a hardware trap that reveals system failure.

On execution of the SRST instruction, the internal reset sequence is started. The microcontroller behavior is the same as for a synchronous short reset, except that only bits P0.12...P0.8 are latched at the end of the reset sequence, while previously latched, bits P0.7...P0. 2 are cleared (that is written at ' 1 ').
A Software reset is always taken as synchronous. There is no influence on Software reset behavior with RPD status. In case a bidirectional reset is selected, a Software reset event
pulls $\overline{\text { RSTIN }}$ pin low: this occurs only if RPD is high; if RPD is low, $\overline{\text { RSTIN }}$ pin is not pulled low even though Bidirectional reset is selected.

Refer to Figure 79 and Figure 80 for unidirectional software reset timing, and to Figure 81, Figure 82 and Figure 83 for bidirectional.

### 20.5 Watchdog timer reset

When the watchdog timer is not disabled during the initialization, or serviced regularly during program execution, it overflows and triggers the reset sequence.

Unlike hardware and software resets, the watchdog reset completes a running external bus cycle if this bus cycle either does not use READY, or if READY is sampled active (low) after the programmed wait states.

When $\overline{\text { READY }}$ is sampled inactive (high) after the programmed wait states the running external bus cycle is aborted. Then the internal reset sequence is started.
Bit P0.12...P0.8 are latched at the end of the reset sequence and bit P0.7...P0.2 are cleared (that is written at ' 1 ').

A Watchdog reset is always synchronous. There is no influence on Watchdog reset behavior with RPD status. In case a Bidirectional reset is selected, a Watchdog reset event pulls RSTIN pin low; this occurs only if RPD is high; if RPD is low, RSTIN pin is not pulled low even though bidirectional reset is selected.

Refer to Figure 79 and Figure 80 for unidirectional SW reset timing, and to Figure 81, Figure 82 and Figure 83 for bidirectional.

Figure 79. SW / WDT unidirectional RESET (EA=1)


Figure 80. SW / WDT unidirectional RESET ( $\overline{\mathrm{EA}}=0$ )


### 20.6 Bidirectional Reset

As shown in the previous sections, the RSTOUT pin is driven active (low level) at the beginning of any reset sequence (synchronous/asynchronous hardware, software and watchdog timer resets). RSTOUT pin stays active low beyond the end of the initialization routine, until the protected EINIT instruction (end of initialization) is completed.

The Bidirectional reset function is useful when external devices require a reset signal but cannot be connected to RSTOUT pin, because RSTOUT signal lasts during initialization. It is, for instance, the case of external memory running initialization routine before the execution of EINIT instruction.

Bidirectional reset function is enabled by setting bit 3 (BDRSTEN) in SYSCON register. It only can be enabled during the initialization routine, before EINIT instruction is completed.
When enabled, the open drain of the $\overline{\text { RSTIN }}$ pin is activated, pulling down the reset signal, for the duration of the internal reset sequence (synchronous/asynchronous hardware, synchronous software and synchronous watchdog timer resets). At the end of the internal reset sequence ( 1024 TCL ) the pull down is released and the following may occur.

- After a Short Synchronous Bidirectional Hardware Reset, if RSTF is sampled low 8 TCL periods after the internal reset sequence completion (refer to Figure 75 and Figure 76), the Short reset becomes a Long reset. Otherwise, if RSTF is sampled high the device simply exits reset state.
- After a Software or Watchdog Bidirectional reset, the device exits from reset. If RSTF remains still low for at least 4 TCL periods (minimum time to recognize a Short
hardware reset) after the reset exiting (refer to Figure 81 and 82), the Software or Watchdog reset become a Short Hardware reset. On the contrary, if RSTF remains low for less than 4 TCL, the device simply exits reset state.

The Bidirectional reset is not effective in case RPD is held low, when a Software or Watchdog reset event occurs. On the contrary, if a Software or Watchdog Bidirectional reset event is active and RPD becomes low, the $\overline{\text { RSTIN }}$ pin is immediately released, while the internal reset sequence is completed regardless of RPD status change (1024 TCL).

Note: $\quad$ The bidirectional reset function is disabled by any reset sequence (bit BDRSTEN of SYSCON is cleared). To be activated again it must be enabled during the initialization routine.

## WDTCON flags

Similar to what is highlighted in the previous section, when discussing Short reset and the degeneration into Long reset, comparable situations may occur when Bidirectional reset is enabled. The presence of the internal filter on RSTIN pin introduces a delay: When RSTIN is released, the internal signal after the filter (see RSTF in the drawings) is delayed, so it remains still active (low) for a while. It means that depending on the internal clock speed, a short reset may be recognized as a long reset: The WDTCON flags are set accordingly.

Moreover, when either Software or Watchdog bidirectional reset events occur, when the RSTIN pin is released (at the end of the internal reset sequence), the RSTF internal signal (after the filter) remains low for a while, and depending on the clock frequency it is recognized high or low. If the RSTF signal is recognized low for at least another 4 TCL after the completion of the internal sequence, a hardware reset sequence starts, and WDTCON flags this last event, masking the previous one (software or watchdog reset). Typically, a short hardware reset is recognized, unless the RSTIN pin (and consequently internal signal RSTF) is held sufficiently low by the external hardware to inject a long hardware reset. After this occurrence, the initialization routine is not able to recognize a software or watchdog bidirectional reset event, since a different source is flagged inside WDTCON register. This phenomenon does not occur when internal Flash is selected during reset $(\overline{E A}=1)$, since the initialization of the Flash extends the internal reset duration well beyond the filter delay.

The next Figure 81, 82 and 83 summarize the timing for Software and Watchdog Timer Bidirectional reset events. In particular, Figure 83 shows the degeneration into Hardware reset.

Figure 81. SW / WDT bidirectional RESET ( $\overline{\mathrm{EA}}=1$ )


Figure 82. SW / WDT bidirectional RESET ( $\overline{E A}=0$ )


Figure 83. SW / WDT bidirectional RESET ( $\overline{\mathrm{EA}}=0$ )


### 20.7 Reset circuitry

Internal reset circuitry is described in Figure 86. The $\overline{\text { RSTIN }}$ pin provides an internal pull-up resistor of $50 \mathrm{k} \Omega$ to $250 \mathrm{k} \Omega$ (the minimum reset time must be calculated using the lowest value).

It also provides a programmable (BDRSTEN bit of SYSCON register) pull-down to output internal reset state signal (synchronous reset, watchdog timer reset or software reset).

This bidirectional reset function is useful in applications where external devices require a reset signal but cannot be connected to $\overline{\text { RSTOUT }}$ pin.

This is the case of an external memory running codes before EINIT (end of initialization) instruction is executed. RSTOUT pin is pulled high only when EINIT is executed.

The RPD pin provides an internal weak pull-down resistor which discharges external capacitor at a typical rate of $200 \mu \mathrm{~A}$. If bit PWDCFG of SYSCON register is set, an internal pull-up resistor is activated at the end of the reset sequence. This pull-up charges any capacitor connected on RPD pin.

The simplest way to reset the ST10F252M is to insert a capacitor C1 between RSTIN pin and $\mathrm{V}_{\mathrm{SS}}$, and a capacitor between RPD pin and $\mathrm{V}_{\mathrm{SS}}(\mathrm{CO})$ with a pull-up resistor R0 between RPD pin and $V_{D D}$. The input $\overline{\text { RSTIN }}$ provides an internal pull-up device equalling a resistor of $50 \mathrm{k} \Omega$ to $250 \mathrm{k} \Omega$ (the minimum reset time must be determined by the lowest value). Select a
value of C 1 that produces a sufficient discharge time to permit the internal or external oscillator and/or internal PLL and the on-chip voltage regulator to stabilize.
To ensure correct power-up reset with controlled supply current consumption, specially if the clock signal requires a long period of time to stabilize, an asynchronous hardware reset is required during power-up. For this reason, it is recommended to connect the external R0-C0 circuit, shown in Figure 84, to the RPD pin. On power-up, the logical low level on the RPD pin forces an asynchronous hardware reset when $\overline{\text { RSTIN }}$ is asserted low. The external pullup R0 will then charges the capacitor C0. Note that an internal pull-down device on RPD pin is turned on when $\overline{\text { RSTIN }}$ pin is low and causes the external capacitor (C0) to begin discharging at a typical rate of 100-200 $\mu \mathrm{A}$. With this mechanism, after power-up reset, short low pulses applied on $\overline{\text { RSTIN }}$ produce synchronous hardware reset. If RSTIN is asserted longer than the time needed for CO to be discharged by the internal pull-down device, the device is forced in an asynchronous reset. This mechanism insures recovery from very catastrophic failure.

Figure 84. Minimum external reset circuitry


The minimum reset circuit of Figure 84 is not adequate when the $\overline{\mathrm{RSTIN}}$ pin is driven from the ST10F252M itself during software or watchdog triggered resets, because of the capacitor C 1 that keeps the voltage on $\overline{\text { RSTIN }}$ pin above $\mathrm{V}_{\mathrm{IL}}$ after the end of the internal reset sequence, and, thus will triggers an asynchronous reset sequence.

Figure 85 shows an example of a reset circuit. In this example, an R1-C1 external circuit is only used to generate power-up or manual reset, and the R0-C0 circuit on RPD is used for power-up reset and to exit from power down mode. Diode D1 creates a wired-OR gate connection to the reset pin and may be replaced by open-collector Schmitt trigger buffer. Diode D2 provides a faster cycle time for repetitive power-on resets.

R2 is an optional pull-up for faster recovery and correct biasing of TTL open collector drivers.

Figure 85. System reset circuit


Figure 86. Internal (simplified) reset circuitry


### 20.8 Reset summary

Table 114 summarizes the different reset events.
Table 114. Reset events summary

| Event | $\begin{aligned} & \text { Q } \\ & \stackrel{n}{x} \end{aligned}$ | $\underset{山}{\mathbb{4}}$ | $\frac{\vdots}{0}$ |  | RSTIN |  | WDTCON Flags |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | min | max | ¢ | $\stackrel{\text { T }}{\substack{\text { T }}}$ | - | 钲 |  |
| Power-on Reset | 0 | 0 | N | Asynch | 1 ms (VREG) <br> 1.2 ms (Reson. + PLL) <br> 10.2 ms (Crystal + PLL) | - | 1 | 1 | 1 | 1 | 0 |
|  | 0 | 1 | N | Asynch | $1 \mathrm{~ms} \mathrm{(VREG)}$ | - | 1 | 1 | 1 | 1 | 0 |
|  | 1 | x | x | FORBIDDEN |  |  |  |  |  |  |  |
|  | X | x | Y | NOT APPLICABLE |  |  |  |  |  |  |  |
| Hardware Reset (Asynchronous) ${ }^{(1)}$ | 0 | 0 | N | Asynch | 500ns | - | 0 | 1 | 1 | 1 | 0 |
|  | 0 | 1 | N | Asynch | 500ns | - | 0 | 1 | 1 | 1 | 0 |
|  | 0 | 0 | Y | Asynch | 500ns | - | 0 | 1 | 1 | 1 | 0 |
|  | 0 | 1 | Y | Asynch | 500ns | - | 0 | 1 | 1 | 1 | 0 |
| Short Hardware Reset (Synchronous) ${ }^{1}$ | 1 | 0 | N | Synch. | max (4 TCL, 500ns) | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | 0 | 0 | 1 | 1 | 0 |
|  | 1 | 1 | N | Synch. | max (4 TCL, 500ns) | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | 0 | 0 | 1 | 1 | 0 |
|  | 1 | 0 | Y | Synch. | max (4 TCL, 500ns) | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | 0 | 0 | 1 | 1 | 0 |
|  |  |  |  |  | Activated by internal logic for 1024TCL |  |  |  |  |  |  |
|  | 1 | 1 | Y | Synch. | max (4 TCL, 500ns) | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | 0 | 0 | 1 | 1 | 0 |
|  |  |  |  |  | Activated by internal logic for 1024 TCL |  |  |  |  |  |  |

Table 114. Reset events summary (continued)

| Event | $\begin{aligned} & \text { Q } \\ & \text { 문 } \end{aligned}$ | $\mathbb{\amalg}$ | $\frac{12}{0}$ |  | RSTIN |  | WDTCON Flags |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | min | max | ¢ | $\stackrel{\text { ¢ }}{\substack{\text { T }}}$ |  | ¢ |  |
| Long Hardware Reset (Synchronous) | 1 | 0 | N | Synch. | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | - | 0 | 1 | 1 | 1 | 0 |
|  | 1 | 1 | N | Synch. | $\begin{gathered} 1032+12 \text { TCL + } \\ \max (4 \text { TCL, } 500 \mathrm{~ns}) \end{gathered}$ | - | 0 | 1 | 1 | 1 | 0 |
|  | 1 | 0 | Y | Synch. | $1032+12 \text { TCL + }$ $\max (4$ TCL, 500ns) | - | 0 | 1 | 1 | 1 | 0 |
|  |  |  |  |  | Activated by internal logic only for 1024 TCL |  |  |  |  |  |  |
|  | 1 | 1 | Y | Synch. | $1032+12 \text { TCL + }$ $\max (4$ TCL, 500ns) | - | 0 | 1 | 1 | 1 | 0 |
|  |  |  |  |  | Activated by internal | for 1024 TCL |  |  |  |  |  |
| Software Reset ${ }^{(2)}$ | x | 0 | N | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 0 |
|  | x | 0 | N | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 0 |
|  | 0 | 1 | Y | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 0 |
|  | 1 | 1 | Y | Synch. | Activated by internal logic for 1024 TCL |  | 0 | 0 | 0 | 1 | 0 |
| Watchdog Reset ${ }^{(2)}$ | x | 0 | N | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 1 |
|  | x | 0 | N | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 1 |
|  | 0 | 1 | Y | Synch. | Not activated |  | 0 | 0 | 0 | 1 | 1 |
|  | 1 | 1 | Y | Synch. | Activated by internal logic for 1024 TCL |  | 0 | 0 | 0 | 1 | 1 |

1. It can degenerate into a long hardware reset and consequently differently flagged (see Figure 20.3 for details).
2. When Bidirectional is active (and with RPD=0), it can be followed by a short hardware reset and consequently differently flagged (see Section 20.3 for details).

The start-up configurations are selected on reset sequences as described in Table 115. It describes what is the system configuration latched on PORTO in the six different reset modes.

Table 115. PORTO latched configuration for the different reset events

| $X$ : Pin is sampled <br> - : Pin is not sampled | PORTO |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  | 든 0 0 0 0 0 0 0 0 0 3 | $\begin{aligned} & \stackrel{0}{2} \\ & \underset{\sim}{2} \\ & \underset{\sim}{\infty} \end{aligned}$ |  |  | ๗ |  |  |  |  |
| Sample event | $\begin{aligned} & \text { r } \\ & \text { I } \end{aligned}$ |  |  | + <br> I <br> I | $\begin{aligned} & \text { O } \\ & \text { I } \end{aligned}$ | 포 <br> 픔 | $$ | $\begin{aligned} & \text { 음 } \\ & \text { I } \end{aligned}$ | ì | $\begin{aligned} & 0 \\ & i \\ & 0 \end{aligned}$ | $\begin{aligned} & \text { O} \\ & 0 \\ & 0 \end{aligned}$ | i | $\begin{aligned} & \text { O} \\ & \text { Oin } \end{aligned}$ | $\begin{aligned} & \text { N } \\ & \text { O} \end{aligned}$ | 듬 | 인 |
| Software Reset | - | - | - | X | X | X | X | X | X | X | - | - | - | - | - | - |
| Watchdog Reset | - | - | - | X | X | X | X | X | X | X | - | - | - | - | - | - |

Table 115. PORTO latched configuration for the different reset events (continued)

| $X$ : Pin is sampled <br> - : Pin is not sampled | PORTO |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 00001000000 |  |  |  |  |  |  |  | $\begin{aligned} & \stackrel{0}{2} \\ & \underset{\sim}{2} \\ & \stackrel{n}{0} \end{aligned}$ |  |  | $\underset{\sim}{\boldsymbol{\omega}}$ |  |  | $\begin{aligned} & \frac{0}{0} \\ & \sum_{2}^{0} \\ & \frac{0}{0} \\ & \frac{\pi}{4} \end{aligned}$ |  |
| Sample event | $\begin{aligned} & \text { N } \\ & \text { I } \end{aligned}$ | $\begin{aligned} & \hline \text { O} \\ & \text { I } \end{aligned}$ |  |  | $\begin{aligned} & \text { M } \\ & \text { İ } \\ & \hline \mathbf{x} \end{aligned}$ |  | $\begin{aligned} & \bar{I} \\ & \bar{O} \end{aligned}$ | $\begin{aligned} & \text { 우 } \\ & \text { 웅 } \end{aligned}$ | ì | $\begin{aligned} & 0 \\ & i \\ & \text { in } \end{aligned}$ | OB | it | O | ָỉ | $\overline{\text { io }}$ | 인 |
| Synchronous Short Hardware Reset | - | - | - | X | X | X | X | X | X | X | X | X | X | X | X | X |
| Synchronous Long Hardware Reset | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X |
| Asynchronous Hardware Reset | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X |
| Asynchronous Power-On Reset | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X |

## 21 Power reduction modes

Several different power reduction modes with different levels of power reduction have been implemented in the ST10F252M, which may be entered under software and/or hardware control.

In idle mode the CPU is stopped, while the peripherals continue their operation. Idle mode can be terminated by any reset or interrupt request.

In power down mode both the CPU and the peripherals are stopped. Power down mode can be configured by software to be terminated only by a hardware reset, by a transition on enabled fast external interrupt pins, by an interrupt generated by the real time clock, by an interrupt generated by the activity on CAN and $\mathrm{I}^{2} \mathrm{C}$ module interfaces.

Note: $\quad$ All external bus actions are completed before idle or power down mode is entered.
To use the real time clock when the device is in power down mode a reference clock is needed (XTAL1 / XTAL2 pins). In this case, the main oscillator is not stopped when power down is entered, and the real time clock continues to work using the main oscillator clock signal as reference.

Stand-by mode is achieved by turning off the main power supply ( $\mathrm{V}_{\mathrm{DD}}$ ) while $\mathrm{V}_{\mathrm{STBY}}$ remains the only active supply for the device. In this condition, the $\mathrm{V}_{\text {STBY }}$ pin provides the supply to a portion of the XRAM (the stand-by RAM, 16 Kbyte in this device) through a dedicated on-chip low power voltage regulator; the content of this RAM can be retained and is available at next system start-up.

Note: $\quad V_{\text {STBY }}$ is always powered in the range of 4.5-5.5 Volt.
An exception for the $V_{S T B Y}$ value is allowed when $\overline{R S T I N}$ pin is held low and the main $V_{D D}$ is on - this drives pin $\overline{E A}$ (mapped together with $V_{\text {STBY }}$ ) and configures the access to external memory. After the RSTIN pin is released, $V_{\text {STBY }}$ returns high to be used as the $V_{S T B Y}$ supply voltage.

The real time clock cannot be used in stand-by-mode. Turning off the main power supply $\left(\mathrm{V}_{\mathrm{DD}}\right)$ of the device, stop the main oscillator circuitry working. Standard power down mode must be used to continue operating the real time clock (RTC).

### 21.1 Idle mode

This mode is exactly the same as for the ST10F168 or the ST10F269.
In idle mode the CPU is stopped, while the peripherals continue their operation. Idle mode can be terminated by any reset or interrupt request. Any operation, required by the interrupt is completed and the CPU returns to normal operation.

### 21.2 Power down mode

To further reduce the power consumption the microcontroller can be switched to power down mode. Clocking of all internal blocks is stopped, the contents of the internal RAM, however, are preserved through the voltage supplied via the $\mathrm{V}_{\mathrm{DD}}$ pins (and the on-chip voltage regulator). The watchdog timer is also stopped in power down mode. The only exception could be the real time clock, if appropriately programmed, and the oscillator circuit as a consequence (the main oscillator).

When the ST10F252M is in power-down mode, its on-chip voltage regulator remains on by default. To further reduce the consumption, it can be put in its power-saving mode; the low-power voltage regulator delivers about 1.65 V to supply the core logic. It is mandatory not to reduce the $\mathrm{V}_{\mathrm{DD}}$ during power down mode - it must be always in the range $5 \mathrm{~V} \pm 10 \%$ when in power down mode. Before executing the PWRDN instruction, bit 3 of the XMISC register is set to turn off the main voltage regulator when power down is entered.

## XMISC register



Table 116. XMISC register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 4 | P7EN |  |
| 3 | VREGOFF | Connect PORT7 to pins <br> '0': Ports P4.0-P4.3 are connected to pins 47-50 (default configuration). <br> '1': Ports P7.0-P7.3 are connected to pins 47-50 |
| 2 | CANCK2 | Main voltage regulator disable in power-down mode <br> '0': On-chip main regulator is held active when power-down mode is <br> entered <br> '1': On-chip main regulator is turned off when power-down mode is <br> entered |
| 1 | CANPAR | CAN clock divider by 2 disable <br> '0': Clock provided to CAN modules is CPU clock divided by two <br> (mandatory when fCPU is higher than 40 MHz) <br> '1': Clock provided to CAN modules is directly CPU clock |
|  |  | CAN parallel mode selection <br> '0': CAN2 is mapped on P4.4/P4.7, while CAN1 is mapped on <br> P4.5/P4.6 <br> '1': CAN1 and CAN2 are mapped in parallel on P4.5/P4.6. This is <br> effective only if both CAN1 and CAN2 are enabled through setting of <br> bits CAN1EN and CAN2EN in XPERCON register. If CAN1 is disabled, <br> CAN2 remains on P4.4/P4.7 even if bit CANPAR is set. |

The ST10F252M provides two different operating power down modes:

- protected power down mode
- interruptible power down mode.

The power down operating mode is selected by the bit PWDCFG in SYSCON register.

## SYSCON register

| SYSC | reg | （FF | 89h） |  |  |  |  |  |  |  |  |  |  | t valu | 0xx0h |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|  | － |  | $\sum_{\text {OX }}^{\bar{\infty}}$ | 0 <br> 0 <br> 0 <br> 0 | $\underset{\text { On }}{\substack{Z 1}}$ | $\stackrel{0}{0}$ | $\begin{aligned} & \underset{\sim}{\underset{u}{u}} \\ & \underset{u}{n} \end{aligned}$ | $\begin{aligned} & \text { N } \\ & \text { U } \\ & \text { N } \\ & 3 \end{aligned}$ | $\begin{aligned} & \text { ত্} \\ & \text { U} \\ & \text { U0 } \end{aligned}$ |  | $\sum_{0}^{0} \frac{\infty}{0}$ | $\stackrel{\text { ๙ }}{\stackrel{\sim}{\mathrm{O}}}$ | $\begin{aligned} & \underset{\sim}{\underset{\sim}{x}} \end{aligned}$ | $\begin{aligned} & \text { 山 } \\ & \text { м } \\ & \stackrel{\text { n }}{>} \end{aligned}$ | 尔岗 |
|  | － |  | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW | RRW |

Table 117．SYSCON PWDCFG functions

| Bit | Name | Function |
| :---: | :---: | :--- |
| 5 | PWDCFG | Power down mode configuration control <br> ＇0＇：Power down mode can only be entered during PWRDN instruction <br> execution if NMI pin is low，otherwise the instruction has no effect．To <br> exit power down mode，an external reset must be provided by asserting <br> the $\overline{\text { RSTIN pin．}}$ <br> ＇1＇：Power down mode can only be entered during PWRDN instruction <br> execution if all enabled fast external interrupt（EXxIN）pins are in their <br> inactive level．Exiting this mode can be done by asserting one enabled <br> EXxIN pin and／or by an interrupt coming from the real time clock（if <br> running），and／or by an interrupt coming from CAN1／CAN2／I ${ }^{2}$ C serial <br> interfaces and／or by asserting RSTIN pin． |

Note：$\quad$ The SYSCON register cannot be changed after execution of the EINIT instruction．

## 21．2．1 Protected power down mode

This mode is selected by clearing the bit PWDCFG in register SYSCON to＇ 0 ＇．
In this mode，the power down mode can only be entered if the $\overline{\mathrm{NMI}}$（non maskable interrupt） pin is externally pulled low while the PWRDN instruction is executed．

This feature can be used in conjunction with an external power failure signal which pulls the NMI pin low when a power failure is imminent．The microcontroller enters the NMI trap routine which can save the internal state into RAM．After the internal state has been saved， the trap routine may set a flag or write a certain bit pattern into specific RAM locations and then execute the PWRDN instruction．If the NMI pin is still low at this time，power down mode is entered，otherwise program execution continues．During power down，the voltage delivered by the on－chip voltage regulator automatically lowers the internal logic supply down to about 1.65 V ，saving the power while the contents of the internal RAM and all registers are still preserved．

## Exiting power down mode

In this mode，the only way to exit power down mode is with an external hardware reset．
The initialization routine（executed upon reset）can check the identification flag（see WDTCON－Chapter 19）or bit pattern within RAM to determine whether the controller was initially switched on，or whether it was properly restarted from power down mode．

### 21.2.2 Interruptible power down mode

This mode is selected by setting the bit PWDCFG in register SYSCON to ' 1 '.
In this mode, the power down mode can be entered if the fast external interrupt pins (EXxIN pins, alternate functions of PORT2 pins, with $x=7 \ldots 0$ ) are in their inactive level. This inactive level is configured with the EXIxES bit field in the EXICON register

Figure 87. EXICON register


Table 118. EXICON register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | EXIxES ( $\mathrm{x}=7 . . .0$ ) | External interrupt $x$ edge selection field ( $x=7 \ldots 0$ ) <br> '00': Fast external interrupts disabled: standard mode. EXxIN pin not taken into account for entering or exiting power down mode. <br> '01': Interrupt on positive edge (rising). Enter power down mode if EXiN = ' 0 ', exit if EXxIN = ' 1 ' (referred as 'high' active level) <br> ' 10 ': Interrupt on negative edge (falling). Enter power down mode if EXilN = '1', exit if EXxIN = '0' (referred as 'low' active level) <br> '11': Interrupt on any edge (rising or falling). Always enter power down mode, exit if EXxIN level changed. |

## Exiting power down mode

When interruptible power down mode is entered, the CPU and peripheral clocks are frozen, and the oscillator and PLL are stopped (when RTC is disabled, so there is no need for a clock reference). Interruptible power down mode can be exited by either asserting $\overline{\text { RSTIN }}$ or one of the enabled EXxIN pin (fast external interrupt). If the real time clock module needs to be running during power down, the main oscillator is not stopped. The PLL, on the contrary is switched off.

If power down mode is exited by a hardware RESET, the $\overline{\text { RSTIN }}$ pin must be held low until the oscillator (if not already running for real time clock operation) and PLL have restarted and stabilized.

EXxIN inputs are normally sampled interrupt inputs. However, the power down mode circuitry uses them as level-sensitive inputs. An EXxIN (x=7...0) interrupt enable bit (bit CCxIE in respective CCxIC register) needs not to be set to bring the device out of power down mode.

To guarantee stabilization time before restart the operation when exiting from power down (especially if the main oscillator was stopped - typically when the real time clock module is not used), an external RC circuit must be connected to RPD pin (return from power down), as shown in the Figure 88.

Figure 88. RPD pin: external circuit to exit power down

|  |  |
| :---: | :---: |

To exit power down mode with external interrupt, an EXxIN pin has to be asserted for at least $40 \mathrm{~ns}(x=7 \ldots 0)$. This signal enables the internal main oscillator (if not already running) and PLL circuitry, and also turns on the internal weak pull-down on RPD pin (see Figure 89). The discharging of the external capacitor provides a delay that allows the oscillator and PLL circuits to stabilize before the internal CPU and peripheral clocks are enabled. When the voltage on RPD pin drops below the threshold voltage (about 2.5 V ), the Schmitt trigger clears Q2 flip-flop, thus enabling the CPU and peripheral clocks, and the device resumes code execution.

If the Interrupt was enabled (bit CCxIE='1' in the respective CCxIC register) before entering power down mode, the device executes the interrupt service routine, and resumes execution after the PWRDN instruction (see note below). If the interrupt was disabled, the device executes the instruction following PWRDN instruction, and the interrupt request flag (bit CCxIR in the respective CCxIC register) remains set until it is cleared by software.

Note: Due to internal pipeline, the instruction that follows the PWRDN instruction is executed before the CPU performs a call of the interrupt service routine when exiting power down mode.

Figure 89. Simplified power down exit circuitry


Exiting from interruptible power down is also possible through the CAN receive lines and $I^{2} C$ Serial Clock line (if properly enabled through CC8IC and CC9IC registers), an activity on pins P4.5 and P4.4 is interpreted as a fast external interrupt event able to wake-up the device. For more details refers also to Section 9.1.

Figure 90. Power down exit sequence using an external interrupt (PLL x 2)


### 21.2.3 Real time clock and power down mode

If the real time clock is running (RTOFF bit of RTCCON register cleared), when PWRDN instruction is executed, the oscillator circuit which is providing the reference to the counter is not stopped.

### 21.3 Stand-by mode

In Stand-by mode, the RAM array is maintained powered through the dedicated pin $\mathrm{V}_{\text {STBY }}$ when ST10F252M main power supply $\left(\mathrm{V}_{\mathrm{DD}}\right)$ is turned off.
To enter stand-by mode it is mandatory to hold the device under reset; once the device is under reset, the RAM is disabled (see XRAM2EN and XRAM1EN bits of XPERCON register), and its digital interface is frozen to avoid any kind of data corruption. It is then possible to turn off the main $\mathrm{V}_{\mathrm{DD}}$ provided that $\mathrm{V}_{\mathrm{STBY}}$ is on.
A dedicated embedded low-power voltage regulator is implemented to generate the internal low voltage supply (about 1.65 V in stand-by mode) to bias all those circuits that remain active: XRAM2 (12Kbytes).

In normal running mode (that is when main $V_{D D}$ is on), the $V_{\text {STBY }}$ pin can be tied to $V_{S S}$ during reset to exercise the $\overline{\mathrm{EA}}$ functionality associated with the same pin; the voltage supply for the circuitries which are usually biased with $\mathrm{V}_{\text {STBY }}$ (see in particular the lowpower oscillator used in conjunction with real time clock module), is granted by the active main $V_{D D}$.

Stand-by mode can generate problems associated with the use of different power supplies in CMOS systems. Pay particular attention when the ST10F252M I/O lines are interfaced with other external CMOS integrated circuits. If $\mathrm{V}_{\mathrm{DD}}$ of ST10F252M becomes (for example
in stand-by mode) lower than the output level forced by the I/O lines of these external integrated circuits, the ST10F252M could be directly powered through the inherent diode existing on ST10F252M output driver circuitry. The same is valid for ST10F252M interfaced to active or inactive communication buses during stand-by mode: current injection can be generated through the inherent diode. Furthermore, the sequence of turning on/off of the different voltage could be critical for the system (not only for the ST10F252M device). The device stand-by mode current (ISTBY) may vary while $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {STBY }}$ (and vice versa) transition occurs. Some current flows between $V_{D D}$ and $V_{\text {STBY }}$ pins. System noise on both $V_{D D}$ and $V_{S T B Y}$ can contribute to increase this phenomenon.

### 21.3.1 Entering stand-by mode

To enter stand-by mode XRAM2EN and XRAM1EN bits in the XPERCON register must be cleared (this bit is automatically reset by any kind of RESET event, see Chapter 20); this immediately freezes the RAM interface, avoiding any data corruption. As a consequence of a RESET event, the RAM power supply is switched to the internal low-voltage supply, $\mathrm{V}_{18 \mathrm{SB}}$ (derived from $\mathrm{V}_{\text {STBY }}$ through the low-power voltage regulator). The RAM interface remains frozen until the bits XRAM1EN and XRAM2EN are set again by software initialization routine (at next exit from main $V_{D D}$ power-on reset sequence).

Since $\mathrm{V}_{18}$ is falling (as a consequence of $\mathrm{V}_{\mathrm{DD}}$ turning off), it can happen that the XRAM2EN bit is no longer able to guarantee its content (logic " 0 "), as the XPERCON register is powered by the internal $\mathrm{V}_{18}$. This does not generate any problem, because the Stand-by mode dedicated switching circuit continues to confirm the freezing of the RAM interface, irrespective the XRAM2EN bit content. The XRAM2EN bit status is considered again when internal $\mathrm{V}_{18}$ comes back over internal stand-by reference $\mathrm{V}_{18 \mathrm{SB}}$.

If internal $\mathrm{V}_{18}$ becomes lower than the internal stand-by reference $\left(\mathrm{V}_{18 \mathrm{SB}}\right)$ of about 0.30.45 V with bit XRAM2EN set, the RAM supply switching circuit is not active. If there is a temporary drop on internal $\mathrm{V}_{18}$ voltage versus internal $\mathrm{V}_{18 \mathrm{SB}}$ during normal code execution, no spurious stand-by mode switching can occur (the RAM is not frozen and can still be accessed).

The ST10F252M core module, generating the RAM control signals, is powered by the internal $\mathrm{V}_{18}$ supply. During turning off, these control signals follow the $\mathrm{V}_{18}$, while RAM is switched to the $\mathrm{V}_{18 S B}$ internal reference. It could happen that a high level of RAM write strobe from ST10F252M core (active low signal) is low enough to be recognized as a logic " 0 " by the RAM interface (due to $\mathrm{V}_{18}$ lower than $\mathrm{V}_{18 \mathrm{SB}}$ ); the bus status could contain a valid address for the RAM and an unwanted data corruption could occur. For this reason, an extra interface, powered by the switched supply, is used to prevent the RAM from this kind of potential corruption mechanism.

Warning: During power-off phase, it is important that the external hardware maintains a stable ground level on RSTIN pin, without any glitch, to avoid spurious exiting from reset status with unstable power supply.

### 21.3.2 Exiting stand-by mode

After the system has entered the stand-by mode, the procedure to exit this mode consists of a standard power-on sequence, with the only difference that the RAM is already powered through the $\mathrm{V}_{18 S B}$ internal reference (derived from $\mathrm{V}_{\text {STBY }}$ pin external voltage).
Hold the device under RESET ( $\overline{\text { RSTIN }}$ pin forced low) until external $\mathrm{V}_{\mathrm{DD}}$ voltage pin is stable. Even though, at the very beginning of the power-on phase, the device is maintained under reset by the internal low voltage detector circuit (implemented inside the main voltage regulator) until the internal $\mathrm{V}_{18}$ becomes higher than about 1.0 V , there is no warranty that the device stays under reset status if RSTIN is at high level during power ramp up. So, it is important the external hardware is able to guarantee a stable ground level on $\overline{\text { RSTIN }}$ along the power-on phase, without any temporary glitch.

The external hardware is responsible to drive the $\overline{\text { RSTIN }}$ pin low until $\mathrm{V}_{\mathrm{DD}}$ is stable, even though the internal LVD is active. It is requested an additional time (at least 1 ms ) to allow internal voltage regulator stabilization before releasing the $\overline{\text { RSTIN }}$ pin; this is necessary since the internal Flash has to begin its initialization phase (starting when RSTIN pin is released) with an already stable $\mathrm{V}_{18}$.

Once the internal reset signal goes low, the RAM (still frozen) power supply is switched to the main $\mathrm{V}_{18}$.

At this time, everything becomes stable, and the execution of the initialization routines can start: XRAM1EN and XRAM2EN bit can be set, enabling the RAM.

### 21.3.3 Real time clock and stand-by mode

When stand-by mode is entered (turning off the main supply $\mathrm{V}_{\mathrm{DD}}$ ), the real time clock counting stops running. This is because the main oscillator is used as reference for the counter. As the main oscillator powered by $\mathrm{V}_{\mathrm{DD}}$, once this is switched off, the oscillator stops.

## 22 Real time clock

The Real Time Clock is an independent timer, in which the clock is derived directly from the clock oscillator on XTAL1 (main oscillator) input or XTAL3 input (32 kHz low-power oscillator) so that it can continue running even in Idle or Power-down modes (if so enabled). Registers access is implemented onto the XBUS. This module is designed with the following characteristics:

- generation of the current time and date for the system
- cyclic time based interrupt, on Port2 external interrupts every "RTC basic clock tick" and after $n$ 'RTC basic clock ticks' ( $n$ is programmable) if enabled
- 58-bit timer for long term measurement
- capability to exit the ST10 chip from Power-down mode (if PWDCFG of SYSCON set) after a programmed delay

Note: $\quad$ When the clock is gated, no reset is raised after the EINIT instruction has been executed.
The RTC consists of a chain of programmable counters made of two main blocks. The first block is a prescaler which generates a basic reference clock (for example, a one second period clock). This basic reference clock includes a fixed prescaler divider (1/64) and two programmable dividers: RTCPH (RTC prescaler high - 4-bits) and RTCPL (RTC prescaler low - 16-bits). The second block, which uses TRCLK as an input clock, comprises two 16-bit programmable counters, RTCH and RTCL, that may be initialized to the current system time. This system time is increased at the TRCLK rate and compared with a programmable date to generate an alarm via an interrupt request (RTC_alarmIT), if enabled in the RTC control register.

If enabled in the RTC control register, the RTC generates an interrupt request (RTC_SecIT) every TRCLK period.

RTC_SecIT and RTC_alarmIT can trigger a fast external interrupt via EXISEL register of PORT2 and wake the ST10 chip if it is in power down mode (refer to Section 9.2 for details). Another function, implemented in the RTC, is to switch off the main on-chip oscillator if the ST10 enters the power down mode, so that the chip can be fully switched off (if the RTC is disabled).
At power on and after reset, the main oscillator drives the RTC counter, and since it is powered by the main power supply, it cannot be maintained running in stand-by mode, while in power down mode the main oscillator is maintained running to provide the reference to the RTC module (if not disabled).

Figure 91. SFRs associated with the RTC


Figure 92. RTC block diagram


### 22.1 RTC registers

### 22.1.1 RTCCON: RTC control register

The functions of the RTC are controlled by the bit-addressable RTC control register RTCCON. If the RTOFF bit is set, the RTC dividers and counters clocks are disabled and registers can be written; when the ST10 chip enters power down mode the clock oscillators (both main and low-power) are switched off. The RTC has two interrupt sources, one is triggered every second, the other one is the alarm. RTCCON includes an interrupt request
flag and an interrupt enable bit for each of them. This register is read and written via the XBUS.

## RTC control register



Table 119. RTC control register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 7 | RTCOFF | RTC switch off bit <br> ' 0 ': clock oscillator and RTC keep on running even if ST10 in power <br> down mode. <br> '1': clock oscillator is switched off when ST10 enters power down <br> mode. Setting this bit, RTC dividers and counters are stopped and <br> registers can be written. |
| 3 | RTAEN | RTC alarm interrupt enable <br> ' 0 ': RTC_alarmIT is disabled. <br> '1': RTC_alarmIT is enabled, it is generated every $n$ seconds. |
| 2 | RTAIR | RTC alarm interrupt request flag (when the alarm is triggered) <br> ' 0 ': the bit was reset less than $n$ seconds ago. <br> ' 1 ': the interrupt was triggered. |
| 1 | RTSEN | RTC second interrupt enable <br> ' 0 ': RTC_SecIT is disabled. <br> '1': RTC_SecIT is enabled, it is generated every second. |
| 0 | RTSIR | RTC second interrupt request flag (every second) <br> ' 0 ': the bit was reset less than a second ago. <br> ' 1 ': the interrupt was triggered. |

Note: $\quad$ All the bits of RTCCON are active high.
The two RTC Interrupt request lines are connected to PORT2 to trigger an external interrupt that wakes the chip up if in power down mode.

All the RTC registers are not bit addressable. To clear the RTC interrupt request flags (bit 0 and bit 2 of the RTCCON register) it is necessary to write a ' 1 ' to the corresponding bit of the RTCCON register.

### 22.1.2 RTC prescaler divider loaded value registers

The 20 bit programmable prescaler divider is loaded by two registers. The divisor 4 MSBs are stored into RTCPH and the 16 LSBs in RTCPL. These registers are not reset to keep the system clock. They are write protected by bit RTOFF of RTCCON register, write operation is allowed if RTOFF is set.

## RTC prescaler register

| RTCCPL register (ED06h) |  |  |  | ESFR |  |  |  |  |  |  |  |  | Reset value: uuuuh |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RTCPL |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| RRW |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| RTCCPH register (ED08h) |  |  |  | ESFR |  |  |  |  |  |  |  |  | Reset value: uuuuh |  |  |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |

Figure 93. RTC prescaler register function


The value stored into RTCPH, RTCPL is called RTCP (coded on 20 bits). The dividing ratio of the prescaler divider is:
ratio $=64 \times($ RTCP $)$
The minimum value which can be set in RTCPL is 0002 h .

### 22.1.3 RTC prescaler divider current value registers

Every period of TRCLK the dividers are reloaded with the value stored in RTCPH and RTCPL registers. To get an accurate time measurement, it is possible to access the internal value of the dividers, reading the registers RTCDH, RTCDL. These registers are read only. When any bit changed in the programmable prescaler divider, the new internal value is loaded in the registers.

## RTC prescaler divider register



Note: $\quad$ These registers are not reset, and are read only.

The divider works as a decrement operator. When the internal value reaches 0001h, the second interrupt is generated. When the next decrement occurs (which would set the divider register to the value 0000h), the 20-bit word stored in RTCPH, RTCPL registers is loaded in the divider. The minimum value which can be programmed in RTCPL is 0002h; if 0001h were set, just one second interrupt would be generated, since the divider would stay fixed at the value 0001h forever (a successive second interrupt cannot occur).

Figure 94. RTC prescaler divider register functions


The bits 15 down to 4 of RTCPH and RTCDH are not used. When reading, the return value of these bits is zero.

### 22.1.4 RTC programmable counter registers

The RTC has two 16-bit programmable counters whose count rate is based on the 1 second time reference. These counters can be used as a system clock as the clock oscillator can be working even in power down mode (either the main or the low power on-chip oscillator) if bit RTOFF of RTCCON register is reset. To keep this system clock, the counters are not reset with any system reset; the only way to force their value is to write them via the XBUS.
These counters are write protected. The bit RTOFF of the RTCCON register must be set (RTC dividers and counters are stopped) to enable a write operation on RTCH or RTCL.

A write operation on RTCH or RTCL register loads directly the corresponding counter. When reading, the current value in the counter (system date) is returned.
The counters are kept on running while at least one clock oscillator is working (either the main or the low-power on-chip oscillator).

RTC programmable counter register


Note: $\quad$ These registers are not reset.

### 22.1.5 RTC alarm registers

When the programmable counters reach the 32 bits value stored into RTCAH \& RTCAL registers an alarm is triggered and the interrupt request RTAIR is generated. These registers are not protected.

## RTC alarm register



RW
Note: $\quad$ These registers are not reset.

### 22.2 Programming the RTC

RTC interrupt request signals are connected to PORT2, pin 10 (RTCSI) and pin 11 (RTCAI).
EXICON ESFR controls the external interrupt edge selection; RTC interrupt requests are rising edge active.

RTC external interrupt control register

| EXICON register (F1COh/E0) |  |  | ESFR |  |  |  |  | Reset value: 0000h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1514 | 13 | 12 | 11 | 10 | 98 | $7 \quad 6$ | $5 \quad 4$ | $3 \quad 2$ | 1 | 0 |
| EXI7ES | EXI |  | EXI |  | EXI4ES | EXI3ES | EXI2ES | EXI1ES |  |  |

Table 120. RTC external interrupt control register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.0 | EXIxES (x=7...0) | External interrupt $x$ edge selection field ( $x=7 \ldots 0$ ) <br> '00': Fast external interrupts disabled: standard mode. EXxIN pin not taken into account for entering or exiting power down mode. <br> '01': Interrupt on positive edge (rising). Enter power down mode if EXilN = ' 0 ', exit if EXxIN = ' 1 ' (referred as 'high' active level) <br> '10': Interrupt on negative edge (falling). Enter power down mode if EXilN = '1', exit if EXxIN = '0' (referred as 'low' active level) <br> '11': Interrupt on any edge (rising or falling). Always enter power down mode, exit if EXxIN level changed. |

Note: EXI2ES and EXI3ES must be configured as "01b" because RTC interrupt request lines are rising edge.
Alarm interrupt request line (RTCAI) is linked with EXI3ES; timed interrupt request (RTCSI) is linked with EXI2ES.
EXISEL ESFR enables the Port2 alternate sources. RTC interrupts are alternate sources 2 and 3.

RTC external interrupt select register
EXISEL register (F1DAh/ED)

|  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 |
| Reset value: 0000h |  |  |  |  |  |  |  |  |  |  |  |
| EXI7SS | EXI6SS | EXI5SS | EXI4SS | EXI3SS | EXI2SS | EXI1SS | EXIOSS |  |  |  |  |

Table 121. RTC external interrupt select register functions

| Bit | Name | Function |
| :---: | :---: | :--- |
|  |  | External Interrupt $x$ Source Selection (x=7...0) <br> 15.0 <br> EXIxSS (x=7...0) |
|  | '01': Input from associated PORT2 pin <br> '10': Input from "alternate source". (Advised configuration) <br> configuration) <br> '11': Input from PORT2 pin ORed with "alternate source". (Advised |  |

Interrupt control registers are common with the CAPCOM1 Unit: CC10IC (RTCSI) and CC11IC (RTCAI).

RTC/CAPCOM interrupt control registers


Table 122. RTC/CAPCOM interrupt control requests

| Source of interrupt or <br> PEC service request | Request flag | Enable flag | Interrupt vector | Vector location |
| :--- | :--- | :--- | :--- | :--- |
| CAPCOM Register 10 | CC10IR | CC10IE | CC10INT | $00{ }^{\prime} 0068 \mathrm{~h}$ |
| CAPCOM Register 11 | CC11IR | CC11IE | CC11INT | $00{ }^{\prime} 006 \mathrm{Ch}$ |

## 23 System start-up configuration

RPOH is a 8-bit ESFR loaded at reset with the value read on port POH. Pull-up resistors are active on each port POH pin during reset, leading to RPOH = "FFh", by default.

Figure 95. PORTO configuration during Reset


## Start up configuration register



Table 123. Start up configuration register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 7.5 | CLKSEL | System Clock Selection <br> '000': <br> '001': <br> '010': <br> '011': <br> '100': <br> '101': <br> '110': <br> '111': |
| 4.3 | SALSEL | Segment Address Line Selection (Number of active segment address outputs) <br> 00: 4-bit segment address: A19...A16 <br> 0 1: No segment address lines at all <br> 10: 8-bit segment address: A23...A16 <br> 11: 2-bit segment address: A17...A16 (Default without pull-downs) |
| 0 | WRC | Write Configuration Control <br> '0': Pins WR acts as WRL, pin BHE acts as WRH <br> ' 1 ': Pins WR and BHE retain their normal function |

Note: $\quad$ RPOH(7:5) bits are loaded only during a long hardware reset.

## 24 Bootstrap loader

ST10F252M has an ST10 standard bootstrap mode that supports bootstrap via UART or CAN.

### 24.1 Selection between user-code or standard bootstrap

The selection between user-code or standard bootstrap is made by special combinations on PORTOL[5...4] during the time the reset configuration is latched from PORT0.

Bootstrap mode is triggered with a special combination set on PORTOL[5...4]. These signals, as are other configuration signals, are latched on the rising edge of RSTIN pin.

- Decoding of reset configuration (POL. $5=1$, POL. $4=1$ ) selects the normal mode and selects the user Flash to be mapped from address 00'0000h.
- Decoding of reset configuration (POL. $5=1$, POL. $4=0$ ) selects the ST10 standard bootstrap mode (user Flash is remapped at address 01'0000h and test Flash is mapped at address 00'0000h).

Table 124. ST10F252M boot mode selection

| P0.5 | P0.4 | ST10 decoding |
| :---: | :---: | :--- |
| 1 | 1 | No test mode: user Flash mapped at 00'0000h |
| 1 | 0 | Standard Bootstrap loader: User Flash mapped from 01'0000h |
| 0 | x | Reserved |

### 24.2 Standard bootstrap loader

The built-in bootstrap loader (BSL) of the ST10F252M provides a mechanism to load the startup program, which is executed after reset, via the serial interface. In this case, no external (ROM) memory or internal ROM is required for the initialization code starting at location 00'000oh. The bootstrap loader moves code and data into the internal RAM but it is also possible to transfer data via the serial interface into an external RAM using a second level loader routine. ROM memory (internal or external) is not necessary. However, it may be used to provide lookup tables or may provide "core-code", that is, a set of general-purpose subroutines, for example, for I/O operations, number crunching, system initialization, etc.

The bootstrap loader may be used to load the complete application software into ROMless systems, it may load temporary software into complete systems for testing or calibration, it may also be used to load a programming routine for Flash devices.

The BSL mechanism may be used for standard system startup as well as only for special occasions like system maintenance (firmware update) or end-of-line programming or testing.

### 24.2.1 Entering the standard bootstrap loader

As with the old ST10 bootstrap mode, the ST10F252M enters BSL mode, if pin P0L. 4 is sampled low at the end of a hardware reset. In this case, the built-in bootstrap loader is
activated independently of the selected bus mode. The bootstrap loader code is stored in a special test Flash; no part of the standard of the Flash memory area is required for this.

After entering BSL mode and the respective initialization, the ST10F252M scans the RxD0 line and the CAN1_RxD line to receive either a valid dominant bit from CAN interface, or a start condition from UART line.

- Start condition on UART RxD

ST10F252M starts standard bootstrap loader. This bootstrap loader is identical to other ST10 devices (example: ST10F269, ST10F168). See Section 24.3 for details.

- Valid dominant bit on CAN1 RxD

ST10F252M start bootstrapping via CAN; the bootstrapping method is new and is described in Section 24.4. Figure 96 shows the program flow of the new bootstrap loader. It illustrates clearly how the new functionalities are implemented:

- UART: UART has priority over CAN after a falling edge on CAN1_RxD till the 1st valid rising edge on CAN1_RxD
- CAN: pulses on CAN1_RxD shorter than 20*CPU-cycles are filtered.

Figure 96. ST10F252M new bootstrap loader program flow


### 24.2.2 ST10 configuration in BSL

When the ST10F252M has entered BSL mode, the following configuration is automatically set (values that deviate from the normal reset values, are marked):

Table 125. Register configuration in BSL

| Register | Value | Notes |
| :--- | :---: | :--- |
| Watchdog Timer: | Disabled |  |
| Register SYSCON: | $\mathbf{0 4 0 4}_{\boldsymbol{h}}{ }^{(1)}$ | XPEN bit set for Bootstrap via <br> CAN or Alternate Boot Mode |
| Context Pointer CP: | $\mathrm{FAOO}_{\mathrm{h}}$ |  |
| Register STKUN: | $\mathrm{FCOO}_{\mathrm{h}}$ |  |

Table 125. Register configuration in BSL (continued)

| Register | Value | Notes |
| :---: | :---: | :---: |
| Stack Pointer SP: | $\mathrm{FAHO}_{\boldsymbol{h}}$ |  |
| Register STKOV: | $\mathrm{FAOO}_{\mathrm{h}}$ |  |
| Register BUSCONO: | acc. to startup configuration ${ }^{(2)}$ |  |
| Register SOCON: | 8011 ${ }_{h}$ | Initialized only if Bootstrap via UART |
| Register SOBG: | acc. to '00' byte | Initialized only if Bootstrap via UART |
| P3.10 / TXD0: | '1' | Initialized only if Bootstrap via UART |
| DP3.10: | '1' | Initialized only if Bootstrap via UART |
| CAN Status/Control register: | $0000{ }_{h}$ | Initialized only if Bootstrap via CAN |
| CAN Bit Timing Register: | acc. to '0' frame | Initialized only if Bootstrap via CAN |
| XPERCON: | 042D ${ }_{\text {h }}$ | XRAM1-2, XFlash, CAN1 and XMISC enabled. Initialized only if Bootstrap via CAN |
| P4.6 / CAN1_TxD: | '1' | Initialized only if Bootstrap via CAN |
| DP4.6: | '1' | Initialized only if Bootstrap via CAN |

1. In bootstrap modes (standard or alternate) ROMEN, bit 10 of SYSCON, is always set regardless of $\overline{E A}$ pin level. BYTDIS, bit 9 of SYSCON, is set according to data bus width selection via PORTO configuration.
2. BUSCONO is initialized with 0000 h , external bus disabled, if pin $\overline{E A}$ is high during reset. If pin EA is low during reset, BUSACTO, bit 10, and ALECTLO, bit 9, are set enabling the external bus with lengthened ALE signal. BTYP field, bit 7 and 6 , is set according to Port0 configuration.

Other than after a normal reset, the watchdog timer is disabled, so the bootstrap loading sequence is not time limited. Depending on the serial link (UART or CAN), the pin TxD0 or CAN1_TxD is configured as output, so the ST10F252M can return an acknowledge. Even if the internal IFlash is enabled, no code can be executed out of it.

### 24.2.3 Booting steps

As Figure 97 shows, booting ST10F252M with the boot loader code occurs in a minimum of four steps.

1. The ST10F252M is reset with P0L. 4 low.
2. The internal new bootstrap code runs on the ST10 and a first level user code is downloaded from the external device using the selected serial link (UART or CAN). The bootstrap code is contained in the ST10F252M test Flash and is automatically run when ST10F252M is reset with P0L. 4 low. After loading a preselected number of bytes, ST10F252M begins executing the downloaded program.
3. The first level user code run on ST10F252M. Typically, this first level user code is another loader that is used to download the application software into the ST10F252M.
4. The loaded application software is now running.

Figure 97. Booting steps for ST10F252M


### 24.2.4 Hardware to activate BSL

The hardware that activates the BSL during reset may be a simple pull-down resistor on POL. 4 for systems that use this feature upon every hardware reset. Alternatively, use a switchable solution (via jumper or an external signal) for systems that only temporarily use the bootstrap loader.

Note: $\quad$ CAN alternate function on PORT4 lines is not activated if the user has selected eight address segments (PORT4 pins have three functions: I/O-port, address-segment, CAN). Boot via CAN requires that four address segments or less are selected.

Figure 98. Hardware provisions to activate BSL


### 24.2.5 Memory configuration in bootstrap loader mode

The configuration (that is, the accessibility) of the ST10F252M's memory areas after reset in bootstrap loader mode differs from the standard case. Pin EA is evaluated when BSL mode is selected to enable or not the external bus:

- if $\overline{E A}=1$, the external bus is disabled (BUSACT0 $=0$ in BUSCON0 register)
- if $\overline{E A}=0$, the external bus is enabled (BUSACTO $=1$ in BUSCONO register)

Moreover, while in BSL mode, accesses to the internal Flash area are partly redirected:

- all code accesses are made from the special test Flash seen in the range 00'0000h to 00'01FFFh
- user IFlash is only available for read and write accesses (test Flash can neither be read nor written)
- write accesses must be made with addresses starting in segment 1 from 01'0000h, whatever the value of ROMS1 bit in SYSCON register
- read accesses are made in segment 0 or in segment 1 depending of ROMS1 value
- in BSL mode by default, ROMS1=0 so the first 32 Kbytes of IFlash are mapped in segment 0.

For example: in the default configuration, to program address 0 , the user software must put the value 01 '0000h in the FARL and FARH registers but, to verify the content of the address 0 , a read to 00'0000h must be performed.

Figure 99. Memory configuration in bootstrap loader mode

|  |  |  |  |
| :---: | :---: | :---: | :---: |
| BSL mode active | Yes (POL.4='0') | Yes (P0L.4='0') | No (POL.4='1') |
| $\overline{\mathrm{EA}}$ pin | high | low | according to application |
| Code fetch from internal Flash area | Test-Flash access | Test-Flash access | User IFlash access |
| Data fetch from internal Flash area | User IFlash access | User IFlash access | User IFlash access |

Note: $\quad$ As long as ST10F252M is in BSL, the user software should not try to execute code from the internal IFlash as the fetches are redirected to the test Flash.

### 24.2.6 Loading the start-up code

After the serial link initialization sequence, the BSL enters a loop to receive 32 bytes (boot via UART) or 128 bytes (boot via CAN).
These bytes are stored sequentially into ST10F252M dual-port RAM from location 00'FA40h.

To execute the loaded code, the BSL jumps to location 00'FA40h. The bootstrap sequence running from the test Flash is now terminated but the microcontroller remains in BSL mode.
Most probably, the initially loaded routine (the first level user code) will load additional code and data. This first level user code may use the pre-initialized interface (UART or CAN) to receive data, a second level of code, and store it in arbitrary user-defined locations.

This second level of code may be the final application code. It may also be another, more sophisticated, loader routine that adds a transmission protocol to enhance the integrity of the loaded code or data. It may also contain a code sequence to change the system configuration and enable the bus interface to store the received data into external memory.
In all cases, the ST10F252M still runs in BSL mode, that is, with the watchdog timer disabled and limited access to the internal IFlash area.

### 24.2.7 Exiting bootstrap loader mode

To execute a program in normal mode, the BSL mode must be terminated. The ST10F252M exits BSL mode upon a software reset (level on P0L. 4 is ignored) or a hardware reset (P0L. 4 must be high). After the reset, the ST10F252M starts executing from location 00'0000h of the internal Flash (user Flash) or the external memory, as programmed via pin $\overline{\mathrm{EA}}$.
Note: If a bidirectional software reset is executed and external memory boot is selected $\overline{E A}=0$ ), a degeneration of the software reset event into a hardware reset can occur (refer to Section 20.6 for details). This would imply that POL. 4 becomes transparent so, to exit from bootstrap mode, it is necessary to release pin POL. 4 (it is no longer ignored).

### 24.2.8 Hardware requirements

Although the new bootstrap loader has been designed to be compatible with the old bootstrap loader, there are few hardware requirements related with the new bootstrap loader:

- external bus configuration needs to use four segment address lines or less to keep CAN I/O available
- use of CAN pins (P4.5 and P4.6): even in bootstrap via UART, pin P4.5 (CAN1_RxD) can not be used as port output but only as input; pin P4.6 (CAN1_TxD) can be used as input or output only if bootstrap via UART is needed
- level on UART RxD and CAN1_RxD during the bootstrap phase (see Figure 97 - Step 2) must be 1 (an external pull-up is recommended).


### 24.3 Standard bootstrap with UART (RS232 or K-Line)

### 24.3.1 Features

ST10F252M bootstrap via UART has the same overall behavior as the old ST10 bootstrap via UART:

- same bootstrapping steps
- same bootstrap method: analyze the timing of a predefined byte, send back an acknowledge byte, load a fixed number of bytes and run them
- same functionalities: boot with different crystals and PLL ratios.

Figure 100. UART bootstrap loader sequence


1. BSL initialization time, $>2 \mathrm{~ms} @ \mathrm{f}_{\mathrm{CPU}}=20 \mathrm{MHz}$.
2. Zero byte ( 1 start bit, eight ' 0 ' data bits, 1 stop bit), sent by host.
3. Acknowledge byte, sent by ST10F252M
4. 32 bytes of code / data, sent by host.
5. Caution: TxD0 is only driven a certain time after reception of the zero byte ( $2.5 \mathrm{~ms} @ \mathrm{f}_{\mathrm{CPU}}=20 \mathrm{MHz}$ ).
6. Internal Boot ROM / test-Flash.

### 24.3.2 Entering bootstrap via UART

The ST10F252M enters BSL mode if pin P0L. 4 is sampled low at the end of a hardware reset. In this case, the built-in bootstrap loader is activated independently of the selected bus mode. The bootstrap loader code is stored in a special test Flash, no part of the standard mask ROM or Flash memory area is required for this.

After entering BSL mode and the respective initialization, the ST10F252M scans the RxD0 line to receive a zero byte, that is, one start bit, eight ' 0 ' data bits and one stop bit. From the duration of this zero byte, it calculates the corresponding baud rate factor with respect to the current CPU clock, initializes the serial interface, ASC0, accordingly and switches pin TxD0
to output. Using this baud rate, an acknowledge byte is returned to the host that provides the loaded data.

The acknowledge byte is D5h for the ST10F252M.

### 24.3.3 ST10 configuration in UART BSL (RS232 or K-Line)

When the ST10F252M has entered BSL mode on UART, the following configuration is automatically set (values that deviate from the normal reset values, are marked):

Table 126. Register configuration in UART BSL

| Register | Value | Notes |
| :---: | :---: | :---: |
| Watchdog Timer: | Disabled |  |
| Register SYSCON: | 0400 ${ }_{\boldsymbol{h}}{ }^{(1)}$ |  |
| Context Pointer CP: | $\mathrm{FAOO}_{\mathrm{h}}$ |  |
| Register STKUN: | $\mathrm{FAOO}_{\mathrm{h}}$ |  |
| Stack Pointer SP: | FA40 ${ }_{\text {h }}$ |  |
| Register STKOV: | $\mathrm{FCOO}_{\mathrm{h}}$ |  |
| Register SOCON: | 8011 ${ }_{h}$ |  |
| Register BUSCONO: | acc. to startup configuration ${ }^{(2)}$ |  |
| Register SOBG: | acc. to '00' byte |  |
| P3.10 / TXD0: | ' 1 ' |  |
| DP3.10: | '1' |  |

1. In bootstrap modes (standard or alternate), ROMEN, bit 10 of SYSCON, is always set regardless of $\overline{E A}$ pin level. BYTDIS, bit 9 of SYSCON, is set according to data bus width selection via PORTO configuration.
2. BUSCONO is initialized with 0000 h, external bus disabled, if pin $\overline{E A}$ is high during reset. If pin $\overline{E A}$ is low during reset, BUSACTO, bit 10, and ALECTLO, bit 9, are set enabling the external bus with lengthened ALE signal. BTYP field, bit 7 and 6 , is set according to PORT0 configuration.

Other than after a normal reset, the watchdog timer is disabled so the bootstrap loading sequence is not time limited. Pin TxD0 is configured as output, so the ST10F252M can return the acknowledge byte. Even if the internal IFlash is enabled, no code can be executed from it.

### 24.3.4 Loading the start-up code

After sending the acknowledge byte, the BSL enters a loop to receive 32 bytes via ASC0. These bytes are stored sequentially into locations 00'FA40h through 00'FA5Fh of the internal RAM. So up to 16 instructions may be placed into the RAM area. To execute the loaded code, the BSL jumps to location 00'FA40h, that is, the first loaded instruction. The bootstrap loading sequence is now terminated but the ST10F252M remains in BSL mode. Most probably, the initially loaded routine will load additional code or data, as an average application is likely to require substantially more than 16 instructions. This second receive loop may directly use the pre-initialized interface ASC0 to receive data and store it to arbitrary user-defined locations.

This second level of loaded code may be the final application code. It may also be another, more sophisticated, loader routine that adds a transmission protocol to enhance the integrity
of the loaded code or data. It may also contain a code sequence to change the system configuration and enable the bus interface to store the received data into external memory.
This process may go through several iterations or may directly execute the final application. In all cases the ST10F252M still runs in BSL mode, that is, with the watchdog timer disabled and limited access to the internal Flash area. All code fetches from the IFlash area ( 01 '0000h...08'FFFFh, if mapped to segment 1) are redirected to the special test Flash. Data read operations access the internal Flash of the ST10F252M, if any is available, but will return undefined data on ROM-less devices.

### 24.3.5 Choosing the baud rate for the BSL via UART

The calculation of the serial baud rate for ASCO from the length of the first zero byte that is received allows the operation of the bootstrap loader of the ST10F252M with a wide range of baud rates. However, the upper and lower limits have to be kept, to insure proper data transfer.

$$
\mathrm{B}_{\mathrm{ST} 10 \mathrm{~F} 252 \mathrm{M}}=\frac{\mathrm{f}_{\mathrm{CPU}}}{32 \cdot(\mathrm{~S} 0 \mathrm{BRL}+1)}
$$

The ST10F252M uses timer T6 to measure the length of the initial zero byte. The quantization uncertainty of this measurement implies the first deviation from the real baud rate, the next deviation is implied by the computation of the SOBRL reload value from the timer contents. The formula below shows the association:

$$
\text { SOBRL }=\frac{\mathrm{T} 6-36}{72} \quad, \quad \mathrm{~T} 6=\frac{9}{4} \cdot \frac{\mathrm{f}_{\mathrm{CPU}}}{\mathrm{~B}_{\mathrm{Host}}}
$$

For a correct data transfer from the host to the ST10F252M the maximum deviation between the internal initialized baudrate for ASC0 and the real baud rate of the host should be below $2.5 \%$. The deviation ( $F_{B}$, in percent) between host baud rate and ST10F252M baud rate can be calculated via the formula below

$$
F_{B}=\left|\frac{\mathrm{B}_{\text {Contr }}-\mathrm{B}_{\text {Host }}}{\mathrm{B}_{\text {Contr }}}\right| \cdot 100 \%, \quad \mathrm{~F}_{\mathrm{B}} \leqslant 2.5 \%
$$

Note: $\quad$ Function $\left(F_{B}\right)$ does not consider the tolerances of oscillators and other devices supporting the serial communication.

This baud rate deviation is a nonlinear function depending on the CPU clock and the baud rate of the host. The maxima of the function $\left(F_{B}\right)$ increases with the host baud rate due to the smaller baud rate pre-scaler factors and the implied higher quantization error (see Figure 101).

Figure 101. Baudrate deviation between host and ST10F252M


The minimum baud rate ( $\mathrm{B}_{\text {Low }}$ in Figure 101) is determined by the maximum count capacity of timer T6, when measuring the zero byte, that is, it depends on the CPU clock. Using the maximum T6 count $2^{16}$ in the formula the minimum baud rate can be calculated. The lowest standard baudrate in this case would be 1200 baud. Baudrates below $\mathrm{B}_{\text {Low }}$ would cause T6 to overflow. In this case, ASC0 cannot be initialized properly.

The maximum baudrate ( $\mathrm{B}_{\text {High }}$ in Figure 101) is the highest baudrate where the deviation still does not exceed the limit, that is, all baudrates between $B_{\text {Low }}$ and $B_{\text {High }}$ are below the deviation limit. The maximum standard baudrate that fulfills this requirement is 19200 baud.

Higher baud rates, however, may be used as long as the actual deviation does not exceed the limit. A certain baudrate (marked I) in the figure) may for example, violate the deviation limit, while an even higher baudrate (marked II) in the figure) stays very well below it. This depends on the host interface.

### 24.4 Standard bootstrap with CAN

### 24.4.1 Features

The bootstrap via CAN has the same overall behavior as the bootstrap via UART:

- same bootstrapping steps
- same bootstrap method: analyze the timing of a predefined frame, send back an acknowledge frame but only on request, load a fixed number of bytes and run
- same functionalities: boot with different crystals and PLL ratios.

Figure 102. CAN bootstrap loader sequence


1. BSL initialization time, $>2 \mathrm{~ms} @ \mathrm{f}_{\mathrm{CPU}}=20 \mathrm{MHz}$.
2. Zero frame (CAN message: standard ID $=0, D L C=0$ ), sent by host.
3. CAN message (standard ID $=0 x E 6, D L C=3$, Data0 $=0 x D 5$, Data1-Data2 $=$ IDCHIP_low-high), sent by ST10F252M on request
4. 128 bytes of code / data, sent by host.
5. Caution: CAN1_TxD is only driven a certain time after reception of the zero byte ( $2.5 \mathrm{~ms} @ \mathrm{f}_{\mathrm{CPU}}=20 \mathrm{MHz}$ ).
6. Internal Boot ROM / Test-Flash.

The Bootstrap Loader may be used to load the complete application software into ROM-less systems, it may load temporary software into complete systems for testing or calibration, it may also be used to load a programming routine for Flash devices.

The BSL mechanism may be used for standard system start-up as well as only for special occasions like system maintenance (firmware update) or end-of-line programming or testing.

### 24.4.2 Entering the CAN bootstrap loader (BSL)

The ST10F252M enters BSL mode, if pin P0L. 4 is sampled low at the end of a hardware reset. In this case, the built-in bootstrap loader is activated independently of the selected bus mode. The bootstrap loader code is stored in a special test Flash, no part of the standard mask ROM or Flash memory area is required for this.

After entering BSL mode and completing the initialization, the ST10F252M scans the CAN1_TxD line to receive the following initialization frame:

- $\quad$ standard identifier $=0 \times 0$
- $\quad \mathrm{DLC}=0 \times 0$.

As all the bits to be transmitted are dominant bits, a succession of five dominant bits and one stuff bit on the CAN network is used. From the duration of this frame, it calculates the corresponding baud rate factor with respect to the current CPU clock, initializes the CAN1 interface accordingly, switches pin CAN1_TxD to output and enables the CAN1 interface to take part in the network communication. Using this baud rate, a message object is configured to send an acknowledge frame. The ST10F252M does not send this message object but the host can request it by sending a remote frame.

The acknowledge frame is the following for the ST10F252M:

- standard identifier $=0 x E 6$
- DLC $=0 \times 3$
- Data0 $=0 x D 5$, that is, generic acknowledge of the ST10 devices
- Data1 = IDCHIP least significant byte
- Data2 = IDCHIP most significant byte

For the ST10F252M, IDCHIP = 0FCXh.
Note: Two behaviors can be distinguished in the acknowledging of the ST10 to the host. If the host is behaving according to the CAN protocol, as at the beginning, the ST10 CAN is not configured, the host is alone on the CAN network and will not get any acknowledgement. It automatically resends the zero frame. As soon as the ST10 CAN is configured, it acknowledges the zero frame. The "acknowledge frame" with identifier OxE6 is configured, but the transmit request is not set. The host can request this frame to be sent and, therefore, get the IDCHIP by sending a remote frame.

As the IDCHIP is sent in the acknowledge frame, the Flash programming software can now know immediately the exact type of device to be programmed.

### 24.4.3 ST10 configuration in CAN BSL

When the ST10F252M enters BSL mode via CAN, the following configuration is automatically set (values that deviate from the normal reset values, are marked):

Figure 103. Register configuration in CAN BSL

| Register | Value | Notes |
| :--- | :---: | :--- |
| Watchdog Timer: | Disabled |  |
| XPERCON: | $042 D_{h}$ | XRAM1-2, CAN1, XFlash and <br> XMISC enabled |
| SYSCON: | $0404_{\mathrm{h}}{ }^{\text {(1) }}$ | XPEN bit set |
| Context Pointer CP: | FA00 $_{\mathrm{h}}$ |  |
| Register STKUN: | FA00 $_{\mathrm{h}}$ |  |
| Stack Pointer SP: | FA40 $_{\mathrm{h}}$ |  |
| Register STKOV: | FC00 $_{\mathrm{h}}$ |  |
| BUSCON0: | according to start-up $_{\text {configuration }}$ (2) |  |
| CAN1 Status/Control Register: | $0000_{h}$ |  |
| CAN1 Bit Timing Register: | according to 'Zero' <br> frame |  |
| P4.6 / CAN1_TxD: | '1' |  |
| DP4.6: | '1' |  |

1. In bootstrap modes (standard or alternate), ROMEN, bit 10 of SYSCON, is always set regardless of EA pin level. BYTDIS, bit 9 of SYSCON, is set according to data bus width selection via PORTO configuration.
2. BUSCONO is initialized with 0000h, external bus disabled, if pin $\overline{E A}$ is high during reset. If pin $\overline{E A}$ is low during reset, BUSACTO, bit 10, and ALECTLO, bit 9, are set enabling the external bus with lengthened ALE signal. BTYP field, bit 7 and 6, is set according to PORT0 configuration.

The watchdog timer is disabled, so the bootstrap loading sequence is not time limited. Pin CAN1_TxD is configured as output, so the ST10F252M can return the identification frame. Even if the internal Flash is enabled, no code can be executed from it.

### 24.4.4 Loading the startup code via CAN

After sending the acknowledge byte the BSL enters a loop to receive 128 bytes via CAN1.
Hint: the number of bytes loaded when booting via the CAN interface has been extended to 128 bytes to allow the re-configuration of the CAN bit timing register with the best timings (synchronization window, ...). This can be achieved by the following sequence of instructions:

```
ReconfigureBaudRate:
\begin{tabular}{ll} 
MOV R1,\#041h & \\
MOV DPP3:0EF00h,R1 ; Put CAN in Init, enable Configuration Change \\
MOV R1,\#01600h & \\
MOV DPP3:0EF06h,R1 ; 1MBaud at FCPu \(=20 \mathrm{MHz}\)
\end{tabular}
```

These 128 bytes are stored sequentially into locations 00'FA40h through 00'FABFh of the internal RAM (DPRAM). Up to 64 instructions may be placed into the RAM area. To execute the loaded code, the BSL jumps to location 00'FA40h, that is, the first loaded instruction. The bootstrap loading sequence is now terminated but the ST10F252M remains in BSL mode. Most probably, the initially loaded routine loads additional code or data, as an average application is likely to require substantially more than 64 instructions. This second
receive loop may directly use the pre-initialized CAN interface to receive data and store it in arbitrary user-defined locations.

This second level of loaded code may be the final application code. It may also be another, more sophisticated, loader routine that adds a transmission protocol to enhance the integrity of the loaded code or data. It may also contain a code sequence to change the system configuration and enable the bus interface to store the received data into external memory.

This process may go through several iterations or may directly execute the final application. In all cases, the ST10F252M still runs in BSL mode, that is, with the watchdog timer disabled and limited access to the internal Flash area. All code fetches from the internal Flash area (01'0000h to 08'FFFFh) are redirected to the special test Flash. Data fetches access the internal Flash of the ST10F252M, if any is available, but return undefined data on ROM-less devices.

### 24.4.5 Choosing the baud rate for the BSL via CAN

The bootstrap via CAN acts in the same way than the UART bootstrap mode. When the ST10F252M is started in BSL mode, it polls the RxD0 and CAN1_RxD lines. On polling a low level on one of these lines, a timer is launched that is stopped when the line gets back to high level.

For CAN communication, the algorithm is made to receive a zero frame, that is, a standard identifier is $0 \times 0$, $D L C$ is 0 . This frame will produce the following levels: 5D, 1R, 5D, 1R, 5D, $1 R, 5 D, 1 R, 5 D, 1 R, 4 D, 1 R, 1 D, 11 R$. The algorithm runs the timer until the detection of the fifth recessive bit. This calculates the bit timing over the duration of 29 bits; this minimizes the error introduced by the polling.

Figure 104. Bit rate measurement over a predefined zero-frame


## Error induced by the polling

The code used for the polling is as follows:

```
WaitCom:
    JNB P4.5,CAN_Boot ; if SOF detected on CAN, then go to CAN loader
    JB P3.11,WaitCom ; Wait for start bit at RXD0
    BSET T6R ; Start Timer T6
CAN_Boot:
    BSET PWMCONO.O
; Start PWM Timer0
; (resolution is 1 CPU clk cycle)
```

```
JMPR Cc_UC,WaitRecessiveBi
t
```

WaitDominantBit:
JB P4.5,WaitDominantBit ; wait for end of stuff bit
WaitRecessiveBit:


Therefore, the maximum error at the detection of the communication on CAN pin is:
(1 not taken + 1 taken jumps) + 1 taken jump + 1 bit set: (6) + 6 CPU clock cycles
The error at the detection for the fifth recessive bit is:
(1 taken jump) + 1 not taken jump + 1 compare + 1 bit clear: (4) + 6 CPU cycles
In the worst case, the induced error is of six CPU clock cycles. So the polling could induce an error of six timer ticks.

## Error induced by the bit rate calculation

The code used for the polling is as follows:

```
WaitCom:
    JNB P4.5,CAN_Boot ; if SOF detected on CAN,
        ; then go to CAN loader
    JB P3.11,WaitCom ; Wait for start bit at RxD0
    BSET T6R ; Start Timer T6
CAN_Boot:
    BSET PWMCONO.0 ; Start PWM Timer0
                                    ; (resolution is 1 CPU clk cycle)
    JMPR Cc_UC,WaitRecessiveBit
WaitDominantBit:
    JB P4.5,WaitDominantBit ; wait for end of stuff bit
WaitRecessiveBit:
    JNB P4.5,WaitRecessiveBit ; wait for 1st dominant bit = Stuff bit
    CMPI1 R1,#5 ; Test if 5th stuff bit detected
    JMPR cc_NE,WaitDominantBit ; No, go back to count more
    BCLR PWMCON.0 ; Stop timer
                                    ; here the 5th stuff bit is detected:
                                    ; PTO = 29 Bit_Time (25D and 4R)
```

Therefore, the maximum error at the detection of the communication on CAN pin is:

```
(1 not taken + 1 taken jumps) + 1 taken jump + 1 bit set: (6) + 6 CPU clock cycles
```

The error at the detection for the fifth recessive bit is:

```
(1 taken jump) + 1 not taken jump + 1 compare + 1 bit clear: (4) + 6 CPU cycles
```

In the worst case the induced error is of six CPU clock cycles. So the polling could induce an error of six timer ticks.

## Error induced by the baud rate calculation

The content of the timer PT0 counter corresponds to 29 bit times. This gives the following equation:

$$
P T 0=58 \times(B R P+1) \times(1+T \operatorname{seg} 1+T \text { seg } 2)
$$

where BRP, Tseg1 and Tseg2 are the fields of the CAN bit timing register.
The CAN protocol specification recommends the implementation of a bit time that has at least 8 time quantum (tq). This recommendation applies here. The maximum bit time length is 25 tq . To have good precision, the target has the smallest bit rate prescaler (BRP) and the maximum number of tq in a bit time.

This gives the following ranges for PT0 according to BRP:

$$
\begin{gathered}
8 \leq 1+T \operatorname{seg} 1+T \operatorname{seg} 2 \leq 5 \\
464 \times(1+B R P) \leq P T 0 \leq 1450 \times(1+B R P)
\end{gathered}
$$

Table 127. Ranges of timer contents in function of BRP value

| BRP | PTO_min | PTO_max | Comments |
| :---: | :---: | :---: | :---: |
| 0 | 464 | 1450 |  |
| 1 | 1451 | 2900 |  |
| 2 | 2901 | 4350 |  |
| 3 | 4351 | 5800 |  |
| 4 | 5801 | 7250 |  |
| 5 | 7251 | 8700 |  |
| .. | .. | .. |  |
| 43 | 20416 | 63800 |  |
| 44 | 20880 | 65250 |  |
| 45 | 21344 | 66700 | Possible Timer overflow |
| .. | .. | .. |  |
| 63 | $X$ | $X$ |  |

The error from the measurement of the 29 bits is:
$\mathrm{e}_{1}=6 /[\mathrm{PT} 0]$
It is a maximum for the smallest BRP value and the smallest number of ticks in PTO. Therefore:
$e_{1 \text { Max }}=1.29 \%$
To have better precision, the target is to have the smallest BRP so that the time quantum is the smallest possible. Thus an error on the calculation of time quanta in a bit time is
minimized. To do so, the value of PT0 is divided in ranges of 1450 ticks. In the algorithm, PTO is divided by 1451 and the result is BRP.

The calculated BRP value is used to divide PT0 to have the value of (1+Tseg1+Tseg2). A table is generated to set the values for Tseg1 and Tseg2 according to the value of ( $1+$ Tseg1 + Tseg2). These values of Tseg1 and Tseg2 are chosen to reach a sample point between $70 \%$ and $80 \%$ of the bit time.

During the calculation of ( $1+T \operatorname{seg} 1+T \operatorname{seg} 2$ ), an error $e_{2}$ can be introduced by the division. This error is a maximum of one time quantum.

To compensate any possible error on bit rate, the (re)synchronization jump width is fixed at two time quanta.

### 24.4.6 How to compute the baud rate error

Considering the following conditions, the error is calculated as example.

- CPU frequency: 20 MHz
- target bit rate: $1 \mathrm{Mbit} / \mathrm{s}$

In these conditions, the content of PT0 timer for 29 Bit should be:

$$
[P T 0]=\frac{29 \times F c p u}{\text { BitRate }}=\frac{29 \times 20 \times 10^{6}}{1 \times 10^{6}}=580
$$

Therefore:

$$
574<[P T 0]<586
$$

This gives:

- $\quad B R P=0$
- $\mathrm{tq}=100 \mathrm{~ns}$

Computation of $1+$ Tseg1 + Tseg2 from the equation:

$$
[P T 0]=58 \times(1+B R P) \times(1+T \operatorname{seg} 1+T \operatorname{seg} 2)
$$

Thus:

$$
9=\frac{574}{58} \leq 1+T \operatorname{seg} 1+T \operatorname{seg} 2 \leq \frac{586}{58}=10
$$

In the algorithm, a rounding to the superior value is made if the remainder of the division is greater than half of the divisor. Here it would have been the case if the PT0 content was 574. Thus in this example it results $1+T \operatorname{seg} 1+$ Tseg $2=10$, giving a bit time of exactly $1 \mu \mathrm{~s}$ and, thus, no error in bit rate.

Note: $\quad$ In most cases ( $24 \mathrm{MHz}, 32 \mathrm{MHz}, 40 \mathrm{MHz}$ of CPU frequency and 125, 250, 500 or $1 \mathrm{Mb} / \mathrm{s}$ of bit rate), there is no error. However, it is better to check the error with the real application parameters.
The content of the Bit Timing register is: $0 \times 1640$. This gives a sample point at $80 \%$.
Note: $\quad$ The (re)synchronization jump width is fixed at two time quanta.

### 24.4.7 Bootstrap via CAN

After the bootstrap phase, the ST10F252 CAN module is configured as follow:

- the pin P4.6 is configured as output (the latch value is ' 1 ' = recessive) to assume CAN1_TxD function.
- the MO 2 is configured to output the acknowledge of the bootstrap with the standard identifier 0xE6, a DLC of 3 and Data0 = 0xD5, Data1 and 2 = IDCHIP.
- The MO1 is configured to receive messages with the standard identifier $0 \times 5$; its acceptance mask is set so that all bits match - the DLC received is not checked; the ST10 expects only 1 byte of data at a time.

No other message is sent by the ST10F252M after the acknowledge.
Note: $\quad$ The CAN boot waits for 128 byte of data instead of 32 (see UART boot). This is done in order to allow the user to reconfigure the CAN bitrate as soon as possible.

### 24.5 Comparing the old and the new bootstrap loader

Table 128 and 129 summarize the differences between the old ST10 (boot via UART only) bootstrap and the new one (boot via UART or CAN).

### 24.5.1 Software aspects

Table 128 summarizes the software differences.
Table 128. Software topics summary

| Old bootstrap loader | New bootstrap loader | Comments |
| :--- | :--- | :--- |
| uses only 32 bytes in Dual-Port <br> RAM from 00'FA40h | uses up to 128 bytes in Dual- <br> Port RAM from 00'FA4Oh | for compatibility between boot <br> via UART and boot via CAN1, <br> please avoid loading the <br> application software in the <br> 00'FA60h/00'FABFh range |
| load 32 bytes from UART | Ioad 32 bytes from UART (boot <br> via UART mode) | same files can be used for boot <br> via UART. |
| user selected Xperipherals can <br> be enabled during boot (step 3 <br> or step 4) | Xperipherals selection is fixed. | user can change the <br> Xperipherals selections through <br> a specific code. |

As the CAN1 is needed, the XPERCON register is configured by the bootstrap loader code and bit XPEN of SYSCON is set. As long as the EINIT instruction is not executed (and it is not in the bootstrap loader code), the settings can be modified. Perform the following steps to do this:

- disable the XPeripherals by clearing XPEN in SYSCON register; this part of code must not be located in XRAM as it will be disabled
- enabled the required XPeripherals by writing the correct value in XPERCON register
- set XPEN bit in SYSCON.


### 24.5.2 Hardware aspects

Although the new bootstrap loader has been designed to be compatible with the old bootstrap loader, there are few hardware requirements with the new bootstrap loader. These are summarized in Table 129.

Table 129. Hardware topics summary

| Actual bootstrap loader | New bootstrap loader | Comments |
| :--- | :--- | :---: |
| P4.5 and P4.6 can be used as <br> output in BSL mode | P4.5 and P4.6 cannot be used <br> as user output in BSL mode, but <br> only as CAN1 alternate pins or <br> inputs or address-segments |  |
| level on CAN1_RxD can change <br> during boot step2 | level on CAN1_RxD must be <br> stable at '1' during boot step2 | external pull-up on P4.5 needed |

Figure 105. Reset Boot Sequence


## 25 Identification registers

The ST10F252M has four Identification registers, mapped in ESFR space. These register contain:

- a manufacturer identifier
- a chip identifier, with its revision
- an internal memory and size identifier
- programming voltage description.


## Manufacturer identifier register



Table 130. Manufacturer identifier register functions

| Bit | Name | Function |
| :---: | :--- | :--- |
| 15.5 | MANUF | Manufacturer identifier <br> '020h': STMicroelectronics manufacturer (JTAG worldwide <br> normalization) |
| 4.0 | PROCESSID | Process identifier <br> '03h': $0.18 ~ \mu \mathrm{~m}$ CMOS process |

## Chip identifier register



Table 131. Chip identifier register functions

| Bit | Name | Function |
| :--- | :--- | :--- |
| 15.14 | PCONF | Peripheral Configuration <br>  <br>  |
|  | '00': (E) Enhanced (ST10F252) <br> '01': (B) Basic <br> '10': (D) Dedicated <br> '11': reserved |  |

Table 131. Chip identifier register functions (continued)

| Bit | Name | Function |
| :---: | :--- | :--- |
| 13.4 | CHIPID | ST10 Module Identifier <br> '0FCh': ST10F252M Identifier (252) |
| 3.0 | REVID | ST10 Module Revision Identifier (Full Mask Set revision) <br> '01h': Rev. A (First main revision) <br> '02h': Rev. B (Second main revision) <br> $\vdots$ <br> '0Fh': Rev. P |

Figure 106. Internal memory and size identifier register

| IDMEM register (F07Ah/3Dh) |  |  |  | ESFR |  |  |  |  |  |  |  |  | Reset value: 2040h |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| MEMTYP |  |  |  | MEMSIZE |  |  |  |  |  |  |  |  |  |  |  |

Table 132. Internal memory and size identifier register functions

| Bit | Name | Function |
| :--- | :--- | :--- |
| 15.12 |  | MEMTYP |
|  |  | Internal memory type <br> 'Oh': ROM-less <br> '1h': (M) ROM memory <br> '2h': (S) Standard Flash memory (ST10F252M) <br>  |
|  |  | '3h': (H) High performance Flash memory <br> '4h...Fh': reserved. |
|  | MEMSIZ | Internal Memory Size <br> Internal Memory size is 4 * <MEMSIZE> (in Kbyte) <br> '040h': ST10F252M (256 Kbytes). |

## Programming voltage description register



Table 133. Programming voltage description register functions

| Bit | Name | Function |
| :---: | :---: | :---: |
| 15.8 | PROGVPP | Programming $\mathrm{V}_{\mathrm{PP}}$ voltage ( no need of external $\mathrm{V}_{\mathrm{PP}}$ ) - 00h |
| 7.0 | PROGVDD | Programming $\mathrm{V}_{\mathrm{DD}}$ voltage <br> $V_{D D}$ voltage when programming EPROM or Flash devices is calculated using the following formula: $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=20 \text { * <PROGVDD> / } 256 \text { [V] } \\ & \text { 40h': ST10F252M (5.0 V). } \end{aligned}$ |

The values written in the different identification register bits are valid only after the Flash initialization phase is completed. When code execution is started from internal memory (pin $\overline{E A}$ held high during reset), the Flash has certainly completed its initialization, so the bits of identification registers are immediately ready to be read out. When code execution is started from external memory (pin $\overline{\mathrm{EA}}$ held low during reset), the Flash initialization is not yet completed, so the bits of identification registers are not ready. Poll bits 15 and 14 of the IDMEM register; when both bits read low, the Flash initialization is complete, so all identification register bits are correct.

Before Flash initialization completion, the default setting of the different Identification Registers are as follows:

| IDMANUF | 0403 h |
| :--- | :--- |
| IDCHIP | $0 F C n h$ 0FBnh (with n representing the silicon revision number) |
| IDMEM | F2040h |
| IDPROG | 0040h |

## 26 Register set

### 26.1 General purpose registers

General purpose registers (GPRs) form the register bank that the CPU works with. This register bank may be located anywhere within the internal RAM via the context pointer (CP). Due to the addressing mechanism, GPR banks can only reside within the internal RAM. All GPRs are bit-addressable.

Table 134. General purpose registers (GPRs)

| Name | Physical <br> address | 8-bit <br> address | Reseription <br> value |  |
| :---: | :---: | :---: | :--- | :---: |
| R0 | $(\mathrm{CP})+0$ | F0h | CPU General Purpose (word) Register R0 | UUUUh |
| R1 | $(\mathrm{CP})+2$ | F1h | CPU General Purpose (word) Register R1 | UUUUh |
| R2 | $(\mathrm{CP})+4$ | F2h | CPU General Purpose (word) Register R2 | UUUUh |
| R3 | $(\mathrm{CP})+6$ | F3h | CPU General Purpose (word) Register R3 | UUUUh |
| R4 | $(\mathrm{CP})+8$ | F4h | CPU General Purpose (word) Register R4 | UUUUh |
| R5 | $(\mathrm{CP})+10$ | F5h | CPU General Purpose (word) Register R5 | UUUUh |
| R6 | $(\mathrm{CP})+12$ | F6h | CPU General Purpose (word) Register R6 | UUUUh |
| R7 | $(\mathrm{CP})+14$ | F7h | CPU General Purpose (word) Register R7 | UUUUh |
| R8 | $(\mathrm{CP})+16$ | F8h | CPU General Purpose (word) Register R8 | UUUUh |
| R9 | $(C P)+18$ | F9h | CPU General Purpose (word) Register R9 | UUUUh |
| R10 | $(C P)+20$ | FAh | CPU General Purpose (word) Register R10 | UUUUh |
| R11 | $(C P)+22$ | FBh | CPU General Purpose (word) Register R11 | UUUUh |
| R12 | $(C P)+24$ | FCh | CPU General Purpose (word) Register R12 | UUUUh |
| R13 | $(C P)+26$ | FDh | CPU General Purpose (word) Register R13 | UUUUh |
| R14 | $(C P)+28$ | FEh | CPU General Purpose (word) Register R14 | UUUUh |
| R15 | $(C P)+30 ~$ | FFh | CPU General Purpose (word) Register R15 | UUUUh |

The first eight GPRs (R7...R0) may also be accessed byte wise. Other than with SFRs, writing to a GPR byte does not affect the other byte of the respective GPR. The respective halves of the byte-accessible registers receive special names as shown in Table 135.

Table 135. General purpose registers (GPRs) bit wise addressing

| Name | Physical <br> address | 8-bit <br> address | Description <br> value |  |
| :---: | :---: | :---: | :--- | :---: |
| RL0 | (CP) +0 | F0h | CPU General Purpose (byte) Register RL0 | UUh |
| RH0 | (CP) +1 | F1h | CPU General Purpose (byte) Register RH0 | UUh |
| RL1 | (CP) +2 | F2h | CPU General Purpose (byte) Register RL1 | UUh |
| RH1 | (CP) +3 | F3h | CPU General Purpose (byte) Register RH1 | UUh |
| RL2 | (CP) +4 | F4h | CPU General Purpose (byte) Register RL2 | UUh |

Table 135. General purpose registers (GPRs) bit wise addressing (continued)

| Name | Physical <br> address | 8-bit <br> address | Rescription <br> value |  |
| :---: | :---: | :---: | :--- | :---: |
| RH2 | (CP) +5 | F5h | CPU General Purpose (byte) Register RH2 | UUh |
| RL3 | (CP) +6 | F6h | CPU General Purpose (byte) Register RL3 | UUh |
| RH3 | (CP) +7 | F7h | CPU General Purpose (byte) Register RH3 | UUh |
| RL4 | (CP) +8 | F8h | CPU General Purpose (byte) Register RL4 | UUh |
| RH4 | (CP) +9 | F9h | CPU General Purpose (byte) Register RH4 | UUh |
| RL5 | (CP) +10 | FAh | CPU General Purpose (byte) Register RL5 | UUh |
| RH5 | (CP) +11 | FBh | CPU General Purpose (byte) Register RH5 | UUh |
| RL6 | (CP) +12 | FCh | CPU General Purpose (byte) Register RL6 | UUh |
| RH6 | (CP) +13 | FDh | CPU General Purpose (byte) Register RH6 | UUh |
| RL7 | (CP) +14 | FEh | CPU General Purpose (byte) Register RL7 | UUh |
| RH7 | (CP) +15 | FFh | CPU General Purpose (byte) Register RH7 | UUh |

### 26.2 Special function register overview

### 26.2.1 Registers ordered by name

Table 136 lists all SFRs which are implemented in the ST10F252M in alphabetical order. Bitaddressable SFRs are marked with the letter "b" in column "Name". SFRs within the Extended SFR-Space (ESFRs) are marked with the letter "E" in column "Physical Address".

Table 136. Special function registers listed by name

| Name | Physical <br> address | 8-bit <br> address | Description | Reset <br> value |
| :--- | :--- | :---: | :--- | :---: |
| ADCIC | b | FF98h | CCh | ADC end of Conversion Interrupt Control Reg. |
| ADCON | b | FFA0h | D0h | ADC Control Register |
| ADDAT | FEAOh | 50 h | ADC Result Register | 0000 h |
| ADDAT2 | F0AOh E | 50 h | ADC 2 Result Register | 0000 h |
| ADDRSEL1 | FE18h | 0Ch | Address Select Register 1 | 0000 h |
| ADDRSEL2 | FE1Ah | 0Dh | Address Select Register 2 | 0000 h |
| ADDRSEL3 | FE1Ch | 0Eh | Address Select Register 3 | 0000 h |
| ADDRSEL4 | FE1Eh | 0Fh | Address Select Register 4 | 0000 h |
| ADEIC | b | FF9Ah | CDh | ADC Overrun Error Interrupt Control Register |
| BUSCON0b | FF0Ch | 86h | Bus Configuration Register 0 | --00 h |
| BUSCON1b | FF14h | 8Ah | Bus Configuration Register 1 | $0 x x 0 \mathrm{~h}$ |
| BUSCON2b | FF16h | 8Bh | Bus Configuration Register 2 | 0000 h |
| BUSCON3b | FF18h | 8Ch | Bus Configuration Register 3 | 0000 h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| BUSCON4b | FF1Ah | 8Dh | Bus Configuration Register 4 | 0000h |
| CAPREL | FE4Ah | 25h | GPT2 Capture/Reload Register | 0000h |
| CCO | FE80h | 40h | CAPCOM Register 0 | 0000h |
| CCOIC b | FF78h | BCh | CAPCOM Register 0 Interrupt Control Register | - - 00h |
| CC1 | FE82h | 41h | CAPCOM Register 1 | 0000h |
| CC1IC b | FF7Ah | BDh | CAPCOM Register 1 Interrupt Control Register | - - 00h |
| CC2 | FE84h | 42h | CAPCOM Register 2 | 0000h |
| CC2IC b | FF7Ch | BEh | CAPCOM Register 2 Interrupt Control Register | - - 00h |
| CC3 | FE86h | 43h | CAPCOM Register 3 | 0000h |
| CC3IC b | FF7Eh | BFh | CAPCOM Register 3 Interrupt Control Register | - - 00h |
| CC4 | FE88h | 44h | CAPCOM Register 4 | 0000h |
| CC4IC b | FF80h | COh | CAPCOM Register 4 Interrupt Control Register | - - 00h |
| CC5 | FE8Ah | 45h | CAPCOM Register 5 | 0000h |
| CC5IC b | FF82h | C1h | CAPCOM Register 5 Interrupt Control Register | - - 00h |
| CC6 | FE8Ch | 46h | CAPCOM Register 6 | 0000h |
| CC6IC b | FF84h | C2h | CAPCOM Register 6 Interrupt Control Register | - - 00h |
| CC7 | FE8Eh | 47h | CAPCOM Register 7 | 0000h |
| CC7IC b | FF86h | C3h | CAPCOM Register 7 Interrupt Control Register | - - 00h |
| CC8 | FE90h | 48h | CAPCOM Register 8 | 0000h |
| CC8IC b | FF88h | C4h | CAPCOM Register 8 Interrupt Control Register | - - 00h |
| CC9 | FE92h | 49h | CAPCOM Register 9 | 0000h |
| CC9IC b | FF8Ah | C5h | CAPCOM Register 9 Interrupt Control Register | - - 00h |
| CC10 | FE94h | 4Ah | CAPCOM Register 10 | 0000h |
| CC10IC b | FF8Ch | C6h | CAPCOM Register 10 Interrupt Control Register | - - 00h |
| CC11 | FE96h | 4Bh | CAPCOM Register 11 | 0000h |
| CC11IC b | FF8Eh | C7h | CAPCOM Register 11 Interrupt Control Register | --00h |
| CC12 | FE98h | 4Ch | CAPCOM Register 12 | 0000h |
| CC12IC b | FF90h | C8h | CAPCOM Register 12 Interrupt Control Register | - - 00h |
| CC13 | FE9Ah | 4Dh | CAPCOM Register 13 | 0000h |
| CC13IC b | FF92h | C9h | CAPCOM Register 13 Interrupt Control Register | - - 00h |
| CC14 | FE9Ch | 4Eh | CAPCOM Register 14 | 0000h |
| CC14IC b | FF94h | CAh | CAPCOM Register 14 Interrupt Control Register | - - 00h |
| CC15 | FE9Eh | 4Fh | CAPCOM Register 15 | 0000h |
| CC15IC b | FF96h | CBh | CAPCOM Register 15 Interrupt Control Register | - - 00h |

Table 136. Special function registers listed by name (continued)

| Name | Physica addres | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| CC16 | FE60h | 30h | CAPCOM Register 16 | 0000h |
| CC16IC b | F160h | B0h | CAPCOM Register 16 Interrupt Control Register | - - 00h |
| CC17 | FE62h | 31h | CAPCOM Register 17 | 0000h |
| CC17IC b | F162h | B1n | CAPCOM Register 17 Interrupt Control Register | - - 00h |
| CC18 | FE64h | 32h | CAPCOM Register 18 | 0000h |
| CC18IC b | F164h | B2h | CAPCOM Register 18 Interrupt Control Register | - - 00h |
| CC19 | FE66h | 33h | CAPCOM Register 19 | 0000h |
| CC19IC b | F166h | B3h | CAPCOM Register 19 Interrupt Control Register | - - 00h |
| CC20 | FE68h | 34h | CAPCOM Register 20 | 0000h |
| CC20IC b | F168h | B4h | CAPCOM Register 20 Interrupt Control Register | - - 00h |
| CC21 | FE6Ah | 35h | CAPCOM Register 21 | 0000h |
| CC21IC b | F16Ah | B5h | CAPCOM Register 21 Interrupt Control Register | - - 00h |
| CC22 | FE6Ch | 36h | CAPCOM Register 22 | 0000h |
| CC22IC b | F16Ch | B6h | CAPCOM Register 22 Interrupt Control Register | - - 00h |
| CC23 | FE6Eh | 37h | CAPCOM Register 23 | 0000h |
| CC23IC b | F16Eh | B7h | CAPCOM Register 23 Interrupt Control Register | - - 00h |
| CC24 | FE70h | 38h | CAPCOM Register 24 | 0000h |
| CC24IC b | F170h | B8h | CAPCOM Register 24 Interrupt Control Register | - - 00h |
| CC25 | FE72h | 39h | CAPCOM Register 25 | 0000h |
| CC25IC b | F172h | B9h | CAPCOM Register 25 Interrupt Control Register | - - 00h |
| CC26 | FE74h | 3Ah | CAPCOM Register 26 | 0000h |
| CC26IC b | F174h | BAh | CAPCOM Register 26 Interrupt Control Register | - - 00h |
| CC27 | FE76h | 3Bh | CAPCOM Register 27 | 0000h |
| CC27IC b | F176h | BBh | CAPCOM Register 27 Interrupt Control Register | - - 00h |
| CC28 | FE78h | 3Ch | CAPCOM Register 28 | 0000h |
| CC28IC b | F178h | BCh | CAPCOM Register 28 Interrupt Control Register | -- 00h |
| CC29 | FE7Ah | 3Dh | CAPCOM Register 29 | 0000h |
| CC29IC b | F184h | C2h | CAPCOM Register 29 Interrupt Control Register | - - 00h |
| CC30 | FE7Ch | 3Eh | CAPCOM Register 30 | 0000h |
| CC30IC b | F18Ch | C6h | CAPCOM Register 30 Interrupt Control Register | - - 00h |
| CC31 | FE7Eh | 3Fh | CAPCOM Register 31 | 0000h |
| CC31IC b | F194h | CAh | CAPCOM Register 31 Interrupt Control Register | - - 00h |
| CCM0 b | FF52h | A9h | CAPCOM Mode Control Register 0 | 0000h |
| CCM1 b | FF54h | AAh | CAPCOM Mode Control Register 1 | 0000h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| CCM2 b | FF56h | ABh | CAPCOM Mode Control Register 2 | 0000h |
| CCM3 b | FF58h | ACh | CAPCOM Mode Control Register 3 | 0000h |
| CCM4 b | FF22h | 91h | CAPCOM Mode Control Register 4 | 0000h |
| CCM5 b | FF24h | 92h | CAPCOM Mode Control Register 5 | 0000h |
| CCM6 b | FF26h | 93h | CAPCOM Mode Control Register 6 | 0000h |
| CCM7 b | FF28h | 94h | CAPCOM Mode Control Register 7 | 0000h |
| CP | FE10h | 08h | CPU Context Pointer Register | FC00h |
| CRIC b | FF6Ah | B5h | GPT2 CAPREL Interrupt Control Register | -- 00h |
| CSP | FE08h | 04h | CPU Code Segment Pointer Register (read only) | 0000h |
| DPOL b | F100h E | 80h | POL Direction Control Register | -- 00h |
| DPOH b | F102h E | 81h | POh Direction Control Register | - - 00h |
| DP1L b | F104h E | 82h | P1L Direction Control Register | --00h |
| DP1H b | F106h E | 83h | P1h Direction Control Register | - - 00h |
| DP2 b | FFC2h | E1h | Port 2 Direction Control Register | 0000h |
| DP3 b | FFC6h | E3h | Port 3 Direction Control Register | 0000h |
| DP4 b | FFCAh | E5h | Port 4 Direction Control Register | - - 00h |
| DP6 b | FFCEh | E7h | Port 6 Direction Control Register | --00h |
| DP7 b | FFD2h | E9h | Port 7 Direction Control Register | - - 00h |
| DP8 b | FFD6h | EBh | Port 8 Direction Control Register | - - 00h |
| DPP0 | FE00h | 00h | CPU Data Page Pointer 0 Register (10-bit) | 0000h |
| DPP1 | FE02h | 01h | CPU Data Page Pointer 1 Register (10-bit) | 0001h |
| DPP2 | FE04h | 02h | CPU Data Page Pointer 2 Register (10-bit) | 0002h |
| DPP3 | FE06h | 03h | CPU Data Page Pointer 3 Register (10-bit) | 0003h |
| EXICON b | F1C0h E | EOh | External Interrupt Control Register | 0000h |
| EXISEL b | F1DAh E | EDh | External Interrupt Source Selection Register | 0000h |
| IDCHIP | F07Ch E | 3Eh | Device Identifier Register ( n is the device revision) | FBnh |
| IDMANUF | F07Eh E | 3Fh | Manufacturer Identifier Register | 0403h |
| IDMEM | F07Ah E | 3Dh | On-chip Memory Identifier Register | 2040h |
| IDPROG | F078h E | 3Ch | Programming Voltage Identifier Register | 0040h |
| IDX0 b | FF08h | 84h | MAC Unit Address Pointer 0 | 0000h |
| IDX1 b | FFOAh | 85h | MAC Unit Address Pointer 1 | 0000h |
| MAH | FE5Eh | 2Fh | MAC Unit Accumulator - High Word | 0000h |
| MAL | FE5Ch | 2Eh | MAC Unit Accumulator - Low Word | 0000h |
| MCW b | FFDCh | EEh | MAC Unit Control Word | 0000h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| MDC b | FF0Eh | 87h | CPU Multiply Divide Control Register | 0000h |
| MDH | FEOCh | 06h | CPU Multiply Divide Register - High Word | 0000h |
| MDL | FE0Eh | 07h | CPU Multiply Divide Register - Low Word | 0000h |
| MRW b | FFDAh | EDh | MAC Unit Repeat Word | 0000h |
| MSW b | FFDEh | EFh | MAC Unit Status Word | 0200h |
| ODP2 b | F1C2h E | E1h | Port 2 Open Drain Control Register | 0000h |
| ODP3 b | F1C6h E | E3h | Port 3 Open Drain Control Register | 0000h |
| ODP4 b | F1CAh E | E5h | Port 4 Open Drain Control Register | --00h |
| ODP6 b | F1CEh E | E7h | Port 6 Open Drain Control Register | - - 00h |
| ODP7 b | F1D2h E | E9h | Port 7 Open Drain Control Register | --00h |
| ODP8 b | F1D6h E | EBh | Port 8 Open Drain Control Register | --00h |
| ONES b | FF1Eh | 8Fh | Constant Value 1's Register (read only) | FFFFh |
| POL b | FF00h | 80h | PORT0 Low Register (Lower half of PORT0) | - -00h |
| $\mathrm{POH} \quad \mathrm{b}$ | FF02h | 81h | PORT0 High Register (Upper half of PORT0) | - -00h |
| P1L b | FF04h | 82h | PORT1 Low Register (Lower half of PORT1) | - - 00h |
| P1H b | FF06h | 83h | PORT1 High Register (Upper half of PORT1) | - - 00h |
| P2 b | FFC0h | EOh | Port 2 Register | 0000h |
| P3 b | FFC4h | E2h | Port 3 Register | 0000h |
| P4 b | FFC8h | E4h | Port 4 Register (8-bit) | --00h |
| P5 b | FFA2h | D1h | Port 5 Register (read only) | XXXXh |
| P6 b | FFCCh | E6h | Port 6 Register (8-bit) | - - 00h |
| P7 b | FFD0h | E8h | Port 7 Register (8-bit) | - - 00h |
| P8 b | FFD4h | EAh | Port 8 Register (8-bit) | --00h |
| P5DIDIS b | FFA4h | D2h | Port 5 Digital Disable Register | 0000h |
| PECC0 | FECOh | 60h | PEC Channel 0 Control Register | 0000h |
| PECC1 | FEC2h | 61h | PEC Channel 1 Control Register | 0000h |
| PECC2 | FEC4h | 62h | PEC Channel 2 Control Register | 0000h |
| PECC3 | FEC6h | 63h | PEC Channel 3 Control Register | 0000h |
| PECC4 | FEC8h | 64h | PEC Channel 4 Control Register | 0000h |
| PECC5 | FECAh | 65h | PEC Channel 5 Control Register | 0000h |
| PECC6 | FECCh | 66h | PEC Channel 6 Control Register | 0000h |
| PECC7 | FECEh | 67h | PEC Channel 7 Control Register | 0000h |
| PICON b | F1C4h E | E2h | Port Input Threshold Control Register | - - 00h |
| PPO | F038h E | 1Ch | PWM Module Period Register 0 | 0000h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| PP1 | F03Ah E | 1Dh | PWM Module Period Register 1 | 0000h |
| PP2 | F03Ch E | 1Eh | PWM Module Period Register 2 | 0000h |
| PP3 | F03Eh E | 1Fh | PWM Module Period Register 3 | 0000h |
| PSW b | FF10h | 88h | CPU Program Status Word | 0000h |
| PT0 | F030h E | 18h | PWM Module Up/Down Counter 0 | 0000h |
| PT1 | F032h E | 19h | PWM Module Up/Down Counter 1 | 0000h |
| PT2 | F034h E | 1Ah | PWM Module Up/Down Counter 2 | 0000h |
| PT3 | F036h E | 1Bh | PWM Module Up/Down Counter 3 | 0000h |
| PW0 | FE30h | 18h | PWM Module Pulse Width Register 0 | 0000h |
| PW1 | FE32h | 19h | PWM Module Pulse Width Register 1 | 0000h |
| PW2 | FE34h | 1Ah | PWM Module Pulse Width Register 2 | 0000h |
| PW3 | FE36h | 1Bh | PWM Module Pulse Width Register 3 | 0000h |
| PWMCONOb | FF30h | 98h | PWM Module Control Register 0 | 0000h |
| PWMCON1b | FF32h | 99h | PWM Module Control Register 1 | 0000h |
| PWMIC b | F17Eh E | BFh | PWM Module Interrupt Control Register | - - 00h |
| QR0 | F004h E | 02h | MAC Unit Offset Register R0 | 0000h |
| QR1 | F006h E | 03h | MAC Unit Offset Register R1 | 0000h |
| QX0 | F000h E | 00h | MAC Unit Offset Register X0 | 0000h |
| QX1 | F002h E | 01h | MAC Unit Offset Register X1 | 0000h |
| RPOH b | F108h E | 84h | System Start-up Configuration Register (read only) | - - XXh |
| SOBG | FEB4h | 5Ah | Serial Channel 0 Baud Rate Generator Reload Register | 0000h |
| SOCON b | FFBOh | D8h | Serial Channel 0 Control Register | 0000h |
| SOEIC b | FF70h | B8h | Serial Channel 0 Error Interrupt Control Register | - - 00h |
| SORBUF | FEB2h | 59h | Serial Channel 0 Receive Buffer Register (read only) | - - XXh |
| SORIC b | FF6Eh | B7h | Serial Channel 0 Receive Interrupt Control Register | --00h |
| SOTBIC b | F19Ch E | CEh | Serial Channel 0 Transmit Buffer Interrupt Control Reg. | --00h |
| SOTBUF | FEBOh | 58h | Serial Channel 0 Transmit Buffer Register (write only) | 0000h |
| SOTIC b | FF6Ch | B6h | Serial Channel 0 Transmit Interrupt Control Register | --00h |
| SP | FE12h | 09h | CPU System Stack Pointer Register | FC00h |
| SSCBR | FOB4h E | 5Ah | SSC Baud Rate Register | 0000h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| SSCCON b | FFB2h | D9h | SSC Control Register | 0000h |
| SSCEIC b | FF76h | BBh | SSC Error Interrupt Control Register | - - 00h |
| SSCRB | FOB2h E | 59h | SSC Receive Buffer (read only) | XXXXh |
| SSCRIC b | FF74h | BAh | SSC Receive Interrupt Control Register | - - 00h |
| SSCTB | FOBOh E | 58h | SSC Transmit Buffer (write only) | 0000h |
| SSCTIC b | FF72h | B9h | SSC Transmit Interrupt Control Register | - - 00h |
| STKOV | FE14h | OAh | CPU Stack Overflow Pointer Register | FA00h |
| STKUN | FE16h | OBh | CPU Stack Underflow Pointer Register | FCOOh |
| SYSCON b | FF12h | 89h | CPU System Configuration Register | 0xx0h ${ }^{1)}$ |
| T0 | FE50h | 28h | CAPCOM Timer 0 Register | 0000h |
| T01CON b | FF50h | A8h | CAPCOM Timer 0 and Timer 1 Control Register | 0000h |
| TOIC b | FF9Ch | CEh | CAPCOM Timer 0 Interrupt Control Register | - - 00h |
| TOREL | FE54h | 2Ah | CAPCOM Timer 0 Reload Register | 0000h |
| T1 | FE52h | 29h | CAPCOM Timer 1 Register | 0000h |
| T1IC b | FF9Eh | CFh | CAPCOM Timer 1 Interrupt Control Register | - - 00h |
| T1REL | FE56h | 2Bh | CAPCOM Timer 1 Reload Register | 0000h |
| T2 | FE40h | 20h | GPT1 Timer 2 Register | 0000h |
| T2CON b | FF40h | AOh | GPT1 Timer 2 Control Register | 0000h |
| T2IC b | FF60h | B0h | GPT1 Timer 2 Interrupt Control Register | - - 00h |
| T3 | FE42h | 21h | GPT1 Timer 3 Register | 0000h |
| T3CON b | FF42h | A1h | GPT1 Timer 3 Control Register | 0000h |
| T3IC b | FF62h | B1h | GPT1 Timer 3 Interrupt Control Register | - - 00h |
| T4 | FE44h | 22h | GPT1 Timer 4 Register | 0000h |
| T4CON b | FF44h | A2h | GPT1 Timer 4 Control Register | 0000h |
| T4IC b | FF64h | B2h | GPT1 Timer 4 Interrupt Control Register | - - 00h |
| T5 | FE46h | 23h | GPT2 Timer 5 Register | 0000h |
| T5CON b | FF46h | A3h | GPT2 Timer 5 Control Register | 0000h |
| T5IC b | FF66h | B3h | GPT2 Timer 5 Interrupt Control Register | - - 00h |
| T6 | FE48h | 24h | GPT2 Timer 6 Register | 0000h |
| T6CON b | FF48h | A4h | GPT2 Timer 6 Control Register | 0000h |
| T6IC b | FF68h | B4h | GPT2 Timer 6 Interrupt Control Register | - - 00h |
| T7 | F050h E | 28h | CAPCOM Timer 7 Register | 0000h |
| T78CON b | FF20h | 90h | CAPCOM Timer 7 and 8 Control Register | 0000h |
| T7IC b | F17Ah E | BDh | CAPCOM Timer 7 Interrupt Control Register | - - 00h |

Table 136. Special function registers listed by name (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| T7REL | F054h E | 2Ah | CAPCOM Timer 7 Reload Register | 0000h |
| T8 | F052h E | 29h | CAPCOM Timer 8 Register | 0000h |
| T8IC b | F17Ch E | BEh | CAPCOM Timer 8 Interrupt Control Register | - - 00h |
| T8REL | F056h E | 2Bh | CAPCOM Timer 8 Reload Register | 0000h |
| TFR b | FFACh | D6h | Trap Flag Register | 0000h |
| WDT | FEAEh | 57h | Watchdog Timer Register (read only) | 0000h |
| WDTCON b | FFAEh | D7h | Watchdog Timer Control Register | $00 x x{ }^{2)}$ |
| XADRS3 | F01Ch E | OEh | XPER Address Select Register 3 | 800Bh |
| XPOIC b | F186h E | C3h | See Section 9.2 | - -00h ${ }^{3}$ |
| XP1IC b | F18Eh E | C7h | See Section 9.2 | - -00h ${ }^{3}$ |
| XP2IC b | F196h E | CBh | See Section 9.2 | - -00h ${ }^{3}$ |
| XP3IC b | F19Eh E | CFh | See Section 9.2 | - - 00h ${ }^{3}$ |
| XPERCON | F024h E | 12h | XPER Configuration Register | - - 05h |
| ZEROS b | FF1Ch | 8Eh | Constant Value O's Register (read only) | 0000h |

Note: 1 The system configuration is selected during reset.
2 Reset value depends on different triggered reset event.
3 The XPnIC interrupt control registers control interrupt requests from integrated X-Bus peripherals. Some software controlled interrupt requests may be generated by setting the XPnIR bits (of XPnIC register) of the unused X-peripheral nodes.

### 26.2.2 Registers ordered by address

Table 137 lists all SFRs which are implemented in the ST10F252M ordered by their physical address. Bit-addressable SFRs are marked with the letter "b" in column "Name". SFRs within the Extended SFR-Space (ESFRs) are marked with the letter "E" in column "Physical Address".

Table 137. Special function registers listed by address

| Name | Physical <br> address | 8-bit <br> address | Description | Reset <br> value |  |
| :--- | :--- | :---: | :---: | :--- | :---: |
| QX0 | F000h | E | 00 h | MAC Unit Offset Register X0 | 0000 h |
| QX1 | F002h | E | 01 h | MAC Unit Offset Register X1 | 0000 h |
| QR0 | F004h | E | 02 h | MAC Unit Offset Register R0 | 0000 h |
| QR1 | F006h | E | 03 h | MAC Unit Offset Register R1 | 0000 h |
| XADRS3 | F01Ch | E | 0Eh | XPER Address Select Register 3 | 800 Bh |
| XPERCON | F024h | E | 12 h | XPER Configuration Register | --05 h |
| PT0 | F030h | E | 18 h | PWM Module Up/Down Counter 0 | 0000 h |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| PT1 | F032h E | 19h | PWM Module Up/Down Counter 1 | 0000h |
| PT2 | F034h E | 1Ah | PWM Module Up/Down Counter 2 | 0000h |
| PT3 | F036h E | 1Bh | PWM Module Up/Down Counter 3 | 0000h |
| PPO | F038h E | 1Ch | PWM Module Period Register 0 | 0000h |
| PP1 | F03Ah E | 1Dh | PWM Module Period Register 1 | 0000h |
| PP2 | F03Ch E | 1Eh | PWM Module Period Register 2 | 0000h |
| PP3 | F03Eh E | 1Fh | PWM Module Period Register 3 | 0000h |
| T7 | F050h E | 28h | CAPCOM Timer 7 Register | 0000h |
| T8 | F052h E | 29h | CAPCOM Timer 8 Register | 0000h |
| T7REL | F054h E | 2Ah | CAPCOM Timer 7 Reload Register | 0000h |
| T8REL | F056h E | 2Bh | CAPCOM Timer 8 Reload Register | 0000h |
| IDPROG | F078h E | 3Ch | Programming Voltage Identifier Register | 001740h |
| IDMEM | F07Ah E | 3Dh | On-chip Memory Identifier Register | 32040h |
| IDCHIP | F07Ch E | 3Eh | Device Identifier Register ( n is the device revision) | FBnh |
| IDMANUF | F07Eh E | 3Fh | Manufacturer Identifier Register | 0403h |
| ADDAT2 | FOAOh E | 50h | ADC 2 Result Register | 0000h |
| SSCTB | FOBOh E | 58h | SSC Transmit Buffer (write only) | 0000h |
| SSCRB | F0B2h E | 59h | SSC Receive Buffer (read only) | XXXXh |
| SSCBR | F0B4h E | 5Ah | SSC Baud Rate Register | 0000h |
| DPOL b | F100h E | 80h | POL Direction Control Register | --00h |
| DPOH b | F102h E | 81h | POh Direction Control Register | - - 00h |
| DP1L b | F104h E | 82h | P1L Direction Control Register | --00h |
| DP1H b | F106h E | 83h | P1h Direction Control Register | --00h |
| $\mathrm{RPOH} \quad \mathrm{b}$ | F108h E | 84h | System Start-up Configuration Register (read only) | - - XXh |
| CC16IC b | F160h E | B0h | CAPCOM Register 16 Interrupt Control Register | - - 00h |
| CC17IC b | F162h E | B1h | CAPCOM Register 17 Interrupt Control Register | - - 00h |
| CC18IC b | F164h E | B2h | CAPCOM Register 18 Interrupt Control Register | - - 00h |
| CC19IC b | F166h E | B3h | CAPCOM Register 19 Interrupt Control Register | - - 00h |
| CC20IC b | F168h E | B4h | CAPCOM Register 20 Interrupt Control Register | - - 00h |
| CC21IC b | F16Ah E | B5h | CAPCOM Register 21 Interrupt Control Register | - - 00h |
| CC22IC b | F16Ch E | B6h | CAPCOM Register 22 Interrupt Control Register | - - 00h |
| CC23IC b | F16Eh E | B7h | CAPCOM Register 23 Interrupt Control Register | --00h |
| CC24IC b | F170h E | B8h | CAPCOM Register 24 Interrupt Control Register | - - 00h |
| CC25IC b | F172h E | B9h | CAPCOM Register 25 Interrupt Control Register | --00h |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| CC26IC b | F174h E | BAh | CAPCOM Register 26 Interrupt Control Register | - - 00h |
| CC27IC b | F176h E | BBh | CAPCOM Register 27 Interrupt Control Register | - - 00h |
| CC28IC b | F178h E | BCh | CAPCOM Register 28 Interrupt Control Register | - - 00h |
| T7IC b | F17Ah E | BDh | CAPCOM Timer 7 Interrupt Control Register | - - 00h |
| T8IC b | F17Ch E | BEh | CAPCOM Timer 8 Interrupt Control Register | - - 00h |
| PWMIC b | F17Eh E | BFh | PWM Module Interrupt Control Register | - - 00h |
| CC29IC b | F184h E | C2h | CAPCOM Register 29 Interrupt Control Register | - - 00h |
| XPOIC b | F186h E | C3h | See Section 9.2 | - - 00h ${ }^{3}$ |
| CC30IC b | F18Ch E | C6h | CAPCOM Register 30 Interrupt Control Register | - - 00h |
| XP1IC b | F18Eh E | C7h | See Section 9.2 | - - 00h ${ }^{3}$ |
| CC31IC b | F194h E | CAh | CAPCOM Register 31 Interrupt Control Register | --00h |
| XP2IC b | F196h E | CBh | See Section 9.2 | - - 00h ${ }^{3}$ |
| SOTBIC b | F19Ch E | CEh | Serial Channel 0 Transmit Buffer Interrupt Control Reg. | --00h |
| XP3IC b | F19Eh E | CFh | See Section 9.2 | - -00h ${ }^{3)}$ |
| EXICON b | F1COh E | EOh | External Interrupt Control Register | 0000h |
| ODP2 b | F1C2h E | E1h | Port 2 Open Drain Control Register | 0000h |
| PICON b | F1C4h E | E2h | Port Input Threshold Control Register | - - 00h |
| ODP3 b | F1C6h E | E3h | Port 3 Open Drain Control Register | 0000h |
| ODP4 b | F1CAh E | E5h | Port 4 Open Drain Control Register | - - 00h |
| ODP6 b | F1CEh E | E7h | Port 6 Open Drain Control Register | - - 00h |
| ODP7 b | F1D2h E | E9h | Port 7 Open Drain Control Register | - - 00h |
| ODP8 b | F1D6h E | EBh | Port 8 Open Drain Control Register | - - 00h |
| EXISEL b | F1DAh E | EDh | External Interrupt Source Selection Register | 0000h |
| DPP0 | FE00h | 00h | CPU Data Page Pointer 0 Register (10-bit) | 0000h |
| DPP1 | FE02h | 01h | CPU Data Page Pointer 1 Register (10-bit) | 0001h |
| DPP2 | FE04h | 02h | CPU Data Page Pointer 2 Register (10-bit) | 0002h |
| DPP3 | FE06h | 03h | CPU Data Page Pointer 3 Register (10-bit) | 0003h |
| CSP | FE08h | 04h | CPU Code Segment Pointer Register (read only) | 0000h |
| MDH | FEOCh | 06h | CPU Multiply Divide Register - High Word | 0000h |
| MDL | FEOEh | 07h | CPU Multiply Divide Register - Low Word | 0000h |
| CP | FE10h | 08h | CPU Context Pointer Register | FCOOh |
| SP | FE12h | 09h | CPU System Stack Pointer Register | FCOOh |
| STKOV | FE14h | OAh | CPU Stack Overflow Pointer Register | FA00h |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| STKUN | FE16h | OBh | CPU Stack Underflow Pointer Register | FC00h |
| ADDRSEL1 | FE18h | 0Ch | Address Select Register 1 | 0000h |
| ADDRSEL2 | FE1Ah | 0Dh | Address Select Register 2 | 0000h |
| ADDRSEL3 | FE1Ch | 0Eh | Address Select Register 3 | 0000h |
| ADDRSEL4 | FE1Eh | OFh | Address Select Register 4 | 0000h |
| PWO | FE30h | 18h | PWM Module Pulse Width Register 0 | 0000h |
| PW1 | FE32h | 19h | PWM Module Pulse Width Register 1 | 0000h |
| PW2 | FE34h | 1Ah | PWM Module Pulse Width Register 2 | 0000h |
| PW3 | FE36h | 1Bh | PWM Module Pulse Width Register 3 | 0000h |
| T2 | FE40h | 20h | GPT1 Timer 2 Register | 0000h |
| T3 | FE42h | 21h | GPT1 Timer 3 Register | 0000h |
| T4 | FE44h | 22h | GPT1 Timer 4 Register | 0000h |
| T5 | FE46h | 23h | GPT2 Timer 5 Register | 0000h |
| T6 | FE48h | 24h | GPT2 Timer 6 Register | 0000h |
| CAPREL | FE4Ah | 25h | GPT2 Capture/Reload Register | 0000h |
| T0 | FE50h | 28h | CAPCOM Timer 0 Register | 0000h |
| T1 | FE52h | 29h | CAPCOM Timer 1 Register | 0000h |
| TOREL | FE54h | 2Ah | CAPCOM Timer 0 Reload Register | 0000h |
| T1REL | FE56h | 2Bh | CAPCOM Timer 1 Reload Register | 0000h |
| MAL | FE5Ch | 2Eh | MAC Unit Accumulator - Low Word | 0000h |
| MAH | FE5Eh | 2Fh | MAC Unit Accumulator - High Word | 0000h |
| CC16 | FE60h | 30h | CAPCOM Register 16 | 0000h |
| CC17 | FE62h | 31h | CAPCOM Register 17 | 0000h |
| CC18 | FE64h | 32h | CAPCOM Register 18 | 0000h |
| CC19 | FE66h | 33h | CAPCOM Register 19 | 0000h |
| CC20 | FE68h | 34h | CAPCOM Register 20 | 0000h |
| CC21 | FE6Ah | 35h | CAPCOM Register 21 | 0000h |
| CC22 | FE6Ch | 36h | CAPCOM Register 22 | 0000h |
| CC23 | FE6Eh | 37h | CAPCOM Register 23 | 0000h |
| CC24 | FE70h | 38h | CAPCOM Register 24 | 0000h |
| CC25 | FE72h | 39h | CAPCOM Register 25 | 0000h |
| CC26 | FE74h | 3Ah | CAPCOM Register 26 | 0000h |
| CC27 | FE76h | 3Bh | CAPCOM Register 27 | 0000h |
| CC28 | FE78h | 3Ch | CAPCOM Register 28 | 0000h |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| CC29 | FE7Ah | 3Dh | CAPCOM Register 29 | 0000h |
| CC30 | FE7Ch | 3Eh | CAPCOM Register 30 | 0000h |
| CC31 | FE7Eh | 3Fh | CAPCOM Register 31 | 0000h |
| CCO | FE80h | 40h | CAPCOM Register 0 | 0000h |
| CC1 | FE82h | 41h | CAPCOM Register 1 | 0000h |
| CC2 | FE84h | 42h | CAPCOM Register 2 | 0000h |
| CC3 | FE86h | 43h | CAPCOM Register 3 | 0000h |
| CC4 | FE88h | 44h | CAPCOM Register 4 | 0000h |
| CC5 | FE8Ah | 45h | CAPCOM Register 5 | 0000h |
| CC6 | FE8Ch | 46h | CAPCOM Register 6 | 0000h |
| CC7 | FE8Eh | 47h | CAPCOM Register 7 | 0000h |
| CC8 | FE90h | 48h | CAPCOM Register 8 | 0000h |
| CC9 | FE92h | 49h | CAPCOM Register 9 | 0000h |
| CC10 | FE94h | 4Ah | CAPCOM Register 10 | 0000h |
| CC11 | FE96h | 4Bh | CAPCOM Register 11 | 0000h |
| CC12 | FE98h | 4Ch | CAPCOM Register 12 | 0000h |
| CC13 | FE9Ah | 4Dh | CAPCOM Register 13 | 0000h |
| CC14 | FE9Ch | 4Eh | CAPCOM Register 14 | 0000h |
| CC15 | FE9Eh | 4Fh | CAPCOM Register 15 | 0000h |
| ADDAT | FEAOh | 50h | ADC Result Register | 0000h |
| WDT | FEAEh | 57h | Watchdog Timer Register (read only) | 0000h |
| SOTBUF | FEB0h | 58h | Serial Channel 0 Transmit Buffer Register (write only) | 0000h |
| SORBUF | FEB2h | 59h | Serial Channel 0 Receive Buffer Register (read only) | - - XXh |
| SOBG | FEB4h | 5Ah | Serial Channel 0 Baud Rate Generator Reload Register | 0000h |
| PECC0 | FECOh | 60h | PEC Channel 0 Control Register | 0000h |
| PECC1 | FEC2h | 61h | PEC Channel 1 Control Register | 0000h |
| PECC2 | FEC4h | 62h | PEC Channel 2 Control Register | 0000h |
| PECC3 | FEC6h | 63h | PEC Channel 3 Control Register | 0000h |
| PECC4 | FEC8h | 64h | PEC Channel 4 Control Register | 0000h |
| PECC5 | FECAh | 65h | PEC Channel 5 Control Register | 0000h |
| PECC6 | FECCh | 66h | PEC Channel 6 Control Register | 0000h |
| PECC7 | FECEh | 67h | PEC Channel 7 Control Register | 0000h |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| POL b | FF00h | 80h | PORT0 Low Register (Lower half of PORT0) | --00h |
| $\mathrm{POH} \quad \mathrm{b}$ | FF02h | 81h | PORT0 High Register (Upper half of PORT0) | - - 00h |
| P1L b | FF04h | 82h | PORT1 Low Register (Lower half of PORT1) | - - 00h |
| P1H b | FF06h | 83h | PORT1 High Register (Upper half of PORT1) | - - 00h |
| IDX0 b | FF08h | 84h | MAC Unit Address Pointer 0 | 0000h |
| IDX1 b | FF0Ah | 85h | MAC Unit Address Pointer 1 | 0000h |
| BUSCON0b | FF0Ch | 86h | Bus Configuration Register 0 | 0xx0h |
| MDC b | FF0Eh | 87h | CPU Multiply Divide Control Register | 0000h |
| PSW b | FF10h | 88h | CPU Program Status Word | 0000h |
| SYSCON b | FF12h | 89h | CPU System Configuration Register | 0xx0h ${ }^{1)}$ |
| BUSCON1b | FF14h | 8Ah | Bus Configuration Register 1 | 0000h |
| BUSCON2b | FF16h | 8Bh | Bus Configuration Register 2 | 0000h |
| BUSCON3b | FF18h | 8Ch | Bus Configuration Register 3 | 0000h |
| BUSCON4b | FF1Ah | 8Dh | Bus Configuration Register 4 | 0000h |
| ZEROS b | FF1Ch | 8Eh | Constant Value 0's Register (read only) | 0000h |
| ONES b | FF1Eh | 8Fh | Constant Value 1's Register (read only) | FFFFh |
| T78CON b | FF20h | 90h | CAPCOM Timer 7 and 8 Control Register | 0000h |
| CCM4 b | FF22h | 91h | CAPCOM Mode Control Register 4 | 0000h |
| CCM5 b | FF24h | 92h | CAPCOM Mode Control Register 5 | 0000h |
| CCM6 b | FF26h | 93h | CAPCOM Mode Control Register 6 | 0000h |
| CCM7 b | FF28h | 94h | CAPCOM Mode Control Register 7 | 0000h |
| PWMCONOb | FF30h | 98h | PWM Module Control Register 0 | 0000h |
| PWMCON1b | FF32h | 99h | PWM Module Control Register 1 | 0000h |
| T2CON b | FF40h | A0h | GPT1 Timer 2 Control Register | 0000h |
| T3CON b | FF42h | A1h | GPT1 Timer 3 Control Register | 0000h |
| T4CON b | FF44h | A2h | GPT1 Timer 4 Control Register | 0000h |
| T5CON b | FF46h | A3h | GPT2 Timer 5 Control Register | 0000h |
| T6CON b | FF48h | A4h | GPT2 Timer 6 Control Register | 0000h |
| T01CON b | FF50h | A8h | CAPCOM Timer 0 and Timer 1 Control Register | 0000h |
| CCMO b | FF52h | A9h | CAPCOM Mode Control Register 0 | 0000h |
| CCM1 b | FF54h | AAh | CAPCOM Mode Control Register 1 | 0000h |
| CCM2 b | FF56h | ABh | CAPCOM Mode Control Register 2 | 0000h |
| CCM3 b | FF58h | ACh | CAPCOM Mode Control Register 3 | 0000h |
| T2IC b | FF60h | B0h | GPT1 Timer 2 Interrupt Control Register | --00h |

Table 137. Special function registers listed by address (continued)

| Name |  | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: | :---: |
| T3IC | b | FF62h | B1h | GPT1 Timer 3 Interrupt Control Register | - - 00h |
| T4IC | b | FF64h | B2h | GPT1 Timer 4 Interrupt Control Register | - - 00h |
| T5IC | b | FF66h | B3h | GPT2 Timer 5 Interrupt Control Register | - - 00h |
| T6IC | b | FF68h | B4h | GPT2 Timer 6 Interrupt Control Register | - - 00h |
| CRIC | b | FF6Ah | B5h | GPT2 CAPREL Interrupt Control Register | - - 00h |
| SOTIC | b | FF6Ch | B6h | Serial Channel 0 Transmit Interrupt Control Register | --00h |
| SORIC | b | FF6Eh | B7h | Serial Channel 0 Receive Interrupt Control Register | -- 00h |
| SOEIC | b | FF70h | B8h | Serial Channel 0 Error Interrupt Control Register | - - 00h |
| SSCTIC | b | FF72h | B9h | SSC Transmit Interrupt Control Register | - - 00h |
| SSCRIC | b | FF74h | BAh | SSC Receive Interrupt Control Register | - - 00h |
| SSCEIC | b | FF76h | BBh | SSC Error Interrupt Control Register | - - 00h |
| CCOIC | b | FF78h | BCh | CAPCOM Register 0 Interrupt Control Register | - - 00h |
| CC1IC | b | FF7Ah | BDh | CAPCOM Register 1 Interrupt Control Register | - - 00h |
| CC2IC | b | FF7Ch | BEh | CAPCOM Register 2 Interrupt Control Register | - - 00h |
| CC3IC | b | FF7Eh | BFh | CAPCOM Register 3 Interrupt Control Register | - - 00h |
| CC4IC | b | FF80h | COh | CAPCOM Register 4 Interrupt Control Register | - - 00h |
| CC5IC | b | FF82h | C1h | CAPCOM Register 5 Interrupt Control Register | - - 00h |
| CC6IC | b | FF84h | C2h | CAPCOM Register 6 Interrupt Control Register | - - 00h |
| CC7IC | b | FF86h | C3h | CAPCOM Register 7 Interrupt Control Register | - - 00h |
| CC8IC | b | FF88h | C4h | CAPCOM Register 8 Interrupt Control Register | - - 00h |
| CC9IC | b | FF8Ah | C5h | CAPCOM Register 9 Interrupt Control Register | - - 00h |
| CC10IC | b | FF8Ch | C6h | CAPCOM Register 10 Interrupt Control Register | - - 00h |
| CC11IC | b | FF8Eh | C7h | CAPCOM Register 11 Interrupt Control Register | - - 00h |
| CC12IC | b | FF90h | C8h | CAPCOM Register 12 Interrupt Control Register | - - 00h |
| CC13IC | b | FF92h | C9h | CAPCOM Register 13 Interrupt Control Register | - - 00h |
| CC14IC | b | FF94h | CAh | CAPCOM Register 14 Interrupt Control Register | - - 00h |
| CC15IC | b | FF96h | CBh | CAPCOM Register 15 Interrupt Control Register | - - 00h |
| ADCIC | b | FF98h | CCh | ADC end of Conversion Interrupt Control Reg. | - - 00h |
| ADEIC | b | FF9Ah | CDh | ADC Overrun Error Interrupt Control Register | - - 00h |
| TOIC | b | FF9Ch | CEh | CAPCOM Timer 0 Interrupt Control Register | - - 00h |
| T1IC | b | FF9Eh | CFh | CAPCOM Timer 1 Interrupt Control Register | - - 00h |
| ADCON | b | FFAOh | DOh | ADC Control Register | 0000h |
| P5 | b | FFA2h | D1h | Port 5 Register (read only) | XXXXh |

Table 137. Special function registers listed by address (continued)

| Name | Physical address | 8-bit address | Description | Reset value |
| :---: | :---: | :---: | :---: | :---: |
| P5DIDIS b | FFA4h | D2h | Port 5 Digital Disable Register | 0000h |
| TFR | FFACh | D6h | Trap Flag Register | 0000h |
| WDTCON b | FFAEh | D7h | Watchdog Timer Control Register | $00 \mathrm{xxh}{ }^{2)}$ |
| SOCON | FFB0h | D8h | Serial Channel 0 Control Register | 0000h |
| SSCCON b | FFB2h | D9h | SSC Control Register | 0000h |
| P2 | FFCOh | EOh | Port 2 Register | 0000h |
| DP2 | FFC2h | E1h | Port 2 Direction Control Register | 0000h |
| P3 | FFC4h | E2h | Port 3 Register | 0000h |
| DP3 | FFC6h | E3h | Port 3 Direction Control Register | 0000h |
| P4 | FFC8h | E4h | Port 4 Register (8-bit) | - - 00h |
| DP4 | FFCAh | E5h | Port 4 Direction Control Register | - - 00h |
| P6 | FFCCh | E6h | Port 6 Register (8-bit) | - - 00h |
| DP6 | FFCEh | E7h | Port 6 Direction Control Register | - - 00h |
| P7 | FFDOh | E8h | Port 7 Register (8-bit) | - - 00h |
| DP7 | FFD2h | E9h | Port 7 Direction Control Register | - - 00h |
| P8 | FFD4h | EAh | Port 8 Register (8-bit) | - - 00h |
| DP8 | FFD6h | EBh | Port 8 Direction Control Register | - - 00h |
| MRW | FFDAh | EDh | MAC Unit Repeat Word | 0000h |
| MCW | FFDCh | EEh | MAC Unit Control Word | 0000h |
| MSW b | FFDEh | EFh | MAC Unit Status Word | 0200h |

### 26.3 X-registers overview

### 26.3.1 X-registers ordered by name

Table 138 lists all X-Bus registers which are implemented in the ST10F252M ordered by their name. Not all X-registers are bit-addressable.
Table 138. Registers listed by name

| Name | Physical address | Resestiption <br> value |  |
| :--- | :--- | :--- | :---: |
| CAN1BRPER | EF0Ch | CAN1: BRP Extension Register | 0000 h |
| CAN1BTR | EF06h | CAN1: Bit Timing Register | 2301 h |
| CAN1CR | EF00h | CAN1: CAN Control Register | 0001 h |
| CAN1EC | EF04h | CAN1: Error Counter | 0000 h |
| CAN1IF1A1 | EF18h | CAN1: IF1 Arbitration 1 | 0000 h |

Table 138. Registers listed by name (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| CAN1IF1A2 | EF1Ah | CAN1: IF1 Arbitration 2 | 0000h |
| CAN1IF1CM | EF12h | CAN1: IF1 Command Mask | 0000h |
| CAN1IF1CR | EF10h | CAN1: IF1 Command Request | 0001h |
| CAN1IF1DA1 | EF1Eh | CAN1: IF1 Data A 1 | 0000h |
| CAN1IF1DA2 | EF20h | CAN1: IF1 Data A 2 | 0000h |
| CAN1IF1DB1 | EF22h | CAN1: IF1 Data B 1 | 0000h |
| CAN1IF1DB2 | EF24h | CAN1: IF1 Data B 2 | 0000h |
| CAN1IF1M1 | EF14h | CAN1: IF1 Mask 1 | FFFFh |
| CAN1IF1M2 | EF16h | CAN1: IF1 Mask 2 | FFFFh |
| CAN1IF1MC | EF1Ch | CAN1: IF1 Message Control | 0000h |
| CAN1IF2A1 | EF48h | CAN1: IF2 Arbitration 1 | 0000h |
| CAN1IF2A2 | EF4Ah | CAN1: IF2 Arbitration 2 | 0000h |
| CAN1IF2CM | EF42h | CAN1: IF2 Command Mask | 0000h |
| CAN1IF2CR | EF40h | CAN1: IF2 Command Request | 0001h |
| CAN1IF2DA1 | EF4Eh | CAN1: IF2 Data A 1 | 0000h |
| CAN1IF2DA2 | EF50h | CAN1: IF2 Data A 2 | 0000h |
| CAN1IF2DB1 | EF52h | CAN1: IF2 Data B 1 | 0000h |
| CAN1IF2DB2 | EF54h | CAN1: IF2 Data B 2 | 0000h |
| CAN1IF2M1 | EF44h | CAN1: IF2 Mask 1 | FFFFh |
| CAN1IF2M2 | EF46h | CAN1: IF2 Mask 2 | FFFFh |
| CAN1IF2MC | EF4Ch | CAN1: IF2 Message Control | 0000h |
| CAN1IP1 | EFAOh | CAN1: Interrupt Pending 1 | 0000h |
| CAN1IP2 | EFA2h | CAN1: Interrupt Pending 2 | 0000h |
| CAN1IR | EF08h | CAN1: Interrupt Register | 0000h |
| CAN1MV1 | EFBOh | CAN1: Message Valid 1 | 0000h |
| CAN1MV2 | EFB2h | CAN1: Message Valid 2 | 0000h |
| CAN1ND1 | EF90h | CAN1: New Data 1 | 0000h |
| CAN1ND2 | EF92h | CAN1: New Data 2 | 0000h |
| CAN1SR | EF02h | CAN1: Status Register | 0000h |
| CAN1TR | EFOAh | CAN1: Test Register | 00x0h |
| CAN1TR1 | EF80h | CAN1: Transmission Request 1 | 0000h |
| CAN1TR2 | EF82h | CAN1: Transmission Request 2 | 0000h |
| CAN2BRPER | EEOCh | CAN2: BRP Extension Register | 0000h |
| CAN2BTR | EE06h | CAN2: Bit Timing Register | 2301h |

Table 138. Registers listed by name (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| CAN2CR | EE00h | CAN2: CAN Control Register | 0001h |
| CAN2EC | EE04h | CAN2: Error Counter | 0000h |
| CAN2IF1A1 | EE18h | CAN2: IF1 Arbitration 1 | 0000h |
| CAN2IF1A2 | EE1Ah | CAN2: IF1 Arbitration 2 | 0000h |
| CAN2IF1CM | EE12h | CAN2: IF1 Command Mask | 0000h |
| CAN2IF1CR | EE10h | CAN2: IF1 Command Request | 0001h |
| CAN2IF1DA1 | EE1Eh | CAN2: IF1 Data A 1 | 0000h |
| CAN2IF1DA2 | EE20h | CAN2: IF1 Data A 2 | 0000h |
| CAN2IF1DB1 | EE22h | CAN2: IF1 Data B 1 | 0000h |
| CAN2IF1DB2 | EE24h | CAN2: IF1 Data B 2 | 0000h |
| CAN2IF1M1 | EE14h | CAN2: IF1 Mask 1 | FFFFh |
| CAN2IF1M2 | EE16h | CAN2: IF1 Mask 2 | FFFFh |
| CAN2IF1MC | EE1Ch | CAN2: IF1 Message Control | 0000h |
| CAN2IF2A1 | EE48h | CAN2: IF2 Arbitration 1 | 0000h |
| CAN2IF2A2 | EE4Ah | CAN2: IF2 Arbitration 2 | 0000h |
| CAN2IF2CM | EE42h | CAN2: IF2 Command Mask | 0000h |
| CAN2IF2CR | EE40h | CAN2: IF2 Command Request | 0001h |
| CAN2IF2DA1 | EE4Eh | CAN2: IF2 Data A 1 | 0000h |
| CAN2IF2DA2 | EE50h | CAN2: IF2 Data A 2 | 0000h |
| CAN2IF2DB1 | EE52h | CAN2: IF2 Data B 1 | 0000h |
| CAN2IF2DB2 | EE54h | CAN2: IF2 Data B 2 | 0000h |
| CAN2IF2M1 | EE44h | CAN2: IF2 Mask 1 | FFFFh |
| CAN2IF2M2 | EE46h | CAN2: IF2 Mask 2 | FFFFh |
| CAN2IF2MC | EE4Ch | CAN2: IF2 Message Control | 0000h |
| CAN2IP1 | EEAOh | CAN2: Interrupt Pending 1 | 0000h |
| CAN2IP2 | EEA2h | CAN2: Interrupt Pending 2 | 0000h |
| CAN2IR | EE08h | CAN2: Interrupt Register | 0000h |
| CAN2MV1 | EEB0h | CAN2: Message Valid 1 | 0000h |
| CAN2MV2 | EEB2h | CAN2: Message Valid 2 | 0000h |
| CAN2ND1 | EE90h | CAN2: New Data 1 | 0000h |
| CAN2ND2 | EE92h | CAN2: New Data 2 | 0000h |
| CAN2SR | EE02h | CAN2: Status Register | 0000h |
| CAN2TR | EE0Ah | CAN2: Test Register | 00x0h |
| CAN2TR1 | EE80h | CAN2: Transmission Request 1 | 0000h |

Table 138. Registers listed by name (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| CAN2TR2 | EE82h | CAN2: Transmission Request 2 | 0000h |
| CCR1 | EA06h | I2C Clock Control Register 1 | 0000h |
| CCR2 | EAOEh | I2C Clock Control Register 2 | 0000h |
| CR | EA00h | I2C Control Register | 0000h |
| DR | EAOCh | I2C Data Register | 0000h |
| OAR1 | EA08h | I2C Own Address Register 1 | 0000h |
| OAR2 | EAOAh | I2C Own Address Register 1 | 0000h |
| RTCAH | ED14h | RTC Alarm Register High Byte | XXXXh |
| RTCAL | ED12h | RTC Alarm Register Low Byte | XXXXh |
| RTCCON | EDOOH | RTC Control Register | 000Xh |
| RTCDH | EDOCh | RTC Divider Counter High Byte | XXXXh |
| RTCDL | EDOAh | RTC Divider Counter Low Byte | XXXXh |
| RTCH | ED10h | RTC Programmable Counter High Byte | XXXXh |
| RTCL | ED0Eh | RTC Programmable Counter Low Byte | XXXXh |
| RTCPH | ED08h | RTC Prescaler Register High Byte | XXXXh |
| RTCPL | ED06h | RTC Prescaler Register Low Byte | XXXXh |
| SR1 | EA02h | I2C Status Register 1 | 0000h |
| SR2 | EA04h | I2C Status Register 2 | 0000h |
| XCLKOUTDIV | EB02h | CLKOUT Divider Control Register | --00h |
| XEMU0 | EB76h | XBUS Emulation Register 0 (write only) | XXXXh |
| XEMU1 | EB78h | XBUS Emulation Register 1 (write only) | XXXXh |
| XEMU2 | EB7Ah | XBUS Emulation Register 2 (write only) | XXXXh |
| XEMU3 | EB7Ch | XBUS Emulation Register 3 (write only) | XXXXh |
| XIROCLR | EB14h | X-Interrupt 0 Clear Register (write only) | 0000h |
| XIROSEL | EB10h | X-Interrupt 0 Selection Register | 0000h |
| XIROSET | EB12h | X-Interrupt 0 Set Register (write only) | 0000h |
| XIR1CLR | EB24h | X-Interrupt 1 Clear Register (write only) | 0000h |
| XIR1SEL | EB20h | X-Interrupt 1 Selection Register | 0000h |
| XIR1SET | EB22h | X-Interrupt 1 Set Register (write only) | 0000h |
| XIR2CLR | EB34h | X-Interrupt 2 Clear Register (write only) | 0000h |
| XIR2SEL | EB30h | X-Interrupt 2 Selection Register | 0000h |
| XIR2SET | EB32h | X-Interrupt 2 Set Register (write only) | 0000h |
| XIR3CLR | EB44h | X-Interrupt 3 Clear Selection Register (write only) | 0000h |

Table 138. Registers listed by name (continued)

| Name | Physical address |  | Reset <br> value |
| :--- | :--- | :--- | :---: |
| XIR3SEL | EB40h | X-Interrupt 3 Selection Register | 0000 h |
| XIR3SET | EB42h | X-Interrupt 3 Set Selection Register (write <br> only) | 0000 h |
| XMISC | EB46h | XBUS Miscellaneous Features Register | 0000 h |
| XP0DIDIS | EB36h | Port 1 Digital Disable Register | 0000 h |
| XPEREMU | EB7Eh | XPERCON copy for Emulation (write only) | XXXXh |
| XPICON | EB26h | Port Input Threshold Control Register | --00 h |
| XPMWCON0CLR | EC08h | XPWM Module Clear Control Reg. 0 (write <br> only) | 0000 h |
| XPMWCON0SET | EC06h | XPWM Module Set Control Register 0 <br> (write only) | 0000 h |
| XPMWCON1CLR | EC0Ch | XPWM Module Clear Control Reg. 0 (write <br> only) | 0000 h |
| XPMWCON1SET | EC0Ah | XPWM Module Set Control Register 0 <br> (write only) | 0000 h |
| XPOLAR | EC04h | XPWM Module Channel Polarity Register | 0000 h |
| XPP0 | E906h | E920h | XPWM Module Period Register 0 |

Table 138. Registers listed by name (continued)

| Name | Physical address | Description <br> value |  |
| :--- | :--- | :--- | :---: |
| XS1PORT | E980h | XASC Port Control Register | 0000 h |
| XS1RBUF | E90Ah | XASC Receive Buffer Register | 0000 h |
| XS1TBUF | E908h | XASC Transmit Buffer Register | 0000 h |
| XSSCBR | E80Ah | XSSC Baud Rate Register | 0000 h |
| XSSCCON | E800h | XSSC Control Register | 0000 h |
| XSSCCONCLR | E804h | XSSC Clear Control Register (write only) | 0000 h |
| XSSCCONSET | E802h | XSSC Set Control Register (write only) | 0000 h |
| XSSCPORT | E880h | XSSC Port Control Register | 0000 h |
| XSSCRB | E808h | XSSC Receive Buffer | XXXXh |
| XSSCTB | E806h | XSSC Transmit Buffer | 0000 h |

### 26.3.2 X-registers ordered by address

Table 139 lists all X-Bus registers which are implemented in the ST10F252M ordered by their physical address. Not all X-registers are bit-addressable.

Table 139. Registers listed by address

| Name | Physical address | Description | Reset <br> value |
| :--- | :--- | :--- | ---: |
| XSSCCON | E800h | XSSC Control Register | 0000 h |
| XSSCCONSET | E802h | XSSC Set Control Register (write only) | 0000 h |
| XSSCCONCLR | E804h | XSSC Clear Control Register (write only) | 0000 h |
| XSSCTB | E806h | XSSC Transmit Buffer | 0000 h |
| XSSCRB | E808h | XSSC Receive Buffer | XXXXh |
| XSSCBR | E80Ah | XSSC Baud Rate Register | 0000 h |
| XSSCPORT | E880h | XSSC Port Control Register | 0000 h |
| XS1CON | E900h | XASC Control Register | 0000 h |
| XS1CONSET | E902h | XASC Set Control Register (write only) | 0000 h |
| XS1CONCLR | E904h | XASC Clear Control Register (write only) | 0000 h |
| XS1BG | E906h | XASC Baud Rate Generator Reload <br> Register | 0000 h |
| XS1TBUF | E908h | XASC Transmit Buffer Register | 0000 h |
| XS1RBUF | E90Ah | XASC Receive Buffer Register | 0000 h |
| XS1PORT | E980h | XASC Port Control Register | 0000 h |
| CR | EA00h | I2C Control Register | 0000 h |
| SR1 | EA02h | I2C Status Register 1 | 0000 h |

Table 139. Registers listed by address (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| SR2 | EA04h | I2C Status Register 2 | 0000h |
| CCR1 | EA06h | I2C Clock Control Register 1 | 0000h |
| OAR1 | EA08h | I2C Own Address Register 1 | 0000h |
| OAR2 | EAOAh | I2C Own Address Register 1 | 0000h |
| DR | EAOCh | I2C Data Register | 0000h |
| CCR2 | EAOEh | I2C Clock Control Register 2 | 0000h |
| XCLKOUTDIV | EB02h | CLKOUT Divider Control Register | - - 00h |
| XIROSEL | EB10h | X-Interrupt 0 Selection Register | 0000h |
| XIROSET | EB12h | X-Interrupt 0 Set Register (write only) | 0000h |
| XIROCLR | EB14h | X-Interrupt 0 Clear Register (write only) | 0000h |
| XIR1SEL | EB20h | X-Interrupt 1 Selection Register | 0000h |
| XIR1SET | EB22h | X-Interrupt 1 Set Register (write only) | 0000h |
| XIR1CLR | EB24h | X-Interrupt 1 Clear Register (write only) | 0000h |
| XPICON | EB26h | Port Input Threshold Control Register | - - 00h |
| XIR2SEL | EB30h | X-Interrupt 2 Selection Register | 0000h |
| XIR2SET | EB32h | X-Interrupt 2 Set Register (write only) | 0000h |
| XIR2CLR | EB34h | X-Interrupt 2 Clear Register (write only) | 0000h |
| XPODIDIS | EB36h | Port 1 Digital Disable Register | 0000h |
| XIR3SEL | EB40h | X-Interrupt 3 Selection Register | 0000h |
| XIR3SET | EB42h | X-Interrupt 3 Set Selection Register (write only) | 0000h |
| XIR3CLR | EB44h | X-Interrupt 3 Clear Selection Register (write only) | 0000h |
| XMISC | EB46h | XBUS Miscellaneous Features Register | 0000h |
| XEMU0 | EB76h | XBUS Emulation Register 0 (write only) | XXXXh |
| XEMU1 | EB78h | XBUS Emulation Register 1 (write only) | XXXXh |
| XEMU2 | EB7Ah | XBUS Emulation Register 2 (write only) | XXXXh |
| XEMU3 | EB7Ch | XBUS Emulation Register 3 (write only) | XXXXh |
| XPEREMU | EB7Eh | XPERCON copy for Emulation (write only) | XXXXh |
| XPWMCON0 | EC00h | XPWM Module Control Register 0 | 0000h |
| XPWMCON1 | EC02h | XPWM Module Control Register 1 | 0000h |
| XPOLAR | EC04h | XPWM Module Channel Polarity Register | 0000h |
| XPMWCONOSET | EC06h | XPWM Module Set Control Register 0 (write only) | 0000h |

Table 139. Registers listed by address (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| XPMWCONOCLR | EC08h | XPWM Module Clear Control Reg. 0 (write only) | 0000h |
| XPMWCON1SET | EC0Ah | XPWM Module Set Control Register 0 (write only) | 0000h |
| XPMWCON1CLR | EC0Ch | XPWM Module Clear Control Reg. 0 (write only) | 0000h |
| XPT0 | EC10h | XPWM Module Up/Down Counter 0 | 0000h |
| XPT1 | EC12h | XPWM Module Up/Down Counter 1 | 0000h |
| XPT2 | EC14h | XPWM Module Up/Down Counter 2 | 0000h |
| XPT3 | EC16h | XPWM Module Up/Down Counter 3 | 0000h |
| XPP0 | EC20h | XPWM Module Period Register 0 | 0000h |
| XPP1 | EC22h | XPWM Module Period Register 1 | 0000h |
| XPP2 | EC24h | XPWM Module Period Register 2 | 0000h |
| XPP3 | EC26h | XPWM Module Period Register 3 | 0000h |
| XPW0 | EC30h | XPWM Module Pulse Width Register 0 | 0000h |
| XPW1 | EC32h | XPWM Module Pulse Width Register 1 | 0000h |
| XPW2 | EC34h | XPWM Module Pulse Width Register 2 | 0000h |
| XPW3 | EC36h | XPWM Module Pulse Width Register 3 | 0000h |
| XPWMPORT | EC80h | XPWM Module Port Control Register | 0000h |
| RTCCON | EDOOH | RTC Control Register | 000Xh |
| RTCPL | ED06h | RTC Prescaler Register Low Byte | XXXXh |
| RTCPH | ED08h | RTC Prescaler Register High Byte | XXXXh |
| RTCDL | EDOAh | RTC Divider Counter Low Byte | XXXXh |
| RTCDH | EDOCh | RTC Divider Counter High Byte | XXXXh |
| RTCL | ED0Eh | RTC Programmable Counter Low Byte | XXXXh |
| RTCH | ED10h | RTC Programmable Counter High Byte | XXXXh |
| RTCAL | ED12h | RTC Alarm Register Low Byte | XXXXh |
| RTCAH | ED14h | RTC Alarm Register High Byte | XXXXh |
| CAN2CR | EE00h | CAN2: CAN Control Register | 0001h |
| CAN2SR | EE02h | CAN2: Status Register | 0000h |
| CAN2EC | EE04h | CAN2: Error Counter | 0000h |
| CAN2BTR | EE06h | CAN2: Bit Timing Register | 2301h |
| CAN2IR | EE08h | CAN2: Interrupt Register | 0000h |
| CAN2TR | EEOAh | CAN2: Test Register | 00x0h |
| CAN2BRPER | EE0Ch | CAN2: BRP Extension Register | 0000h |

Table 139. Registers listed by address (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| CAN2IF1CR | EE10h | CAN2: IF1 Command Request | 0001h |
| CAN2IF1CM | EE12h | CAN2: IF1 Command Mask | 0000h |
| CAN2IF1M1 | EE14h | CAN2: IF1 Mask 1 | FFFFh |
| CAN2IF1M2 | EE16h | CAN2: IF1 Mask 2 | FFFFh |
| CAN2IF1A1 | EE18h | CAN2: IF1 Arbitration 1 | 0000h |
| CAN2IF1A2 | EE1Ah | CAN2: IF1 Arbitration 2 | 0000h |
| CAN2IF1MC | EE1Ch | CAN2: IF1 Message Control | 0000h |
| CAN2IF1DA1 | EE1Eh | CAN2: IF1 Data A 1 | 0000h |
| CAN2IF1DA2 | EE20h | CAN2: IF1 Data A 2 | 0000h |
| CAN2IF1DB1 | EE22h | CAN2: IF1 Data B 1 | 0000h |
| CAN2IF1DB2 | EE24h | CAN2: IF1 Data B 2 | 0000h |
| CAN2IF2CR | EE40h | CAN2: IF2 Command Request | 0001h |
| CAN2IF2CM | EE42h | CAN2: IF2 Command Mask | 0000h |
| CAN2IF2M1 | EE44h | CAN2: IF2 Mask 1 | FFFFh |
| CAN2IF2M2 | EE46h | CAN2: IF2 Mask 2 | FFFFh |
| CAN2IF2A1 | EE48h | CAN2: IF2 Arbitration 1 | 0000h |
| CAN2IF2A2 | EE4Ah | CAN2: IF2 Arbitration 2 | 0000h |
| CAN2IF2MC | EE4Ch | CAN2: IF2 Message Control | 0000h |
| CAN2IF2DA1 | EE4Eh | CAN2: IF2 Data A 1 | 0000h |
| CAN2IF2DA2 | EE50h | CAN2: IF2 Data A 2 | 0000h |
| CAN2IF2DB1 | EE52h | CAN2: IF2 Data B 1 | 0000h |
| CAN2IF2DB2 | EE54h | CAN2: IF2 Data B 2 | 0000h |
| CAN2TR1 | EE80h | CAN2: Transmission Request 1 | 0000h |
| CAN2TR2 | EE82h | CAN2: Transmission Request 2 | 0000h |
| CAN2ND1 | EE90h | CAN2: New Data 1 | 0000h |
| CAN2ND2 | EE92h | CAN2: New Data 2 | 0000h |
| CAN2IP1 | EEAOh | CAN2: Interrupt Pending 1 | 0000h |
| CAN2IP2 | EEA2h | CAN2: Interrupt Pending 2 | 0000h |
| CAN2MV1 | EEBOh | CAN2: Message Valid 1 | 0000h |
| CAN2MV2 | EEB2h | CAN2: Message Valid 2 | 0000h |
| CAN1CR | EFOOh | CAN1: CAN Control Register | 0001h |
| CAN1SR | EF02h | CAN1: Status Register | 0000h |
| CAN1EC | EF04h | CAN1: Error Counter | 0000h |
| CAN1BTR | EF06h | CAN1: Bit Timing Register | 2301h |

Table 139. Registers listed by address (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| CAN1IR | EF08h | CAN1: Interrupt Register | 0000h |
| CAN1TR | EFOAh | CAN1: Test Register | 00x0h |
| CAN1BRPER | EFOCh | CAN1: BRP Extension Register | 0000h |
| CAN1IF1CR | EF10h | CAN1: IF1 Command Request | 0001h |
| CAN1IF1CM | EF12h | CAN1: IF1 Command Mask | 0000h |
| CAN1IF1M1 | EF14h | CAN1: IF1 Mask 1 | FFFFh |
| CAN1IF1M2 | EF16h | CAN1: IF1 Mask 2 | FFFFh |
| CAN1IF1A1 | EF18h | CAN1: IF1 Arbitration 1 | 0000h |
| CAN1IF1A2 | EF1Ah | CAN1: IF1 Arbitration 2 | 0000h |
| CAN1IF1MC | EF1Ch | CAN1: IF1 Message Control | 0000h |
| CAN1IF1DA1 | EF1Eh | CAN1: IF1 Data A 1 | 0000h |
| CAN1IF1DA2 | EF20h | CAN1: IF1 Data A 2 | 0000h |
| CAN1IF1DB1 | EF22h | CAN1: IF1 Data B 1 | 0000h |
| CAN1IF1DB2 | EF24h | CAN1: IF1 Data B 2 | 0000h |
| CAN1IF2CR | EF40h | CAN1: IF2 Command Request | 0001h |
| CAN1IF2CM | EF42h | CAN1: IF2 Command Mask | 0000h |
| CAN1IF2M1 | EF44h | CAN1: IF2 Mask 1 | FFFFh |
| CAN1IF2M2 | EF46h | CAN1: IF2 Mask 2 | FFFFh |
| CAN1IF2A1 | EF48h | CAN1: IF2 Arbitration 1 | 0000h |
| CAN1IF2A2 | EF4Ah | CAN1: IF2 Arbitration 2 | 0000h |
| CAN1IF2MC | EF4Ch | CAN1: IF2 Message Control | 0000h |
| CAN1IF2DA1 | EF4Eh | CAN1: IF2 Data A 1 | 0000h |
| CAN1IF2DA2 | EF50h | CAN1: IF2 Data A 2 | 0000h |
| CAN1IF2DB1 | EF52h | CAN1: IF2 Data B 1 | 0000h |
| CAN1IF2DB2 | EF54h | CAN1: IF2 Data B 2 | 0000h |
| CAN1TR1 | EF80h | CAN1: Transmission Request 1 | 0000h |
| CAN1TR2 | EF82h | CAN1: Transmission Request 2 | 0000h |
| CAN1ND1 | EF90h | CAN1: New Data 1 | 0000h |
| CAN1ND2 | EF92h | CAN1: New Data 2 | 0000h |
| CAN1IP1 | EFAOh | CAN1: Interrupt Pending 1 | 0000h |
| CAN1IP2 | EFA2h | CAN1: Interrupt Pending 2 | 0000h |
| CAN1MV1 | EFBOh | CAN1: Message Valid 1 | 0000h |
| CAN1MV2 | EFB2h | CAN1: Message Valid 2 | 0000h |

### 26.4 Flash control registers overview

### 26.4.1 Registers ordered by name

Table 140 lists all Flash control registers which are implemented in the ST10F252M ordered by their name. As these registers are physically mapped on the I-Bus, they are not bitaddressable.

Table 140. Flash registers listed by name

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| FARH | 0x0008 0012 | Flash Address Register High | 0000h |
| FARL | 0x0008 0010 | Flash Address Register Low | 0000h |
| FCROH | 0x0008 0002 | Flash Control Register 0 - High | 0000h |
| FCROL | 0x0008 0000 | Flash Control Register 0 - Low | 0000h |
| FCR1H | 0x0008 0006 | Flash Control Register 1 - High | 0000h |
| FCR1L | 0x0008 0004 | Flash Control Register 1 - Low | 0000h |
| FDROH | 0x0008 000A | Flash Data Register 0 - High | FFFFh |
| FDROL | 0x0008 0008 | Flash Data Register 0 - Low | FFFFh |
| FDR1H | 0x0008 000E | Flash Data Register 1 - High | FFFFh |
| FDR1L | 0x0008 000C | Flash Data Register 1 - Low | FFFFh |
| FER | 0x0008 0014 | Flash Error Register | 0000h |
| FNVAPR | 0x0008 DFB8 | Flash Non Volatile Access Protection Reg. 0 | ACFFh |
| FNVWPIR-Mirror | 0x0008 DFB4 | Flash Non Volatile Protection I Reg. | FFFFh |
| FNVAPR1H | 0x0008 DFBE | Flash Non Volatile Access Protection Reg. 1 High | FFFFh |
| FNVAPR1L | 0x0008 DFBC | Flash Non Volatile Access Protection Reg. 1 Low | FFFFh |
| FNVWPIR | 0x0008 DFB0 | Flash Non Volatile Protection I Reg. | FFFFh |
| XFVTAU0 | 0x0000 EB50 | Xbus Flash Temporary Unprotection Register | 0000h |

### 26.4.2 Registers ordered by address

Table 141 lists all Flash control registers which are implemented in the ST10F252M ordered by their physical address. As these registers are physically mapped on the I-Bus, they are not bit-addressable.

Table 141. Flash registers listed by address

| Name | Physical address | Description | Reset <br> value |
| :--- | :--- | :--- | :---: |
| FCROL | 0x000B 0000 | Flash Control Register 0 - Low | 0000 h |
| FCROH | 0x000B 0002 | Flash Control Register 0 - High | 0000 h |

Table 141. Flash registers listed by address (continued)

| Name | Physical address | Description | Reset value |
| :---: | :---: | :---: | :---: |
| FCR1L | 0x000B 0004 | Flash Control Register 1 - Low | 0000h |
| FCR1H | 0x000B 0006 | Flash Control Register 1 - High | 0000h |
| FDROL | 0x000B 0008 | Flash Data Register 0 - Low | FFFFh |
| FDROH | 0x000B 000A | Flash Data Register 0-High | FFFFh |
| FDR1L | 0x000B 000C | Flash Data Register 1 - Low | FFFFh |
| FDR1H | 0x000B 000E | Flash Data Register 1 - High | FFFFh |
| FARL | 0x000B 0010 | Flash Address Register Low | 0000h |
| FARH | 0x000B 0012 | Flash Address Register High | 0000h |
| FER | 0x000B 0014 | Flash Error Register | 0000h |
| FNVWPIRL | 0x000B DFB0 | Flash Non Volatile Protection I Reg. Low | FFFFh |
| FNVAPR0 | 0x000B DFB8 | Flash Non Volatile Access Protection Reg. 0 | ACFFh |
| FNVAPR1L | 0x000B DFBC | Flash Non Volatile Access Protection Reg. 1 Low | FFFFh |
| FNVAPR1H | 0x000B DFBE | Flash Non Volatile Access Protection Reg. 1High | FFFFh |
| XTAUR0 | 0x0000 EB50 | Xbus Flash Temporary Unprotection Register | 0000h |

## 27 Electrical Characteristics

### 27.1 Absolute maximum ratings

Table 142. Absolute maximum ratings

| Symbol | Parameter | Values | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Voltage on $\mathrm{V}_{\mathrm{DD}}$ pins with respect to ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ | -0.5 to +6.5 | V |
| $\mathrm{~V}_{\mathrm{STBY}}$ | Voltage on $\mathrm{V}_{\mathrm{STBY}}$ pin with respect to ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ | -0.5 to +6.5 | V |
| $\mathrm{~V}_{\mathrm{AREF}}$ | Voltage on $\mathrm{V}_{\text {AREF }}$ pins with respect to ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $\mathrm{~V}_{\mathrm{AGND}}$ | Voltage on $\mathrm{V}_{\mathrm{AGND}}$ pins with respect to ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ | $\mathrm{V}_{\mathrm{SS}}$ | V |
| $\mathrm{V}_{\text {IO }}$ | Voltage on any pin with respect to ground $\left(\mathrm{V}_{\mathrm{SS}}\right)$ | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $\mathrm{I}_{\mathrm{OV}}$ | Input current on any pin during overload condition | $\pm 10$ | mA |
| $\mathrm{I}_{\text {TOV }}$ | Absolute sum of all input currents during overload condition | I 75 I | mA |
| $\mathrm{T}_{\mathrm{ST}}$ | Storage temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| ESD | ESD Susceptibility (Human Body Model) | 2000 | V |

Note: $\quad$ Stresses above those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. During overload conditions ( $V_{I N}>V_{D D}$ or $V_{I N}<V_{S S}$ ) the voltage on pins with respect to ground ( $V_{S S}$ ) must not exceed the values defined by the Absolute Maximum Ratings.
During power-on and power-off transients (including Standby entering/exiting phases), the relationships between voltages applied to the device and the main $V_{D D}$ must always be respected. In particular, power-on and power-off of $V_{A R E F}$ must be coherent with $V_{D D}$ transient, in order to avoid undesired current injection through the on-chip protection diodes.

### 27.2 Recommended operating conditions

Table 143. Recommended operating conditions

| Symbol | Parameter |  | Value |  |
| :---: | :--- | :---: | :---: | :---: |
|  |  |  |  |  |
|  |  | Min | Max |  |
| $\mathrm{V}_{\mathrm{DD}}$ | Operating supply voltage | 4.5 | 5.5 | V |
| $\mathrm{~V}_{\mathrm{STBY}}$ | Operation stand-by supply voltage ${ }^{(1)}$ |  |  |  |
| $\mathrm{V}_{\text {AREF }}$ | Operating analog reference voltage ${ }^{(2)}$ | 0 | $\mathrm{~V}_{\mathrm{DD}}+0.1$ | V |
| $\mathrm{~T}_{\mathrm{A}}$ | Ambient temperature under bias | -40 | +125 | C |
|  | $\mathrm{T}_{\mathrm{J}}$ |  | +150 |  |

1. The value of the $\mathrm{V}_{\mathrm{STBY}}$ voltage is specified in the range of 4.5 to 5.5 volts. When $\mathrm{V}_{\mathrm{STBY}}$ voltage is lower than main $\mathrm{V}_{\mathrm{DD}}$, the input section of $\mathrm{V}_{\mathrm{STB}} / / \overline{\mathrm{EA}}$ pin can generate a spurious static consumption on $\mathrm{V}_{\mathrm{DD}}$ power supply (in the range of tenth of $\mu \mathrm{A}$ ).
2. For details on operating conditions concerning the usage of $A / D$ Converter refer to Section 27.7.

### 27.3 Power considerations

The average chip-junction temperature, $\mathrm{T}_{\mathrm{J}}$, in degrees Celsius, may be calculated using the following equation:
$T_{J}=T_{A}+\left(P_{D} \times \Theta_{J A}\right)$
Where:

- $\mathrm{T}_{\mathrm{A}}$ is the Ambient Temperature in ${ }^{\circ} \mathrm{C}$,
- $\quad \Theta_{\mathrm{JA}}$ is the Package Junction-to-Ambient Thermal Resistance, in ${ }^{\circ} \mathrm{C} / \mathrm{W}$,
- $\quad P_{D}$ is the sum of $P_{I N T}$ and $P_{I / O}\left(P_{D}=P_{I N T}+P_{/ / O}\right)$,
- $\quad P_{\text {INT }}$ is the product of $I_{D D}$ and $V_{18}$, expressed in Watt. This is the Chip Internal Power,
- $\quad P_{/ / O}$ represents the Power Dissipation on Input and Output Pins; User Determined.

Most of the time for the applications $\mathrm{P}_{\mathrm{I} / \mathrm{O}}<\mathrm{P}_{\mathrm{INT}}$ and may be neglected. On the other hand, $\mathrm{P}_{/ / \mathrm{O}}$ may be significant if the device is configured to drive continuously external modules and/or memories.

An approximate relationship between $\mathrm{P}_{\mathrm{D}}$ and $\mathrm{T}_{\mathrm{J}}$ (if $\mathrm{P}_{\mathrm{I} / \mathrm{O}}$ is neglected) is given by:
$P_{D}=K /\left(T_{J}+273^{\circ} C\right)$
Therefore (solving equations 1 and 2 ):
$K=P_{D} \times\left(T_{A}+273^{\circ} \mathrm{C}\right)+\Theta_{J A} \times P_{D}{ }^{2}$
Where:
K is a constant for the particular part, which may be determined from equation (3) by measuring $P_{D}$ (at equilibrium) for a known $T_{A}$. Using this value of $K$, the values of $P_{D}$ and $T_{J}$ may be obtained by solving equations (1) and (2) iteratively for any value of $\mathrm{T}_{\mathrm{A}}$.

Table 144. Thermal characteristics

| Symbol | Description | Value (typical) | Unit |
| :---: | :--- | :---: | :---: |
| $\Theta_{J A}$ | Thermal Resistance Junction-Ambient <br> LQFP $100-14 \times 14 \mathrm{~mm} / 0.5 \mathrm{~mm}$ pitch | 55 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

### 27.4 Parameter interpretation

The parameters listed in the following tables represent the characteristics of the ST10F252M and its demands on the system.
Where the ST10F252M logic provides signals with their respective timing characteristics, the symbol "CC" for Controller Characteristics, is included in the "Symbol" column.

Where the external system must provide signals with their respective timing characteristics to the ST10F252M, the symbol "SR" for System Requirement, is included in the "Symbol" column.

### 27.5 DC characteristics

$V_{D D}=5 \mathrm{~V} \pm 10 \%, V_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+125^{\circ} \mathrm{C}$
Table 145. DC characteristics

| Parameter | Symbol |  | Limit values |  | Unit | Test condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |  |
| Input low voltage (TTL mode) (except $\overline{R S T I N}, \overline{\mathrm{EA}}, \overline{\mathrm{NMI}}, \mathrm{RPD}, \mathrm{XTAL1}$, READY) | $\mathrm{V}_{\text {IL }}$ | SR | -0.3 | 0.8 | V | - |
| Input low voltage (CMOS mode) (except $\overline{R S T I N}, \overline{E A}, \overline{N M I}, ~ R P D, ~ X T A L 1, ~$ READY) | $\mathrm{V}_{\text {ILS }}$ | SR | -0.3 | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V | - |
| Input low voltage $\overline{\mathrm{RSTIN}}, \overline{\mathrm{EA}}, \overline{\mathrm{NMI}}, \mathrm{RPD}$ | $\mathrm{V}_{\text {IL1 }}$ | SR | -0.3 | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V | - |
| Input low voltage XTAL1 (CMOS only) | $\mathrm{V}_{\text {IL2 }}$ | SR | -0.3 | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V | Direct Drive mode |
| Input low voltage READY (TTL only) | $\mathrm{V}_{\text {IL3 }}$ | SR | -0.3 | 0.8 | V | - |
| Input high voltage (TTL mode) (except RSTIN, EA, NMI, RPD, XTAL1) | $\mathrm{V}_{\mathrm{IH}}$ | SR | 2.0 | $V_{D D}+0.3$ | V | - |
| Input high voltage (CMOS mode) (except RSTIN, EA, NMI, RPD, XTAL1) | $\mathrm{V}_{\mathrm{IHS}}$ | SR | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | $V_{D D}+0.3$ | V | - |
| Input high voltage $\overline{\mathrm{RSTIN}}, \overline{\mathrm{EA}}, \overline{\mathrm{NMI}}, \mathrm{RPD}$ | $\mathrm{V}_{\mathrm{H} 1}$ | SR | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | $V_{D D}+0.3$ | V | - |
| Input high voltage XTAL1 (CMOS only) | $\mathrm{V}_{\mathrm{IH} 2}$ | SR | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | $V_{D D}+0.3$ | V | Direct Drive mode |
| Input high voltage READY (TTL only) | $\mathrm{V}_{\mathrm{IH} 3}$ | SR | 2.0 | $\mathrm{V}_{\mathrm{DD}}+0.3$ | V | - |
| Input Hysteresis (TTL mode) <br>  | $\mathrm{V}_{\mathrm{HYS}}$ | CC | 400 | 700 | mV | (1) |
| Input Hysteresis (CMOS mode) (except $\overline{\mathrm{RSTIN}}, \overline{\mathrm{EA}}, \overline{\mathrm{NMI}}$, XTAL1, RPD) | $\mathrm{V}_{\text {HYSS }}$ | CC | 750 | 1400 | mV | (1) |

Table 145. DC characteristics (continued)

| Parameter | Symbol |  | Limit values |  | Unit | Test condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |  |
| Input Hysteresis $\overline{\mathrm{RSTIN}}$, $\overline{\mathrm{EA}}, \overline{\mathrm{NMII}}$ | $\mathrm{V}_{\text {HYS1 }}$ | CC | 750 | 1400 | mV | (1) |
| Input Hysteresis XTAL1 | $\mathrm{V}_{\text {HYS2 }}$ | CC | 0 | 50 | mV | (1) |
| Input Hysteresis READY (TTL only) | $\mathrm{V}_{\text {HYS3 }}$ | CC | 400 | 700 | mV | (1) |
| Input Hysteresis RPD | $\mathrm{V}_{\text {HYS4 }}$ | CC | 500 | 1500 | mV | (1) |
| Output low voltage (P6[7:0], ALE, $\overline{\mathrm{RD}}, \overline{\mathrm{WR}} / \overline{\mathrm{WRL}}$, BHE/WRH, CLKOUT, RSTIN, RSTOUT) | $\mathrm{V}_{\mathrm{OL}}$ | CC | - | $\begin{gathered} 0.4 \\ 0.05 \end{gathered}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=8 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=1 \mathrm{~mA} \end{aligned}$ |
| Output low voltage <br> (PO[15:0], P1[15:0], P2[15:0], <br> P3[15,13:0], P4[7:0], P7[7:0], <br> P8[7:0]) | $\mathrm{V}_{\text {OL1 }}$ | CC | - | $\begin{gathered} 0.4 \\ 0.05 \end{gathered}$ | V | $\begin{gathered} \mathrm{I}_{\mathrm{OL} 1}=4 \mathrm{~mA} \\ \mathrm{I}_{\mathrm{OL} 1}=0.5 \mathrm{~mA} \end{gathered}$ |
| Output low voltage RPD | $\mathrm{V}_{\text {OL2 }}$ | CC | - | $V_{D D}$ $0.5 V_{D D}$ $0.3 V_{D D}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OL} 2}=85 \mu \mathrm{~A} \\ & \mathrm{I}_{\mathrm{OL} 2}=80 \mu \mathrm{~A} \\ & \mathrm{I}_{\mathrm{OL} 2}=60 \mu \mathrm{~A} \end{aligned}$ |
| Output high voltage (P6[7:0], ALE, $\overline{\mathrm{RD}}, \overline{\mathrm{WR}} / \overline{\mathrm{WRL}}$, BHE/WRH, CLKOUT, RSTOUT) | $\mathrm{V}_{\mathrm{OH}}$ | CC | $\begin{gathered} V_{D D}-0.8 \\ V_{D D}-0.08 \end{gathered}$ | - | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-1 \mathrm{~mA} \end{aligned}$ |
| Output high voltage ${ }^{(2)}$ (PO[15:0], P1[15:0], P2[15:0], P3[15,13:0], P4[7:0], P7[7:0], P8[7:0]) | $\mathrm{V}_{\mathrm{OH} 1}$ | CC | $\begin{gathered} V_{D D}-0.8 \\ V_{D D}-0.08 \end{gathered}$ | - | V | $\begin{gathered} \mathrm{I}_{\mathrm{OH} 1}=-4 \mathrm{~mA} \\ \mathrm{I}_{\mathrm{OH} 1}=-0.5 \mathrm{~mA} \end{gathered}$ |
| Output high voltage RPD | $\mathrm{V}_{\mathrm{OH} 2}$ | CC |  | - | V | $\begin{aligned} \mathrm{I}_{\mathrm{OH} 2} & =-2 \mathrm{~mA} \\ \mathrm{I}_{\mathrm{OH} 2} & =-750 \mu \mathrm{~A} \\ \mathrm{I}_{\mathrm{OH} 2} & =-150 \mu \mathrm{~A} \end{aligned}$ |
| Input leakage current (P5[15:0]) ${ }^{(3)}$ | $\\|_{\mathrm{oz} 1}$ | CC | - | $\pm 0.2$ | $\mu \mathrm{A}$ | - |
| Input leakage current <br> (all except P5[15:0], P2[0], RPD, P3[12], P3[15]) | $\mid l_{\text {loz2 }}$ | CC | - | $\pm 0.5$ | $\mu \mathrm{A}$ | - |
| Input leakage current (P2[0]) ${ }^{(4)}$ | $\mid l_{\text {loza }}$ | CC | - | $\begin{aligned} & +1.0 \\ & -0.5 \end{aligned}$ | $\mu \mathrm{A}$ | - |
| Input leakage current (RPD) | I loz4 | CC | - | $\pm 3.0$ | $\mu \mathrm{A}$ | - |
| Input leakage current (P3[12], P3[15]) | I loz5 | CC | - | $\pm 1.0$ | $\mu \mathrm{A}$ | - |
| Overload current (all except P2[0]) | l lov1 | SR | - | $\pm 5$ | mA | (1)(5) |
| Overload current (P2[0]) ${ }^{(4)}$ | I lov2 | SR | - | $\begin{aligned} & +5 \\ & -1 \end{aligned}$ | mA | (1)(5) |
| $\overline{\text { RSTIN }}$ pull-up resistor | $\mathrm{R}_{\text {RST }}$ | CC | 50 | 250 | k $\Omega$ | $100 \mathrm{k} \Omega$ nominal |
| Read/Write inactive current ${ }^{(6)(7)}$ | $\mathrm{I}_{\text {RWH }}$ |  | - | -40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}$ |

Table 145. DC characteristics (continued)

| Parameter | Symbol |  | Limit values |  | Unit | Test condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |  |
| Read/Write active current ${ }^{(6)(8)}$ | $\mathrm{I}_{\text {RWL }}$ |  | -500 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ |
| ALE inactive current ${ }^{(6)(7)}$ | $\mathrm{I}_{\text {ALEL }}$ |  | 20 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ |
| ALE active current ${ }^{(6)(8)}$ | $\mathrm{I}_{\text {ALEH }}$ |  | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}$ |
| Port 6 inactive current (P6[4:0]) ${ }^{(6)(7)}$ | $\mathrm{IP6H}$ |  | - | -40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}$ |
| Port 6 active current (P6[4:0]) ${ }^{(6)(8)}$ | $\mathrm{I}_{\text {P6L }}$ |  | -500 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ |
| PORT0 configuration current ${ }^{(6)}$ | $\mathrm{IPOH}^{(6)}$ |  | - | -10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=2.0 \mathrm{~V}$ |
|  | $\mathrm{IPOL}^{(7)}$ |  | -100 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0.8 \mathrm{~V}$ |
| Pin Capacitance (Digital inputs / outputs) | $\mathrm{C}_{10}$ | CC | - | 10 | pF | (1)(6) |
| Run Mode Power supply current ${ }^{(9)}$ (Execution from Internal RAM) | ${ }^{\text {cCa } 1}$ |  | - | $\begin{gathered} 15+1.5 \\ \mathrm{f}_{\mathrm{CPU}} \end{gathered}$ | mA | - |
| Run Mode Power supply current ${ }^{(1)(10)}$ (Execution from Internal Flash) | $\mathrm{I}_{\mathrm{CC} 2}$ |  | - | $\begin{gathered} 15+1.5 \\ \mathrm{f}_{\mathrm{CPU}} \end{gathered}$ | mA | - |
| Idle mode supply current ${ }^{(11)}$ | ${ }^{1} \mathrm{D}$ |  | - | $\begin{gathered} 15+0.6 \\ \mathrm{f}_{\mathrm{CPU}} \end{gathered}$ | mA | - |
| Power-down supply current ${ }^{(12)}$ (RTC off, Oscillators off, Main Voltage Regulator off) | ${ }^{\text {PDD1 }}$ |  | - | 150 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |
| Power-down supply current ${ }^{(12)}$ (RTC on, Main Oscillator on, Main Voltage Regulator off) | ${ }^{\text {P PD2 }}$ |  | - | $\begin{gathered} 400 \\ 1100 \end{gathered}$ | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |
| Stand-by supply current ${ }^{(12)}$ <br> (RTC off, Oscillators off, $V_{D D}$ off, $V_{S T B Y}$ on) | $\mathrm{I}_{\text {SB1 }}$ |  | - | 120 | $\mu \mathrm{A}$ | $\begin{gathered} V_{\text {STBY }}=5.5 \mathrm{~V} \\ T_{A}=T_{J}=25^{\circ} \mathrm{C} \end{gathered}$ |
|  |  |  | - | 500 | $\mu \mathrm{A}$ | $\begin{gathered} \mathrm{V}_{\mathrm{STBY}}=5.5 \mathrm{~V} \\ \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C} \end{gathered}$ |
| Stand-by supply current ${ }^{(1)(12)}$ ( $V_{D D}$ transient condition) | ${ }^{\text {SB3 }}$ |  | - | 2.5 | mA | - |

1. Not $100 \%$ tested, guaranteed by design characterization.
2. This specification is not valid for outputs which are switched to open drain mode. In this case the respective output will float and the voltage is imposed by the external circuitry.
3. Port 5 leakage values are granted for not selected $A / D$ Converter channel. One channels is always selected (by default, after reset, P5.0 is selected). For the selected channel the leakage value is similar to that of other port pins.
4. The leakage of P2.0 is higher than other pins due to the additional logic (pass gates active only in specific test modes) implemented on input path. Pay attention to not stress P2.0 input pin with negative overload beyond the specified limits: failures in Flash reading may occur (sense amplifier perturbation). Refer to next Figure 107 for a scheme of the input circuitry.
5. Overload conditions occur if the standard operating conditions are exceeded, that is, the voltage on any pin exceeds the specified range (that is, $\mathrm{V}_{\mathrm{OV}}>\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{OV}}<-0.3 \mathrm{~V}$ ). The absolute sum of input overload currents on all port pins may not exceed 50 mA . The supply voltage must remain within the specified limits.
6. This specification is only valid during Reset, or during Hold- or Adapt-mode. Port 6 pins are only affected, if they are used for CS output and the open drain function is not enabled.
7. The maximum current may be drawn while the respective signal line remains inactive.
8. The minimum current must be drawn in order to drive the respective signal line active.
9. The power supply current is a function of the operating frequency ( $\mathrm{f}_{\mathrm{CPU}}$ is expressed in MHz ). This dependency is illustrated in Figure 108 below. This parameter is tested at $\mathrm{V}_{\text {DDmax }}$ and at maximum CPU clock frequency with all outputs disconnected and all inputs at $\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$, $\overline{\text { RSTIN }}$ pin at $\mathrm{V}_{\mathrm{IH} 1 \text { min }}$ : this implies I/O current is not considered. The device is doing the following:
Fetching code from IRAM and XRAM1, accessing in read and write to both XRAM modules
Watchdog Timer is enabled and regularly serviced
RTC is running with main oscillator clock as reference, generating a tick interrupts every 192 clock cycles
Four channel of XPWM are running (waves period: 2, 2.5, 3 and 4 CPU clock cycles): no output toggling
Five General Purpose Timers are running in timer mode with prescaler equal to 8 (T2, T3, T4, T5, T6)
ADC is in Auto Scan Continuous Conversion mode on all 16 channels of Port5
All interrupts generated by XPWM, RTC, Timers and ADC are not serviced
10. The power supply current is a function of the operating frequency ( $\mathrm{f}_{\mathrm{CP}}$ is expressed in MHz ). This dependency is illustrated in Figure 108 below. This parameter is tested at $V_{\text {DDmax }}$ and at maximum CPU clock frequency with all outputs disconnected and all inputs at $\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$, $\overline{\text { RSTIN }}$ pin at $\mathrm{V}_{\mathrm{IH} 1 \text { min }}$ : this implies I/O current is not considered. The device is doing the following:

- Fetching code from all sectors of IFlash, accessing in read (few fetches) and write to XRAM
- Watchdog Timer is enabled and regularly serviced
- RTC is running with main oscillator clock as reference, generating a tick interrupts every 192 clock cycles
- Four channel of XPWM are running (waves period: 2, 2.5, 3 and 4 CPU clock cycles): no output toggling
- Five General Purpose Timers are running in timer mode with prescaler equal to 8 (T2, T3, T4, T5, T6)
- ADC is in Auto Scan Continuous Conversion mode on all 16 channels of Port5
- All interrupts generated by XPWM, RTC, Timers and ADC are not serviced

11. The Idle mode supply current is a function of the operating frequency ( $\mathrm{f}_{\mathrm{CPU}}$ is expressed in MHz ). This dependency is illustrated in Figure 108 below. These parameters are tested and at maximum CPU clock with all outputs disconnected and all inputs at $\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$, RSTIN pin at $\mathrm{V}_{\mathrm{IH} 1 \text { min }}$.
12. This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at $\mathrm{V}_{\mathrm{DD}}$ -0.1 V to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\text {AREF }}=0 \mathrm{~V}$, all outputs (including pins configured as outputs) disconnected. Also, the Main Voltage Regulator is assumed to be off; if it is not, an additional 1 mA must be added.

Figure 107. Port2 test mode structure


Figure 108. Supply current versus the operating frequency (RUN and IDLE modes)


### 27.6 Flash characteristics

$$
V_{D D}=5 \mathrm{~V} \pm 10 \%, V_{S S}=0 V
$$

Table 146. Flash characteristics

| Parameter | Typical | Maximum |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ |  |  |  |
|  | 0 cycles $^{(1)}$ | 0 cycles $^{(1)}$ | 100k cycles |  |  |
| Word Program (32-bit) ${ }^{(2)}$ | 35 | 80 | 290 | $\mu \mathrm{s}$ | - |
| Double Word Program (64-bit) ${ }^{(2)}$ | 60 | 150 | 570 | $\mu \mathrm{s}$ | - |
| Bank 0 Program (256 Kbyte) (Double Word Program) | 1.6 | 2.0 | 3.9 | s | - |
| Sector Erase (8 Kbyte) | $\begin{aligned} & 0.6 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.9 \end{aligned}$ | s | not preprogrammed preprogrammed |
| Sector Erase (32 Kbyte) | $\begin{aligned} & 1.1 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.8 \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 2.5 \end{aligned}$ | s | not preprogrammed preprogrammed |
| Sector Erase (64 Kbyte) | $\begin{aligned} & 1.7 \\ & 1.3 \end{aligned}$ | $\begin{aligned} & 3.7 \\ & 3.3 \end{aligned}$ | $\begin{aligned} & 5.1 \\ & 4.7 \end{aligned}$ | s | not preprogrammed preprogrammed |
| Bank 0 Erase (256 Kbyte) ${ }^{(3)}$ | $\begin{aligned} & 5.6 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 13.6 \\ & 11.9 \end{aligned}$ | $\begin{aligned} & 19.2 \\ & 17.5 \end{aligned}$ | s | not preprogrammed preprogrammed |
| Recovery from Power-Down (tpD) | - | 40 | 40 | $\mu \mathrm{s}$ | (4) |
| Program Suspend Latency ${ }^{(4)}$ | - | 10 | 10 | $\mu \mathrm{s}$ | - |
| Erase Suspend Latency ${ }^{(4)}$ | - | 30 | 30 | $\mu \mathrm{s}$ | - |
| Erase Suspend Request Rate ${ }^{(4)}$ | 20 | 20 | 20 | ms | Minimum delay between two requests |
| Set Protection ${ }^{(4)}$ | 40 | 90 | 300 | $\mu \mathrm{s}$ | - |

1. The figures are given after about 100 cycles due to testing routines ( 0 cycles at the final customer).
2. Word and Double Word Programming times are provided as average values derived from a full sector programming time: absolute value of a Word or Double Word Programming time could be longer than the average value.
3. Bank Erase is obtained through a multiple Sector Erase operation (setting bits related to all sectors of the Bank). As ST10F252M implements only one bank, the Bank Erase operation is equivalent to Module and Chip Erase operations.
4. Not $100 \%$ tested, guaranteed by Design Characterization.

Table 147. Flash data retention characteristics

| Number of program / erase cycles <br> $\left(-40^{\circ} \mathbf{C} \leq \mathrm{T}_{\mathrm{A}} \leq \mathbf{1 2 5}^{\circ} \mathrm{C}\right)$ | Data retention time <br> (average ambient temperature $\mathbf{6 0}$ |  |
| :---: | :---: | :---: |
|  | $\mathbf{2 5 6}$ ) Kbyte (code store) | $\mathbf{6 4 ~ K b y t e ~ ( E E P R O M ~ e m u l a t i o n ) ~}{ }^{\mathbf{( 1 )}}$ |
| $0-100$ | $>20$ years | $>20$ years |
| 1000 | - | $>20$ years |
| 10000 | - | 10 years |
| 100000 | - | 1 year |

1. Two 64 Kbyte Flash Sectors may be typically used to emulate up to 4,8 or 16 Kbytes of EEPROM. Therefore, in case of an emulation of a 16 Kbyte EEPROM, 100,000 Flash Program / Erase cycles are equivalent to 800,000 EEPROM
Program/Erase cycles. For an efficient use of the EEPROM Emulation please refer to dedicated Application Note document (AN2061 - "EEPROM Emulation with ST10F2xx"). Contact your local field service, local sales person or STMicroelectronics representative to obtain a copy of such a guideline document.

### 27.7 A/D converter characteristics

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40 \text { to }+125^{\circ} \mathrm{C}, 4.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{AREF}} \leq \mathrm{V}_{\mathrm{DD}} \\
& \mathrm{~V}_{\mathrm{SS}} \leq \mathrm{V}_{\mathrm{AGND}} \leq \mathrm{V}_{\mathrm{SS}}+0.2 \mathrm{~V}
\end{aligned}
$$

Table 148. A/D converter characteristics

| Parameter | Symbol |  | Limit values |  | Unit | Test condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |  |
| Analog Reference voltage ${ }^{(1)}$ | $V_{\text {AREF }}$ | SR | 4.5 | $V_{D D}$ | V |  |
| Analog Ground voltage | $\mathrm{V}_{\text {AGND }}$ | SR | $\mathrm{V}_{S S}$ | $\mathrm{V}_{\mathrm{SS}}+0.2$ | V |  |
| Analog Input voltage ${ }^{(2)}$ | $\mathrm{V}_{\text {AIN }}$ | SR | $\mathrm{V}_{\text {AGND }}$ | $\mathrm{V}_{\text {AREF }}$ | V |  |
| Reference supply current | $\mathrm{I}_{\text {AREF }}$ | CC | $\begin{aligned} & \text { - } \\ & \text { - } \end{aligned}$ | $\begin{aligned} & 5 \\ & 1 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mu \mathrm{~A} \end{aligned}$ | Running mode ${ }^{(3)}$ Power-down mode |
| Sample time | $t_{s}$ | CC | 1 | - | $\mu \mathrm{s}$ | (4) |
| Conversion time | ${ }^{\text {c }}$ | CC | 3 | - | $\mu \mathrm{s}$ | (5) |
| Differential Non Linearity ${ }^{(6)}$ | DNL | CC | -1 | +1 | LSB | No overload |
| Integral Non Linearity ${ }^{(6)}$ | INL | CC | -1.5 | +1.5 | LSB | No overload |
| Offset Error ${ }^{(6)}$ | OFS | CC | -1.5 | +1.5 | LSB | No overload |
| Total unadjusted error ${ }^{(6)}$ | TUE | CC | $\begin{aligned} & -2.0 \\ & -5.0 \\ & -7.0 \end{aligned}$ | $\begin{aligned} & +2.0 \\ & +5.0 \\ & +7.0 \end{aligned}$ | LSB | Port5 <br> Port1 - No overload ${ }^{(3)}$ <br> Port1 - Overload ${ }^{(3)}$ |
| Coupling Factor between inputs ${ }^{(3)(7)}$ | K | CC | - | $10^{-6}$ | - | On both Port5 and Port1 |
| Input Pin Capacitance ${ }^{(3)(8)}$ | $\mathrm{C}_{\text {P1 }}$ | CC | - | 3 | pF |  |
|  | $\mathrm{C}_{\text {P2 }}$ | CC | - | $\begin{aligned} & 4 \\ & 6 \end{aligned}$ | pF | Port5 <br> Port1 |
| Sampling Capacitance ${ }^{(3)(8)}$ | $\mathrm{C}_{S}$ | CC | - | 3.5 | pF |  |

Table 148. A/D converter characteristics (continued)

| Parameter | Symbol |  | Limit values |  | Unit | Test condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |  |
| Analog Switch Resistance ${ }^{(3)(8)}$ | $\mathrm{R}_{\text {Sw }}$ | CC | - | $\begin{gathered} \hline 600 \\ 1600 \end{gathered}$ | W | Port5 <br> Port1 |
|  | $\mathrm{R}_{\text {AD }}$ | CC | - | 1300 | W |  |

1. $V_{\text {AREF }}$ can be tied to ground when $A / D$ Converter is not in use: There is increased consumption (approximately $200 \mu A$ ) on main $V_{D D}$ due to internal analog circuitry not being completely turned off. Therefore, it is suggested to maintain the $V_{A R E F}$ at $V_{D D}$ level even when not in use, and to eventually switch off the A/D Converter circuitry setting bit ADOFF in ADCON register.
2. $\mathrm{V}_{\text {AIN }}$ may exceed $\mathrm{V}_{\text {AGND }}$ or $\mathrm{V}_{\text {AREF }}$ up to the absolute maximum ratings. However, the conversion result in these cases will be $0 \times 000_{H}$ or $0 \times 3 F F_{H}$, respectively
3. Not $100 \%$ tested, guaranteed by design characterization
4. During the sample time the input capacitance $\mathrm{C}_{\text {AIN }}$ can be charged/discharged by the external source. The internal resistance of the analog source must allow the capacitance to reach its final voltage level within $\mathrm{t}_{\mathrm{s}}$. After the end of the sample time $\mathrm{t}_{\mathrm{S}}$, changes of the analog input voltage have no effect on the conversion result. Values for the sample clock $\mathrm{t}_{\mathrm{S}}$ depend on programming and can be taken from Table 149: $A / D$ converter programming.
5. This parameter includes the sample time $t_{S}$, the time for determining the digital result and the time to load the result register with the conversion result. Values for the conversion clock $t_{c c}$ depend on programming and can be taken from the next Table 149
6. DNL , INL, OFS and TUE are tested at $\mathrm{V}_{\mathrm{AREF}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{AGND}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5.0 \mathrm{~V}$. It is guaranteed by design characterization for all other voltages within the defined voltage range.
'LSB' has a value of $\mathrm{V}_{\text {AREF }} / 1024$.
For Port5 channels, the specified TUE ( $\pm 2 \mathrm{LSB}$ ) is guaranteed also with an overload condition (see IOv specification) occurring on maximum 2 not selected analog input pins of Port5 and the absolute sum of input overload currents on all Port5 analog input pins does not exceed 10 mA .
For Port1 channels, the specified TUE is guaranteed when no overload condition is applied to Port1 pins: when an overload condition occurs on maximum 2 not selected analog input pins of Port1 and the input positive overload current on all analog input pins does not exceed 10 mA (either dynamic or static injection), the specified TUE is degraded ( $\pm 7 \mathrm{LSB}$ ). To obtain the same accuracy, the negative injection current on Port1 pins must not exceed -1 mA in case of both dynamic and static injection.
7. The coupling factor is measured on a channel while an overload condition occurs on the adjacent not selected channels with the overload current within the different specified ranges (for both positive and negative injection current).
8. Refer to scheme shown in Figure 110.

### 27.7.1 Conversion timing control

When a conversion is started, first the capacitances of the converter are loaded via the respective analog input pin to the current analog input voltage. The time to load the capacitances is referred to as sample time. Next the sampled voltage is converted to a digital value several successive steps, which correspond to the 10-bit resolution of the ADC. During these steps the internal capacitances are repeatedly charged and discharged via the $V_{\text {AREF }}$ pin.

The current that has to be drawn from the sources for sampling and changing charges depends on the time that each respective step takes, because the capacitors must reach their final voltage level within the given time, at least with a certain approximation. The maximum current, however, that a source can deliver, depends on its internal resistance.

The time that the two different actions during conversion take (sampling, and converting) can be programmed within a certain range in the ST10F252M relative to the CPU clock. The absolute time that is consumed by the different conversion steps therefore is independent from the general speed of the controller. This allows adjustment of the ST10F252M A/D converter to the system's properties:

Fast conversion can be achieved by programming the respective times to their absolute possible minimum. This is preferable for scanning high frequency signals. The internal resistance of analog source and analog supply must be sufficiently low, however.

High internal resistance can be achieved by programming the respective times to a higher value, or the possible maximum. This is preferable when using analog sources and supply with a high internal resistance in order to keep the current as low as possible. The conversion rate in this case may be considerably lower, however.

The conversion times are programmed via the upper four bits of register ADCON. Bit fields ADCTC and ADSTC are used to define the basic conversion time and in particular the partition between sample phase and comparison phases. The table below lists the possible combinations. The timings refer to the unit TCL, where $f_{C P U}=1 / 2 T C L$. A complete conversion time includes the conversion itself, the sample time and the time required to transfer the digital value to the result register.

Table 149. A/D converter programming

| ADCTC | ADSTC | Sample | Comparison | Extra | Total conversion |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 00 | 00 | TCL * 120 | TCL * 240 | TCL * 28 | TCL * 388 |
| 00 | 01 | TCL * 140 | TCL * 280 | TCL * 16 | TCL * 436 |
| 00 | 10 | TCL * 200 | TCL * 280 | TCL * 52 | TCL * 532 |
| 00 | 11 | TCL * 400 | TCL * 280 | TCL * 44 | TCL * 724 |
| 11 | 00 | TCL * 240 | TCL * 480 | TCL * 52 | TCL * 772 |
| 11 | 01 | TCL * 280 | TCL * 560 | TCL * 28 | TCL * 868 |
| 11 | 10 | TCL * 400 | TCL * 560 | TCL * 100 | TCL * 1060 |
| 11 | 11 | TCL * 800 | TCL * 560 | TCL * 52 | TCL * 1444 |
| 10 | 00 | TCL * 480 | TCL * 960 | TCL * 100 | TCL * 1540 |
| 10 | 01 | TCL * 560 | TCL * 1120 | TCL * 52 | TCL * 1732 |
| 10 | 10 | TCL * 800 | TCL * 1120 | TCL * 196 | TCL * 2116 |
| 10 | 11 | TCL * 1600 | TCL * 1120 | TCL * 164 | TCL * 2884 |

Note: $\quad$ The total conversion time is compatible with the formula valid for ST10F269, while the meaning of the bit fields ADCTC and ADSTC is no longer compatible: the minimum conversion time is 388 TCL, which at 40 MHz CPU frequency corresponds to $4.85 \mu \mathrm{~s}$ (see ST10F269).

### 27.7.2 A/D conversion accuracy

The A/D Converter compares the analog voltage sampled on the selected analog input channel to its analog reference voltage ( $\mathrm{V}_{\text {AREF }}$ ) and converts it into 10-bit digital data. The absolute accuracy of the $A / D$ conversion is the deviation between the input analog value and the output digital value. It includes the following errors:

- Offset error (OFS)
- Gain Error (GE)
- Quantization error
- Non-Linearity error (Differential and Integral)

These four error quantities are explained below using Figure 109.

## Offset error

Offset error is the deviation between actual and ideal A/D conversion characteristics when the digital output value changes from the minimum (zero voltage) 00 to 01 (Figure 109, see OFS).

## Gain error

Gain error is the deviation between the actual and ideal $A / D$ conversion characteristics when the digital output value changes from the 3FE to the maximum 3FF, once offset error is subtracted. Gain error combined with offset error represents the so-called full-scale error (Figure 109, OFS + GE).

## Quantization error

Quantization error is the intrinsic error of the A/D converter and is expressed as $1 / 2$ LSB.

## Non-linearity error

Non-Linearity error is the deviation between actual and the best-fitting A/D conversion characteristics (see Figure 109):

- Differential Non-Linearity error is the actual step dimension versus the ideal one (1 LSB ${ }_{\text {IDEAL }}$ ).
- Integral Non-Linearity error is the distance between the center of the actual step and the center of the bisector line, in the actual characteristics. Note that for Integral NonLinearity error, the effect of offset, gain and quantization errors is not included.

Note: $\quad$ Bisector characteristic is obtained drawing a line from $1 / 2$ LSB before the first step of the real characteristic, and 1/2 LSB after the last step again of the real characteristic.

### 27.7.3 Total unadjusted error

The Total Unadjusted Error specifies the maximum deviation from the ideal characteristic: the number provided in the Data Sheet represents the maximum error with respect to the entire characteristic. It is a combination of the Offset, Gain and Integral Linearity errors. The different errors may compensate each other depending on the relative sign of the Offset and Gain errors. Refer to Figure 109, see TUE.

Figure 109. A/D conversion characteristics


### 27.7.4 Analog reference pins

The accuracy of the A/D converter depends on how accurate is its analog reference: a noise in the reference results in at least that much error in a conversion. A low pass filter on the $A / D$ converter reference source (supplied through pins $\mathrm{V}_{\text {AREF }}$ and $\mathrm{V}_{\text {AGND }}$ ), is recommended in order to clean the signal, minimizing the noise. A simple capacitive bypassing may be sufficient in most of the cases; in presence of high RF noise energy, inductors or ferrite beads may be necessary.

In this architecture, $\mathrm{V}_{\text {AREF }}$ and $\mathrm{V}_{\text {AGND }}$ pins represents also the power supply of the analog circuitry of the $A / D$ converter: there is an effective $D C$ current requirement from the reference voltage by the internal resistor string in the R-C DAC array and by the rest of the analog circuitry.

An external resistance on $V_{\text {AREF }}$ could introduce error under certain conditions: for this reasons, series resistance are not advisable, and more in general any series devices in the filter network should be designed to minimize the DC resistance.

## Analog input pins

To improve the accuracy of the A/D converter, it is definitively necessary that analog input pins have low AC impedance. Placing a capacitor with good high frequency characteristics at the input pin of the device, can be effective: the capacitor should be as large as possible, ideally infinite. This capacitor contributes to attenuating the noise present on the input pin; moreover, it sources charge during the sampling phase, when the analog signal source is a high-impedance source.

A real filter, can typically be obtained by using a series resistance with a capacitor on the input pin (simple RC Filter). The RC filtering may be limited according to the value of source impedance of the transducer or circuit supplying the analog signal to be measured. The filter at the input pins must be designed taking into account the dynamic characteristics of the input signal (bandwidth).

Figure 110. A/D converter input pins scheme
EXTERNAL CIRCUIT

## Input leakage and external circuit

The series resistor utilized to limit the current to a pin (see $R_{L}$ in Figure 110), in combination with a large source impedance can lead to a degradation of $A / D$ converter accuracy when input leakage is present.
Data about maximum input leakage current at each pin is provided in the Data Sheet (Electrical Characteristics section). Input leakage is greatest at high operating temperatures, and in general it decreases by one half for each $10^{\circ} \mathrm{C}$ decrease in temperature.
Considering that, for a 10-bit $\mathrm{A} / \mathrm{D}$ converter one count is about 5 mV (assuming $\mathrm{V}_{\text {AREF }}=5 \mathrm{~V}$ ), an input leakage of 100 nA acting though an $R_{L}=50 \mathrm{k} \Omega$ of external resistance leads to an error of exactly one count ( 5 mV ); if the resistance were $100 \mathrm{k} \Omega$ the error would become two counts.

Eventual additional leakage due to external clamping diodes must also be taken into account in computing the total leakage affecting the A/D converter measurements. Another contribution to the total leakage is represented by the charge sharing effects with the sampling capacitance: being $\mathrm{C}_{S}$ substantially a switched capacitance, with a frequency equal to the conversion rate of a single channel (maximum when fixed channel continuous conversion mode is selected), it can be seen as a resistive path to ground. For instance, assuming a conversion rate of 250 kHz , with $\mathrm{C}_{\mathrm{S}}$ equal to 4 pF , a resistance of $1 \mathrm{M} \Omega$ is obtained $\left(R_{E Q}=1 / f_{C} C_{S}\right.$, where $f_{C}$ represents the conversion rate at the considered channel). To minimize the error induced by the voltage partitioning between this resistance
(sampled voltage on $C_{S}$ ) and the sum of $R_{S}+R_{F}+R_{L}+R_{S W}+R_{A D}$, the external circuit must be designed to respect the following relation:

$$
v_{A} \cdot \frac{R_{S}+R_{F}+R_{L}+R_{S W}+R_{A D}}{R_{E Q}}<\frac{1}{2} L S B
$$

The formula above provides constraints for external network design, in particular on resistive path.

A second aspect involving the capacitance network must be considered. Assuming the three capacitances $C_{F} C_{P 1}$ and $C_{P 2}$ initially charged at the source voltage $V_{A}$ (refer to the equivalent circuit shown in Figure 110), when the sampling phase is started (A/D switch close), a charge sharing phenomena is installed.

Figure 111. Charge sharing timing diagram during sampling phase


In particular two different transient periods can be distinguished (see Figure 111):

- A first and quick charge transfer from the internal capacitance $C_{P 1}$ and $C_{P 2}$ to the sampling capacitance $\mathrm{C}_{S}$ occurs ( $\mathrm{C}_{S}$ is supposed initially completely discharged): considering a worst case (since the time constant in reality would be faster) in which $C_{P 2}$ is shown in parallel to $C_{P 1}$ (call $C_{P}=C_{P 1}+C_{P 2}$ ), the two capacitance $C_{P}$ and $C_{S}$ are in series, and the time constant is:

$$
\tau_{1}=\left(\mathrm{R}_{\mathrm{SW}}+\mathrm{R}_{\mathrm{AD}}\right) \cdot \frac{\mathrm{C}_{\mathrm{P}} \cdot \mathrm{C}_{\mathrm{S}}}{\mathrm{C}_{\mathrm{P}}+\mathrm{C}_{\mathrm{S}}}
$$

This relation can again be simplified considering only $\mathrm{C}_{S}$ as an additional worst condition. In reality, the transient is faster, but the A/D Converter circuitry has been designed to be robust also in the very worst case: the sampling time $T_{S}$ is always much longer than the internal time constant:

$$
\tau_{1}<\left(\mathrm{R}_{\mathrm{SW}}+\mathrm{R}_{\mathrm{AD}}\right) \cdot \mathrm{C}_{\mathrm{S}} \ll \mathrm{~T}_{\mathrm{S}}
$$

The charge of $C_{P 1}$ and $C_{P 2}$ is redistributed also on $C_{S}$, determining a new value of the voltage $\mathrm{V}_{\mathrm{A} 1}$ on the capacitance according to the following equation:

$$
\mathrm{V}_{\mathrm{A} 1} \cdot\left(\mathrm{C}_{\mathrm{S}}+\mathrm{C}_{\mathrm{P} 1}+\mathrm{C}_{\mathrm{P} 2}\right)=\mathrm{v}_{\mathrm{A}} \cdot\left(\mathrm{C}_{\mathrm{P} 1}+\mathrm{C}_{\mathrm{P} 2}\right)
$$

- A second charge transfer involves also $C_{F}$ (that is typically bigger than the on-chip capacitance) through the resistance $R_{L}$ : again considering the worst case in which $C_{P 2}$ and $\mathrm{C}_{\mathrm{S}}$ were in parallel to $\mathrm{C}_{\mathrm{P}_{1}}$ (since the time constant in reality would be faster), the time constant is:

$$
\tau_{2}<R_{L} \cdot\left(C_{S}+C_{P 1}+C_{P 2}\right)
$$

In this case, the time constant depends on the external circuit: in particular imposing that the transient is completed well before the end of sampling time $T_{S}$, a constraint on $R_{L}$ sizing is obtained:

$$
10 \cdot \tau_{2}=10 \cdot R_{L} \cdot\left(C_{S}+C_{P 1}+C_{P 2}\right) \leq T_{S}
$$

Of course, $R_{L}$ must also be sized according to the current limitation constraints, in combination with $R_{S}$ (source impedance) and $R_{F}$ (filter resistance). Being $C_{F}$ definitively bigger than $\mathrm{C}_{\mathrm{P} 1}, \mathrm{C}_{\mathrm{P} 2}$ and $\mathrm{C}_{\mathrm{S}}$, then the final voltage $\mathrm{V}_{\mathrm{A} 2}$ (at the end of the charge transfer transient) will be much higher than $\mathrm{V}_{\mathrm{A} 1}$. The following equation must be respected (charge balance assuming now $\mathrm{C}_{\mathrm{S}}$ already charged at $\mathrm{V}_{\mathrm{A} 1}$ ):

$$
\mathrm{V}_{\mathrm{A} 2} \cdot\left(\mathrm{C}_{\mathrm{S}}+\mathrm{C}_{\mathrm{P} 1}+\mathrm{C}_{\mathrm{P} 2}+\mathrm{C}_{\mathrm{F}}\right)=\mathrm{V}_{\mathrm{A}} \cdot \mathrm{C}_{\mathrm{F}}+\mathrm{V}_{\mathrm{A} 1} \cdot\left(\mathrm{C}_{\mathrm{P} 1}+\mathrm{C}_{\mathrm{P} 2}+\mathrm{C}_{\mathrm{S}}\right)
$$

The two transients above are not influenced by the voltage source that, due to the presence of the $R_{F} C_{F}$ filter, is not able to provide the extra charge to compensate the voltage drop on $C_{S}$ with respect to the ideal source $V_{A}$; the time constant $R_{F} C_{F}$ of the filter is very high with respect to the sampling time ( $\mathrm{T}_{\mathrm{S}}$ ). The filter is typically designed to act as anti-aliasing (see Figure 112).

Calling $f_{0}$ the bandwidth of the source signal (and as a consequence the cut-off frequency of the anti-aliasing filter, $\mathrm{f}_{\mathrm{F}}$ ), according to Nyquist theorem the conversion rate $\mathrm{f}_{\mathrm{C}}$ must be at least $2 f_{0}$; it means that the constant time of the filter is greater than or at least equal to twice the conversion period $\left(\mathrm{T}_{\mathrm{C}}\right)$. Again the conversion period $\mathrm{T}_{\mathrm{C}}$ is longer than the sampling time $\mathrm{T}_{\mathrm{S}}$, which is just a portion of it, even when fixed channel continuous conversion mode is selected (fastest conversion rate at a specific channel): in conclusion it is evident that the time constant of the filter $R_{F} C_{F}$ is definitively much higher than the sampling time $T_{S}$, so the charge level on $\mathrm{C}_{S}$ cannot be modified by the analog signal source during the time in which the sampling switch is closed.

Figure 112. Anti-aliasing filter and conversion rate

Analog Source Bandwidth $\left(V_{A}\right)$


Anti-Aliasing Filter ( $f_{F}=$ RC Filter pole) Sampled Signal Spectrum ( $f_{C}=$ conversion Rate)

$\mathrm{T}_{\mathrm{C}} \leq 2 \mathrm{R}_{\mathrm{F}} \mathrm{C}_{\mathrm{F}}$ (Conversion Rate vs. Filter Pole)
$\mathrm{f}_{\mathrm{F}}=\mathrm{f}_{0}$ (Anti-aliasing Filtering Condition)
$2 \mathrm{f}_{0} \leq \mathrm{f}_{\mathrm{C}}$ (Nyquist)


The considerations above lead to impose new constraints to the external circuit, to reduce the accuracy error due to the voltage drop on $\mathrm{C}_{S}$; from the two charge balance equations above, it is simple to derive the following relation between the ideal and real sampled voltage on $\mathrm{C}_{\mathrm{S}}$ :

$$
\frac{v_{A}}{v_{A 2}}=\frac{C_{P 1}+C_{P 2}+C_{F}}{C_{P 1}+C_{P 2}+C_{F}+C_{S}}
$$

From this formula, in the worst case (when $\mathrm{V}_{\mathrm{A}}$ is maximum, that is for instance 5 V ), assuming to accept a maximum error of half a count ( $\sim 2.44 \mathrm{mV}$ ), a constraint is immediately evident on $C_{F}$ value:

$$
C_{F}>2048 \cdot C_{S}
$$

In the next section an example of how to design the external network is provided, assuming some reasonable values for the internal parameters and making a hypothesis on the characteristics of the analog signal to be sampled.

## Example of external network sizing

The following hypotheses are formulated in order to proceed in designing the external network on A/D Converter input pins:

- Analog Signal Source Bandwidth ( $\mathrm{f}_{0}$ ): 10 kHz
- conversion Rate ( $\mathrm{f}_{\mathrm{C}}$ ): 25 kHz
- Sampling Time $\left(T_{S}\right)$ : $1 \mu \mathrm{~s}$
- Pin Input Capacitance $\left(\mathrm{C}_{\mathrm{P} 1}\right): 5 \mathrm{pF}$
- Pin Input Routing Capacitance $\left(\mathrm{C}_{\mathrm{P} 2}\right)$ : 1 pF
- Sampling Capacitance $\left(\mathrm{C}_{\mathrm{S}}\right)$ : 4 pF
- Maximum Input Current Injection $\left(I_{\mathrm{INJ}}\right): 3 m A$
- Maximum Analog Source Voltage ( $\mathrm{V}_{\mathrm{AM}}$ : 12 V
- Analog Source Impedance ( $\mathrm{R}_{\mathrm{S}}$ ): $100 \Omega$
- Channel Switch Resistance ( $\mathrm{R}_{\mathrm{SW}}$ ): $500 \Omega$
- Sampling Switch Resistance $\left(\mathrm{R}_{\mathrm{AD}}\right): \quad 200 \Omega$

1. Supposing to design the filter with the pole exactly at the maximum frequency of the signal, the time constant of the filter is:

$$
R_{C} C_{F}=\frac{1}{2 \pi f_{0}}=15.9 \mu \mathrm{~s}
$$

2. Using the relation between $C_{F}$ and $C_{S}$ and taking some margin (4000 instead of 2048), it is possible to define $C_{F}$ :

$$
C_{F}=4000 \cdot C_{S}=16 n F
$$

3. As a consequence of step 1 and $2, R C$ can be chosen:

$$
R_{F}=\frac{1}{2 \pi f_{0} C_{F}}=995 \Omega \cong 1 \mathrm{k} \Omega
$$

4. Considering the current injection limitation and supposing that the source can go up to 12 V , the total series resistance can be defined as:

$$
\mathrm{R}_{\mathrm{S}}+\mathrm{R}_{\mathrm{F}}+\mathrm{R}_{\mathrm{L}}=\frac{\mathrm{V}_{\mathrm{AM}}}{\mathrm{I}_{\mathrm{INJ}}}=4 \mathrm{k} \Omega
$$

from which is now simple to define the value of $R_{L}$ :

$$
\mathrm{R}_{\mathrm{L}}=\frac{\mathrm{V}_{\mathrm{AM}}}{\mathrm{I}_{\mathrm{INJ}}}-\mathrm{R}_{\mathrm{F}}-\mathrm{R}_{\mathrm{S}}=2.9 \mathrm{k} \Omega
$$

5. Now the three elements of the external circuit $R_{F} C_{F}$ and $R_{L}$ are defined. Some conditions discussed in the previous paragraphs have been used to size the component, the other must now be verified. The relation which allows minimization of the accuracy error introduced by the switched capacitance equivalent resistance is in this case:

$$
R_{E Q}=\frac{1}{f_{C} C_{S}}=10 \mathrm{M} \Omega
$$

So the error due to the voltage partitioning between the real resistive path and $\mathrm{C}_{\mathrm{S}}$ is less then half a count (considering the worst case when $V_{A}=5 \mathrm{~V}$ ):

$$
\mathrm{V}_{\mathrm{A}} \cdot \frac{\mathrm{R}_{\mathrm{S}}+\mathrm{R}_{\mathrm{F}}+\mathrm{R}_{\mathrm{L}}+\mathrm{R}_{\mathrm{SW}}+\mathrm{R}_{\mathrm{AD}}}{\mathrm{R}_{\mathrm{EQ}}}=2.35 \mathrm{mV}<\frac{1}{2} \mathrm{LSB}
$$

The other condition to be verified is if the time constants of the transients are really and significantly shorter than the sampling period duration $\mathrm{T}_{\mathrm{S}}$ :

$$
\begin{gathered}
\tau_{1}=\left(R_{S W}+R_{A D}\right) \cdot C_{S}=2.8 \mathrm{~ns} \ll T_{S}=1 \mu \mathrm{~s} \\
10 \cdot \tau_{2}=10 \cdot R_{L} \cdot\left(C_{S}+C_{P 1}+C_{P 2}\right)=290 \mathrm{~ns}<T_{S}=1 \mu \mathrm{~s}
\end{gathered}
$$

For the complete set of parameters characterizing the ST10F252M A/D Converter equivalent circuit, refer to Section 27.7: A/D converter characteristics on page 289.

### 27.8 AC characteristics

### 27.8.1 Test waveforms

Figure 113. Input / output waveforms


AC inputs during testing are driven at 2.4 V for a logic ' 1 ' and 0.4 V for a logic ' 0 '. Timing measurements are made at $\mathrm{V}_{\mathrm{IH}}$ min. for a logic ' 1 ' and $\mathrm{V}_{\mathrm{IL}}$ max for a logic ' 0 '.

Figure 114. Float waveforms


For timing purposes a port pin is no longer floating when $V_{\text {LOAD }}$ changes of $\pm 100 \mathrm{mV}$.
It begins to float when a 100 mV change from the loaded $\mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ level occurs $\left(\mathrm{I}_{\mathrm{OH}} / \mathrm{l}_{\mathrm{OL}}=20 \mathrm{~mA}\right)$.

### 27.8.2 Definition of internal timing

The internal operation of the ST10F252M is controlled by the internal CPU clock $\mathrm{f}_{\mathrm{CPU}}$. Both edges of the CPU clock can trigger internal (for example, pipeline) or external (for example, bus cycles) operations.

The specification of the external timing (AC Characteristics) therefore depends on the time between two consecutive edges of the CPU clock, called "TCL".

The CPU clock signal can be generated by different mechanisms. The duration of TCL and its variation (and also the derived external timing) depends on the mechanism used to generate $\mathrm{f}_{\mathrm{CPU}}$.
This influence must be regarded when calculating the timings for the ST10F252M.
The example for PLL operation shown in Figure 115 refers to a PLL factor of 4.
The mechanism used to generate the CPU clock is selected during reset by the logic levels on pins P0.15-13 (POH.7-5).

Figure 115. Generation mechanisms for the CPU clock


### 27.8.3 Clock generation modes

The next Table 150 associates the combinations of these three bits with the respective clock generation mode.

Table 150. On-chip clock generator selections

| P0.15-13 <br> (P0H.7-5) |  | CPU frequency <br> $\mathbf{f}_{\text {CPU }}=\mathrm{f}_{\text {XTAL }} \times$ F | External clock <br> input range | (3) |
| :--- | :---: | :---: | :---: | :---: | :--- | Notes

1. The external clock input range refers to a CPU clock range of $1 . . .40 \mathrm{MHz}$. Moreover, the PLL usage is limited to $4-8 \mathrm{MHz}$. All configurations need a crystal (or ceramic resonator) to generate the CPU clock through the internal oscillator amplifier (apart from Direct Drive): vice versa, the clock can be forced through an external clock source only in Direct Drive mode (on-chip oscillator amplifier disabled, so no crystal or resonator can be used).
2. The maximum depends on the duty cycle of the external clock signal: when 40 MHz is used, $50 \%$ duty cycle is granted (low phase = high phase = 12.5 ns ); when 20 MHz is selected a $25 \%$ duty cycle can be accepted (minimum phase, high or low, again equal to 12.5 ns ).
3. The limits on input frequency are $4-8 \mathrm{MHz}$ since the usage of the internal oscillator amplifier is required. Also when the PLL is not used and the CPU clock corresponds to $f_{X T A L} / 2$, an external crystal or resonator must be used: It is not possible to force any clock though an external clock source.

### 27.8.4 Prescaler operation

When pins P0.15-13 (POH.7-5) equal "001" during reset, the CPU clock is derived from the internal oscillator (input clock signal) by a 2:1 prescaler.
The frequency of $f_{\mathrm{CPU}}$ is half the frequency of $\mathrm{f}_{\text {XTAL }}$ and the high and low time of $\mathrm{f}_{\mathrm{CPU}}$ (that is, the duration of an individual TCL) is defined by the period of the input clock $\mathrm{f}_{\mathrm{XTAL}}$.
The timings listed in the AC Characteristics that refer to TCL therefore can be calculated using the period of $f_{\text {XTAL }}$ for any TCL.

Note that if the bit OWDDIS in SYSCON register is cleared, the PLL runs on its free-running frequency and delivers the clock signal for the Oscillator Watchdog. If bit OWDDIS is set, then the PLL is switched off.

### 27.8.5 Direct drive

When pins P0.15-13 (POH.7-5) equal "011" during reset the on-chip phase locked loop is disabled, the on-chip oscillator amplifier is bypassed and the CPU clock is directly driven by the input clock signal on XTAL1 pin.

The frequency of CPU clock ( $\mathrm{f}_{\mathrm{CPU}}$ ) directly follows the frequency of $\mathrm{f}_{\mathrm{XTAL}}$ so the high and low time of $\mathrm{f}_{\mathrm{CPU}}$ (that is, the duration of an individual TCL) is defined by the duty cycle of the input clock $\mathrm{f}_{\mathrm{XTAL}}$.
Therefore, the timings given in this chapter refer to the minimum TCL. This minimum value can be calculated by the following formula:

$$
\begin{aligned}
\mathrm{TCL}_{\min } & =1 / \mathrm{f}_{\mathrm{XTAL}} \times D C_{\min } \\
\mathrm{DC} & =\text { duty cycle }
\end{aligned}
$$

For two consecutive TCLs, the deviation caused by the duty cycle of $f_{X T A L}$ is compensated, so the duration of $2 T C L$ is always $1 / \mathrm{f}_{\mathrm{XTAL}}$.
The minimum value $\mathrm{TCL}_{\text {min }}$ has to be used only once for timings that require an odd number of TCLs $(1,3, \ldots)$. Timings that require an even number of TCLs $(2,4, \ldots)$ may use the formula:

$$
2 T C L=1 / f_{X T A L}
$$

The address float timings in Multiplexed bus mode ( $\mathrm{t}_{11}$ and $\mathrm{t}_{45}$ ) use the maximum duration of TCL ( $\mathrm{TCL}_{\text {max }}=1 / \mathrm{f}_{\text {XTAL }} \times \mathrm{DC}_{\text {max }}$ ) instead of $\mathrm{TCL}_{\text {min }}$.
Similarly to what happen for Prescaler Operation, if the bit OWDDIS in SYSCON register is cleared, the PLL runs on its free-running frequency and delivers the clock signal for the Oscillator Watchdog. If bit OWDDIS is set, then the PLL is switched off.

### 27.8.6 Oscillator watchdog (OWD)

An on-chip watchdog oscillator is implemented in the ST10F252M. This feature is used for safety operation with external crystal oscillator (available only when using direct drive mode with or without prescaler, so the PLL is not used to generate the CPU clock multiplying the frequency of the external crystal oscillator). This watchdog oscillator operates as following.

The reset default configuration enables the watchdog oscillator. It can be disabled by setting the OWDDIS (bit 4) of SYSCON register.

When the OWD is enabled, the PLL runs at its free-running frequency, and it increments the watchdog counter. On each transition of external clock, the watchdog counter is cleared. If
an external clock failure occurs, then the watchdog counter overflows (after 16 PLL clock cycles).

The CPU clock signal will be switched to the PLL free-running clock signal, and the oscillator watchdog Interrupt Request is flagged. The CPU clock will not switch back to the external clock even if a valid external clock exits on XTAL1 pin. Only a hardware reset (or bidirectional Software / Watchdog reset) can switch the CPU clock source back to direct clock input.
When the OWD is disabled, the CPU clock is always the external oscillator clock (in Direct Drive or Prescaler Operation) and the PLL is switched off to decrease consumption supply current.

### 27.8.7 Phase locked loop (PLL)

For all other combinations of pins $\mathrm{P} 0.15-13$ ( $\mathrm{POH} .7-5$ ) during reset the on-chip phase locked loop is enabled and it provides the CPU clock (see Table 150). The PLL multiplies the input frequency by the factor $F$ which is selected via the combination of pins P0.15-13 ( $\mathrm{f}_{\mathrm{CPU}}=$ $\left.f_{X T A L} \times F\right)$. With every $\mathrm{F}^{\prime}$ th transition of $\mathrm{f}_{\mathrm{XTAL}}$ the PLL circuit synchronizes the CPU clock to the input clock. This synchronization is done smoothly, so the CPU clock frequency does not change abruptly.

Due to this adaptation to the input clock the frequency of $\mathrm{f}_{\mathrm{CPU}}$ is constantly adjusted so it is locked to $f_{\text {XTAL }}$. The slight variation causes a jitter of $f_{\mathrm{CPU}}$ which also effects the duration of individual TCLs.

The timings listed in the AC Characteristics that refer to TCLs therefore must be calculated using the minimum TCL that is possible under the respective circumstances.

The real minimum value for TCL depends on the jitter of the PLL. The PLL tunes $\mathrm{f}_{\mathrm{CPU}}$ to keep it locked on $\mathrm{f}_{\text {XTAL }}$. The relative deviation of TCL is the maximum when it is referred to one TCL period.
This is especially important for bus cycles using wait states and for example, such as for the operation of timers or serial interfaces. For all slower operations and longer periods (for example, pulse train generation or measurement, or lower baudrates) the deviation caused by the PLL jitter is negligible. Refer to next Section 27.8.9: PLL jitter for more details.

### 27.8.8 Voltage controlled oscillator

The ST10F252M implements a PLL which combines different levels of frequency dividers with a Voltage Controlled Oscillator (VCO) working as frequency multiplier. The following table gives a detailed summary of the internal settings and VCO frequency.

Table 151. Internal PLL divider mechanism

| $\begin{aligned} & \text { PO.15-13 } \\ & \text { (POH.7-5) } \end{aligned}$ |  |  | XTAL frequency | Input prescaler | PLL |  | Output prescaler | CPU frequency$f_{\mathrm{CPU}}=\mathrm{f}_{\mathrm{XTAL}} \times F$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Multiply by |  | Divide by |  |  |
| 1 | 1 | 1 |  | 4 to 8 MHz | $\mathrm{f}_{\text {XTAL }} / 4$ | 64 | 4 | - | $\mathrm{f}_{\text {XTAL }} \times 4$ |
| 1 | 1 | 0 | 5.3 to $8 \mathrm{MHz}^{(1)}$ | $\mathrm{f}_{\text {XTAL }} / 4$ | 48 | 4 | - | $\mathrm{f}_{\text {XTAL }} \times 3$ |
| 1 | 0 | 1 | 4 to 5 MHz | $\mathrm{f}_{\text {XTAL }} / 4$ | 64 | 2 | - | $\mathrm{f}_{\text {XTAL }} \times 8$ |
| 1 | 0 | 0 | 6.4 to $8 \mathrm{MHz}^{(1)}$ | $\mathrm{f}_{\text {XTAL }} / 4$ | 40 | 2 | - | $\mathrm{f}_{\text {XTAL }} \times 5$ |
|  | 1 |  | 1 to 40 MHz | - | PLL bypassed |  | - | $\mathrm{f}_{\text {XTAL }} \mathrm{x} 1$ |

Table 151. Internal PLL divider mechanism (continued)

| $\begin{aligned} & \text { P0.15-13 } \\ & \text { (POH.7-5) } \end{aligned}$ |  |  | XTAL frequency | Input prescaler | PLL |  | Output prescaler | CPU frequency $f_{\text {CPU }}=f_{\text {XTAL }} \times F$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Multiply by |  | Divide by |  |  |
| 0 | 1 | 0 |  | 4 MHz | $\mathrm{f}_{\text {XTAL }} / 2$ | 40 | 2 | - | $\mathrm{f}_{\text {XTAL }} \times 10$ |
| 0 | 0 | 1 | 4 to $8 \mathrm{MHz}^{(1)}$ | - | PLL bypassed |  | $\mathrm{f}_{\text {PLL }} / 2$ | $\mathrm{f}_{\text {XTAL }} / 2$ |
|  | 0 |  | - |  |  |  |  |  |

1. The PLL input frequency range is limited to 1 to 3.5 MHz , while the VCO oscillation range is 64 to 128 MHz . The CPU clock frequency range when PLL is used is 16 to 40 MHz .

## Example 1

- $\mathrm{f}_{\mathrm{XTAL}}=4 \mathrm{MHz}$
- $\mathrm{P} 0(15: 13)=$ ' 110 ’ (multiplication by 3$)$
- PLL input frequency $=1 \mathrm{MHz}$
- VCO frequency $=48 \mathrm{MHz}$ : NOT VALID, must be 64 to 128 MHz
- $\quad \mathrm{f}_{\mathrm{CPU}}=$ NOT VALID


## Example 2

- $f_{X T A L}=8 \mathrm{MHz}$
- $\mathrm{P} 0(15: 13)=$ ' 100 ' (multiplication by 5$)$
- PLL input frequency $=2 \mathrm{MHz}$
- VCO frequency $=80 \mathrm{MHz}$
- PLL output frequency $=40 \mathrm{MHz}$ (VCO frequency divided by 2 )
- $\quad \mathrm{f}_{\mathrm{CPU}}=40 \mathrm{MHz}$ (no effect of Output Prescaler)


### 27.8.9 PLL jitter

The following terminology is hereafter defined:

## - Self referred single period jitter

Also called "Period Jitter", it can be defined as the difference of the $T_{\max }$ and $T_{\min }$, where $T_{\max }$ is maximum time period of the PLL output clock and $T_{\text {min }}$ is the minimum time period of the PLL output clock.

## - Self referred long term jitter

Also called " $N$ period jitter", it can be defined as the difference of $T_{\max }$ and $T_{\min }$, where $T_{\text {max }}$ is the maximum time difference between $N+1$ clock rising edges and $T_{\text {min }}$ is the minimum time difference between $N+1$ clock rising edges. Here $N$ should be kept sufficiently large to have the long term jitter. For $\mathrm{N}=1$, this becomes the single period jitter.

Jitter at the PLL output can be due to the following reasons:

- Jitter in the input clock
- Noise in the PLL loop


## Jitter in the input clock

PLL acts like a low pass filter for any jitter in the input clock. Input Clock jitter with the frequencies within the PLL loop bandwidth is passed to the PLL output and higher frequency jitter (frequency > PLL bandwidth) is attenuated @ $20 \mathrm{~dB} / \mathrm{decade}$.

## Noise in the PLL loop

This contribution again can be caused by the following sources:

- Device noise of the circuit in the PLL
- Noise in supply and substrate.


## Device noise of the circuit in the PLL

The long term jitter is inversely proportional to the bandwidth of the PLL: the wider the loop bandwidth is, the lower the jitter is due to noise in the loop. Moreover, the long term jitter is practically independent of the multiplication factor.

The most noise sensitive circuit in the PLL circuit is definitively the VCO (Voltage Controlled Oscillator). There are two main sources of noise: thermal (random noise, frequencyindependent noise, thus, practically white noise) and flicker (low frequency noise, 1/f). For the frequency characteristics of the VCO circuitry, the effect of the thermal noise results in a $1 / f^{2}$ region in the output noise spectrum, while the flicker noise in a $1 / f^{3}$. Assuming a noiseless PLL input and supposing that the VCO is dominated by its $1 / f^{2}$ noise, the R.M.S. value of the accumulated jitter is proportional to the square root of $N$, where N is the number of clock periods within the considered time interval.
On the contrary, assuming again a noiseless PLL input and supposing that the VCO is dominated by its $1 / f^{3}$ noise, the R.M.S. value of the accumulated jitter is proportional to $N$, where N is the number of clock periods within the considered time interval.
The jitter in the PLL loop can be modelized as dominated by the $i 1 / f^{2}$ noise for N smaller than a certain value depending on the PLL output frequency and on the bandwidth characteristics of loop. Above this first value, the jitter becomes dominated by the i1/f ${ }^{3}$ noise component. Lastly, for N greater than a second value of N , a saturation effect is evident, so the jitter does not grow anymore when considering a longer time interval (jitter stable increasing the number of clock periods N). The PLL loop acts as a high pass filter for any noise in the loop, with cutoff frequency equal to the bandwidth of the PLL. The saturation value corresponds to what has been called self referred long term jitter of the PLL. In Figure 116 the maximum jitter trend versus the number of clock periods N (for some typical CPU frequencies) is shown: The curves represent the very worst case, computed taking into account all corners of temperature, power supply and process variations: The real jitter is always measured well below the given worst case values.

## Noise in supply and substrate

Digital supply noise adds deterministic components to the PLL output jitter, independent of the multiplication factor. Its effects are strongly reduced thanks to the particular care used in the physical implementation and integration of the PLL module inside the device. Nonetheless, the contribution of the digital noise to the global jitter is widely taken into account in the curves provided in Figure 116.

Figure 116. ST10F252M PLL jitter


### 27.8.10 PLL lock / unlock

During normal operation, if the PLL gets unlocked for any reason, an interrupt request to the CPU is generated, and the reference clock (oscillator) is automatically disconnected from the PLL input: in this way, the PLL goes into free-running mode, providing the system with a backup clock signal (free running frequency $f_{\text {free }}$ ). This feature allows recovery from a crystal failure occurrence without risking to go into an undefined configuration: The system is provided with a clock allowing the execution of the PLL unlock interrupt routine in a safe mode.

The path between reference clock and PLL input can be restored only by a hardware reset, or by a bidirectional software or watchdog reset event that forces the RSTIN pin low.
Note: $\quad$ The external RC circuit on $\overline{R S T I N}$ pin must be properly sized in order to extend the duration of the low pulse to lock the PLL before the level at $\overline{R S T I N}$ pin is recognized high: A bidirectional reset internally drives the $\overline{R S T I N}$ pin low for just 1024 TCL (definitely not sufficient to lock the PLL starting from free-running mode).

Table 152. PLL characteristics $\left(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$

| Symbol | Parameter | Conditions | Value |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |
| $\mathrm{t}_{\text {PSUP }}$ | PLL Start-up time ${ }^{(1)}$ | Stable $\mathrm{V}_{\text {DD }}$ and reference clock | - | 300 | $\mu \mathrm{s}$ |
| t lock | PLL Lock-in time | Stable $V_{D D}$ and reference clock, starting from free-running mode | - | 250 | $\mu \mathrm{s}$ |
| $\mathrm{T}_{\text {JIT }}$ | Single Period Jitter ${ }^{(1)}$ (cycle to cycle $=2 \mathrm{TCL}$ ) | 6 sigma time period variation (peak to peak) | -500 | +500 | ps |
| $\mathrm{f}_{\text {free }}$ | PLL free running frequency | Multiplication factors: 3, 4 | 250 | 2000 | kHz |
|  |  | Multiplication factors: 5, 8, 10, 16 | 500 | 4000 |  |

1. Not $100 \%$ tested, guaranteed by design characterization

### 27.8.11 Main oscillator specifications

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+125^{\circ} \mathrm{C}$
Table 153. Main oscillator characteristics

| Symbol | Parameter | Conditions |  |  | Value |  |  | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |  |
| $\mathrm{g}_{\mathrm{m}}$ | Oscillator <br> Transconductance |  | 1.4 | 2.6 | 4.2 | $\mathrm{~mA} / \mathrm{V}$ |  |  |
| $\mathrm{V}_{\mathrm{OSC}}$ | Oscillation Amplitude $^{(1)}$ | Peak to Peak | - | 1.5 | - |  |  |  |
| $\mathrm{V}_{\mathrm{AV}}$ | Oscillation Voltage level $^{(1)}$ | Sine wave middle | - | 0.8 | - | V |  |  |
| $\mathrm{t}_{\text {STUP }}$ | Oscillator Start-up Time $^{(1)}$ | Stable $\mathrm{V}_{\mathrm{DD}}-$ Crystal | - | 6 | 10 | ms |  |  |
|  | Stable $\mathrm{V}_{\mathrm{DD}}$ - Resonator | - | 1 | 2 | ms |  |  |  |

1. Not $100 \%$ tested, guaranteed by design characterization

Figure 117. Crystal oscillator and resonator connection diagram


Table 154. Main oscillator negative resistance (module)

|  | $\mathrm{C}_{\mathrm{A}}=15 \mathrm{pF}$ |  |  | $\mathrm{C}_{\mathrm{A}}=25 \mathrm{pF}$ |  |  | $\mathrm{C}_{\mathrm{A}}=35 \mathrm{pF}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |
| 4 MHz | $545 \Omega$ | 1035 ת | - | $550 \Omega$ | $1050 \Omega$ | - | $430 \Omega$ | $850 \Omega$ | - |
| 8 MHz | $240 \Omega$ | $450 \Omega$ | - | $170 \Omega$ | $350 \Omega$ | - | $120 \Omega$ | $250 \Omega$ | - |

The given values of $C_{A}$ do not include the stray capacitance of the package and of the printed circuit board: the negative resistance values are calculated assuming additional 5 pF to the values in the table. The crystal shunt capacitance $\left(\mathrm{C}_{0}\right)$ and the package capacitance between XTAL1 and XTAL2 pins is globally assumed equal to 10 pF .

The external resistance between XTAL1 and XTAL2 is not necessary, since already present on the silicon.

### 27.8.12 External clock drive XTAL1

When Direct Drive configuration is selected during reset, it is possible to drive the CPU clock directly from the XTAL1 pin, without particular restrictions on the maximum frequency, since the on-chip oscillator amplifier is bypassed. The speed limit is imposed by internal logic that targets a maximum CPU frequency of 40 MHz .

In all other clock configurations (Direct Drive with Prescaler or PLL usage) the on-chip oscillator amplifier is not bypassed, so it determines the input clock speed limit. Then, when the on-chip oscillator is enabled it is forbidden to use any external clock source different from crystal or ceramic resonator.

Table 155. External clock drive

| Parameter | Symbol |  | Direct drive$\mathbf{f}_{\mathrm{CPU}}=\mathrm{f}_{\mathrm{XTAL}}$ |  | Direct drive with prescaler <br> $\mathbf{f}_{\mathrm{CPU}}=\mathrm{f}_{\mathrm{XTAL}} / 2$ |  | PLL usage$f_{\text {CPU }}=f_{\text {XTAL }} \times F$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |  |
| XTAL1 period ${ }^{(1)(2)}$ | tosc | SR | 25 | - | 83.3 | 250 | 83.3 | 250 | ns |
| High time ${ }^{(3)}$ | $\mathrm{t}_{1}$ | SR | 6 | - | 3 | - | 6 | - | ns |
| Low time ${ }^{(3)}$ | $\mathrm{t}_{2}$ | SR | 6 | - | 3 | - | 6 | - | ns |
| Rise time ${ }^{(3)}$ | $\mathrm{t}_{3}$ | SR | - | 2 | - | 2 | - | 2 | ns |
| Fall time ${ }^{(3)}$ | $\mathrm{t}_{4}$ | SR | - | 2 | - | 2 | - | 2 | ns |

1. The minimum value for the XTAL1 signal period is considered the theoretical minimum. The real minimum value depends on the duty cycle of the input clock signal.
2. 4 to 8 MHz is the input frequency range when using an external clock source. 40 MHz can be applied with an external clock source only when Direct Drive mode is selected: in this case, the oscillator amplifier is bypassed so it does not limit the input frequency.
3. The input clock signal must reach the defined levels $\mathrm{V}_{\mathrm{IL} 2}$ and $\mathrm{V}_{\mathrm{IH} 2}$.

Figure 118. External clock drive XTAL1


Note: $\quad$ When Direct Drive is selected, an external clock source can be used to drive XTAL1. The maximum frequency of the external clock source depends on the duty cycle: When 40 MHz is used, $50 \%$ duty cycle is granted (low phase $=$ high phase $=12.5 n s$ ); when for instance 20 MHz is used, a $25 \%$ duty cycle can be accepted (minimum phase, high or low, again equal to $12.5 n s$ ).

### 27.8.13 Memory cycle variables

The tables below use three variables which are derived from the BUSCONx registers and represent the special characteristics of the programmed memory cycle. The following table describes how these variables are to be computed.

Table 156. Memory cycle variables

| Description | Symbol | Values |
| :--- | :---: | :--- |
| ALE Extension | $\mathrm{t}_{\mathrm{A}}$ | TCL $\times[$ ALECTL $]$ |
| Memory Cycle Time wait states | $\mathrm{t}_{\mathrm{C}}$ | $2 T C L \times(15-[\mathrm{MCTC}])$ |
| Memory Tri-state Time | $\mathrm{t}_{\mathrm{F}}$ | $2 T C L \times(1-[\mathrm{MTTC}])$ |

### 27.8.14 External memory bus timing

The following sections include the External Memory Bus timings. The given values are computed for a maximum CPU clock of 40 MHz .

Note: $\quad$ All External Memory Bus Timings and SSC Timings listed in the following tables are granted by Design Characterization and not fully tested in production.

### 27.8.15 Multiplexed bus

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+125^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pF}$,
ALE cycle time $=6 \mathrm{TCL}+2 \mathrm{t}_{\mathrm{A}}+\mathrm{t}_{\mathrm{C}}+\mathrm{t}_{\mathrm{F}}$ ( 75 ns at 40 MHz CPU clock without wait states)
Table 157. Multiplexed bus timings

| Symbol |  | Parameter | $\begin{aligned} \mathrm{f}_{\mathrm{CPU}} & =40 \mathrm{MHz} \\ \mathrm{TCL} & =12.5 \mathrm{~ns} \end{aligned}$ |  | Variable CPU clock $1 / 2$ TCL $=1$ to 40 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{5}$ | CC |  | ALE high time | $4+t_{\text {A }}$ | - | TCL - 8.5 + $\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{6}$ | CC | Address setup to ALE | $1.5+t_{\text {A }}$ | - | TCL - $11+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{7}$ | CC | Address hold after ALE | $4+t_{\text {A }}$ | - | TCL - $8.5+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{8}$ | CC | ALE falling edge to $\overline{R D}, \overline{W R}$ (with RW-delay) | $4+t_{\text {A }}$ | - | TCL $-8.5+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{9}$ | CC | ALE falling edge to RD, $\overline{W R}$ (no RW-delay) | $-8.5+t_{\text {A }}$ | - | $-8.5+t_{\text {A }}$ | - | ns |
| $\mathrm{t}_{10}$ | CC | Address float after $\overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ (with RW-delay) | - | 6 | - | 6 | ns |
| $t_{11}$ | CC | Address float after $\overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ (no RW-delay) | - | 18.5 | - | TCL + 6 | ns |
| $\mathrm{t}_{12}$ | CC | $\overline{R D}, \overline{W R}$ low time (with RW-delay) | $15.5+t_{C}$ | - | $2 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{13}$ | CC | RD, $\bar{W}$ low time (no RW-delay) | $28+t_{C}$ | - | $3 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{14}$ | SR | RD to valid data in (with RW-delay) | - | $6+t_{C}$ | - | $2 \mathrm{TCL}-19+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{15}$ | SR | RD to valid data in (no RW-delay) | - | $18.5+t_{C}$ | - | $3 \mathrm{TCL}-19+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{16}$ | SR | ALE low to valid data in | - | $\begin{gathered} 17.5+ \\ +t_{\mathrm{A}}+\mathrm{t}_{\mathrm{C}} \end{gathered}$ | - | $\begin{gathered} 3 T C L-20+ \\ +t_{A}+t_{C} \end{gathered}$ | ns |

Table 157. Multiplexed bus timings (continued)

| Symbol |  | Parameter | $\begin{aligned} \mathrm{f}_{\mathrm{CPU}} & =40 \mathrm{MHz} \\ \mathrm{TCL} & =12.5 \mathrm{~ns} \end{aligned}$ |  | Variable CPU clock $1 / 2 \mathrm{TCL}=1$ to 40 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{17}$ | SR |  | Address/Unlatched $\overline{\mathrm{CS}}$ to valid data in | - | $\begin{gathered} 20+2 \mathrm{t}_{\mathrm{A}}+ \\ +\mathrm{t}_{\mathrm{C}} \end{gathered}$ | - | $\begin{gathered} 4 \mathrm{TCL}-30+ \\ +2 \mathrm{t}_{\mathrm{A}}+\mathrm{t}_{\mathrm{C}} \end{gathered}$ | ns |
| $\mathrm{t}_{18}$ | SR | Data hold after $\overline{\mathrm{RD}}$ rising edge | 0 | - | 0 | - | ns |
| $\mathrm{t}_{19}$ | SR | Data float after $\overline{\mathrm{RD}}$ | - | $16.5+t_{F}$ | - | $2 \mathrm{TCL}-8.5+\mathrm{t}_{\mathrm{F}}$ | ns |
| $\mathrm{t}_{22}$ | CC | Data valid to $\overline{W R}$ | $10+t_{C}$ | - | $2 \mathrm{TCL}-15+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{23}$ | CC | Data hold after $\overline{\mathrm{WR}}$ | $4+\mathrm{t}_{\mathrm{F}}$ | - | $2 \mathrm{TCL}-8.5+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{25}$ | CC | ALE rising edge after $\overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ | $15+t_{F}$ | - | $2 \mathrm{TCL}-10+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{27}$ | CC | Address/Unlatched $\overline{\mathrm{CS}}$ hold after $\overline{R D}, \overline{W R}$ | $10+t_{F}$ | - | $2 \mathrm{TCL}-15+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{38}$ | CC | ALE falling edge to Latched $\overline{\mathrm{CS}}$ | $-4-t_{\text {A }}$ | $10-t_{\text {A }}$ | $-4-t_{\text {A }}$ | $10-t_{\text {A }}$ | ns |
| $t_{39}$ | SR | Latched CS low to Valid Data In | - | $\begin{gathered} 16.5+t_{\mathrm{C}}+ \\ +2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | - | $\begin{gathered} 3 T C L-21+ \\ +\mathrm{t}_{\mathrm{C}}+2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | ns |
| $\mathrm{t}_{40}$ | CC | Latched $\overline{\mathrm{CS}}$ hold after $\overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ | $27+t_{F}$ | - | $3 \mathrm{TCL}-10.5+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{42}$ | CC | ALE fall. edge to $\overline{\mathrm{RdCS}}, \overline{\mathrm{WrCS}}$ (with RW delay) | $7+t_{\text {A }}$ | - | TCL $-5.5+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{43}$ | CC | ALE fall. edge to $\overline{\mathrm{RdCS}}, \overline{\mathrm{WrCS}}$ (no RW delay) | $-5.5+t_{\text {A }}$ | - | $-5.5+t_{\text {A }}$ | - | ns |
| $\mathrm{t}_{44}$ | CC | Address float after $\overline{R d C S}, \overline{\text { WrCS }}$ (with RW delay) | - | 1.5 | - | 1.5 | ns |
| $\mathrm{t}_{45}$ | CC | Address float after RdCS, WrCS (no RW delay) | - | 14 | - | TCL + 1.5 | ns |
| $\mathrm{t}_{46}$ | SR | RdCS to Valid Data In (with RW delay) | - | $4+t_{C}$ | - | $2 \mathrm{TCL}-21+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{47}$ | SR | $\overline{\mathrm{RdCS}}$ to Valid Data In (no RW delay) | - | $16.5+t_{C}$ | - | $3 T C L-21+t_{C}$ | ns |
| $\mathrm{t}_{48}$ | CC | $\overline{R d C S}, \overline{W r C S}$ Low Time (with RW delay) | $15.5+t_{c}$ | - | $2 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{49}$ | CC | $\overline{\text { RdCS }}, \overline{\text { WrCS }}$ Low Time (no RW delay) | $28+t_{C}$ | - | $3 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{c}}$ | - | ns |
| $\mathrm{t}_{50}$ | CC | Data valid to $\overline{W r C S}$ | $10+t_{C}$ | - | $2 \mathrm{TCL}-15+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{51}$ | SR | Data hold after RdCS | 0 | - | 0 | - | ns |
| $\mathrm{t}_{52}$ | SR | Data float after RdCS | - | $16.5+\mathrm{t}_{\mathrm{F}}$ | - | $2 \mathrm{TCL}-8.5+\mathrm{t}_{\mathrm{F}}$ | ns |
| $\mathrm{t}_{54}$ | CC | Address hold after RdCS, WrCS | $6+t_{F}$ | - | $2 \mathrm{CCL}-19+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{56}$ | CC | Data hold after $\overline{W r C S}$ | $6+t_{F}$ | - | $2 \mathrm{TCL}-19+\mathrm{t}_{\mathrm{F}}$ | - | ns |

Figure 119. External memory cycle: multiplexed bus, with/without read/write delay, normal ALE


Figure 120. External memory cycle: multiplexed bus, with/without read/write delay, extended ALE


Figure 121. External memory cycle: multiplexed bus, with/without r/w delay, normal ALE, r/w CS


Figure 122. External memory cycle: multiplexed bus, with/without r/w delay, extended ALE, r/w CS


### 27.8.16 Demultiplexed bus

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+125^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pF}$,
ALE cycle time $=4 \mathrm{TCL}+2 \mathrm{t}_{\mathrm{A}}+\mathrm{t}_{\mathrm{C}}+\mathrm{t}_{\mathrm{F}}$ ( 50 ns at 40 MHz CPU clock without wait states).
Table 158. Demultiplexed bus timings

| Symbol |  | Parameter | $\begin{aligned} \mathrm{f}_{\mathrm{CPU}} & =40 \mathrm{MHz} \\ \mathrm{TCL} & =12.5 \mathrm{~ns} \end{aligned}$ |  | Variable CPU clock $1 / 2 \mathrm{TCL}=1$ to 40 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $t_{5}$ | CC |  | ALE high time | $4+t_{\text {A }}$ | - | TCL - $8.5+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{6}$ | CC | Address setup to ALE | $1.5+\mathrm{t}_{\mathrm{A}}$ | - | TCL $-11+\mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{80}$ | CC | Address/Unlatched $\overline{C S}$ setup to $\overline{R D}, \overline{W R}$ (with RW-delay) | $12.5+2 \mathrm{t}_{\mathrm{A}}$ | - | $\begin{gathered} 2 \mathrm{TCL}-12.5+ \\ +2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | - | ns |
| $\mathrm{t}_{81}$ | CC | Address/Unlatched $\overline{\mathrm{CS}}$ setup to $\overline{R D}, \overline{W R}$ (no RW-delay) | $0.5+2 \mathrm{t}_{\mathrm{A}}$ | - | TCL - $12+2 \mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{12}$ | CC | $\overline{R D}, \overline{W R}$ low time (with RW-delay) | $15.5+t_{C}$ | - | $2 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $t_{13}$ | CC | RD, $\overline{W R}$ low time (no RW-delay) | $28+t_{C}$ | - | 3 TCL - $9.5+t_{C}$ | - | ns |
| $\mathrm{t}_{14}$ | SR | RD to valid data in (with RW-delay) | - | $6+t_{C}$ | - | $2 \mathrm{TCL}-19+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{15}$ | SR | $\overline{\mathrm{RD}}$ to valid data in (no RW-delay) | - | $18.5+t_{C}$ | - | 3 TCL - $19+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{16}$ | SR | ALE low to valid data in | - | $\begin{gathered} 17.5+t_{\mathrm{A}}+ \\ +\mathrm{t}_{\mathrm{C}} \end{gathered}$ | - | $\begin{gathered} 3 T C L-20+ \\ +t_{A}+t_{\mathrm{C}} \end{gathered}$ | ns |
| $\mathrm{t}_{17}$ | SR | Address/Unlatched $\overline{\mathrm{CS}}$ to valid data in | - | $\begin{aligned} 20 & +2 \mathrm{t}_{\mathrm{A}}+ \\ & +\mathrm{t}_{\mathrm{C}} \end{aligned}$ | - | $\begin{gathered} 4 \mathrm{TCL}-30+ \\ +2 \mathrm{t}_{\mathrm{A}}+\mathrm{t}_{\mathrm{C}} \end{gathered}$ | ns |
| $\mathrm{t}_{18}$ | SR | Data hold after $\overline{R D}$ rising edge | 0 | - | 0 | - | ns |
| $\mathrm{t}_{20}$ | SR | Data float after $\overline{\mathrm{RD}}$ rising edge (with RW-delay) ${ }^{(1)}$ | - | $16.5+t_{F}$ | - | $\begin{gathered} 2 \text { TCL }-8.5+ \\ +\mathrm{t}_{\mathrm{F}}+2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | ns |
| $\mathrm{t}_{21}$ | SR | Data float after $\overline{\mathrm{RD}}$ rising edge (no RW-delay) ${ }^{(1)}$ | - | $4+t_{F}$ | - | $\begin{gathered} \text { TCL }-8.5+ \\ +\mathrm{t}_{\mathrm{F}}+2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | ns |
| $\mathrm{t}_{22}$ | CC | Data valid to $\overline{W R}$ | $10+t_{C}$ | - | $2 T C L-15+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{24}$ | CC | Data hold after $\overline{W R}$ | $4+\mathrm{t}_{\mathrm{F}}$ | - | TCL - $8.5+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{26}$ | CC | ALE rising edge after $\overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ | $-10+t_{F}$ | - | $-10+t_{F}$ | - | ns |
| $\mathrm{t}_{28}$ | CC | Address/Unlatched $\overline{C S}$ hold after $\overline{\mathrm{RD}}, \mathrm{WR}^{(2)}$ | $0+t_{F}$ | - | $0+t_{F}$ | - | ns |
| $\mathrm{t}_{28} \mathrm{~h}$ | CC | Address/Unlatched $\overline{\mathrm{CS}}$ hold after $\overline{\text { WRH }}$ | $-5+t_{F}$ | - | $-5+t_{F}$ | - | ns |
| $\mathrm{t}_{38}$ | CC | ALE falling edge to Latched $\overline{\mathrm{CS}}$ | $-4-t_{\text {A }}$ | $6-t_{\text {A }}$ | $-4-t_{A}$ | $6-t_{\text {A }}$ | ns |

Table 158. Demultiplexed bus timings (continued)

| Symbol |  | Parameter | $\begin{aligned} \mathrm{f}_{\mathrm{CPU}} & =40 \mathrm{MHz} \\ \mathrm{TCL} & =12.5 \mathrm{~ns} \end{aligned}$ |  | Variable CPU clock $1 / 2 \mathrm{TCL}=1$ to 40 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $t_{39}$ | SR |  | Latched CS low to Valid Data In | - | $\begin{gathered} 16.5+ \\ +t_{C}+2 t_{\mathrm{A}} \end{gathered}$ | - | $\begin{gathered} 3 T C L-21+ \\ +\mathrm{t}_{\mathrm{C}}+2 \mathrm{t}_{\mathrm{A}} \end{gathered}$ | ns |
| $\mathrm{t}_{41}$ | CC | Latched $\overline{\mathrm{CS}}$ hold after $\overline{\mathrm{RD}}$, $\overline{W R}$ | $2+t_{F}$ | - | TCL - $10.5+\mathrm{t}_{\mathrm{F}}$ | - | ns |
| $\mathrm{t}_{82}$ | CC | Address setup to $\overline{\mathrm{RdCS}}$, WrCS <br> (with RW-delay) | $14+2 \mathrm{t}_{\mathrm{A}}$ | - | $2 \mathrm{TCL}-11+2 \mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{83}$ | CC | Address setup to $\overline{\mathrm{RdCS}}$, WrCS (no RW-delay) | $2+2 t_{\text {A }}$ | - | TCL - $10.5+2 \mathrm{t}_{\mathrm{A}}$ | - | ns |
| $\mathrm{t}_{46}$ | SR | $\overline{\mathrm{RdCS}}$ to Valid Data In (with RW-delay) | - | $4+t_{C}$ | - | $2 \mathrm{TCL}-21+\mathrm{t}_{\mathrm{C}}$ | ns |
| $\mathrm{t}_{47}$ | SR | $\overline{\mathrm{RdCS}}$ to Valid Data In (no RW-delay) | - | $16.5+t_{C}$ | - | 3 TCL - $21+t_{C}$ | ns |
| $\mathrm{t}_{48}$ | CC | RdCS, $\overline{\text { WrCS }}$ Low Time (with RW-delay) | $15.5+t_{C}$ | - | $2 \mathrm{TCL}-9.5+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{49}$ | CC | RdCS, WrCS Low Time (no RW-delay) | $28+t_{C}$ | - | $3 T C L-9.5+t_{C}$ | - | ns |
| $\mathrm{t}_{50}$ | CC | Data valid to $\overline{\mathrm{WrCS}}$ | $10+\mathrm{t}_{\mathrm{C}}$ | - | 2TCL - $15+\mathrm{t}_{\mathrm{C}}$ | - | ns |
| $\mathrm{t}_{51}$ | SR | Data hold after RdCS | 0 | - | 0 | - | ns |
| $\mathrm{t}_{53}$ | SR | Data float after $\overline{\mathrm{RdCS}}$ (with RW-delay) ${ }^{(3)}$ | - | $16.5+t_{F}$ | - | $2 \mathrm{TCL}-8.5+\mathrm{t}_{\mathrm{F}}$ | ns |
| $\mathrm{t}_{68}$ | SR | Data float after $\overline{\mathrm{RdCS}}$ (no RW-delay) ${ }^{(3)}$ | - | $4+t_{F}$ | - | TCL - $8.5+\mathrm{t}_{\mathrm{F}}$ | ns |
| $t_{55}$ | CC | Address hold after RdCS, WrCS | $-8.5+t_{F}$ | - | $-8.5+t_{F}$ | - | ns |
| $t_{57}$ | CC | Data hold after $\overline{\text { WrCS }}$ | $2+\mathrm{t}_{\mathrm{F}}$ | - | TCL - $10.5+\mathrm{t}_{\mathrm{F}}$ | - | ns |

1. RW-delay and $t_{A}$ refer to the next following bus cycle.
2. Read data is latched with the same clock edge that triggers the address change and the rising $\overline{\mathrm{RD}}$ edge. Therefore address changes before the end of RD have no impact on read cycles.
3. Partially tested, guaranteed by design characterization.

Figure 123. External memory cycle: demultiplexed bus, with/without r/w delay, normal ALE


Figure 124. External memory cycle: demultiplexed bus, with/without r/w delay, extended ALE


Figure 125. External memory cycle: demultiplexed bus, with/without r/w delay, normal ALE, r/w CS


Figure 126. External memory cycle: Demultiplexed bus, without r/w delay, extended ALE, r/w CS


### 27.8.17 CLKOUT and READY

$$
\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40 \text { to }+125^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pF}
$$

Table 159. CLKOUT and READY timings

| Symbol |  | Parameter | $\begin{aligned} \mathrm{f}_{\mathrm{CPU}} & =40 \mathrm{MHz} \\ \mathrm{TCL} & =12.5 \mathrm{~ns} \end{aligned}$ |  | Variable CPU clock $1 / 2 \mathrm{TCL}=1$ to 40 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{29}$ | CC |  | CLKOUT cycle time | 25 | 25 | 2TCL | 2TCL | ns |
| $\mathrm{t}_{30}$ | CC | CLKOUT high time | 9 | - | TCL - 3.5 | - | ns |
| $\mathrm{t}_{31}$ | CC | CLKOUT low time | 10 | - | TCL - 2.5 | - | ns |
| $t_{32}$ | CC | CLKOUT rise time | - | 4 | - | 4 | ns |
| $\mathrm{t}_{3}$ | CC | CLKOUT fall time | - | 4 | - | 4 | ns |
| $\mathrm{t}_{34}$ | CC | CLKOUT rising edge to ALE falling edge | $-2+t_{\text {A }}$ | $8+t_{\text {A }}$ | $-2+t_{A}$ | $8+t_{\text {A }}$ | ns |
| $t_{35}$ | SR | Synchronous $\overline{\text { READY }}$ setup time to CLKOUT | 17 | - | 17 | - | ns |
| $\mathrm{t}_{36}$ | SR | Synchronous $\overline{\text { READY }}$ hold time after CLKOUT | 2 | - | 2 | - | ns |
| $\mathrm{t}_{37}$ | SR | Asynchronous READY low time | 35 | - | $2 \mathrm{TCL}+10$ | - | ns |
| $\mathrm{t}_{58}$ | SR | Asynchronous READY setup time ${ }^{(1)}$ | 17 | - | 17 | - | ns |
| $\mathrm{t}_{59}$ | SR | Asynchronous $\overline{\text { READY }}$ hold time ${ }^{(1)}$ | 2 | - | 2 | - | ns |
| $\mathrm{t}_{60}$ | SR | Asynchronous READY hold time after RD, WR high (Demultiplexed Bus) ${ }^{(2)}$ | 0 | $2 t_{A}+t_{C}+t_{F}$ | 0 | $2 t_{A}+t_{C}+t_{F}$ | ns |

1. These timings are given for characterization purposes only, in order to assure recognition at a specific clock edge.
2. Demultiplexed bus is the worst case. For multiplexed bus $2 T C L$ are to be added to the maximum values. This adds even more time for deactivating READY. $2 \mathrm{t}_{\mathrm{A}}$ and $\mathrm{t}_{\mathrm{C}}$ refer to the next following bus cycle, $\mathrm{t}_{\mathrm{F}}$ refers to the current bus cycle.

Figure 127. CLKOUT and READY


1. Cycle as programmed, including MCTC wait states (Example shows 0 MCTC WS).
2. The leading edge of the respective command depends on RW-delay.
3. $\overline{\text { READY }}$ sampled HIGH at this sampling point generates a READY controlled wait state, $\overline{\text { READY }}$ sampled LOW at this sampling point terminates the currently running bus cycle.
4. $\overline{\mathrm{READY}}$ may be deactivated in response to the trailing (rising) edge of the corresponding command ( $\overline{\mathrm{RD}}$ or WR).
5. If the Asynchronous $\overline{\text { READY }}$ signal does not fulfill the indicated setup and hold times with respect to CLKOUT (for example, because CLKOUT is not enabled), it must fulfill $\mathrm{t}_{37}$ in order to be safely synchronized. This is guaranteed, if READY is removed in response to the command (see Note 4).
6. Multiplexed bus modes have a MUX wait state added after a bus cycle, and an additional MTTC wait state may be inserted here.
For a multiplexed bus with MTTC wait state this delay is two CLKOUT cycles, for a demultiplexed bus without MTTC wait state this delay is zero.
7. The next external bus cycle may start here.

### 27.8.18 High-speed synchronous serial interface (SSC) timing

### 27.8.18.1 Master mode

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40$ to $+125^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$
Table 160. SSC master mode timings

| Symbol | Parameter | $\begin{gathered} \text { Maximum baudrate } \\ 6.6 \mathrm{Mbaud}{ }^{(1)} \\ @ \mathrm{f}_{\mathrm{CPU}}=40 \mathrm{MHz} \\ (\langle S S C B R>=0002 \mathrm{~h}) \end{gathered}$ |  | Variable baudrate$(<\text { SSCBR }>=0001 \mathrm{~h}-\mathrm{FFFFh})$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{300} \mathrm{CC}$ | SSC clock cycle time ${ }^{(2)}$ | 150 | 150 | 8TCL | 262144 TCL | ns |
| $\mathrm{t}_{301} \mathrm{CC}$ | SSC clock high time | 63 | - | $\mathrm{t}_{300} / 2-12$ | - | ns |

Table 160. SSC master mode timings (continued)

| Symbol | Parameter | $\begin{gathered} \text { Maximum baudrate } \\ 6.6 \mathrm{Mbaud}{ }^{(1)} \\ @ \mathrm{f}_{\mathrm{CPU}}=40 \mathrm{MHz} \\ (<\text { SSCBR }>=0002 \mathrm{~h}) \end{gathered}$ |  | Variable baudrate$(<\text { SSCBR }>=0001 \mathrm{~h}-\mathrm{FFFFh})$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{302} \mathrm{CC}$ | SSC clock low time | 63 | - | $\mathrm{t}_{300} / 2-12$ | - | ns |
| $\mathrm{t}_{303} \mathrm{CC}$ | SSC clock rise time | - | 10 | - | 10 | ns |
| $\mathrm{t}_{304} \mathrm{CC}$ | SSC clock fall time | - | 10 | - | 10 | ns |
| $\mathrm{t}_{305} \mathrm{CC}$ | Write data valid after shift edge | - | 15 | - | 15 | ns |
| $\mathrm{t}_{306} \mathrm{CC}$ | Write data hold after shift edge ${ }^{(3)}$ | -2 | - | -2 | - | ns |
| $\mathrm{t}_{307 \mathrm{p}}$ SR | Read data setup time before latch edge, phase error detection on (SSCPEN = 1) | 37.5 | - | $2 \mathrm{TCL}+12.5$ | - | ns |
| $\mathrm{t}_{308 \mathrm{p}}$ SR | Read data hold time after latch edge, phase error detection on (SSCPEN = 1) | 50 | - | 4TCL | - | ns |
| $t_{307}$ SR | Read data setup time before latch edge, phase error detection off (SSCPEN = 0) | 25 | - | 2TCL | - | ns |
| $t_{308} \quad$ SR | Read data hold time after latch edge, phase error detection off (SSCPEN = 0) | 0 | - | 0 | - | ns |

1. When 40 MHz CPU clock is used the maximum baudrate cannot be higher than $6.6 \mathrm{Mbaud}(<$ SSCBR $>=$ ' 2 h ') due to the limited granularity of <SSCBR>. Value '1h' for <SSCBR> can be used only with CPU clock equal to (or lower than) 32 MHz .
2. Formula for SSC Clock Cycle time: $t_{300}=4$ TCL $x(<S S C B R>+1)$ Where <SSCBR $>$ represents the content of the SSC baudrate register, taken as unsigned 16-bit integer. Minimum limit allowed for $\mathrm{t}_{300}$ is 125 ns (corresponding to 8 Mbaud ).
3. Partially tested, guaranteed by design characterization.

Figure 128. SSC master timing


1. The phase and polarity of shift and latch edge of SCLK is programmable. This figure uses the leading clock edge as shift edge (drawn in bold), with latch on trailing edge (SSCPH = 0b), Idle clock line is low, leading clock edge is low-to-high transition (SSCPO = Ob).
2. The bit timing is repeated for all bits to be transmitted or received.

### 27.8.18.2 Slave mode

$$
\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40 \text { to }+125^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}
$$

Table 161. SSC slave mode timings

| Symbol | Parameter | $\begin{gathered} \text { Maximum baudrate } \\ 6.6 \mathrm{Mbaud}{ }^{(1)} \\ @ \mathrm{f}_{\mathrm{CPU}}=40 \mathrm{MHz} \\ (<\text { SSCBR }>=0002 \mathrm{~h}) \end{gathered}$ |  | Variable baudrate(<SSCBR> = 0001h - FFFFh) |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |
| $\mathrm{t}_{310}$ SR | SSC clock cycle time ${ }^{(2)}$ | 150 | 150 | 8TCL | 262144 TCL | ns |
| $\mathrm{t}_{311}$ SR | SSC clock high time | 63 | - | $\mathrm{t}_{310} / 2-12$ | - | ns |
| $\mathrm{t}_{312}$ SR | SSC clock low time | 63 | - | $\mathrm{t}_{310} / 2-12$ | - | ns |
| $\mathrm{t}_{313}$ SR | SSC clock rise time | - | 10 | - | 10 | ns |
| $\mathrm{t}_{314}$ SR | SSC clock fall time | - | 10 | - | 10 | ns |
| $\mathrm{t}_{315} \mathbf{C C}$ | Write data valid after shift edge | - | 55 | - | $2 \mathrm{TCL}+30$ | ns |
| $\mathrm{t}_{316} \mathrm{CC}$ | Write data hold after shift edge | 0 | - | 0 | - | ns |
| $\mathrm{t}_{317 \mathrm{p}}$ SR | Read data setup time before latch edge, phase error detection on (SSCPEN = 1) | 62 | - | 4TCL + 12 | - | ns |
| $\mathrm{t}_{318 \mathrm{p}}$ SR | Read data hold time after latch edge, phase error detection on (SSCPEN = 1) | 87 | - | $6 \mathrm{TCL}+12$ | - | ns |
| $\mathrm{t}_{317}$ SR | Read data setup time before latch edge, phase error detection off (SSCPEN = 0) | 6 | - | 6 | - | ns |
| $\mathrm{t}_{318}$ SR | Read data hold time after latch edge, phase error detection off (SSCPEN = 0) | 31 | - | $2 \mathrm{TCL}+6$ | - | ns |

1. When 40 MHz CPU clock is used the maximum baudrate cannot be higher than 6.6 Mbaud ( $<$ SSCBR $>=$ ' 2 ' ') due to the limited granularity of <SSCBR>. Value '1h' for <SSCBR> may be used only with CPU clock lower than 32 MHz (after checking that resulting timings are suitable for the master).
2. Formula for SSC Clock Cycle time: $\mathrm{t}_{310}=4$ TCL * (<SSCBR $>+1$ )

Where <SSCBR> represents the content of the SSC baudrate register, taken as unsigned 16-bit integer.
Minimum limit allowed for $\mathrm{t}_{310}$ is 125 ns (corresponding to 8 Mbaud ).

Figure 129. SSC slave timing


1. The phase and polarity of shift and latch edge of SCLK is programmable. This figure uses the leading clock edge as shift edge (drawn in bold), with latch on trailing edge (SSCPH = 0b), Idle clock line is low, leading clock edge is low-to-high transition (SSCPO = Ob).
2. The bit timing is repeated for all bits to be transmitted or received.

## 28 Package information

In order to meet environmental requirements, ST (also) offers these devices in ECOPACK ${ }^{\circledR}$ packages. ECOPACK ${ }^{\circledR}$ packages are lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.
Figure 130. LQFP100 mechanical data and package dimensions

| DIM. | mm |  |  | inch |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A |  |  | 1.600 |  |  | 0.0630 |
| A1 | 0.050 |  | 0.150 | 0.0020 |  | 0.0059 |
| A2 | 1.350 | 1.400 | 1.450 | 0.0531 | 0.0551 | 0.0571 |
| b | 0.170 | 0.220 | 0.270 | 0.0067 | 0.0087 | 0.0106 |
| c | 0.090 |  | 0.200 | 0.0035 |  | 0.0079 |
| D | 15.800 | 16.000 | 16.200 | 0.6220 | 0.6299 | 0.6378 |
| D1 | 13.800 | 14.000 | 14.200 | 0.5433 | 0.5512 | 0.5591 |
| D3 |  | 12.000 |  |  | 0.4724 |  |
| E | 15.800 | 16.000 | 16.200 | 0.6220 | 0.6299 | 0.6378 |
| E1 | 13.800 | 14.000 | 14.200 | 0.5433 | 0.5512 | 0.5591 |
| E3 |  | 12.000 |  |  | 0.4724 |  |
| e |  | 0.500 |  |  | 0.0197 |  |
| L | 0.450 | 0.600 | 0.750 | 0.0177 | 0.0236 | 0.0295 |
| L1 |  | 1.000 |  |  | 0.0394 |  |
| K | $0^{\circ}$ (min.), $3.5^{\circ}$ (typ.), $7^{\circ}$ (max.) |  |  |  |  |  |
| ccc |  |  | 0.080 |  |  | 0.003 |

OUTLINE AND
MECHANICAL DATA


LQFP100 (14x14x1.40mm) Low profile Quad Flat Package


## 29 Ordering Information

Table 162. Device summary

| Order code | Package | Packing | Temperature <br> range ( ${ }^{\circ} \mathbf{C}$ ) | CPU frequency <br> range (MHz) |
| :--- | :---: | :---: | :---: | :---: |
| ST10F252M-4T3 | LQFP100 | Tray | -40 to +125 | 1 to 40 |
|  |  |  |  |  |

## 30 Revision history

Table 163. Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 7 -Feb-2008 | 1 | Initial release |

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